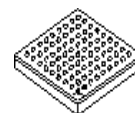


## MCIMX50



### Package Information

Plastic Package

Case 416 MAPBGA 13 x 13 mm, 0.5 mm pitch

Case 416 PoPBGA 13 x 13 mm, 0.5 mm pitch

Case 400 MAPBGA 17 x 17 mm, 0.8 mm pitch

# i.MX50 Applications Processors for Consumer Products

### Ordering Information

See [Table 1 on page 7](#) for ordering information.

## 1 Introduction

The i.MX50 applications processors are multimedia-focused products offering high-performance processing optimized for lowest power consumption. The i.MX50 processors are Freescale Energy Efficiency Solutions products.

The i.MX50 is optimized for portable multimedia applications and features Freescale's advanced implementation of the ARM Cortex-A8® core, which operates at speeds as high as 1 GHz. The i.MX50 provides a powerful display architecture, including a 2D Graphics Processing Unit (GPU) and Pixel Processing Pipeline (eXP). Additionally, the i.MX50 includes a complete integration of the electrophoretic display function. The i.MX50 supports DDR2, LPDDR2, and LPDDR1 DRAM at clock rate up to 266 MHz to enable a range of performance and power trade-offs.

The flexibility of the i.MX50 architecture allows it to be used in a variety of applications. As the heart of the

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Freescale reserves the right to change the detail specifications as may be required to permit improvements in the design of its products.

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application chipset, the i.MX50 provides a rich set of interfaces for connecting peripherals, such as WLAN, Bluetooth™, GPS, and displays.

## 1.1 Product Overview

The i.MX50 is designed to enable high-tier portable applications by satisfying the performance requirements of advanced operating systems and applications.

### 1.1.1 Dynamic Performance Scaling

Freescale's dynamic voltage and frequency scaling (DVFS) allows the device to run at much lower voltage and frequency with ample processing capacity for tasks, such as audio decode, resulting in significant power reduction.

### 1.1.2 Multimedia Processing Powerhouse

The multimedia performance of the i.MX50 processor ARM Cortex-A8 core is boosted by a multi-level cache system, a NEON™ coprocessor with SIMD media processing architecture and 32-bit single-precision floating point support, and two vector floating point coprocessors. The system is further enhanced by a programmable smart DMA (SDMA) controller.

### 1.1.3 Powerful Display System

The i.MX50 includes support for both standard LCD displays as well as electrophoretic displays (e-paper). The display subsystem consists of the following modules:

- Electrophoretic Display Controller (EPDC) (i.MX508 only)  
The EPDC is a feature-rich, low power, and high-performance direct-drive active matrix EPD controller. It is specifically designed to drive E-INK™ EPD panels, supporting a wide variety of TFT architectures. The goal of the EPDC is to provide an efficient SoC integration of this functionality for e-paper applications, allowing a significant bill of materials cost savings over an external solution while reaching much higher levels of performance and lower power. The EPDC module is defined in the context of an optimized hardware/software partitioning and works in conjunction with the ePXP (see [Section 1.1.4, “Graphics Accelerators”](#)).
- Enhanced LCD Controller Interface (eLCDIF)  
The eLCDIF is a high-performance LCD controller interface that supports a rich set of modes and allows interoperability with a wide variety of LCD panels, including DOTCK/RGB and smart panels. The module also supports synchronous operation with the ePXP to allow the processed frames to be passed from the ePXP to the eLCDIF through an on-chip SRAM buffer. The eLCDIF can support up to 32-bit interfaces.

### 1.1.4 Graphics Accelerators

Integrated graphics accelerators offload processing from the ARM processor, enabling high performance graphic applications at minimum power.

- Pixel Processing Pipeline (ePXP)

The ePXP is a high-performance pixel processor capable of 1 pixel/clock performance for combined operations, such as color-space conversion, alpha blending, gamma mapping, and rotation. The ePXP is enhanced with features specifically for grayscale applications working in conjunction with the electrophoretic display controller to form a full grayscale display solution. In addition, the ePXP supports traditional pixel/frame processing paths for still-image and video processing applications, allowing it to interface with the integrated LCD controller (eLCDIF).

- Graphics acceleration

The i.MX50 provides a 2D graphics accelerator with performance up to 200 Mpix/s.

### 1.1.5 Multilevel Memory System

The multilevel memory system of the i.MX50 is based on the L1 instruction and data caches, L2 cache, and internal and external memory. The i.MX50 supports many types of external memory devices, including DDR2, LPDDR2, LPDDR1, NOR Flash, PSRAM, Cellular RAM, NAND Flash (MLC and SLC) and OneNAND™, and managed NAND including eMMC up to rev. 4.4.

### 1.1.6 Smart Speed™ Technology

The i.MX50 device has power management throughout the SOC that enables the rich suite of multimedia features and peripherals to consume minimum power in both active and various low power modes. Smart Speed technology enables the designer to deliver a feature-rich product that requires levels of power that are far less than industry expectations.

### 1.1.7 Interface Flexibility

The i.MX50 supports connection to a variety of interfaces, including an LCD controller for displays, two high-speed USB on-the-go-capable PHYs, multiple expansion card ports (high-speed MMC/SDIO host and others), 10/100 Ethernet controller, and a variety of other popular interfaces (for example, UART, I<sup>2</sup>C, and I<sup>2</sup>S serial audio).

### 1.1.8 Advanced Security

The i.MX50 delivers hardware-enabled security features, such as High-Assurance Boot 4 (HAB4) for signed/authenticated firmware images, basic DRM support with random private keys and AES encryption/decryption, and storage and programmability of on-chip fuses.

## 1.2 Features

The i.MX50 applications processor is based on the ARM Cortex-A8 platform and has the following features:

- MMU, L1 instruction cache, and L1 data cache
- Unified L2 cache
- 800 MHz or 1 GHz target frequency of the core (including NEON, VFPv3, and L1 cache)

## Introduction

- NEON coprocessor (SIMD Media Processing Architecture) and Vector Floating Point (VFP-Lite) coprocessor supporting VFPv3

The memory system consists of the following components:

- Level 1 cache:
  - Instruction (32 Kbyte)
  - Data (32 Kbyte)
- Level 2 cache:
  - Unified instruction and data (256 Kbyte)
- Level 2 (internal) memory:
  - Boot ROM, including HAB (96 Kbyte)
  - Internal multimedia/shared, fast access RAM (128 Kbyte)
- External memory interfaces:
  - 16/32-bit DDR2-533, LPDDR2-533, or LPDDR1-400 up to a total of 2 GByte
  - 8-bit NAND SLC/MLC Flash with up to 100 MHz synchronous clock rate and up to 32-bit hardware ECC for 1 Kbyte block size
  - 16/32-bit NOR Flash with a dedicated 16-bit muxed-mode interface. I/O muxing logic selects EIMv2 port as primary muxing at system boot.
  - 16-bit PSRAM, Cellular RAM
  - Managed NAND, including eMMC up to rev 4.4

The i.MX50 introduces a next generation system bus fabric architecture that aggregates various sub-system buses and masters for access to system peripherals and memories. The various bus-systems and components are as follows:

- 64-bit AXI Fabric (266 MHz)—This bus-fabric is the SoC's central bus aggregation point.
  - Provides access to all slave targets in the SoC:
    - ROM (ROMCP)
    - On-chip RAM (OCRAM)
    - External DRAM (DRAM MC)
    - External static RAM (EIM)
    - Interrupt controller (TZIC)
    - Decode into the AHB MAX crossbar second level AHB fabric.
  - Provides arbitration to the following masters in the system:
    - ARM CPU complex
    - Pixel processing pipeline (ePXP)
    - Electrophoretic display controller (EPDC)
    - eLCDIF LCD display controller
    - DCP Crypto engine
    - BCH ECC engine
    - MAX AHB crossbar

- GPU 2D
- SDMA
- USBOH1 (USB OTG and host controller complex)
- FEC Ethernet controller
- MAX AHB crossbar (133 MHz)—This connects the various AHB bus sub-segments in the system and provides decode into the following slaves:
  - IP-Bus 1 (66 MHz)—This bus segment contains peripherals accessible by the ARM core and without DMA capability
  - IP-Bus 2 (66 MHz)—This bus segment contains peripherals accessible by the ARM core and without DMA capability
  - APBH DMA bridge (133 MHz)—The APBH DMA bridge is a master to the MAX for its memory-side DMA operations. The APBH bus is an AMBA APB slave bus providing peripheral access to many of the high-speed IP blocks on the i.MX50.
- IP-Bus 3 (66 MHz)—This third peripheral bus segment contains peripherals accessible by the ARM core and SDMA and as such houses peripherals with DMA capability. The IP-Bus 3 can be accessed by the ARM CPU through IP-Bus 1 and SPBA.
- Quality of service controller (QoSC)—This provides both soft and dynamic arbitration/priority control. The QoSC works in conjunction with the critical display modules such as the eLCDIF and EPDC to provide dynamic priority control, based on real-time metrics.

The i.MX50 makes use of dedicated hardware accelerators to achieve state-of-the-art multimedia performance. The use of hardware accelerators provides both high performance and low power consumption, while freeing up the CPU core for other tasks.

The i.MX50 incorporates the following hardware accelerators:

- GPU2Dv1—2D Graphics accelerator, OpenVG 1.1, 200 Mpix/s performance
- ePXP—enhanced PiXel Processing Pipeline off loading key pixel processing operations required to support both LCD and EPD display applications

The i.MX50 includes the following interfaces to external devices:

### NOTE

Not all the interfaces are available simultaneously depending on I/O multiplexer configuration.

- Displays:
  - EPDC (i.MX508 Only)—Supporting direct-driver TFT backplanes beyond  $2048 \times 1536$  at 106 Hz refresh (or  $4096 \times 4096$  at 20 Hz)
  - eLCDIF—Supporting beyond SXGA + ( $1400 \times 1050$ ) at 60 Hz resolutions with up to a 32-bit display interface
  - On the i.MX508, both displays can be active simultaneously. If both displays are active, the eLCDIF only provides a 16-bit interface due to pin muxing.
- Expansion cards:
  - Four SD/MMC card

## Introduction

- USB:
  - One High Speed (HS) USB 2.0 OTG-capable port with integrated HS USB PHY
  - One High Speed (HS) USB 2.0 host port with integrated HS USB PHY
- Miscellaneous interfaces:
  - One-wire (OWIRE) port
  - Two I2S/SSI/AC97 ports, supporting up to 1.4 Mbps each connected to the Audio Multiplexer (AUDMUX) providing four external ports
  - Five UART RS232 ports, up to 4.0 Mbps each
  - Two eCSPI (Enhanced CSPI) ports, up to 66 Mbps each plus CSPI port, up to 16.6 Mbps
  - Three I<sup>2</sup>C ports, supporting 400 kbps
  - Fast Ethernet controller IEEE 802.3, 10/100 Mbps
  - Key pad port (KPP)
  - Two pulse width modulators (PWM)
  - GPIO with interrupt capabilities
  - Secure JTAG controller (SJC)

The system supports efficient and smart power control and clocking:

- Supporting DVFS techniques for low power modes, including auto slow architecture
- Power gating-SRPG (state retention power gating) for ARM core and NEON
- Support for various levels of system power modes
- Flexible clock gating control scheme
- On-chip temperature monitor
- On-chip 32 kHz and 24 MHz oscillators
- A total of four PLLs with the fourth PLL providing up to eight independently controllable outputs, improving the ease of clocking control, especially for display and connectivity modules

Security functions are enabled and accelerated by the following hardware:

- Secure JTAG controller (SJC)—Protecting JTAG from debug port attacks by regulating or blocking the access to the system debug features
- Secure real-time clock (SRTC)—Tamper resistant RTC with dedicated power domain and mechanism to detect voltage and clock glitches
- Advanced high assurance boot (A-HAB)—HAB with the next embedded enhancements: SHA-256, 2048-bit RSA key, version control mechanism, warm boot, CSU, and TZ initialization

## 1.3 Ordering Information

Table 1 provides the ordering information.

Table 1. Ordering Information

| Part Number   | Maximum ARM CLK Frequency | Mask Set | Features                                           | Temperature Range (°C) |                       | Package <sup>1</sup>                             |
|---------------|---------------------------|----------|----------------------------------------------------|------------------------|-----------------------|--------------------------------------------------|
|               |                           |          |                                                    | T <sub>ambient</sub>   | T <sub>junction</sub> |                                                  |
| MCIMX508CVK1B | 1 GHz                     | N78A     | Full Specification                                 | 0 to 70                | 0 to 90               | 13 x 13 mm, 0.5 mm pitch BGA<br>Case: 416 MAPBGA |
| MCIMX508CVM1B | 1 GHz                     | N78A     | Full Specification                                 | 0 to 70                | 0 to 90               | 17 x 17 mm, 0.8 mm pitch BGA<br>Case: 400 MAPBGA |
| MCIMX508CVK8B | 800 MHz                   | N78A     | Full Specification                                 | 0 to 70                | 0 to 90               | 13 x 13 mm, 0.5 mm pitch BGA<br>Case: 416 MAPBGA |
| MCIMX508CZK8B | 800 MHz                   | N78A     | Full Specification                                 | 0 to 70                | 0 to 90               | 13 x 13 mm, 0.5 mm pitch BGA<br>Case: 416 PoPBGA |
| MCIMX508CVM8B | 800 MHz                   | N78A     | Full Specification                                 | 0 to 70                | 0 to 90               | 17 x 17 mm, 0.8 mm pitch BGA<br>Case: 400 MAPBGA |
| MCIMX507CVM1B | 1 GHz                     | N78A     | No GPU                                             | 0 to 70                | 0 to 90               | 17 x 17 mm, 0.8 mm pitch BGA<br>Case: 400 MAPBGA |
| MCIMX507CVK1B | 1 GHz                     | N78A     | No GPU                                             | 0 to 70                | 0 to 90               | 13 x 13 mm, 0.5 mm pitch BGA<br>Case: 416 MAPBGA |
| MCIMX507CVM8B | 800 MHz                   | N78A     | No GPU                                             | 0 to 70                | 0 to 90               | 17 x 17 mm, 0.8 mm pitch BGA<br>Case: 400 MAPBGA |
| MCIMX507CVK8B | 800 MHz                   | N78A     | No GPU                                             | 0 to 70                | 0 to 90               | 13 x 13 mm, 0.5 mm pitch BGA<br>Case: 416 MAPBGA |
| MCIMX503CVK8B | 800 MHz                   | N78A     | No EPD controller                                  | 0 to 70                | 0 to 90               | 13 x 13 mm, 0.5 mm pitch BGA<br>Case: 416 MAPBGA |
| MCIMX503CVM8B | 800 MHz                   | N78A     | No EPD controller                                  | 0 to 70                | 0 to 90               | 17 x 17 mm, 0.8 mm pitch BGA<br>Case: 400 MAPBGA |
| MCIMX503EVM8B | 800 MHz                   | N78A     | No EPD controller,<br>Extended Temperature         | -20 to 70              | -20 to 90             | 17 x 17 mm, 0.8 mm pitch BGA<br>Case: 400 MAPBGA |
| MCIMX502CVK8B | 800 MHz                   | N78A     | No GPU, no EPD controller                          | 0 to 70                | 0 to 90               | 13 x 13 mm, 0.5 mm pitch BGA<br>Case: 416 MAPBGA |
| MCIMX502CVM8B | 800 MHz                   | N78A     | No GPU, no EPD controller                          | 0 to 70                | 0 to 90               | 17 x 17 mm, 0.8 mm pitch BGA<br>Case: 400 MAPBGA |
| MCIMX502EVM8B | 800 MHz                   | N78A     | No GPU, no EPD controller,<br>Extended Temperature | -20 to 70              | -20 to 90             | 17 x 17 mm, 0.8 mm pitch BGA<br>Case: 400 MAPBGA |

<sup>1</sup> Case MAPBGA is RoHS compliant, lead-free MSL (Moisture Sensitivity Level) 3.

## 1.4 Part Number Feature Comparison

Table 2 provides an overview of the feature differences between the i.MX50 part numbers.

**Table 2. Part Number Feature Comparison**

| Part Number | Disabled Features | Comments                                                                                                                                                                                                                                                                 |
|-------------|-------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| MCIMX508    | None              |                                                                                                                                                                                                                                                                          |
| MCIMX507    | GPU               |                                                                                                                                                                                                                                                                          |
| MCIMX503    | EPDC              | The i.MX503 has the same ball map and IOMUX as the i.MX508. The EPDC pins still exist on the i.MX503, but because the EPDC block is disabled, those pins cannot be used for EPDC functionality (ALT0) and must be configured in the IOMUX with another ALT-mode setting. |
| MCIMX502    | GPU, EPDC         | The i.MX502 has the same ball map and IOMUX as the i.MX508. The EPDC pins still exist on the i.MX502, but because the EPDC block is disabled, those pins cannot be used for EPDC functionality (ALT0) and must be configured in the IOMUX with another ALT-mode setting. |

## 1.5 Package Feature Comparison

Table 3 provides an overview of the feature and pin differences between the i.MX50 packages.

**Table 3. Package Feature Comparison**

| Package    | Dimensions               | I/O Pin Differences Versus 416 MAPBGA                                                                                                                                                                                                                                                                                                                                                                                                         | Notes on Package Differences                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|------------|--------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 416 MAPBGA | 13 x 13 mm, 0.5 mm pitch | —                                                                                                                                                                                                                                                                                                                                                                                                                                             | <ul style="list-style-type: none"> <li>USB_OTG_VDDA25 and USB_H1_VDDA25 are shorted together on the 416 MAPBGA package substrate.</li> <li>USB_OTG_VDDA33 and USB_H1_VDDA33 are shorted together on the 416 MAPBGA package substrate.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| 416 PoPBGA | 13 x 13 mm, 0.5 mm pitch | <p><b>Deleted Pins:</b></p> <p>DRAM_A10<br/>DRAM_A11<br/>DRAM_A12<br/>DRAM_A13<br/>DRAM_A14<br/>DRAM_CAS<br/>DRAM_OPEN<br/>DRAM_OPENFB<br/>DRAM_RAS<br/>DRAM_SDBA0<br/>DRAM_SDBA1<br/>DRAM_SDBA2<br/>DRAM_SDCLK_1<br/>DRAM_SDCLK_1_B<br/>DRAM_SDODT0<br/>DRAM_SDODT1<br/>DRAM_SDWE<br/>DRAM_OPEN<br/>DRAM_OPENFB</p> <p><b>Added Pins:</b></p> <p>POP_EMMC_RST<br/>POP_LPDDR2_ZQ0<br/>POP_LPDDR2_ZQ1<br/>POP_LPDDR2_1.8V<br/>POP_NAND_VCC</p> | <ul style="list-style-type: none"> <li>The i.MX50 PoPBGA package supports 168-FBGA LPDDR2 DRAM memory only. It is not possible to support LPDDR1 or DDR2 on the i.MX50 PoPBGA.</li> <li>i.MX50 PoPBGA was designed to accommodate a combined LPDDR2 / eMMC PoP memory. The PoP eMMC device uses the SD3_DATA[7:0], SD3_CLK, and SD3_CMD pins. Because the PoP eMMC I/O and memory supplies are tied together on the substrate, 1.8 V eMMC I/O operation is not supported for the PoP eMMC device. POP_NAND_VCC and NVCC_NANDF must use a 3 V supply.</li> <li>The NVCC_EMI_DRAM power pins supply 1.2 V power to the i.MX50 DRAM controller as well as the PoP LPDDR2 DRAM.</li> <li>Additional PoP package pin descriptions may be found in the Special Signals Considerations section (Table 5).</li> <li>On the PoPBGA package, the DRAM Address, Data, and clock pins are routed to the bottom balls for Freescale test purposes only. It is recommended that these bottom DRAM pins are left unconnected on the customer PCB.</li> <li>USB_OTG_VDDA25 and USB_H1_VDDA25 are shorted together on the 416 PoPBGA package substrate.</li> <li>USB_OTG_VDDA33 and USB_H1_VDDA33 are shorted together on the 416 PoPBGA package substrate.</li> </ul> |
| 400 MAPBGA | 17 x 17 mm, 0.8 mm pitch | <p><b>Deleted Pins:</b></p> <p>DRAM_SDCLK_1<br/>DRAM_SDCLK_1_B<br/>DRAM_A14<br/>DRAM_SDODT1<br/>UART2_CTS<br/>UART2_RTS</p>                                                                                                                                                                                                                                                                                                                   | <ul style="list-style-type: none"> <li>USB_OTG_VDDA25 and USB_H1_VDDA25 are independent and NOT shorted together on the 400 MAPBGA package substrate.</li> <li>USB_OTG_VDDA33 and USB_H1_VDDA33 are independent and NOT shorted together on the 400 MAPBGA package substrate.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |

## 2 Architectural Overview

The following sections provide an architectural overview of the i.MX50 processor system.

### 2.1 Block Diagram

Figure 1 shows the functional modules in the i.MX50 processor system.

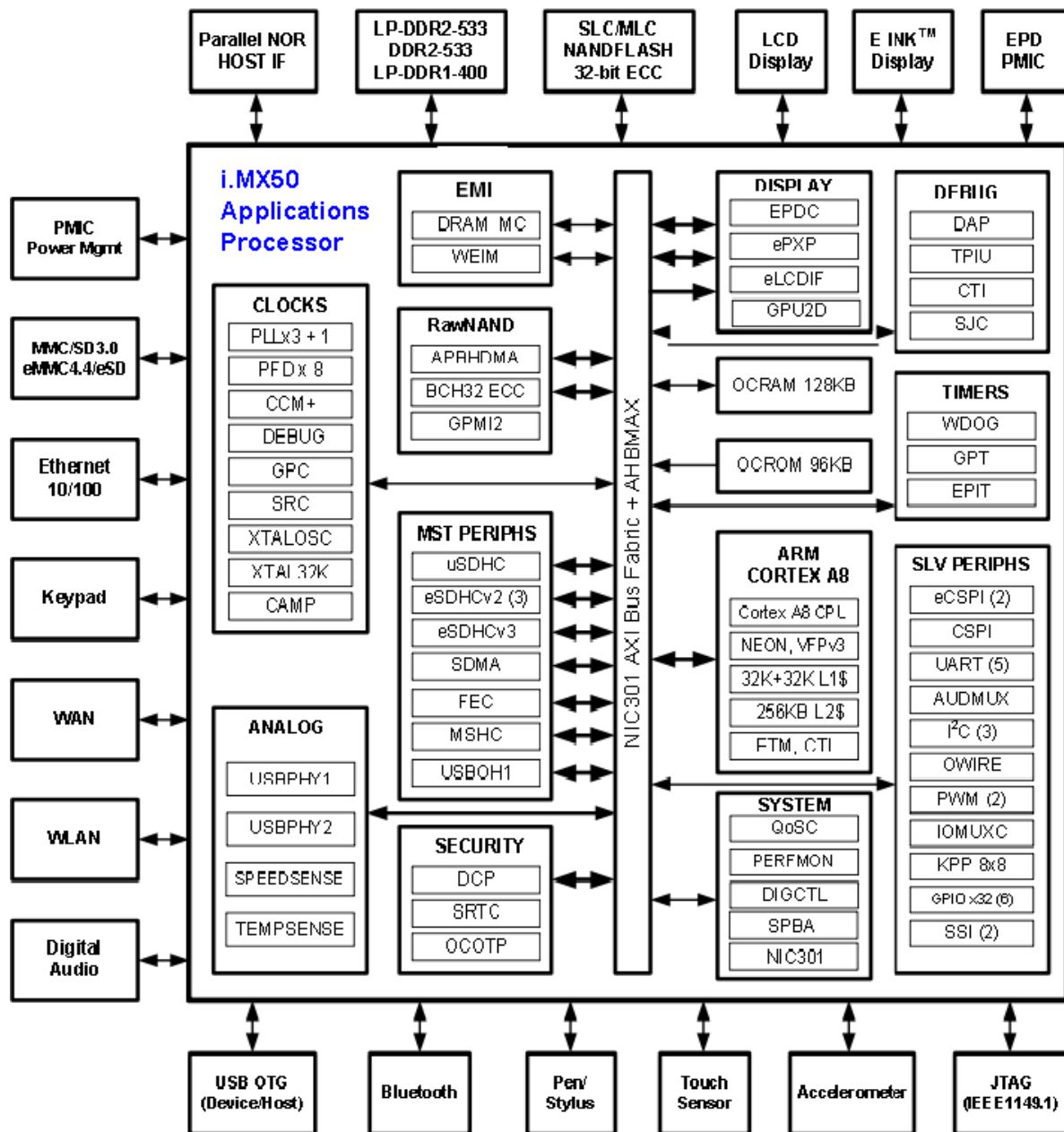


Figure 1. i.MX50 System Block Diagram

## NOTE

The numbers in brackets indicate the number of module instances. For example, PWM (2) indicates two separate PWM peripherals.

## 3 Modules List

The i.MX50 processor contains a variety of digital and analog modules that are described in [Table 4](#) in alphabetical order.

**Table 4. i.MX50 Digital and Analog Modules**

| Block Mnemonic | Block Name                         | Subsystem                         | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
|----------------|------------------------------------|-----------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ARM Cortex-A8  | ARM Cortex-A8 Platform             | ARM                               | The ARM Cortex-A8 Core Platform consists of the ARM Cortex-A8 processor and its essential sub-blocks. It contains the 32 Kbyte L1 instruction cache, 32 Kbyte L1 data cache, Level 2 cache controller and a 256 Kbyte L2 cache. The platform also contains an event monitor and debug modules. It also has a NEON coprocessor with SIMD media processing architecture, register file with $32 \times 64$ -bit general-purpose registers, an Integer execute pipeline (ALU, Shift, MAC), dual, single-precision floating point execute pipeline (FADD, FMUL), load/store and permute pipeline, and a non-pipelined vector floating point (VFP Lite) coprocessor supporting VFPv3. |
| EPDC           | Electrophoretic Display Controller | Display Peripherals               | The EPDC is a feature-rich, low power, and high-performance direct-drive active matrix EPD controller. It is specifically designed to drive E-INK™ EPD panels supporting a wide variety of TFT backplanes.                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| eXPX           | enhanced PiXel Processing Pipeline | Display Peripherals               | A high-performance pixel processor capable of 1 pixel/clock performance for combined operations such as color-space conversion, alpha blending, gamma-mapping, and rotation. The eXPX is enhanced with features specifically for grayscale applications. In addition, the eXPX supports traditional pixel/frame processing paths for still-image and video processing applications allowing it to interface with the integrated LCD controller (eLCDIF).                                                                                                                                                                                                                         |
| eLCDIF         | enhanced LCD Interface             | Display Peripherals               | The eLCDIF is a high-performance LCD controller interface supporting a rich set of modes allowing inter operability with a wide variety of LCD panels, including DOTCK/RGB and smart panels. The module also supports a synchronous operation with the eXPX to allow the processed frames to be passed from the eXPX to the eLCDIF through an on-chip SRAM buffer. The eLCDIF can support up to 32-bit interfaces.                                                                                                                                                                                                                                                               |
| AUDMUX         | Digital Audio Mux                  | Slave Connectivity Peripherals    | The AUDMUX is a programmable interconnect for voice, audio, and synchronous data routing between host serial interfaces (for example, SSI1 and SSI2) and peripheral serial interfaces (audio and voice codecs). The AUDMUX has six ports (two internal and four external) with identical functionality and programming models. A desired connectivity is achieved by configuring two or more AUDMUX ports.                                                                                                                                                                                                                                                                       |
| CAMP-1         | Clock Amplifier                    | Clocks, Resets, and Power Control | Clock Amplifier                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |

**Table 4. i.MX50 Digital and Analog Modules (continued)**

| Block Mnemonic             | Block Name                                                                 | Subsystem                         | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|----------------------------|----------------------------------------------------------------------------|-----------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| CCM<br>GPC<br>SRC          | Clock Control Module<br>Global Power Controller<br>System Reset Controller | Clocks, Resets, and Power Control | These modules are responsible for clock and reset distribution in the system, and also for system power management.<br>The system includes four PLLs.                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| CSPI<br>eCSPI-1<br>eCSPI-2 | Configurable SPI, Enhanced CSPI                                            | Slave Connectivity Peripherals    | Full-duplex enhanced synchronous serial interface, with data rate up to 66.5 Mbit/s (for eCSPI, master mode). It is configurable to support Master/Slave modes, four chip selects to support multiple peripherals.                                                                                                                                                                                                                                                                                                                                                                                                                  |
| DAP<br>TPIU<br>CTI         | Debug System                                                               | System Control Peripherals        | The Debug System provides real-time trace debug capability of both instructions and data. It supports a trace protocol that is an integral part of the ARM Real Time Debug solution (RealView).<br>Real-time tracing is controlled by specifying a set of triggering and filtering resources, which include address and data comparators, three cross-system triggers (CTI), counters, and sequencers.<br>Debug access port (DAP)—The DAP provides real-time access for the debugger without halting the core to System memory and peripheral registers. All debug configuration registers and Debugger access to JTAG scan chains. |
| DRAM MC                    | DRAM Memory Controller                                                     | External Memory Interface         | The DRAM MC consists of a DRAM memory controller and PHY, supporting LPDDR2, DDR2, and LPDDR1 memories with clock frequencies up to 266 MHz with 32-bit interface. It is tightly linked with the system bus fabric and employs advanced arbitration mechanism to maximize DRAM bandwidth efficiency.                                                                                                                                                                                                                                                                                                                                |
| EIM                        | Static Memory Controller                                                   | External Memory Interface         | The EIM is an external static memory and generic host interface. It supports up to a 32-bit interface (through pin-muxing) or a dedicated 16-bit muxed interface. It can be used to interface to PSRAMs (sync and async), NOR-flash or any external memory mapped peripheral.                                                                                                                                                                                                                                                                                                                                                       |
| BCH32/GPMI2                | Raw NAND System with ECC                                                   | RawNAND and SSP Peripherals       | The i.MX50 contains a fully hardware accelerated raw NAND flash solution supporting SLC and MLC devices. The system consists of the GPMI2 module, which is driven by the APBH DMA engine to perform the NAND flash interface function (supporting up to ONFI2.1). Coupled with the GPMI2 is the BCH32 hardware error-correction engine which is an AXI bus-master and supports up to 32-bits of correction over block sizes up to 1 Kbyte (that is, supports up to 2 Kbyte code-size).                                                                                                                                              |
| System Fabric and QoS      | System Fabric and QoS                                                      | System Peripherals                | In order to aggregate the multitude of masters and memory mapped devices, the i.MX50 contains a next-generation AMBA3 AXI bus fabric. In addition, the i.MX50 contains a Quality of Service Controller IP (QoSC) which allows both soft priority control and dynamic priority elevation. Software priority control works for all masters but dynamic hardware control only works for EPDC and eLCDIF.                                                                                                                                                                                                                               |
| EPIT                       | Enhanced Periodic Interrupt Timer                                          | Timer Peripherals                 | Each EPIT is a 32-bit <i>set and forget</i> timer that starts counting after the EPIT is enabled by software. It is capable of providing precise interrupts at regular intervals with minimal processor intervention. It has a 12-bit prescaler for division of input clock frequency to get the required time setting for the interrupts to occur, and counter values can be programmed on the fly.                                                                                                                                                                                                                                |

Table 4. i.MX50 Digital and Analog Modules (continued)

| Block Mnemonic                                           | Block Name                                                                     | Subsystem                       | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|----------------------------------------------------------|--------------------------------------------------------------------------------|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| eSDHCv3-3<br>(eMMC 4.4)                                  | Ultra-High-Speed Multi-Media Card/ Secure Digital card host controller, ver. 3 | Master Connectivity Peripherals | Ultra High-Speed eSDHC, enhanced to support eMMC 4.4 standard specification, for 832 Mbps.<br>IP is backward compatible to eSDHCv2 IP. See complete features listing in eSDHCv2 entry below.<br>Port 3 is specifically enhanced to support eMMC 4.4 specification, for double data rate (832 Mbps, 8-bit port).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| eSDHCv2-1<br>eSDHCv2-2<br>eSDHCv2-4                      | Enhanced Multi-Media Card/ Secure Digital Host Controller, ver. 2              |                                 | In Enhanced Multi-Media Card/Secure Digital Host Controller the Ports 1, 2, and 4 are compatible with the <i>MMC System Specification</i> version 4.3, full support<br>The generic features of the eSDHCv2 module, when serving as SD/MMC host, include the following: <ul style="list-style-type: none"> <li>• Can be configured either as SD/MMC controller</li> <li>• Supports eSD and eMMC standard, for SD/MMC embedded type cards</li> <li>• Conforms to <i>SD Host Controller Standard Specification</i> version 2.0, full support</li> <li>• Compatible with the SD Memory Card Specification version 1.1</li> <li>• Compatible with the SDIO Card Specification version 1.2</li> <li>• Designed to work with SD Memory, miniSD Memory, SDIO, miniSDIO, SD Combo, MMC and MMC RS cards</li> <li>• Configurable to work in one of the following modes: <ul style="list-style-type: none"> <li>—SD/SDIO 1-bit, 4-bit</li> <li>—MMC 1-bit, 4-bit, 8-bit</li> </ul> </li> <li>• Full/High speed mode</li> <li>• Host clock frequency variable between 32 kHz to 52 MHz</li> <li>• Up to 200 Mbps data transfer for SD/SDIO cards using four parallel data lines</li> <li>• Up to 416 Mbps data transfer for MMC cards using eight parallel data lines</li> </ul> |
| FEC                                                      | Fast Ethernet Controller                                                       | Master Connectivity Peripherals | The Ethernet Media Access Controller (MAC) is designed to support both 10 Mbps and 100 Mbps Ethernet/IEEE Std 802.3™ networks. An external transceiver interface and transceiver function are required to complete the interface to the media.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| GPIO-1<br>GPIO-2<br>GPIO-3<br>GPIO-4<br>GPIO-5<br>GPIO-6 | General Purpose I/O Modules                                                    | Slave Connectivity Peripherals  | These modules are used for general purpose input/output to external ICs. Each GPIO module supports up to 32 bits of I/O.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| GPT                                                      | General Purpose Timer                                                          | Timer Peripherals               | Each GPT is a 32-bit <i>free-running</i> or <i>set and forget</i> mode timer with a programmable prescaler and compare and capture register. A timer counter value can be captured using an external event, and can be configured to trigger a capture event on either the leading or trailing edges of an input pulse. When the timer is configured to operate in “set and forget” mode, it is capable of providing precise interrupts at regular intervals with minimal processor intervention. The counter has output compare logic to provide the status and interrupt at comparison. This timer can be configured to run either on an external clock or on an internal clock.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |

**Table 4. i.MX50 Digital and Analog Modules (continued)**

| Block Mnemonic                                                 | Block Name                          | Subsystem                      | Brief Description                                                                                                                                                                                                                                                               |
|----------------------------------------------------------------|-------------------------------------|--------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| GPU2Dv1                                                        | Graphics Processing Unit-2D, ver. 1 | Display Peripherals            | The GPU2Dv1 provides hardware acceleration for 2D graphic algorithms with sufficient processor power to run desk-top quality interactive graphics applications on displays up to HD1080 resolution.                                                                             |
| I <sup>2</sup> C-1<br>I <sup>2</sup> C-2<br>I <sup>2</sup> C-3 | I <sup>2</sup> C Interface          | Connectivity Peripherals       | I <sup>2</sup> C provides serial interface for controlling peripheral devices. Data rates of up to 400 kbps are supported.                                                                                                                                                      |
| OCOTP Controller                                               | On-chip OTP controller              | Security Peripherals           | The on-chip one-time -programmable (OCOTP) ROM serves the functions of hardware and software capability bits, Freescale operations and unique-ID, the customer-programmable cryptography key, and storage of various ROM and general purpose configuration bits.                |
| IOMUXC                                                         | IOMUX Control                       | Slave Connectivity Peripherals | This module enables flexible I/O multiplexing. Each I/O pad has default as well as several alternate functions. The alternate functions are software configurable.                                                                                                              |
| KPP                                                            | Keypad Port                         | Slave Connectivity Peripherals | The KPP supports an 8 × 8 external keypad matrix. The KPP features are as follows: <ul style="list-style-type: none"> <li>• Open drain design</li> <li>• Glitch suppression circuit design</li> <li>• Multiple keys detection</li> <li>• Standby key press detection</li> </ul> |
| OWIRE                                                          | One-Wire Interface                  | Slave Connectivity Peripherals | One-Wire support provided for interfacing with an on-board EEPROM, and smart battery interfaces, for example, Dallas DS2502.                                                                                                                                                    |
| PWM-1<br>PWM-2                                                 | Pulse Width Modulation              | Slave Connectivity Peripherals | The pulse-width modulator (PWM) has a 16-bit counter and is optimized to generate sound from stored sample audio images. It can also generate tones. The PWM uses 16-bit resolution and a 4 x 16 data FIFO to generate sound.                                                   |
| RAM<br>128 Kbytes                                              | Internal RAM                        | Internal Memory                | The On-Chip Memory controller (OCRAM) module, is an interface between the system's AXI bus, to the internal (on-chip) SRAM memory module. It is used for controlling the 128 Kbyte multimedia RAM, through a 64-bit AXI bus.                                                    |
| ROM<br>96 Kbytes                                               | Boot ROM                            | Internal Memory                | Supports secure and regular Boot Modes.<br>The ROM Controller supports ROM Patching.                                                                                                                                                                                            |

**Table 4. i.MX50 Digital and Analog Modules (continued)**

| Block Mnemonic | Block Name                    | Subsystem                       | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|----------------|-------------------------------|---------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SDMA           | Smart Direct Memory Access    | Master Connectivity Peripherals | <p>The SDMA is multi-channel flexible DMA engine. It helps in maximizing system performance by offloading various cores in dynamic data routing. The SDMA features list is as follows:</p> <ul style="list-style-type: none"> <li>• Powered by a 16-bit instruction-set micro-RISC engine</li> <li>• Multi-channel DMA supports up to 32 time-division multiplexed DMA channels</li> <li>• 48 events with total flexibility to trigger any combination of channels</li> <li>• Memory accesses including linear, FIFO, and 2D addressing</li> <li>• Shared peripherals between ARM Cortex-A8 and SDMA</li> <li>• Very fast context-switching with two-level priority-based preemptive multi-tasking</li> <li>• DMA units with auto-flush and prefetch capability</li> <li>• Flexible address management for DMA transfers (increment, decrement, and no address changes on source and destination address)</li> <li>• DMA ports can handle uni-directional and bi-directional flows (copy mode)</li> <li>• Up to 8-word buffer for configurable burst transfers for EMI</li> <li>• Support of byte-swapping and CRC calculations</li> <li>• A library of scripts and API is available</li> </ul> |
| SJC            | Secure JTAG Controller        | System Control Peripherals      | <p>The Secure JTAG Controller provides a mechanism for regulating JTAG access, preventing unauthorized JTAG usage while allowing JTAG access for manufacturing tests and software debugging.</p> <p>The i.MX50 JTAG port provides debug access to several hardware blocks including the ARM processor and the system bus, therefore, it must be accessible for initial laboratory bring-up, manufacturing tests and troubleshooting, and for software debugging by authorized entities. However, if the JTAG port is left unsecured it provides a method for executing unauthorized program code, getting control over secure applications, and running code in privileged modes.</p> <p>The Secure JTAG controller provides three different security modes that can be selected through an e-fuse configuration to prevent unauthorized JTAG access.</p>                                                                                                                                                                                                                                                                                                                                       |
| SPBA           | Shared Peripheral Bus Arbiter | System Control Peripherals      | <p>SPBA (Shared Peripheral Bus Arbiter) is a two-to-one IP bus interface (IP bus) arbiter.</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| SRTC           | Secure Real Time Clock        | Security Peripherals            | <p>The SRTC incorporates a special System State Retention Register (SSRR) that stores system parameters during system shutdown modes. This register and all SRTC counters are powered by dedicated supply rail NVCC_SRTC. The NVCC_SRTC can be energized separately even if all other supply rails are shut down. This register is helpful for storing warm boot parameters. The SSRR also stores the system security state. In case of a security violation, the SSRR marks the event (security violation indication).</p>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |

**Table 4. i.MX50 Digital and Analog Modules (continued)**

| Block Mnemonic                                 | Block Name                                    | Subsystem                       | Brief Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
|------------------------------------------------|-----------------------------------------------|---------------------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| SSI-1<br>SSI-2                                 | I2S/SSI/AC97 Interface                        | Slave Connectivity Peripherals  | The SSI is a full-duplex synchronous interface used on the i.MX50 processor to provide connectivity with off-chip audio peripherals. The SSI interfaces connect internally to the AUDMUX for mapping to external ports. The SSI supports a wide variety of protocols (SSI normal, SSI network, I2S, and AC-97), bit depths (up to 24 bits per word), and clock/frame sync options. Each SSI has two pairs of 8 x 24 FIFOs and hardware support for an external DMA controller in order to minimize its impact on system performance. The second pair of FIFOs provides hardware interleaving of a second audio stream, which reduces CPU overhead in use cases where two time slots are being used simultaneously. |
| Temperature Monitor                            | Temp Sensor                                   | Analog                          | The temperature sensor is an internal module to the i.MX50 that monitors the die temperature.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| UART-1<br>UART-2<br>UART-3<br>UART-4<br>UART-5 | UART Interface, ver. 2                        | Slave Connectivity Peripherals  | Each of the UARTv2 modules supports the following serial data transmit/receive protocols and configurations: <ul style="list-style-type: none"> <li>• 7 or 8-bit data words, 1 or 2 stop bits, programmable parity (even, odd, or none)</li> <li>• Programmable bit-rates up to 4 Mbps. This is a higher max baud rate relative to the 1.875 Mbps, which is specified by the TIA/EIA-232-F standard.</li> <li>• 32-byte FIFO on Tx and 32 half-word FIFO on Rx supporting auto-baud</li> <li>• IrDA 1.0 support (up to SIR speed of 115200 bps)</li> </ul>                                                                                                                                                         |
| USB-OH-1                                       | USB 2.0 High-Speed OTG-capable and Host ports | Master Connectivity Peripherals | USB-OH-1 supports USB2.0 HS/FS/LS, and contains: <ul style="list-style-type: none"> <li>• One high-speed OTG-capable module with integrated HS USB PHY</li> <li>• One high-speed Host module with integrated HS USB PHY</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| WDOG-1                                         | Watch Dog                                     | Timer Peripherals               | The Watchdog (WDOG) timer module protects against system failures by providing a method of escaping from unexpected events or programming errors. The WDOG Timer supports two comparison points during each counting period. Each of the comparison points is configurable to invoke an interrupt to the ARM core, and a second point invokes an external event on the WDOG line.                                                                                                                                                                                                                                                                                                                                  |
| XTALOSC                                        | Crystal Oscillator I/F                        | Clocking                        | The XTALOSC module combined with an external 24 MHz crystal with load capacitors implements a crystal oscillator.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |

## 3.1 Special Signal Considerations

Table 5 lists special signal considerations for the i.MX50. The signal names are listed in alphabetical order. The package contact assignments are found in [Section 5, “Package Information and Contact Assignments.”](#) The signal descriptions are defined in the *MCIMX50 Applications Processor Reference Manual* (MCIMX50RM).

**Table 5. Special Signal Considerations**

| Signal Name                                                   | Remarks                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|---------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| BOOT_MODE0,<br>BOOT_MODE1                                     | These two input pins are sampled out of reset and set the boot mode. For Internal boot, they should be set to 00. For Internal Fuse Only boot, they should be set to 10. For USB downloader, they should be set to 11. The BOOTMODE pins are in the NVCC_RESET domain and include an internal 100K pull-up resistor at start-up.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| BOOT_CONFIG1[7:0],<br>BOOT_CONFIG2[7:0],<br>BOOT_CONFIG3[7:0] | These 24 pins are the GPIO boot override pins and may be driven at power up to select the boot mode. They are sampled 4 x CKIL clock cycles after POR is de-asserted. Consult the “System Boot” chapter of the Reference Manual for more details.<br>Note that these are not dedicated pins: the BOOT_CONFIG pins appear over 24 pins of the EIM interface.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| BT_LPB_FREQ[1:0]                                              | If the LOW_BATT_GPIO (UART4_TXD) is asserted at power up, the BT_LPB_FREQ[1:0] pins will be sampled to determine the ARM core frequency. Consult the “System Boot” chapter of the Reference Manual for more details.<br>Note that these are not dedicated pins: BT_LPB_FREQ0 appears on SSI_TXFS and BT_LPB_FREQ1 appears on SSI_TXC.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| CHGR_DET_B                                                    | This is the USB Charger Detect pin. It is an open drain output pin that expects a 100 K pull-up. This pin is asserted low when a USB charger is detected on the OTG PHY DP and DM. This detection occurs with the application of VBUS. This pin is a raw sensor output and care must be taken to follow the system timings outlined in the USB charger specification Rev 1.1. The maximum current leakage at this pin is 8.5 $\mu$ A. This pin can be controlled by software control as well. If not used, this pin should be tied to ground or left floating.                                                                                                                                                                                                                                                                                                                                                                                                        |
| CKIH                                                          | This is an input to the CAMPS (Clock Amplifiers), which include on-chip AC-coupling precluding the need for external coupling capacitors. The CAMPS are enabled by default, but the main clocks feeding the on-chip clock tree are sourced from XTAL/EXTAL by default. Optionally, the use of a low jitter external oscillators to feed CKIH (while not required) can be an advantage if low jitter or special frequency clock sources are required by modules sourced by CKIH. See CCM chapter in the <i>MCIMX50 Applications Processor Reference Manual</i> (MCIMX50RM) for details on the respective clock trees.<br>After initialization, the CAMPS may be disabled if not used by programming the CCR CAMPx_EN field. If disabled, the on-chip CAMP output is low and the input is irrelevant. CKIH is on the NVCC_JTAG power domain, so the input clock amplitude should not exceed NVCC_JTAG.<br>If unused, the user should tie CKIH to GND for best practice. |
| CKIL/ECKIL                                                    | The user must tie a fundamental mode 32.768 K crystal across ECKIL and CKIL. The target ESR should be 50 K or less. The bias resistor for the amplifier is integrated and approximately 14 M $\Omega$ . The target load capacitance for the crystal is approximately 10 pF. The load capacitors on the board should be slightly less than double this value after taking parasitics into account. While driving in an external 32 KHz signal into ECKIL, CKIL should be left floating so that it biases. A differential amplifier senses these two pins to propagate the clock inside the i.MX508. Care must be taken to minimize external leakages on ECKIL and CKIL. If they are significant to the 14 M $\Omega$ feedback or 1 $\mu$ A, then loss of oscillation margin or cessation of oscillation may result.                                                                                                                                                    |

**Table 5. Special Signal Considerations (continued)**

| Signal Name                                                                             | Remarks                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|-----------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DRAM_OPEN,<br>DRAM_OPENFB (for 416<br>MAPBGA and 400 MAPBGA)                            | These pins are the echo gating output and feedback pins used by the DRAM PHY to bound a window around the DQS transition. For an application using a single DRAM device, these pins should be routed so that the<br>trace length (DRAM_OPEN + DRAM_OPENFB) =<br>trace length (DRAM_SDCLK0 + DRAM_SDQS0).<br>For an application using two DRAM devices, they should be routed so that the<br>trace length (DRAM_OPEN + DRAM_OPENFB) =<br>trace length (AVG(DRAM_SDCLK0+DRAM_SDCLK1) + AVG (DRAM_SDQS0_to_Device0 + DRAM_SDQS0_to_Device1)).<br>This connection is required for LPDDR1, LPDDR2, and DDR2. For the i.MX50 PoP package, these signals are connected on the substrate. |
| DRAM_SDOdT0 (for 416<br>MAPBGA and 400 MAPBGA),<br>DRAM_SDOdT1 (for 416<br>MAPBGA only) | These pins are the On-die termination outputs from the i.MX50.<br>For DDR2, these pins should be connected to the DDR2 DRAM ODT pins. For LPDDR1 and LPDDR2, these pins should be left floating. Note that both SDOdT pins are removed on the 416 PoPBGA package, and only SDOdT0 exists on the 400 MAPBGA package.                                                                                                                                                                                                                                                                                                                                                               |
| DRAM_CALIBRATION                                                                        | This pin is the ZQ calibration used to calibrate DRAM Ron and ODT.<br>For LPDDR2, this pin should be connected to ground through a 240 $\Omega$ 1% resistor. For DDR2 and LPDDR1, this pin should be connected to ground through a 300 $\Omega$ 1% resistor.                                                                                                                                                                                                                                                                                                                                                                                                                      |
| JTAG_MOD                                                                                | This input has an internal 100K pull-up, by default. Note that JTAG_MOD is referenced as SJC_MOD in the <i>MCIMX50 Applications Processor Reference Manual</i> (MCIMX50RM) - both names refer to the same signal. JTAG_MOD must be externally connected to GND for normal operation. Termination to GND through an external pull-down resistor (such as 1 k $\Omega$ ) is allowed. If JTAG port is not needed, the internal pull-up can be disabled in order to reduce supply current to the pin.                                                                                                                                                                                 |
| JTAG_TCK                                                                                | This input has an internal 100K pull-down. This pin is in the NVCC_JTAG domain.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| JTAG_TDI                                                                                | This input has an internal 47K pull-up to NVCC_JTAG. This pin is in the NVCC_JTAG domain.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| JTAG_TDO                                                                                | This is a 3-state output with an internal gate keeper enable to prevent a floating condition. An external pull-up or pull-down resistor on JTAG_TDO is detrimental and should be avoided. This pin is in the NVCC_JTAG domain.                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| JTAG_TMS                                                                                | This input has an internal 47K pull-up to NVCC_JTAG. This pin is in the NVCC_JTAG domain.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| JTAG_TRSTB                                                                              | This input has an internal 47K pull-up to NVCC_JTAG. This pin is in the NVCC_JTAG domain.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| NC                                                                                      | These signals are No Connect (NC) and should be floated by the user.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| LOW_BATT_GPIO                                                                           | If the LOW_BATT_GPIO (UART4_TXD) is asserted at power up, the i.MX50 will boot up at a lower ARM clock frequency to reduce system power. The actual ARM clock frequency used when LOW_BATT_GPIO is asserted is determined by the BT_LPB_FREQ[1:0] pins (220 MHz to 55.3 MHz). The polarity of the LOW_BATT_GPIO is active high by default, but may be set to active low by setting the LOW_BATT_GPIO_LEVEL OTP bit.<br>See the "System Boot" chapter of the Reference Manual for more details.<br>Note that this is not a dedicated pin: LOW_BATT_GPIO appears on the UART4_TXD pin.                                                                                              |
| PMIC_STBY_REQ                                                                           | This output may be driven high when the i.MX50 enters the STOP mode to notify the PMIC to enter its low power standby state. This output is in the NVCC_SRTC domain.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
| PMIC_ON_REQ                                                                             | This output from the i.MX50 can instruct the PMIC to turn on when the i.MX50 only has NVCC_SRTC power. This may be useful for an alarm application, as it allows the i.MX50 to turn off all blocks except for the RTC and then power on again at a specified time. This output is in the NVCC_SRTC domain.                                                                                                                                                                                                                                                                                                                                                                        |

Table 5. Special Signal Considerations (continued)

| Signal Name                             | Remarks                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|-----------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PMIC_RDY                                | This input may be used by a PMIC to signal to the i.MX50 that the PMIC supply outputs are at operating levels when resuming from STOP mode. The PMIC_RDY input is pin muxed on ALT3 of the I2C3_SCL pin and is in the NVCC_MISC domain.                                                                                                                                                                                                                              |
| POP_EMMC_RST<br>(416 PoPBGA Only)       | This pin is the PoP eMMC 4.4 Reset pin. The customer may connect this on their PCB to any free GPIO, or just leave floating for non-4.4 eMMC. This pin does not connect to the i.MX50 die.                                                                                                                                                                                                                                                                           |
| POP_LPDDR2_ZQ0/ZQ1<br>(416 PoPBGA Only) | These pins connect to the PoP LPDDR2 DRAM ZQ pins and should be connected on the customer PCB to a 240 $\Omega$ 1% resistor to ground if used. These pins do not connect to the i.MX50 die.                                                                                                                                                                                                                                                                          |
| POP_LPDDR2_1.8V<br>(416 PoPBGA Only)    | These pins are the 1.8 V supply for the PoP LPDDR2 DRAM. These pins do not connect to the i.MX50 die.                                                                                                                                                                                                                                                                                                                                                                |
| POP_NAND_VCC<br>(416 PoPBGA Only)       | This is the 3.3V I/O and memory supply for the PoP eMMC. Note that most eMMC can operate with a 1.8V I/O or a 3.3V I/O voltage. However, because we tied the eMMC memory and I/O domains together, you can't use the 1.8 V I/O option for the PoP eMMC, only 3.3 V I/O.                                                                                                                                                                                              |
| POR_B                                   | This POWER-ON RESET input is a cold reset negative logic input that resets all modules and logic in the IC. The POR_B pin should have an external 68 K pull-up to NVCC_RESET and a 1 $\mu$ F capacitor to ground.<br><b>Note:</b> The POR_B input must be immediately asserted at power-up and remain asserted until after the last power rail is at its working voltage.                                                                                            |
| RESET_IN_B                              | This warm reset negative logic input resets all modules and logic except for the following: <ul style="list-style-type: none"> <li>• Test logic (JTAG, IOMUXC, DAP)</li> <li>• SRTC</li> <li>• Cold reset logic of WDOG—Some WDOG logic is only reset by POR_B. See WDOG chapter in the <i>MCIMX50 Applications Processor Reference Manual</i> (MCIMX50RM) for details.</li> </ul>                                                                                   |
| SSI_EXT1_CLK,<br>SSI_EXT2_CLK           | The SSI_EXT1_CLK and SSI_EXT2_CLK outputs are recommended for generating a clock output from the i.MX50. Use of the CKO1 and CKO2 clock outputs is not recommended, as the large number of combinational logic muxes on those signals will impact jitter and duty-cycle. Note that these two clock outputs do not have dedicated pins: SSI_EXT1_CLK is IOMUX ALT3 on the OWIRE pin, and SSI_EXT2_CLK is IOMUX ALT3 of the EPITO pin.                                 |
| TEST_MODE                               | TEST_MODE is for Freescale factory use only. This signal is internally connected to an on-chip pull-down device. The user must either float this signal or tie it to GND.                                                                                                                                                                                                                                                                                            |
| USB_H1_GPANAIO,<br>USB_OTG_GPANAIO      | These signals are reserved for Freescale manufacturing use only. Users should float these outputs.                                                                                                                                                                                                                                                                                                                                                                   |
| USB_H1_RREFEXT,<br>USB_OTG_RREFEXT      | These signals determine the reference current for the USB PHY bandgap reference. An external 6.04 k $\Omega$ 1% resistor to GND is required. This resistor should be connected through a short (low impedance connection) and placed away from other noisy regions.<br><br>If USB_H1 is not used, the H1 RREFEXT resistor may be eliminated and the pin left floating. If USB_OTG is not used, the OTG RREFEXT resistor may be eliminated and the pin left floating. |

**Table 5. Special Signal Considerations (continued)**

| Signal Name                  | Remarks                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| USB_H1_VBUS,<br>USB_OTG_VBUS | These inputs are used by the i.MX50 to detect the presence and level of USB 5 V. If either VBUS input pin is connected to an external USB connector, there is a possibility that a fast 5 V edge rate during a cable attach could trigger the VBUS input ESD protection, which could result in damage to the i.MX50 silicon. To prevent this, the system should use some circuitry to prevent the 5 V edge rate from exceeding 5.25 V / 1 $\mu$ s. Freescale recommends the use of a low pass filter consisting of 100 $\Omega$ resistor in series and a 1 $\mu$ F capacitor close to the i.MX50 pin. In the case when the USB interface is connected on an on-board USB device (for example, 3G modem), the corresponding USB_VBUS pin may be left floating.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| VREF                         | This pin is the DRAM MC reference voltage input. For LPDDR2 and DDR2, this pin should be connected to $\frac{1}{2}$ of NVCC_EMI_DRAM. For LPDDR1, this pin should be left floating. The user may generate VREF using a precision external resistor divider. Use a 1 k $\Omega$ 0.5% resistor to GND and a 1 k $\Omega$ 0.5% resistor to NVCC_EMI_DRAM. Shunt each resistor with a closely-mounted 0.1 $\mu$ F capacitor.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| WDOG_B                       | This output can be used to reset the system PMIC when the i.MX50 processor is locked up. This output is in the NVCC_MISC domain.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| WDOG_RST_B_DEB               | This output may be used to drive out the internal system reset signal to the system reset controller. This is only intended for debug purposes.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
| XTAL/EXTAL                   | These pins are the 24 MHz crystal driver as well as the external 24 MHz clock input. If using these pins to directly drive a 24 MHz crystal: <ul style="list-style-type: none"> <li>The user should tie a 24 MHz fundamental-mode crystal across XTAL and EXTAL.</li> <li>The crystal must be rated for a maximum drive level of 100 <math>\mu</math>W or higher.</li> <li>The recommended crystal ESR (equivalent series resistance) is 80 <math>\Omega</math> or less.</li> </ul> If using these pins as a clock input from an external 24 MHz oscillator: <ul style="list-style-type: none"> <li>The crystal may be eliminated and EXTAL driven directly driven by the external oscillator. The clock signal level on EXTAL must swing from NVCC_SRTC to GND.</li> <li>In this configuration, the XTAL pin must be floated and the COSC_EN bit (bit 12 in the CCR register in the Clock Control Module) must be cleared to put the on-chip oscillator circuit in bypass mode which allows EXTAL to be externally driven.</li> <li>Note there are strict jitter requirements if using an external oscillator in a USB application: &lt; 50 ps peak-to-peak below 1.2 MHz and &lt; 100 ps peak-to-peak above 1.2 MHz for the USB PHY.</li> </ul> |

## 4 Electrical Characteristics

This section provides the device and module-level electrical characteristics of the i.MX50 processor.

### NOTE

These electrical specifications are preliminary. These specifications are not fully tested or guaranteed at this early stage of the product life cycle. Finalized specifications are published after thorough characterization and device qualifications have been completed.

## 4.1 Chip-Level Conditions

This section provides the chip-level electrical characteristics for the IC. See [Table 6](#) for a quick reference to the individual tables and sections.

**Table 6. i.MX50 Chip-Level Conditions**

| For these characteristics, see                                    | Topic appears ...          |
|-------------------------------------------------------------------|----------------------------|
| <a href="#">Absolute Maximum Ratings</a>                          | <a href="#">on page 21</a> |
| <a href="#">13 x 13 mm MAPBGA Package Thermal Resistance Data</a> | <a href="#">on page 22</a> |
| <a href="#">13 x 13 mm PoPBGA Package Thermal Resistance Data</a> | <a href="#">on page 23</a> |
| <a href="#">17 x 17 mm MAPBGA Package Thermal Resistance Data</a> | <a href="#">on page 23</a> |
| <a href="#">Operating Ranges</a>                                  | <a href="#">on page 24</a> |
| <a href="#">Operating Frequencies</a>                             | <a href="#">on page 26</a> |
| <a href="#">Supply Current</a>                                    | <a href="#">on page 26</a> |

### 4.1.1 Absolute Maximum Ratings

#### CAUTION

Stresses beyond those listed under [Table 7](#) may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in [Table 11](#) is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

**Table 7. Absolute Maximum Ratings**

| Parameter Description                                  | Symbol                            | Min  | Max                     | Unit |
|--------------------------------------------------------|-----------------------------------|------|-------------------------|------|
| Peripheral core supply voltage                         | VCC                               | −0.3 | 1.5                     | V    |
| ARM core supply voltage                                | VDDGP                             | −0.3 | 1.35                    | V    |
| Bandgap and 480 MHz PLL supply                         | VDD3P0                            | −0.5 | 3.6                     | V    |
| PLL digital supplies                                   | VDD1P2                            | −0.3 | 1.35                    | V    |
| PLL analog supplies                                    | VDD1P8                            | −0.3 | 2.25                    | V    |
| Efuse, 24 MHz oscillator, 32 kHz oscillator mux supply | VDD2P5                            | −0.5 | 2.85                    | V    |
| Memory array supply                                    | VDDA/VDDAL1                       | −0.5 | 1.35                    | V    |
| Supply voltage (HVIO)                                  | Supplies denoted as I/O supply    | −0.5 | 3.6                     | V    |
| Supply voltage (GPIO, LVIO)                            | Supplies denoted as I/O supply    | −0.5 | 3.3                     | V    |
| Input/output voltage range                             | V <sub>in</sub> /V <sub>out</sub> | −0.5 | OVDD + 0.3 <sup>1</sup> | V    |
| USB VBUS                                               | VBUS                              |      |                         | V    |
| DC                                                     |                                   | —    | 6.00                    |      |
| Transient (t<30ms, duty cycle < 0.05%)                 |                                   | —    | 7.00                    |      |

**Table 7. Absolute Maximum Ratings (continued)**

| Parameter Description     | Symbol               | Min | Max  | Unit |
|---------------------------|----------------------|-----|------|------|
| ESD damage immunity:      | $V_{\text{esd}}$     |     |      | V    |
| Human Body Model (HBM)    |                      | —   | 2000 |      |
| Charge Device Model (CDM) |                      | —   | 500  |      |
| Storage temperature range | $T_{\text{STORAGE}}$ | −40 | 125  | °C   |

<sup>1</sup> The term OVDD in this section refers to the associated supply rail of an input or output. The maximum range can be superseded by the DC tables.

## 4.1.2 Thermal Resistance Data

### 4.1.2.1 13 x 13 mm MAPBGA Package Thermal Resistance Data

Table 8 provides thermal resistance data for a 13 x 13 mm MAPBGA package.

**Table 8. 13 x 13 mm MAPBGA Package Thermal Resistance Data**

| Rating                                                      | Board                   | Symbol           | Value | Unit |
|-------------------------------------------------------------|-------------------------|------------------|-------|------|
| Junction to Ambient (natural convection) <sup>1, 2</sup>    | Single layer board (1s) | $R_{\theta JA}$  | 51    | °C/W |
| Junction to Ambient (natural convection) <sup>1, 2, 3</sup> | Four layer board (2s2p) | $R_{\theta JA}$  | 28    | °C/W |
| Junction to Ambient (at 200 ft/min) <sup>1, 3</sup>         | Single layer board (1s) | $R_{\theta JMA}$ | 40    | °C/W |
| Junction to Ambient (at 200 ft/min) <sup>1, 3</sup>         | Four layer board (2s2p) | $R_{\theta JMA}$ | 24    | °C/W |
| Junction to Board <sup>4</sup>                              | —                       | $R_{\theta JB}$  | 14    | °C/W |
| Junction to Case <sup>5</sup>                               | —                       | $R_{\theta JC}$  | 9     | °C/W |
| Junction to Package Top (natural convection) <sup>6</sup>   | —                       | $\Psi_{JT}$      | 2     | °C/W |

<sup>1</sup> Junction temperature is a function of die size, on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board thermal resistance.

<sup>2</sup> Per JEDEC JESD51-2 with the single layer board horizontal. The thermal test board meets JESD51-9 specification.

<sup>3</sup> Per JEDEC JESD51-6 with the board horizontal.

<sup>4</sup> Thermal resistance between the die and the printed circuit board per JEDEC JESD51-8. Board temperature is measured on the top surface of the board near the package.

<sup>5</sup> Thermal resistance between the die and the case top surface as measured by using the cold plate method (MIL SPEC-883 Method 1012.1).

<sup>6</sup> Thermal characterization parameter indicating the temperature difference between the package top and the junction temperature per JEDEC JESD51-2. When Greek letters are not available, the thermal characterization parameter is written as Psi-JT.

### 4.1.2.2 13 x 13 mm PoPBGA Package Thermal Resistance Data

Table 9 provides thermal resistance data for a 13 x 13 mm PoPBGA package.

**Table 9. 13 x 13 mm PoPBGA Package Thermal Resistance Data**

| Rating                                                      | Board                   | Symbol           | Value | Unit |
|-------------------------------------------------------------|-------------------------|------------------|-------|------|
| Junction to Ambient (natural convection) <sup>1, 2</sup>    | Single layer board (1s) | $R_{\theta JA}$  | 57    | °C/W |
| Junction to Ambient (natural convection) <sup>1, 2, 3</sup> | Four layer board (2s2p) | $R_{\theta JA}$  | 31    | °C/W |
| Junction to Ambient (at 200 ft/min) <sup>1, 3</sup>         | Single layer board (1s) | $R_{\theta JMA}$ | 46    | °C/W |
| Junction to Ambient (at 200 ft/min) <sup>1, 3</sup>         | Four layer board (2s2p) | $R_{\theta JMA}$ | 28    | °C/W |
| Junction to Board <sup>4</sup>                              | —                       | $R_{\theta JB}$  | 18    | °C/W |
| Junction to Case <sup>5</sup>                               | —                       | $R_{\theta JC}$  | 6     | °C/W |
| Junction to Package Top (natural convection) <sup>6</sup>   | —                       | $\Psi_{JT}$      | 2     | °C/W |

<sup>1</sup> Junction temperature is a function of die size, on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board thermal resistance.

<sup>2</sup> Per JEDEC JESD51-2 with the single layer board horizontal. The thermal test board meets JESD51-9 specification.

<sup>3</sup> Per JEDEC JESD51-6 with the board horizontal.

<sup>4</sup> Thermal resistance between the die and the printed circuit board per JEDEC JESD51-8. Board temperature is measured on the top surface of the board near the package.

<sup>5</sup> Thermal resistance between the die and the case top surface as measured by using the cold plate method (MIL SPEC-883 Method 1012.1).

<sup>6</sup> Thermal characterization parameter indicating the temperature difference between the package top and the junction temperature per JEDEC JESD51-2. When Greek letters are not available, the thermal characterization parameter is written as Psi-JT.

### 4.1.2.3 17 x 17 mm MAPBGA Package Thermal Resistance Data

Table 10 provides thermal resistance data for a 17 x 17 mm MAPBGA package.

**Table 10. 17 x 17 mm MAPBGA Package Thermal Resistance Data**

| Rating                                                      | Board                   | Symbol           | Value | Unit |
|-------------------------------------------------------------|-------------------------|------------------|-------|------|
| Junction to Ambient (natural convection) <sup>1, 2</sup>    | Single layer board (1s) | $R_{\theta JA}$  | 53    | °C/W |
| Junction to Ambient (natural convection) <sup>1, 2, 3</sup> | Four layer board (2s2p) | $R_{\theta JA}$  | 30    | °C/W |
| Junction to Ambient (at 200 ft/min) <sup>1, 3</sup>         | Single layer board (1s) | $R_{\theta JMA}$ | 44    | °C/W |
| Junction to Ambient (at 200 ft/min) <sup>1, 3</sup>         | Four layer board (2s2p) | $R_{\theta JMA}$ | 26    | °C/W |
| Junction to Board <sup>4</sup>                              | —                       | $R_{\theta JB}$  | 19    | °C/W |
| Junction to Case <sup>5</sup>                               | —                       | $R_{\theta JC}$  | 8     | °C/W |
| Junction to Package Top (natural convection) <sup>6</sup>   | —                       | $\Psi_{JT}$      | 2     | °C/W |

<sup>1</sup> Junction temperature is a function of die size, on-chip power dissipation, package thermal resistance, mounting site (board) temperature, ambient temperature, air flow, power dissipation of other components on the board, and board thermal resistance.

<sup>2</sup> Per JEDEC JESD51-2 with the single layer board horizontal. The thermal test board meets JESD51-9 specification.

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- <sup>3</sup> Per JEDEC JESD51-6 with the board horizontal.
- <sup>4</sup> Thermal resistance between the die and the printed circuit board per JEDEC JESD51-8. Board temperature is measured on the top surface of the board near the package.
- <sup>5</sup> Thermal resistance between the die and the case top surface as measured by using the cold plate method (MIL SPEC-883 Method 1012.1).
- <sup>6</sup> Thermal characterization parameter indicating the temperature difference between the package top and the junction temperature per JEDEC JESD51-2. When Greek letters are not available, the thermal characterization parameter is written as Psi-JT.

### 4.1.3 Operating Ranges

Table 11 provides the operating ranges of the i.MX50 processor.

**Table 11. i.MX50 Operating Ranges**

| Symbol      | Parameter                                                                                                                                                                                 | Minimum <sup>1</sup> | Nominal <sup>2</sup> | Maximum <sup>1</sup> | Unit |
|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|----------------------|----------------------|------|
| VDDGP       | ARM core supply voltage<br>$f_{\text{ARM}} = 1 \text{ GHz}$                                                                                                                               | 1.20                 | 1.275                | 1.35                 | V    |
|             | ARM core supply voltage<br>$400 < f_{\text{ARM}} \leq 800 \text{ MHz}$                                                                                                                    | 0.95                 | 1.05                 | 1.15                 | V    |
|             | ARM core supply voltage<br>$167 < f_{\text{ARM}} \leq 400 \text{ MHz}$                                                                                                                    | 0.85                 | 0.95                 | 1.15                 | V    |
|             | ARM core supply voltage<br>$24 \leq f_{\text{ARM}} \leq 167 \text{ MHz}$                                                                                                                  | 0.8                  | 0.9                  | 1.15                 | V    |
|             | ARM core supply voltage<br>Stop mode                                                                                                                                                      | 0.75                 | 0.85                 | 1.15                 | V    |
| VCC         | Peripheral supply voltage Low Performance mode (LPM). The DDR clock rate is 24 MHz.                                                                                                       | 1 <sup>3</sup>       | 1.05                 | 1.275                | V    |
|             | Peripheral supply voltage Reduced Performance mode (RPM). The DDR clock rate is 133 MHz.                                                                                                  | 1 <sup>3</sup>       | 1.05                 | 1.275                | V    |
|             | Peripheral supply voltage High Performance mode (HPM). The clock frequencies are derived from AHB bus using 133 MHz and AXI bus using 266 MHz (as needed). The DDR clock rate is 266 MHz. | 1.175                | 1.225                | 1.275                | V    |
|             | Peripheral supply voltage Stop mode                                                                                                                                                       | 0.9 <sup>3</sup>     | 0.95                 | 1.275                | V    |
| VDDA/VDDAL1 | Memory arrays voltage—Run mode<br>$24 \leq f_{\text{ARM}} \leq 800 \text{ MHz}$                                                                                                           | 1.15                 | 1.20                 | 1.275                | V    |
|             | Memory arrays voltage—Run mode<br>$f_{\text{ARM}} = 1 \text{ GHz}$                                                                                                                        | 1.25                 | 1.30                 | 1.35                 | V    |
|             | Memory arrays voltage—Stop mode                                                                                                                                                           | 0.9                  | 0.95                 | 1.275                | V    |
| VDD3P0      | Bandgap and 480 MHz PLL supply                                                                                                                                                            | 2.7                  | 3.0                  | 3.3                  | V    |
| VDD2P5      | Efuse, 24 MHz oscillator, 32 kHz oscillator mux supply                                                                                                                                    | 2.375                | 2.5                  | 2.625                | V    |
| VDD1P2      | PLL digital supplies                                                                                                                                                                      | 1.15                 | 1.2                  | 1.32                 | V    |
| VDD1P8      | PLL analog supplies                                                                                                                                                                       | 1.75                 | 1.8                  | 1.95                 | V    |

Table 11. i.MX50 Operating Ranges (continued)

| Symbol                                                                                                                                   | Parameter                                                         | Minimum <sup>1</sup> | Nominal <sup>2</sup> | Maximum <sup>1</sup> | Unit |
|------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------|----------------------|----------------------|----------------------|------|
| NVCC_JTAG                                                                                                                                | GPIO digital power supplies                                       | 1.65                 | 1.875 or 2.775       | 3.1                  | V    |
| NVCC_EMI_DRAM                                                                                                                            | DDR supply DDR2/LPDDR1 range                                      | 1.71                 | 1.8                  | 1.95                 | V    |
|                                                                                                                                          | DDR supply LPDDR2 range                                           | 1.14                 | 1.2                  | 1.3                  | V    |
| VREF                                                                                                                                     | DRAM Reference Voltage Input                                      |                      | 1/2 NVCC_EMI_DRAM    |                      |      |
| VDDO25                                                                                                                                   | EMI Pad Predriver supply                                          | 2.375                | 2.5                  | 2.625                | V    |
| NVCC_NANDF<br>NVCC_SD1<br>NVCC_SD2<br>NVCC_KEYPAD<br>NVCC_EIM<br>NVCC_EPDC<br>NVCC_LCD<br>NVCC_MISC<br>NVCC_SPI<br>NVCC_SSI<br>NVCC_UART | High voltage I/O (HVIO) supplies<br>HVIO_L<br>HVIO_H              | 1.65<br>2.7          | 1.875<br>3.0         | 1.95<br>3.3          | V    |
| NVCC_SRTC                                                                                                                                | SRTC core and I/O supply (LVIO)                                   | 1.1                  | 1.2                  | 1.3                  | V    |
| NVCC_RESET                                                                                                                               | LVIO                                                              | 1.65                 | 1.875 or 2.775       | 3.1                  | V    |
| USB_H1_VDDA25<br>USB_OTG_VDDA25 <sup>4</sup>                                                                                             | USB_PHY analog supply                                             | 2.25                 | 2.5                  | 2.75                 | V    |
| USB_H1_VDDA33<br>USB_OTG_VDDA33 <sup>5</sup>                                                                                             | USB PHY I/O analog supply                                         | 3.0                  | 3.3                  | 3.6                  | V    |
| VBUS                                                                                                                                     | See Table 7 and Table 78 for details. This is not a power supply. | —                    | —                    | —                    | —    |
| T <sub>A</sub>                                                                                                                           | Ambient Temperature, Consumer                                     | 0                    | —                    | 70                   | °C   |
| T <sub>A</sub>                                                                                                                           | Extended Ambient Temperature, Consumer                            | -20                  | —                    | 70                   | °C   |
| T <sub>j</sub>                                                                                                                           | Junction Temperature, Consumer                                    | 0                    | —                    | 90                   | °C   |
| T <sub>j</sub>                                                                                                                           | Extended Junction Temperature, Consumer                           | -20                  | —                    | 90                   | °C   |

<sup>1</sup> Voltage at the package power supply contact must be maintained between the minimum and maximum voltages. The design must allow for supply tolerances and system voltage drops.

<sup>2</sup> The nominal values for the supplies indicate the target setpoint for a tolerance no tighter than ± 50 mV. Use of supplies with a tighter tolerance allows reduction of the setpoint with commensurate power savings.

<sup>3</sup> VCC minimum voltage is 1.02 V for extended temperature (-20°C) devices.

<sup>4</sup> USB\_OTG\_VDDA25 and USB\_H1\_VDDA25 are shorted together on the 416 MAPBGA and 416 PoPBGA package substrates.

<sup>5</sup> USB\_OTG\_VDDA33 and USB\_H1\_VDDA33 are shorted together on the 416 MAPBGA and 416 PoPBGA package substrates.

### 4.1.4 Operating Frequencies

Table 12 shows the interface frequency requirements.

**Table 12. Interface Frequency**

| Parameter Description         | Symbol     | Min                 | Max | Unit |
|-------------------------------|------------|---------------------|-----|------|
| JTAG: TCK operating frequency | $f_{tck}$  | See Table 64        |     | MHz  |
| CKIL: operating frequency     | $f_{ckil}$ | 32.768 <sup>1</sup> |     | kHz  |
| CKIH: operating frequency     | $f_{ckih}$ | See Table 38        |     | MHz  |
| XTAL oscillator               | $f_{xtal}$ | 22                  | 27  | MHz  |

<sup>1</sup> Generated Internally or applied externally.

### 4.1.5 Supply Current

Table 13 shows the run mode current consumption of the i.MX50.

**Table 13. eFuse Supply Current**

| Description                                                                                | Symbol        | Min | Typ | Max | Unit |
|--------------------------------------------------------------------------------------------|---------------|-----|-----|-----|------|
| eFuse program current <sup>1</sup><br>VDD2P5 current is required to program one eFuse bit. | $I_{program}$ | —   | 40  | 55  | mA   |

<sup>1</sup> The current  $I_{program}$  is only required during program time ( $t_{program}$ ).

Table 14 shows the maximum supply current consumption of the i.MX50 for PMIC specification purposes.

**Table 14. Maximum Supply Current Consumption—ARM CLK = 800 MHz**

| Condition                                                                                                                                                                                                                                                                                                                                                             | Supply                                  | Voltage (V) | Current (mA) | Power (mW) |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------|-------------|--------------|------------|
| <ul style="list-style-type: none"> <li>• Ta = 70°C</li> <li>• ARM core in Run mode</li> <li>• ARM CLK = 800 MHz</li> <li>• SYS CLK = 266 MHz</li> <li>• AHB CLK = 133 MHz</li> <li>• DDR CLK = 266 MHz</li> <li>• All voltages operating at maximum levels</li> <li>• External (MHz) crystal and on-chip oscillator enabled</li> <li>• All modules enabled</li> </ul> | VDDGP                                   | 1.15        | 628          | 723        |
|                                                                                                                                                                                                                                                                                                                                                                       | VCC                                     | 1.275       | 185          | 236        |
|                                                                                                                                                                                                                                                                                                                                                                       | VDDA/VDDAL1                             | 1.275       | 40           | 51         |
|                                                                                                                                                                                                                                                                                                                                                                       | VDD1P2                                  | 1.3         | 5.92         | 7.70       |
|                                                                                                                                                                                                                                                                                                                                                                       | VDD1P8                                  | 1.95        | 1.53         | 2.99       |
|                                                                                                                                                                                                                                                                                                                                                                       | VDD2P5 <sup>1</sup>                     | 2.75        | 1.13         | 3.11       |
|                                                                                                                                                                                                                                                                                                                                                                       | VDD3P0                                  | 3.3         | 1.61         | 5.32       |
|                                                                                                                                                                                                                                                                                                                                                                       | NVCC_EMI_DRAM                           | 1.95        | 8.3          | 16.17      |
|                                                                                                                                                                                                                                                                                                                                                                       | VDD_DCDCI                               | 1.95        | 0.021        | 0.041      |
|                                                                                                                                                                                                                                                                                                                                                                       | USB_OTG_VDDA33 + USB_H1_VDDA33          | 3.6         | 10.8         | 38.8       |
|                                                                                                                                                                                                                                                                                                                                                                       | VDDO25 + USB_OTG_VDDA25 + USB_H1_VDDA25 | 2.75        | 12.45        | 34.239     |
|                                                                                                                                                                                                                                                                                                                                                                       | NVCC_RESET                              | 3.1         | 0.226        | 0.701      |
|                                                                                                                                                                                                                                                                                                                                                                       | NVCC_SRTC                               | 1.3         | 0.0035       | 0.0045     |
|                                                                                                                                                                                                                                                                                                                                                                       | Total                                   | —           | —            | 1120       |

<sup>1</sup> During eFuse programming, the maximum current on VDD2P5 will exceed these values. See Table 13 on page 26 for the maximum VDD2P5 current during eFuse programming.

**Table 15. Maximum Supply Current Consumption—ARM CLK = 1 GHz**

| Condition                                                                                                                                                                                                                                                                                                                                                                                    | Supply                                  | Voltage (V) | Current (mA) | Power (mW) |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------|-------------|--------------|------------|
| <ul style="list-style-type: none"> <li>• <math>T_a = 70^\circ\text{C}</math></li> <li>• ARM core in Run mode</li> <li>• ARM CLK = 1GHz</li> <li>• SYS CLK = 266 MHz</li> <li>• AHB CLK = 133 MHz</li> <li>• DDR CLK = 266 MHz</li> <li>• All voltages operating at maximum levels</li> <li>• External (MHz) crystal and on-chip oscillator enabled</li> <li>• All modules enabled</li> </ul> | VDDGP                                   | 1.35        | 1000         | 1350       |
|                                                                                                                                                                                                                                                                                                                                                                                              | VCC                                     | 1.275       | 220          | 280.5      |
|                                                                                                                                                                                                                                                                                                                                                                                              | VDDA/VDDAL1                             | 1.35        | 40           | 54         |
|                                                                                                                                                                                                                                                                                                                                                                                              | VDD1P2                                  | 1.3         | 15           | 19.5       |
|                                                                                                                                                                                                                                                                                                                                                                                              | VDD1P8                                  | 1.95        | 3            | 5.9        |
|                                                                                                                                                                                                                                                                                                                                                                                              | VDD2P5 <sup>1</sup>                     | 2.75        | 2            | 5.5        |
|                                                                                                                                                                                                                                                                                                                                                                                              | VDD3P0                                  | 3.3         | 2            | 6.6        |
|                                                                                                                                                                                                                                                                                                                                                                                              | NVCC_EMI_DRAM                           | 1.95        | 8.3          | 16.17      |
|                                                                                                                                                                                                                                                                                                                                                                                              | VDD_DCDCi                               | 1.95        | 0.021        | 0.041      |
|                                                                                                                                                                                                                                                                                                                                                                                              | USB_OTG_VDDA33 + USB_H1_VDDA33          | 3.6         | 10.8         | 38.8       |
|                                                                                                                                                                                                                                                                                                                                                                                              | VDDO25 + USB_OTG_VDDA25 + USB_H1_VDDA25 | 2.75        | 12.45        | 34.239     |
|                                                                                                                                                                                                                                                                                                                                                                                              | NVCC_RESET                              | 3.1         | 0.226        | 0.701      |
|                                                                                                                                                                                                                                                                                                                                                                                              | NVCC_SRTC                               | 1.3         | 0.0035       | 0.0045     |
|                                                                                                                                                                                                                                                                                                                                                                                              | Total                                   | —           | —            | 1812       |

<sup>1</sup> During eFuse programming, the maximum current on VDD2P5 will exceed these values. See Table 13 on page 26 for the maximum VDD2P5 current during eFuse programming.

**Table 16. Stop Mode Current and Power Consumption <sup>1</sup>**

| Supply      | Voltage (V) | Current (mA)                      |                               |
|-------------|-------------|-----------------------------------|-------------------------------|
|             |             | Typical, $T_a = 25^\circ\text{C}$ | Max, $T_a = 25^\circ\text{C}$ |
| VDDGP       | 0.85        | 0.057                             | 0.198                         |
| VCC         | 0.95        | 0.544                             | 1.890                         |
| VDDA/VDDAL1 | 0.95        | 0.071                             | 0.247                         |

<sup>1</sup> The typical power, at  $T_a = 25^\circ\text{C}$ , will be < 1 mW, including all supplies. Total max power, at  $T_a = 25^\circ\text{C}$ , will not exceed 2.5 mW, including all supplies.

#### 4.1.5.1 Conditions for Stop Mode Current and Power Consumption

- ARM core in STOP mode and power gated
- VDDGP, VCC, and VDDA/VDDAL1 voltages at suspend levels
- VDD3P0, VDD2P5, VDD1P8, and VDD1P2 powered off
- USB\_VDDA25 and USB\_VDDA33 powered off

- All other supply voltages at nominal levels
- External (MHz) crystal and on-chip oscillator disabled
- CKIL input ON with 32 kHz signal present
- All PLLs OFF, all CCM-generated clocks OFF
- All modules disabled
- No external resistive loads that cause current

#### 4.1.6 USB-OH-1 (OTG + 1 Host Port) Current Consumption

Table 17 shows the USB interface current consumption.

**Table 17. USB Interface Current Consumption**

| Parameter                                              | Conditions |    | Typical @ 25 °C | Max | Unit |
|--------------------------------------------------------|------------|----|-----------------|-----|------|
| Analog supply 3.3 V<br>USB_H1_VDDA33<br>USB_OTG_VDDA33 | Full speed | RX | 5.5             | 6   | mA   |
|                                                        |            | TX | 7               | 8   |      |
|                                                        | High speed | RX | 5               | 6   |      |
|                                                        |            | TX | 5               | 6   |      |
| Analog supply 2.5 V<br>USB_H1_VDDA25<br>USB_OTG_VDDA25 | Full speed | RX | 6.5             | 7   | mA   |
|                                                        |            | TX | 6.5             | 7   |      |
|                                                        | High speed | RX | 12              | 13  |      |
|                                                        |            | TX | 21              | 22  |      |
| Digital supply<br>VCC (1.2 V)                          | Full speed | RX | 6               | 7   | mA   |
|                                                        |            | TX | 6               | 7   |      |
|                                                        | High speed | RX | 6               | 7   |      |
|                                                        |            | TX | 6               | 7   |      |

#### 4.2 Supply Power-Up/Power-Down Requirements and Restrictions

The system design must comply with the power-up and power-down sequence guidelines as described in this section to guarantee reliable operation of the device. Any deviation from these sequences can result in the following situations:

- Excessive current during power-up phase
- Prevention of the device from booting
- Irreversible damage to the i.MX50 processor (worst-case scenario)

## 4.2.1 Power-Up Sequence

Figure 2 shows the power-up sequence.

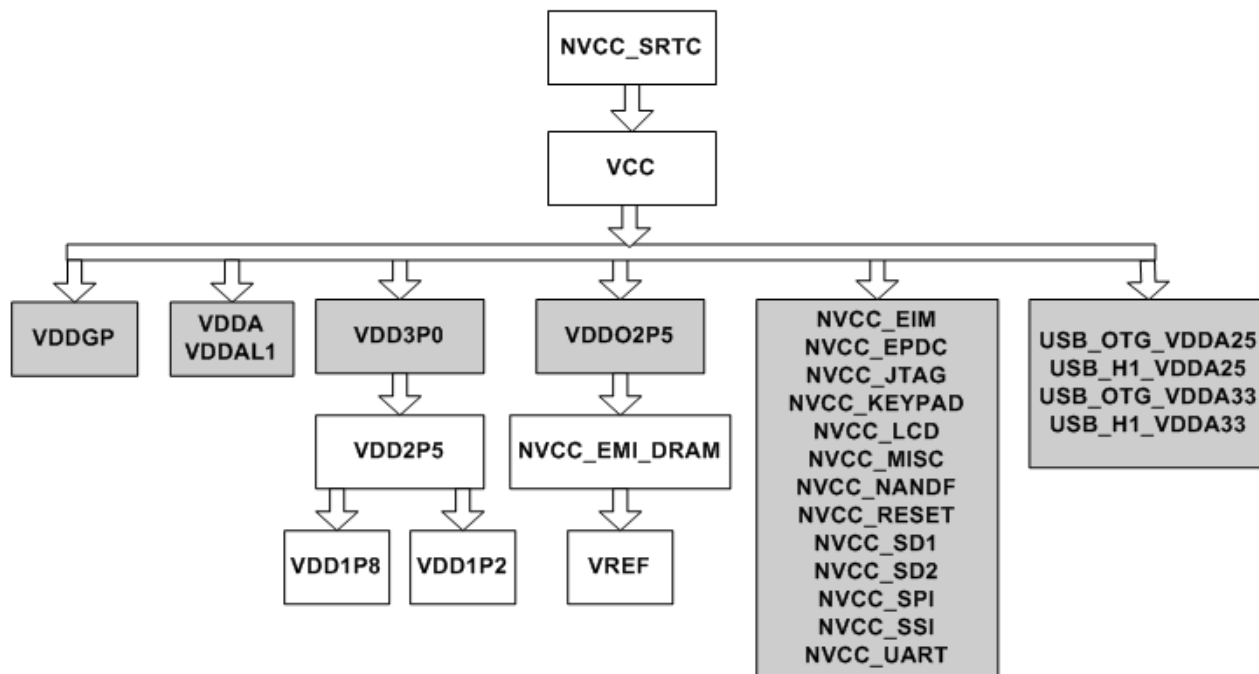


Figure 2. Power-Up Sequence

### NOTE

- 1) The POR\_B input must be immediately asserted at power-up and remain asserted until after the last power rail is at its working voltage.
- 2) No power-up sequence dependencies exist between the supplies shown shaded in gray.

## 4.2.2 Power-Down Sequence

The power-down sequence is recommended to be the opposite of the power-up sequence. In other words, the same power supply constraints exist while powering off as while powering on.

## 4.2.3 Resume Sequence

When the i.MX50 is resuming from STOP mode, there are some special sequencing considerations. The resume timing is determined by the following internal counters:

1. STBY\_COUNT. This register is in the CCM block and may be set to a maximum of 16 x 32 kHz cycles, or 500  $\mu$ sec.

2. OSCNT. This register is in the CCM block and may be set to a maximum of 256 x 32 kHz cycles, or 8 msec. This counter is intended to give the 24MHz clock time to start up and stabilize.

If the PMIC\_RDY input is used and BYPASS\_PMIC\_VFUNCTIONAL\_READY = 0, the i.MX50 will wait for STBY\_COUNT cycles after PMIC\_STBY\_REQ negation before checking PMIC\_RDY status. Once the STBY\_COUNT has expired AND the PMIC\_RDY signal has been asserted, the OSCNT counter begins and the 24MHz oscillator is powered up. After OSCNT expires the processor will enter RUN mode.

If the PMIC\_RDY input is not used, the processor will attempt to start the 24 MHz oscillator after STBY\_COUNT expires. So at a minimum, all the supplies necessary to start up the 24 MHz oscillator need to be powered before STBY\_COUNT expires: NVCC\_SRTC, VDD1P2, VDD1P8, VDD2P5, VDD3P0. After STBY\_COUNT expires, the OSCNT counter begins and the 24 MHz oscillator is powered up. After OSCNT expires the processor will enter RUN mode, so all other supplies need to be at the appropriate operating levels before OSCNT expires.

### 4.3 I/O DC Parameters

This section includes the DC parameters of the following I/O types:

- General Purpose I/O and High-Speed General Purpose I/O (GPIO)
- Double Data Rate 2 (DDR2)
- Low Power Double Data Rate 2 (LPDDR2)
- Low Power Double Data Rate 1(LPDDR1)
- Low Voltage I/O (LVIO)
- High Voltage I/O (HVIO)
- Secure Digital Host Controllers (eSDHCv2 and eSDHCv3)
- USB-OTG and USB Host ports

#### NOTE

The term **OVDD** in this section refers to the associated supply rail of an input or output.

#### 4.3.1 GPIO I/O DC Parameters

The parameters in [Table 18](#) are guaranteed per the operating ranges in [Table 11](#), unless otherwise noted.

**Table 18. GPIO DC Electrical Characteristics**

| DC Electrical Characteristics | Symbol          | Test Conditions                                          | MIN                   | Typ | MAX              | Units |
|-------------------------------|-----------------|----------------------------------------------------------|-----------------------|-----|------------------|-------|
| High-level output voltage     | V <sub>oh</sub> | I <sub>oh</sub> =-1mA<br>I <sub>oh</sub> =spec'ed Drive  | OVDD-0.15<br>0.8*OVDD | —   | —                | V     |
| Low-level output voltage      | V <sub>ol</sub> | I <sub>ol</sub> =1mA<br>I <sub>ol</sub> =specified Drive | —                     | —   | 0.15<br>0.2*OVDD | V     |

**Table 18. GPIO DC Electrical Characteristics (continued)**

| DC Electrical Characteristics                 | Symbol   | Test Conditions                                                      | MIN                           | Typ          | MAX         | Units |
|-----------------------------------------------|----------|----------------------------------------------------------------------|-------------------------------|--------------|-------------|-------|
| High-level output current<br>(1.1-1.3V ovdd)  | I<br>Ioh | Voh=0.8*OVDD<br>Low Drive<br>Medium Drive<br>High Drive<br>Max Drive | -0.85<br>-1.7<br>-2.5<br>-3.4 | —            | —           | mA    |
| Low-level output current (1.1-1.3V ovdd)      | I<br>Iol | Vol=0.2*OVDD<br>Low Drive<br>Medium Drive<br>High Drive<br>Max Drive | 0.9<br>1.9<br>2.9<br>3.8      | —            | —           | mA    |
| High-level output current<br>(1.65-3.1V ovdd) | I<br>Ioh | Voh=0.8*OVDD<br>Low Drive<br>Medium Drive<br>High Drive<br>Max Drive | -2.1<br>-4.2<br>-6.3<br>-8.4  | —            | —           | mA    |
| Low-level output current<br>(1.65-3.1V ovdd)  | I<br>Iol | Vol=0.2*OVDD<br>Low Drive<br>Medium Drive<br>High Drive<br>Max Drive | 2.1<br>4.2<br>6.3<br>8.4      | —            | —           | mA    |
| High-Level DC input voltage <sup>1</sup>      | VIH      | —                                                                    | 0.7*OVDD                      | —            | OVDD        | V     |
| Low-Level DC input voltage                    | VIL      | —                                                                    | 0V                            | —            | 0.3*OVDD    | V     |
| Input Hysteresis                              | VHYS     | OVDD=1.875<br>OVDD=2.775                                             | 0.25                          | 0.34<br>0.45 | —           | V     |
| Schmitt trigger VT+ <sup>2</sup>              | VT+      | —                                                                    | 0.5*OVDD                      | —            | —           | V     |
| Schmitt trigger VT-                           | VT-      | —                                                                    | —                             | —            | 0.5*OVDD    | V     |
| Pull-up resistor (22 KΩ PU)                   | Rpu      | Vi=OVDD/2                                                            | 20                            | 24           | 28          | KΩ    |
| Pull-up resistor (47 KΩ PU)                   | Rpu      | Vi=OVDD/2                                                            | 43                            | 51           | 59          | KΩ    |
| Pull-up resistor (100 KΩ PU)                  | Rpu      | Vi=OVDD/2                                                            | 91                            | 108          | 125         | KΩ    |
| Pull-down resistor (100 KΩ PD)                | Rpd      | Vi=OVDD/2                                                            | 91                            | 108          | 126         | KΩ    |
| Input current (no pull-up/down)               | IIN      | VI = 0<br>VI=OVDD                                                    | —                             | 1.7          | 250<br>120  | nA    |
| Input current (22 KΩ PU)                      | IIN      | VI = 0<br>VI=OVDD                                                    | —                             | —            | 161<br>0.12 | μA    |
| Input current (47 KΩ PU)                      | IIN      | VI = 0<br>VI=OVDD                                                    | —                             | —            | 76<br>0.12  | μA    |
| Input current (100 KΩ PU)                     | IIN      | VI = 0<br>VI=OVDD                                                    | —                             | —            | 36<br>0.12  | μA    |

Table 18. GPIO DC Electrical Characteristics (continued)

| DC Electrical Characteristics                                               | Symbol | Test Conditions   | MIN | Typ | MAX        | Units      |
|-----------------------------------------------------------------------------|--------|-------------------|-----|-----|------------|------------|
| Input current (100 K $\Omega$ PD)                                           | IIN    | VI = 0<br>VI=OVDD | —   | —   | 0.25<br>36 | $\mu$ A    |
| External pull-up / pull-down resistor required to overdrive internal keeper | Rext   | —                 | —   | —   | 47         | K $\Omega$ |

<sup>1</sup> To maintain a valid level, the transitioning edge of the input must sustain a constant slew rate (monotonic) from the current DC level through to the target DC level, VIL or VIH. Monotonic input transition time is from 0.1ns to 1s. VIL and VIH do not apply when hysteresis is enabled.

<sup>2</sup> Hysteresis of 250 mV is guaranteed overall operating conditions when hysteresis is enabled.

### 4.3.2 DDR2 I/O DC Parameters

The DDR2 interface fully complies with JESD79-2E DDR2 JEDEC standard release April, 2008. The JEDEC LPDDR2 specification (JESD209\_2B) supersedes any specification in this document. The parameters in Table 19 are guaranteed per the operating ranges in Table 11, unless otherwise noted.

Table 19. DDR2 DC Electrical Characteristics

| DC Electrical Characteristics                         | Symbol     | Test Conditions   | MIN        | TYP       | MAX        | Units |
|-------------------------------------------------------|------------|-------------------|------------|-----------|------------|-------|
| High-level output voltage                             | Voh        | —                 | 0.9*ovdd   | —         | —          | V     |
| Low-level output voltage                              | Vol        | —                 | —          | —         | 0.1*ovdd   | V     |
| Output min source current <sup>1</sup>                | Ioh(dc)    | —                 | -7.5       | —         | —          | mA    |
| Output min sink current <sup>2</sup>                  | Iol(dc)    | —                 | 7.5        | —         | —          | mA    |
| Input reference voltage                               | Vref       | —                 | 0.49*ovdd  | 0.5*ovdd  | 0.51*ovdd  | —     |
| DC input high voltage (data pins)                     | Vihd(dc)   | —                 | Vref+0.125 | —         | ovdd+0.3   | V     |
| DC input low voltage (data pins)                      | Vild(dc)   | —                 | -0.3       | —         | Vref-0.125 | V     |
| DC input voltage <sup>3</sup> (clk pins)              | Vin(dc)    | —                 | -0.3       | —         | ovdd+0.3   | V     |
| DC differential input voltage <sup>4</sup>            | Vid(dc)    | —                 | 0.25       | —         | ovdd+0.6   | V     |
| Termination voltage <sup>5</sup>                      | Vtt        | —                 | Vref-0.04  | Vref      | Vref+0.04  | —     |
| Input current <sup>6</sup> (no pull-up/down)          | Iin        | VI = 0<br>VI=ovdd | —          | 0.07<br>2 | 5<br>360   | nA    |
| Tri-state I/O supply current <sup>6</sup>             | Icc-ovdd   | VI = ovdd or 0    | —          | 2.3       | 480        | nA    |
| Tri-state 2.5V predrivers supply current <sup>6</sup> | Icc-vdd2p5 | VI = ovdd or 0    | —          | 6.4       | 750        | nA    |
| Tri-state core supply current <sup>6</sup>            | Icc-vddi   | VI = ovdd or 0    | —          | 3.1       | 720        | nA    |

<sup>1</sup> ovdd=1.7 V; Vout=1.42 V. (Vout-ovdd)/Ioh must be less than 21  $\Omega$  for values of Vout between ovdd and ovdd-0.28 V.

<sup>2</sup> ovdd=1.7 V; Vout=280 mV. Vout/Iol must be less than 21  $\Omega$  for values of Vout between 0 V and 280 mV.

<sup>3</sup> Vin(dc) specifies the allowable dc excursion of each differential input.

<sup>4</sup> Vid(dc) specifies the input differential voltage |Vtr-Vcpl required for switching, where Vtr is the “pure” input level and Vcp is the “complementary” input level. the minimum value is equal to Vih(dc) - Vil(dc).

<sup>5</sup> Vtt is expected to track ovdd/2.

<sup>6</sup> Typ condition: typ model, 1.8 V, and 25 °C. Max condition: BCS model, 1.9 V, and 125 °C. Min condition: WCS model, 1.7 V, and -40 °C.

### 4.3.3 Low Power DDR2 I/O DC Parameters

The LPDDR2 interface fully complies with JEDEC standard release April, 2008. The parameters in [Table 20](#) are guaranteed per the operating ranges in [Table 11](#), unless otherwise noted.

**Table 20. LPDDR2 I/O DC Electrical Parameters**

| DC Electrical Characteristics                          | Symbol     | Test Conditions   | MIN       | TYP         | MAX         | Units |
|--------------------------------------------------------|------------|-------------------|-----------|-------------|-------------|-------|
| High-level output voltage                              | Voh        | —                 | 0.9*ovdd  | —           | —           | V     |
| Low-level output voltage                               | Vol        | —                 | —         | —           | 0.1*ovdd    | V     |
| Input reference voltage                                | Vref       | —                 | 0.49*ovdd | 0.5*ovdd    | 0.51*ovdd   | —     |
| DC input high voltage                                  | Vih(dc)    | —                 | Vref+0.13 | —           | ovdd        | V     |
| DC input low voltage                                   | Vil(dc)    | —                 | ovss      | —           | Vref-0.13   | V     |
| Differential input logic high <sup>1</sup>             | Vih(diff)  | —                 | 0.26      | —           | —           | V     |
| Differential input logic low <sup>1</sup>              | Vil(diff)  | —                 | —         | —           | -0.26       | V     |
| Input current (no pull-up/down)                        | Iin        | VI = 0<br>VI=ovdd | —         | 0.02<br>1.5 | 12.8<br>290 | nA    |
| Tri-state I/O supply current <sup>2</sup>              | Icc-ovdd   | VI = ovdd or 0    | —         | 1.85        | 400         | nA    |
| Tri-state 2.5 V predrivers supply current <sup>2</sup> | Icc-vdd2p5 | VI = ovdd or 0    | —         | 5           | 700         | nA    |
| Tri-state core supply current <sup>2</sup>             | Icc-vddi   | VI = ovdd or 0    | —         | 3           | 700         | nA    |
| Pullup/Pulldown impedance mismatch <sup>2</sup>        | —          | —                 | -15       | —           | +15         | %     |
| 240 Ω unit calibration resolution                      | —          | —                 | —         | —           | 10          | Ω     |

<sup>1</sup> The single-ended signals need to be within the respective limits (Vih(dc) max, Vil(dc) min) for single-ended signals as well as the limitations for overshoot and undershoot.

<sup>2</sup> Typ condition: typ model, 1.2V, and 25 °C. Max condition: BCS model, 1.3V, and 125 °C. Min condition: WCS model, 1.14V, and -40 °C.

### 4.3.4 Low Power DDR1 I/O DC Parameters

The LPDDR1 interface fully complies with JEDEC standard release April, 2008. The parameters in [Table 21](#) are guaranteed per the operating ranges in [Table 11](#), unless otherwise noted.

**Table 21. LPDDR1 Mode DC Electrical Characteristics**

| DC Electrical Characteristics                         | Symbol     | Test Conditions   | MIN      | TYP       | MAX      | Units |
|-------------------------------------------------------|------------|-------------------|----------|-----------|----------|-------|
| High-level output voltage                             | Voh        | Ioh=-0.1mA        | 0.9*ovdd | —         | —        | V     |
| Low-level output voltage                              | Vol        | Iol=0.1mA         | —        | —         | 0.1*ovdd | V     |
| DC input high voltage (data pins)                     | Vihd(dc)   | —                 | 0.7*ovdd | —         | ovdd+0.3 | V     |
| DC input low voltage (data pins)                      | Vild(dc)   | —                 | -0.3     | —         | 0.3*ovdd | V     |
| DC input voltage <sup>1</sup> (clk pins)              | Vin(dc)    | —                 | -0.3     | —         | ovdd+0.3 | V     |
| DC input differential voltage <sup>2</sup>            | Vid(dc)    | —                 | 0.4*ovdd | —         | ovdd+0.6 | V     |
| Input current <sup>3</sup> (no pull-up/down)          | Iin        | VI = 0<br>VI=ovdd | —        | 0.07<br>2 | 5<br>360 | nA    |
| Tri-state I/O supply current <sup>3</sup>             | Icc-ovdd   | VI = ovdd or 0    | —        | 2.3       | 480      | nA    |
| Tri-state 2.5V predrivers supply current <sup>3</sup> | Icc-vdd2p5 | VI = ovdd or 0    | —        | 5.3       | 680      | nA    |
| Tri-state core supply current <sup>3</sup>            | Icc-vddi   | VI = ovdd or 0    | —        | 3.1       | 720      | nA    |

- <sup>1</sup> Vin(dc) specifies the allowable dc excursion of each differential input.
- <sup>2</sup> Vid(dc) specifies the input differential voltage  $|V_{tr}-V_{cpl}|$  required for switching, where Vtr is the “pure” input level and Vcp is the “complementary” input level. the minimum value is equal to Vih(dc) - Vil(dc).
- <sup>3</sup> Typ condition: typ model, 1.8 V, and 25 °C. Max condition: BCS model, 1.9 V, and 105 °C. Min condition: WCS model, 1.7 V, and -20 °C.

### 4.3.5 Low Voltage I/O (LVIO) DC Parameters

The parameters in Table 22 are guaranteed per the operating ranges in Table 11, unless otherwise noted.

**Table 22. LVIO DC Electrical Characteristics**

| DC Electrical Characteristics            | Symbol   | Test Conditions                                                      | MIN                          | Typ          | MAX              | Units |
|------------------------------------------|----------|----------------------------------------------------------------------|------------------------------|--------------|------------------|-------|
| High-level output voltage                | Voh      | Ioh=-1mA<br>Ioh=spec'ed Drive                                        | OVDD-0.15<br>0.8*OVDD        | —            | —                | V     |
| Low-level output voltage                 | Vol      | Iol=1mA<br>Iol=specified Drive                                       | —                            | —            | 0.15<br>0.2*OVDD | V     |
| High-level output current                | I<br>Ioh | Voh=0.8*OVDD<br>Low Drive<br>Medium Drive<br>High Drive<br>Max Drive | -2.1<br>-4.2<br>-6.3<br>-8.4 | —            | —                | mA    |
| Low-level output current                 | I<br>Iol | Vol=0.2*OVDD<br>Low Drive<br>Medium Drive<br>High Drive<br>Max Drive | 2.1<br>4.2<br>6.3<br>8.4     | —            | —                | mA    |
| High-Level DC input voltage <sup>1</sup> | VIH      | —                                                                    | 0.7*OVDD                     | —            | OVDD             | V     |
| Low-Level DC input voltage               | VIL      | —                                                                    | 0V                           | —            | 0.3*OVDD         | V     |
| Input Hysteresis                         | VHYS     | OVDD=1.875<br>OVDD=2.775                                             | 0.35                         | 0.62<br>1.27 | —                | V     |
| Schmitt trigger VT+ <sup>2</sup>         | VT+      | —                                                                    | 0.5*OVDD                     | —            | —                | V     |
| Schmitt trigger VT-                      | VT-      | —                                                                    | —                            | —            | 0.5*OVDD         | V     |
| Pull-up resistor (22 KΩ PU)              | Rpu      | Vi=OVDD/2                                                            | 20                           | 24           | 28               | KΩ    |
| Pull-up resistor (47 KΩ PU)              | Rpu      | Vi=OVDD/2                                                            | 43                           | 51           | 59               | KΩ    |
| Pull-up resistor (100 KΩ PU)             | Rpu      | Vi=OVDD/2                                                            | 91                           | 108          | 125              | KΩ    |
| Pull-down resistor (100 KΩ PD)           | Rpd      | Vi=OVDD/2                                                            | 91                           | 108          | 126              | KΩ    |
| Input current (no pull-up/down)          | IIN      | VI = 0<br>VI=OVDD                                                    | —                            | 1.7          | 250<br>120       | nA    |
| Input current (22 KΩ PU)                 | IIN      | VI = 0<br>VI=OVDD                                                    | —                            | —            | 161<br>0.12      | μA    |
| Input current (47 KΩ PU)                 | IIN      | VI = 0<br>VI=OVDD                                                    | —                            | —            | 76<br>0.12       | μA    |
| Input current (100 KΩ PU)                | IIN      | VI = 0<br>VI=OVDD                                                    | —                            | —            | 36<br>0.12       | μA    |

**Table 22. LVIO DC Electrical Characteristics (continued)**

| DC Electrical Characteristics                                               | Symbol | Test Conditions   | MIN | Typ | MAX        | Units      |
|-----------------------------------------------------------------------------|--------|-------------------|-----|-----|------------|------------|
| Input current (100 K $\Omega$ PD)                                           | IIN    | VI = 0<br>VI=OVDD | —   | —   | 0.25<br>36 | $\mu$ A    |
| External pull-up / pull-down resistor required to overdrive internal keeper | Rext   | —                 | —   | —   | 47         | K $\Omega$ |

<sup>1</sup> To maintain a valid level, the transitioning edge of the input must sustain a constant slew rate (monotonic) from the current DC level through to the target DC level, VIL or VIH. Monotonic input transition time is from 0.1 ns to 1 s. VIL and VIH do not apply when hysteresis is enabled.

<sup>2</sup> Hysteresis of 350 mV is guaranteed over all operating conditions when hysteresis is enabled.

### 4.3.6 High Voltage I/O (HVIO) DC Parameters

Table 23 shows the HVIO DC electrical operating conditions. The parameters are guaranteed per the operating ranges in Table 11, unless otherwise noted.

**Table 23. HVIO DC Electrical Characteristics**

| DC Electrical Characteristics                | Symbol | Test Conditions                                         | MIN                    | TYP          | MAX              | Units |
|----------------------------------------------|--------|---------------------------------------------------------|------------------------|--------------|------------------|-------|
| High-level output voltage                    | Voh    | Ioh=-1mA<br>Ioh=spec'ed Drive                           | OVDD-0.15<br>0.8*OVDD  | —            | —                | V     |
| Low-level output voltage                     | Vol    | Iol=1mA<br>Iol=specified Drive                          | —                      | —            | 0.15<br>0.2*OVDD | V     |
| High-level output current, low voltage mode  | Ioh_lv | Voh=0.8*OVDD<br>Low Drive<br>Medium Drive<br>High Drive | -2.2<br>-4.4<br>-6.6   | —            | —                | mA    |
| High-level output current, high voltage mode | Ioh_hv | Vol=0.8*OVDD<br>Low Drive<br>Medium Drive<br>High Drive | -5.1<br>-10.2<br>-15.3 | —            | —                | mA    |
| Low-level output current, low voltage mode   | Iol_lv | Voh=0.2*OVDD<br>Low Drive<br>Medium Drive<br>High Drive | 2.2<br>4.4<br>6.6      | —            | —                | mA    |
| Low-level output current, high voltage mode  | Iol_hv | Voh=0.2*OVDD<br>Low Drive<br>Medium Drive<br>High Drive | 5.1<br>10.2<br>15.3    | —            | —                | mA    |
| High-Level DC input voltage <sup>1</sup>     | VIH    | —                                                       | 0.7*OVDD               | —            | OVDD             | V     |
| Low-Level DC input voltage                   | VIL    | —                                                       | 0V                     | —            | 0.3*OVDD         | V     |
| Input Hysteresis                             | VHYS   | OVDD=1.875<br>OVDD=3.0                                  | 0.25                   | 0.36<br>0.80 | —                | V     |
| Schmitt trigger VT+ <sup>2</sup>             | VT+    | —                                                       | 0.5*OVDD               | —            | —                | V     |
| Schmitt trigger VT-                          | VT-    | —                                                       | —                      | —            | 0.5*OVDD         | V     |

Table 23. HVIO DC Electrical Characteristics (continued)

| DC Electrical Characteristics                                               | Symbol | Test Conditions                                         | MIN                    | TYP | MAX         | Units      |
|-----------------------------------------------------------------------------|--------|---------------------------------------------------------|------------------------|-----|-------------|------------|
| Pull-up resistor (22 K $\Omega$ PU)                                         | Rpu    | Vi=OVDD/2                                               | 22                     | 29  | 71          | K $\Omega$ |
| Pull-up resistor (47 K $\Omega$ PU)                                         | Rpu    | Vi=OVDD/2                                               | 43                     | 59  | 148         | K $\Omega$ |
| Pull-up resistor (100 K $\Omega$ PU)                                        | Rpu    | Vi=OVDD/2                                               | 46                     | 62  | 156         | K $\Omega$ |
| Pull-down resistor (100 K $\Omega$ PD)                                      | Rpd    | Vi=OVDD/2                                               | 53                     | 77  | 256         | K $\Omega$ |
| Input current (no pull-up/down)                                             | IIN    | VI = 0<br>VI=OVDD                                       | —                      | 2.8 | 470<br>50   | nA         |
| Input current (22 K $\Omega$ PU)                                            | IIN    | VI = 0<br>VI=OVDD                                       | —                      | —   | 153<br>0.05 | $\mu$ A    |
| Input current (47 K $\Omega$ PU)                                            | IIN    | VI = 0<br>VI=OVDD                                       | —                      | —   | 77<br>0.05  | $\mu$ A    |
| Input current (100 K $\Omega$ PU)                                           | IIN    | VI = 0<br>VI=OVDD                                       | —                      | —   | 73<br>0.05  | $\mu$ A    |
| Input current (100 K $\Omega$ PD)                                           | IIN    | VI = 0<br>VI=OVDD                                       | —                      | —   | 0.47<br>63  | $\mu$ A    |
| High-level output current, high voltage mode                                | Ioh_hv | Vol=0.8*OVDD<br>Low Drive<br>Medium Drive<br>High Drive | -5.1<br>-10.2<br>-15.3 | —   | —           | mA         |
| External pull-up / pull-down resistor required to overdrive internal keeper | Rext   | —                                                       | —                      | —   | 2.5         | K $\Omega$ |

<sup>1</sup> To maintain a valid level, the transitioning edge of the input must sustain a constant slew rate (monotonic) from the current DC level through to the target DC level, VIL or VIH. Monotonic input transition time is from 0.1 ns to 1 s. VIL and VIH do not apply when hysteresis is enabled.

<sup>2</sup> Hysteresis of 250 mV is guaranteed over all operating conditions when hysteresis is enabled.

## 4.4 Output Buffer Impedance Characteristics

This section defines the I/O impedance parameters of the i.MX50 processor.

## 4.4.1 GPIO Output Buffer Impedance

Table 24 shows the GPIO output buffer impedance of the i.MX50 processor.

**Table 24. GPIO Output Buffer Impedance**

| Parameter               | Symbol | Test Conditions                          | Min | Typ             |                | Max | Unit     |
|-------------------------|--------|------------------------------------------|-----|-----------------|----------------|-----|----------|
|                         |        |                                          |     | OVDD<br>2.775 V | OVDD<br>1.875V |     |          |
| Output driver impedance | Rpu    | Low drive strength, Ztl = 150 $\Omega$   | 80  | 104             | 150            | 250 | $\Omega$ |
|                         |        | Medium drive strength, Ztl = 75 $\Omega$ | 40  | 52              | 75             | 125 |          |
|                         |        | High drive strength, Ztl = 50 $\Omega$   | 27  | 35              | 51             | 83  |          |
|                         |        | Max drive strength, Ztl = 37.5 $\Omega$  | 20  | 26              | 38             | 62  |          |
| Output driver impedance | Rpd    | Low drive strength, Ztl = 150 $\Omega$   | 64  | 88              | 134            | 243 | $\Omega$ |
|                         |        | Medium drive strength, Ztl = 75 $\Omega$ | 32  | 44              | 66             | 122 |          |
|                         |        | High drive strength, Ztl = 50 $\Omega$   | 21  | 30              | 44             | 81  |          |
|                         |        | Max drive strength, Ztl = 37.5 $\Omega$  | 16  | 22              | 34             | 61  |          |

## 4.4.2 LVIO Output Buffer Impedance

Table 25 shows the LVIO output buffer impedance of the i.MX50 processor.

**Table 25. LVIO Output Buffer Impedance**

| Parameter               | Symbol | Test Conditions                          | Min | Typ             |                | Max | Unit     |
|-------------------------|--------|------------------------------------------|-----|-----------------|----------------|-----|----------|
|                         |        |                                          |     | OVDD<br>2.775 V | OVDD<br>1.875V |     |          |
| Output driver impedance | Rpu    | Low drive strength, Ztl = 150 $\Omega$   | 80  | 104             | 150            | 250 | $\Omega$ |
|                         |        | Medium drive strength, Ztl = 75 $\Omega$ | 40  | 52              | 75             | 125 |          |
|                         |        | High drive strength, Ztl = 50 $\Omega$   | 27  | 35              | 51             | 83  |          |
|                         |        | Max drive strength, Ztl = 37.5 $\Omega$  | 20  | 26              | 38             | 62  |          |
| Output driver impedance | Rpd    | Low drive strength, Ztl = 150 $\Omega$   | 64  | 88              | 134            | 243 | $\Omega$ |
|                         |        | Medium drive strength, Ztl = 75 $\Omega$ | 32  | 44              | 66             | 122 |          |
|                         |        | High drive strength, Ztl = 50 $\Omega$   | 21  | 30              | 44             | 81  |          |
|                         |        | Max drive strength, Ztl = 37.5 $\Omega$  | 16  | 22              | 34             | 61  |          |

### 4.4.3 HVIO Output Buffer Impedance

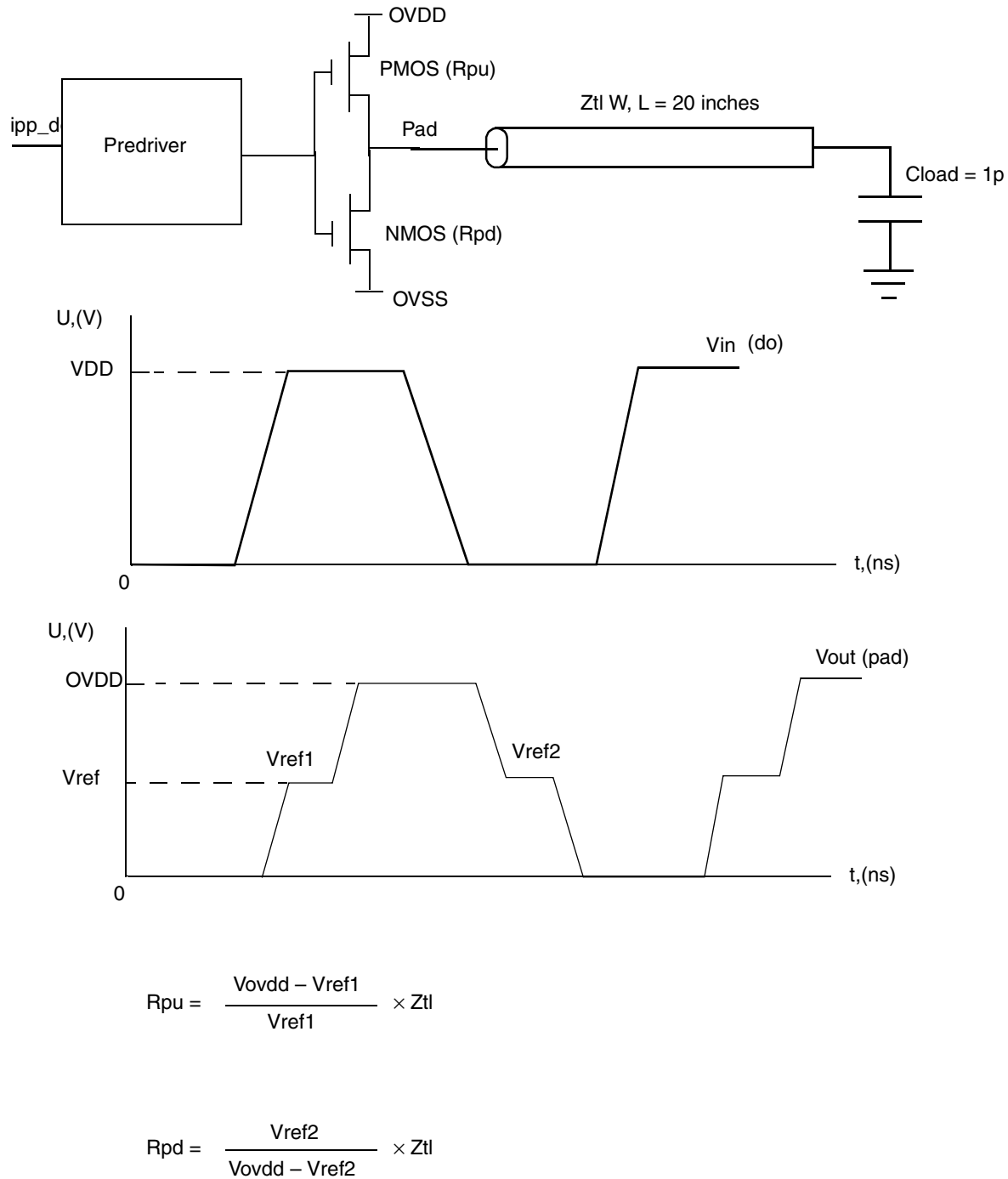
Table 26 shows the HVIO output buffer impedance of the i.MX50 processor.

**Table 26. HVIO Output Buffer Impedance**

| Parameter               | Symbol | Test Conditions                          | Min            |               | Typ             |               | Max            |                | Unit     |
|-------------------------|--------|------------------------------------------|----------------|---------------|-----------------|---------------|----------------|----------------|----------|
|                         |        |                                          | OVDD<br>1.95 V | OVDD<br>3.3 V | OVDD<br>1.875 V | OVDD<br>3.30V | OVDD<br>1.65 V | OVDD<br>2.68 V |          |
| Output driver impedance | Rpu    | Low drive strength, Ztl = 150 $\Omega$   | 113.5          | 103.8         | 130.6           | 133           | 219.4          | 212.2          | $\Omega$ |
|                         |        | Medium drive strength, Ztl = 75 $\Omega$ | 56.2           | 51.9          | 66              | 69.2          | 109.7          | 111.1          |          |
|                         |        | High drive strength, Ztl = 50 $\Omega$   | 37.8           | 35.1          | 45.9            | 41            | 73.1           | 71.8           |          |
| Output driver impedance | Rpd    | Low drive strength, Ztl = 150 $\Omega$   | 78.5           | 70            | 113.6           | 102           | 230.8          | 179.5          | $\Omega$ |
|                         |        | Medium drive strength, Ztl = 75 $\Omega$ | 39.7           | 34.5          | 56.8            | 50            | 115.4          | 89.8           |          |
|                         |        | High drive strength, Ztl = 50 $\Omega$   | 26.8           | 23            | 38.3            | 33.3          | 76.9           | 60.7           |          |

#### NOTE

Output driver impedance is measured with *long* transmission line of impedance Ztl attached to I/O pad and incident wave launched into transmission line. Rpu/Rpd and Ztl form a voltage divider that defines specific voltage of incident wave relative to OVDD. Output driver impedance is calculated from this voltage divider (see Figure 3).



**Figure 3. Impedance Matching Load for Measurement**

## 4.5 I/O AC Parameters

The load circuit and output transition time waveforms are shown in Figure 4 and Figure 5. The AC electrical characteristics for slow and fast I/O are presented in the Table 27 and Table 28, respectively. Note that the fast or slow I/O behavior is determined by the appropriate control bit in the IOMUX control registers.

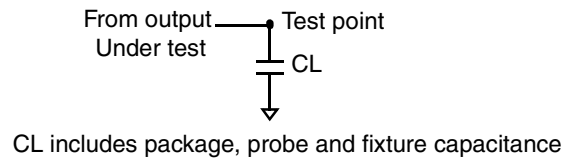


Figure 4. Load Circuit for Output

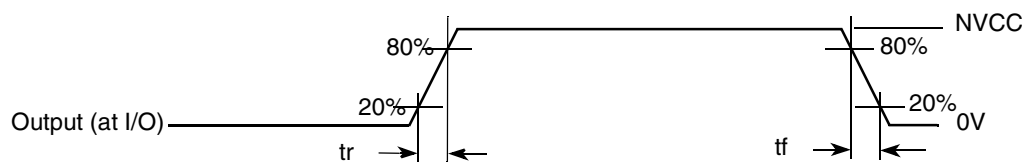


Figure 5. Output Transition Time Waveform

### 4.5.1 GPIO I/O Slow AC Parameters

Table 27 shows the AC parameters for GPIO slow I/O.

Table 27. GPIO I/O Slow AC Parameters

| Parameter                                     | Symbol | Test Condition | Min                    | Typ | Max                     | Unit  |
|-----------------------------------------------|--------|----------------|------------------------|-----|-------------------------|-------|
| Output Pad Transition Times (Max Drive)       | tr, tf | 15 pF<br>35 pF |                        |     | 1.91/1.52<br>3.07/2.65  | ns    |
| Output Pad Transition Times (High Drive)      | tr, tf | 15 pF<br>35 pF |                        |     | 2.22/1.81<br>3.81/3.42  | ns    |
| Output Pad Transition Times (Medium Drive)    | tr, tf | 15 pF<br>35 pF |                        |     | 2.88/2.42<br>5.43/5.02  | ns    |
| Output Pad Transition Times (Low Drive)       | tr, tf | 15 pF<br>35 pF |                        |     | 4.94/4.50<br>10.55/9.70 | ns    |
| Output Pad Slew Rate (Max Drive) <sup>1</sup> | tps    | 15 pF<br>35 pF | 0.5/0.65<br>0.32/0.37  |     |                         | V/ns  |
| Output Pad Slew Rate (High Drive)             | tps    | 15 pF<br>35 pF | 0.43/0.54<br>0.26/0.41 |     |                         | V/ns  |
| Output Pad Slew Rate (Medium Drive)           | tps    | 15 pF<br>35 pF | 0.34/0.41<br>0.18/0.2  |     |                         | V/ns  |
| Output Pad Slew Rate (Low Drive)              | tps    | 15 pF<br>35 pF | 0.20/0.22<br>0.09/0.1  |     |                         | V/ns  |
| Output Pad di/dt (Max Drive)                  | tdit   |                |                        |     | 30                      | mA/ns |

**Table 27. GPIO I/O Slow AC Parameters (continued)**

| Parameter                           | Symbol | Test Condition | Min | Typ | Max | Unit  |
|-------------------------------------|--------|----------------|-----|-----|-----|-------|
| Output Pad di/dt (High Drive)       | tdit   |                |     |     | 23  | mA/ns |
| Output Pad di/dt (Medium drive)     | tdit   |                |     |     | 15  | mA/ns |
| Output Pad di/dt (Low drive)        | tdit   |                |     |     | 7   | mA/ns |
| Input Transition Times <sup>2</sup> | trm    |                |     |     | 25  | ns    |

<sup>1</sup> tps is measured between VIL to VIH for rising edge and between VIH to VIL for falling edge.

<sup>2</sup> Hysteresis mode is recommended for inputs with transition time greater than 25 ns.

## 4.5.2 GPIO I/O Fast AC Parameters

Table 28 shows the AC parameters for GPIO fast I/O.

**Table 28. GPIO I/O Fast AC Parameters**

| Parameter                                     | Symbol | Test Condition | Min                    | Typ | Max                     | Unit  |
|-----------------------------------------------|--------|----------------|------------------------|-----|-------------------------|-------|
| Output Pad Transition Times (Max Drive)       | tr, tf | 15 pF<br>35 pF |                        |     | 1.45/1.24<br>2.76/2.54  | ns    |
| Output Pad Transition Times (High Drive)      | tr, tf | 15 pF<br>35 pF |                        |     | 1.81/1.59<br>3.57/3.33  | ns    |
| Output Pad Transition Times (Medium Drive)    | tr, tf | 15 pF<br>35 pF |                        |     | 2.54/2.29<br>5.25/5.01  | ns    |
| Output Pad Transition Times (Low Drive)       | tr, tf | 15 pF<br>35 pF |                        |     | 4.82/4.50<br>10.54/9.95 | ns    |
| Output Pad Slew Rate (Max Drive) <sup>1</sup> | tps    | 15 pF<br>35 pF | 0.69/0.78<br>0.36/0.39 |     |                         | V/ns  |
| Output Pad Slew Rate (High Drive)             | tps    | 15 pF<br>35 pF | 0.55/0.62<br>0.28/0.30 |     |                         | V/ns  |
| Output Pad Slew Rate (Medium Drive)           | tps    | 15 pF<br>35 pF | 0.39/0.44<br>0.19/0.20 |     |                         | V/ns  |
| Output Pad Slew Rate (Low Drive)              | tps    | 15 pF<br>35 pF | 0.21/0.22<br>0.09/0.1  |     |                         | V/ns  |
| Output pad di/dt (Max drive)                  | tdit   | —              | —                      | —   | 70                      | mA/ns |
| Output pad di/dt (High drive)                 | tdit   | —              | —                      | —   | 53                      | mA/ns |
| Output pad di/dt (Medium drive)               | tdit   | —              | —                      | —   | 35                      | mA/ns |
| Output pad di/dt (Low drive)                  | tdit   | —              | —                      | —   | 18                      | mA/ns |
| Input transition times <sup>2</sup>           | trm    | —              | —                      | —   | 25                      | ns    |

<sup>1</sup> tps is measured between VIL to VIH for rising edge and between VIH to VIL for falling edge.

<sup>2</sup> Hysteresis mode is recommended for inputs with transition time greater than 25 ns.

### 4.5.3 LVIO I/O Slow AC Parameters

Table 27 shows the AC parameters for LVIO slow I/O.

**Table 29. LVIO I/O Slow AC Parameters**

| Parameter                                     | Symbol | Test Condition | Min                    | Typ | Max                     | Unit  |
|-----------------------------------------------|--------|----------------|------------------------|-----|-------------------------|-------|
| Output Pad Transition Times (Max Drive)       | tr, tf | 15 pF<br>35 pF |                        |     | 1.97/1.57<br>3.12/2.70  | ns    |
| Output Pad Transition Times (High Drive)      | tr, tf | 15 pF<br>35 pF |                        |     | 2.29/1.87<br>3.79/3.44  | ns    |
| Output Pad Transition Times (Medium Drive)    | tr, tf | 15 pF<br>35 pF |                        |     | 2.93/2.48<br>5.42/4.98  | ns    |
| Output Pad Transition Times (Low Drive)       | tr, tf | 15 pF<br>35 pF |                        |     | 4.92/4.57<br>10.64/9.85 | ns    |
| Output Pad Slew Rate (Max Drive) <sup>1</sup> | tps    | 15 pF<br>35 pF | 0.50/0.63<br>0.32/0.37 |     |                         | V/ns  |
| Output Pad Slew Rate (High Drive)             | tps    | 15 pF<br>35 pF | 0.43/0.53<br>0.26/0.29 |     |                         | V/ns  |
| Output Pad Slew Rate (Medium Drive)           | tps    | 15 pF<br>35 pF | 0.34/0.40<br>0.18/0.20 |     |                         | V/ns  |
| Output Pad Slew Rate (Low Drive)              | tps    | 15 pF<br>35 pF | 0.20/0.22<br>0.09/0.10 |     |                         | V/ns  |
| Output Pad di/dt (Max Drive)                  | tdit   |                |                        |     | 30                      | mA/ns |
| Output Pad di/dt (High Drive)                 | tdit   |                |                        |     | 24                      | mA/ns |
| Output Pad di/dt (Medium drive)               | tdit   |                |                        |     | 16                      | mA/ns |
| Output Pad di/dt (Low drive)                  | tdit   |                |                        |     | 8                       | mA/ns |
| Input Transition Times <sup>2</sup>           | trm    |                |                        |     | 25                      | ns    |

<sup>1</sup> tps is measured between VIL to VIH for rising edge and between VIH to VIL for falling edge.

<sup>2</sup> Hysteresis mode is recommended for inputs with transition time greater than 25 ns.

## 4.5.4 LVIO I/O Fast AC Parameters

Table 30 shows the AC parameters for LVIO fast I/O.

**Table 30. LVIO I/O Fast AC Parameters**

| Parameter                                     | Symbol | Test Condition | Min                    | Typ | Max                      | Unit  |
|-----------------------------------------------|--------|----------------|------------------------|-----|--------------------------|-------|
| Output Pad Transition Times (Max Drive)       | tr, tf | 15 pF<br>35 pF |                        |     | 1.44/1.27<br>2.78/2.56   | ns    |
| Output Pad Transition Times (High Drive)      | tr, tf | 15 pF<br>35 pF |                        |     | 1.80/1.61<br>3.59/3.34   | ns    |
| Output Pad Transition Times (Medium Drive)    | tr, tf | 15 pF<br>35 pF |                        |     | 2.55/2.28<br>5.32/5.01   | ns    |
| Output Pad Transition Times (Low Drive)       | tr, tf | 15 pF<br>35 pF |                        |     | 4.74/4.59<br>10.59/10.21 | ns    |
| Output Pad Slew Rate (Max Drive) <sup>1</sup> | tps    | 15 pF<br>35 pF | 0.69/0.78<br>0.36/0.39 |     |                          | V/ns  |
| Output Pad Slew Rate (High Drive)             | tps    | 15 pF<br>35 pF | 0.55/0.61<br>0.28/0.30 |     |                          | V/ns  |
| Output Pad Slew Rate (Medium Drive)           | tps    | 15 pF<br>35 pF | 0.39/0.44<br>0.19/0.20 |     |                          | V/ns  |
| Output Pad Slew Rate (Low Drive)              | tps    | 15 pF<br>35 pF | 0.21/0.22<br>0.09/0.10 |     |                          | V/ns  |
| Output pad di/dt (Max drive)                  | tdit   | —              | —                      | —   | 70                       | mA/ns |
| Output pad di/dt (High drive)                 | tdit   | —              | —                      | —   | 54                       | mA/ns |
| Output pad di/dt (Medium drive)               | tdit   | —              | —                      | —   | 35                       | mA/ns |
| Output pad di/dt (Low drive)                  | tdit   | —              | —                      | —   | 18                       | mA/ns |
| Input transition times <sup>2</sup>           | trm    | —              | —                      | —   | 25                       | ns    |

<sup>1</sup> tps is measured between VIL to VIH for rising edge and between VIH to VIL for falling edge.

<sup>2</sup> Hysteresis mode is recommended for inputs with transition time greater than 25 ns.

## 4.5.5 HVIO I/O Low Voltage (1.8 V) AC Parameters

Table 27 shows the AC parameters for HVIO I/O Low Voltage (1.8 V).

**Table 31. HVIO I/O Low Voltage (1.8 V) AC Parameters**

| Parameter                                  | Symbol | Test Condition | Min | Typ | Max                    | Unit |
|--------------------------------------------|--------|----------------|-----|-----|------------------------|------|
| Output Pad Transition Times (High Drive)   | tr, tf | 15 pF<br>35 pF |     |     | 1.82/1.97<br>3.39/3.57 | ns   |
| Output Pad Transition Times (Medium Drive) | tr, tf | 15 pF<br>35 pF |     |     | 2.48/2.62<br>4.95/5.14 | ns   |
| Output Pad Transition Times (Low Drive)    | tr, tf | 15 pF<br>35 pF |     |     | 4.57/4.77<br>9.60/9.91 | ns   |

**Table 31. HVIO I/O Low Voltage (1.8 V) AC Parameters (continued)**

| Parameter                                      | Symbol | Test Condition | Min                    | Typ | Max | Unit  |
|------------------------------------------------|--------|----------------|------------------------|-----|-----|-------|
| Output Pad Slew Rate (High Drive) <sup>1</sup> | tr, tf | 15 pF<br>35 pF | 0.54/0.50<br>0.29/0.28 |     |     | V/ns  |
| Output Pad Slew Rate (Medium Drive)            | tr, tf | 15 pF<br>35 pF | 0.40/0.38<br>0.20/0.19 |     |     | V/ns  |
| Output Pad Slew Rate (Low Drive)               | tr, tf | 15 pF<br>35 pF | 0.22/0.21<br>0.10/0.10 |     |     | V/ns  |
| Output Pad di/dt (High Drive)                  | tdit   |                |                        |     | 34  | mA/ns |
| Output Pad di/dt (Medium drive)                | tdit   |                |                        |     | 22  | mA/ns |
| Output Pad di/dt (Low drive)                   | tdit   |                |                        |     | 11  | mA/ns |
| Input Transition Times <sup>2</sup>            | trm    |                |                        |     | 25  | ns    |

<sup>1</sup> tps is measured between VIL to VIH for rising edge and between VIH to VIL for falling edge.

<sup>2</sup> Hysteresis mode is recommended for inputs with transition time greater than 25 ns.

#### 4.5.6 HVIO I/O High Voltage (3.0 V) AC Parameters

Table 32 shows the AC parameters for HVIO I/O High Voltage (3.0 V).

**Table 32. HVIO I/O High Voltage (3.0 V) AC Parameters**

| Parameter                                      | Symbol | Test Condition | Min                    | Typ | Max                    | Unit  |
|------------------------------------------------|--------|----------------|------------------------|-----|------------------------|-------|
| Output Pad Transition Times (High Drive)       | tpr    | 15 pF<br>35 pF |                        |     | 2.16/1.79<br>3.75/3.28 | ns    |
| Output Pad Transition Times (Medium Drive)     | tpr    | 15 pF<br>35 pF |                        |     | 2.81/2.40<br>5.06/4.58 | ns    |
| Output Pad Transition Times (Low Drive)        | tpr    | 15 pF<br>35 pF |                        |     | 4.69/4.15<br>8.91/8.51 | ns    |
| Output Pad Slew Rate (High Drive) <sup>1</sup> | tps    | 15 pF<br>35 pF | 0.75/0.90<br>0.43/0.49 |     |                        | V/ns  |
| Output Pad Slew Rate (Medium Drive)            | tps    | 15 pF<br>35 pF | 0.57/0.67<br>0.32/0.35 |     |                        | V/ns  |
| Output Pad Slew Rate (Low Drive)               | tps    | 15 pF<br>35 pF | 0.34/0.39<br>0.18/0.19 |     |                        | V/ns  |
| Output pad di/dt (High drive)                  | tdit   | —              | —                      | —   | 55                     | mA/ns |
| Output pad di/dt (Medium drive)                | tdit   | —              | —                      | —   | 36                     | mA/ns |
| Output pad di/dt (Low drive)                   | tdit   | —              | —                      | —   | 16                     | mA/ns |
| Input transition times <sup>2</sup>            | trm    | —              | —                      | —   | 25                     | ns    |

<sup>1</sup> tps is measured between VIL to VIH for rising edge and between VIH to VIL for falling edge.

<sup>2</sup> Hysteresis mode is recommended for inputs with transition time greater than 25 ns.

## 4.5.7 DDR2 I/O AC Parameters

Table 33 shows the AC parameters for DDR2 I/O.

**Table 33. DDR2 I/O AC Parameters**

| Parameter                                               | Symbol              | Min                    | Max                    | Unit |
|---------------------------------------------------------|---------------------|------------------------|------------------------|------|
| AC input logic high                                     | V <sub>ih(ac)</sub> | V <sub>ref</sub> +0.25 | -                      | V    |
| AC input logic low                                      | V <sub>il(ac)</sub> | -                      | V <sub>ref</sub> -0.25 |      |
| AC differential input voltage <sup>1</sup>              | V <sub>id(ac)</sub> | 0.5                    | ovdd                   |      |
| AC Input differential cross point voltage <sup>2</sup>  | V <sub>ix(ac)</sub> | 0.5*ovdd<br>-0.175     | 0.5*ovdd +<br>0.175    |      |
| AC output differential cross point voltage <sup>3</sup> | V <sub>ox(ac)</sub> | 0.5*ovdd<br>-0.125     | 0.5*ovdd+<br>0.125     |      |
| Output propagation delay high to low                    | t <sub>POHLD</sub>  |                        | 3.5                    | ns   |
| Output propagation delay low to high                    | t <sub>POLHD</sub>  |                        | 3.5                    |      |
| Input propagation delay high to low                     | t <sub>PIHLD</sub>  |                        | 1.5                    |      |
| Input propagation delay low to high                     | t <sub>PILHD</sub>  |                        | 1.5                    |      |
| Single output slew rate                                 | tsr                 | 0.4                    | 2                      | V/ns |

<sup>1</sup>V<sub>id(ac)</sub> specifies the input differential voltage |V<sub>tr</sub>-V<sub>cpl</sub>| required for switching, where V<sub>tr</sub> is the “true” input signal and V<sub>cpl</sub> is the “complementary” input signal. The Minimum value is equal to V<sub>ih(ac)</sub>-V<sub>il(ac)</sub>

<sup>2</sup>The typical value of V<sub>ix(ac)</sub> is expected to be about 0.5\*OVDD. and V<sub>ix(ac)</sub> is expected to track variation of OVDD. V<sub>ix(ac)</sub> indicates the voltage at which differential input signal must cross.

<sup>3</sup>The typical value of V<sub>ox(ac)</sub> is expected to be about 0.5\*OVDD and V<sub>ox(ac)</sub> is expected to track variation in OVDD. V<sub>ox(ac)</sub> indicates the voltage at which differential output signal must cross.

## 4.5.8 LPDDR1 I/O AC Parameters

Table 34 shows the AC parameters for LPDDR1 I/O.

**Table 34. LPDDR1 I/O AC Parameters**

| Parameter                                             | Symbol               | Min      | Max      | Unit |
|-------------------------------------------------------|----------------------|----------|----------|------|
| AC input logic high                                   | V <sub>ihd(ac)</sub> | 0.8*ovdd | ovdd+0.3 | V    |
| AC input logic low                                    | V <sub>ild(ac)</sub> | -0.3     | 0.2*ovdd |      |
| AC input differential voltage <sup>1</sup>            | V <sub>id(ac)</sub>  | 0.6*ovdd | ovdd+0.6 |      |
| AC input differential crosspoint voltage <sup>2</sup> | V <sub>ix(ac)</sub>  | 0.4*ovdd | 0.6*ovdd |      |
| Output propagation delay high to low                  | t <sub>POHLD</sub>   |          | 2.5      | ns   |
| Output propagation delay low to high                  | t <sub>POLHD</sub>   |          | 2.5      |      |
| Input propagation delay high to low                   | t <sub>PIHLD</sub>   |          | 1.5      |      |
| Input propagation delay low to high                   | t <sub>PILHD</sub>   |          | 1.5      |      |
| Single output slew rate                               | tsr                  | 0.3      | 2.5      | V/ns |

<sup>1</sup>V<sub>id(ac)</sub> specifies the input differential voltage |V<sub>tr</sub>-V<sub>cpl</sub>| required for switching, where V<sub>tr</sub> is the “true” input signal and V<sub>cpl</sub> is the “complementary” input signal. The Minimum value is equal to V<sub>ih(ac)</sub>-V<sub>il(ac)</sub>

<sup>2</sup>The typical value of V<sub>ix(ac)</sub> is expected to be about 0.5\*ovdd. and V<sub>ix(ac)</sub> is expected to track variation of ovdd. V<sub>ix(ac)</sub> indicates the voltage at which differential input signal must cross.

## 4.5.9 LPDDR2 I/O AC Parameters

Table 35 shows the AC parameters for LPDDR2 I/O.

**Table 35. LPDDR2 I/O AC Parameters**

| Parameter                                                                     | Symbol               | Min                    | Max                    | Unit |
|-------------------------------------------------------------------------------|----------------------|------------------------|------------------------|------|
| AC input logic high                                                           | V <sub>ih(ac)</sub>  | V <sub>ref</sub> +0.22 | ovdd                   | V    |
| AC input logic low                                                            | V <sub>il(ac)</sub>  | ovss                   | V <sub>ref</sub> -0.22 |      |
| AC differential input high voltage <sup>1</sup>                               | V <sub>idh(ac)</sub> | 0.44                   | -                      |      |
| AC differential input low voltage                                             | V <sub>idl(ac)</sub> | -                      | 0.44                   |      |
| AC input differential cross point voltage (relative to ovdd / 2) <sup>2</sup> | V <sub>ix(ac)</sub>  | -0.12                  | 0.12                   |      |
| Over/undershoot peak                                                          | V <sub>peak</sub>    |                        | 0.35                   | ns   |
| Over/undershoot area (above OVDD or below OVSS)                               | V <sub>area</sub>    |                        | 0.6 (at 266 MHz)       | V-ns |
| Output propagation delay high to low                                          | t <sub>POHLD</sub>   |                        | 3.5                    | ns   |
| Output propagation delay low to high                                          | t <sub>POLHD</sub>   |                        | 3.5                    |      |
| Input propagation delay high to low                                           | t <sub>PIHLD</sub>   |                        | 1.5                    |      |
| Input propagation delay low to high                                           | t <sub>PILHD</sub>   |                        | 1.5                    |      |

**Table 35. LPDDR2 I/O AC Parameters (continued)**

| Parameter                                                | Symbol | Min | Max | Unit |
|----------------------------------------------------------|--------|-----|-----|------|
| Single output slew rate<br>(Driver impedance =40Ω+/-30%) | tsr    | 1.5 | 3.5 | V/ns |
| Single output slew rate<br>(Driver impedance =60Ω+/-30%) | tsr    | 1   | 2.5 | V/ns |

<sup>1</sup>V<sub>id(ac)</sub> specifies the input differential voltage |V<sub>tr</sub>-V<sub>cpl</sub>| required for switching, where V<sub>tr</sub> is the “true” input signal and V<sub>cpl</sub> is the “complementary” input signal. The Minimum value is equal to V<sub>ih(ac)</sub>-V<sub>il(ac)</sub>.

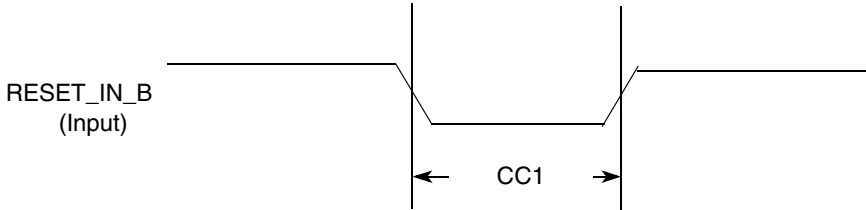
<sup>2</sup>The typical value of V<sub>ix(ac)</sub> is expected to be about 0.5\*OVDD. and V<sub>ix(ac)</sub> is expected to track variation of OVDD. V<sub>ix(ac)</sub> indicates the voltage at which differential input signal must cross.

## 4.6 System Modules Timing

This section contains the timing and electrical parameters for the modules in the i.MX50 processor.

### 4.6.1 Reset Timings Parameters

Figure 6 shows the reset timing and Table 36 lists the timing parameters.



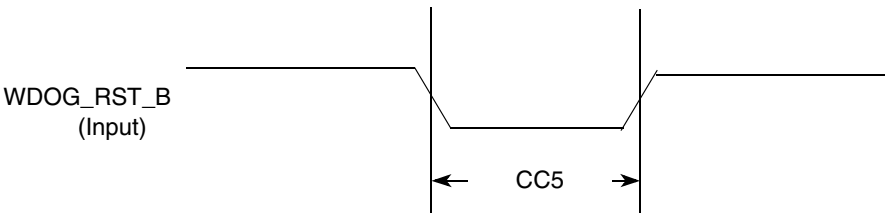
**Figure 6. Reset Timing Diagram**

**Table 36. Reset Timing Parameters**

| ID  | Parameter                                                                      | Min | Max | Unit |
|-----|--------------------------------------------------------------------------------|-----|-----|------|
| CC1 | Duration of RESET_IN_B assertion to be qualified as valid (input slope = 5 ns) | 50  | —   | ns   |

### 4.6.2 WDOG Reset Timing Parameters

Figure 7 shows the WDOG reset timing and Table 37 lists the timing parameters.



**Figure 7. WDOG\_RST\_B Timing Diagram**

Table 37. WDOG\_RST\_B Timing Parameters

| ID  | Parameter                        | Min | Max | Unit              |
|-----|----------------------------------|-----|-----|-------------------|
| CC5 | Duration of WDOG_RST_B Assertion | 1   | —   | T <sub>CKIL</sub> |

### NOTE

CKIL is approximately 32 kHz. T<sub>CKIL</sub> is one period or approximately 30 μs.

## 4.6.3 Clock Amplifier Parameters (CKIH)

The input to clock amplifier (CAMP) is internally ac-coupled allowing direct interface to a square wave or sinusoidal frequency source. No external series capacitors are required.

Table 38 shows the electrical parameters of CAMP.

Table 38. CAMP Electrical Parameters (CKIH)

| Parameter                   | Min                       | Typ | Max  | Unit |
|-----------------------------|---------------------------|-----|------|------|
| Input frequency             | 8.0                       | —   | 40.0 | MHz  |
| VIL (for square wave input) | 0                         | —   | 0.3  | V    |
| VIH (for square wave input) | (VCC <sup>1</sup> – 0.25) | —   | 3    | V    |
| Sinusoidal input amplitude  | 0.4 <sup>2</sup>          | —   | VDD  | Vp-p |
| Output duty cycle           | 45                        | 50  | 55   | %    |

<sup>1</sup> VCC is the supply voltage of CAMP.

<sup>2</sup> This value of the sinusoidal input is determined during characterization.

## 4.6.4 DPLL Electrical Parameters

Table 39 shows the electrical parameters of digital phase-locked loop (DPLL).

Table 39. DPLL Electrical Parameters

| Parameter                                         | Test Conditions/Remarks         | Min       | Typ | Max      | Unit |
|---------------------------------------------------|---------------------------------|-----------|-----|----------|------|
| Reference clock frequency range <sup>1</sup>      | —                               | 10        | —   | 100      | MHz  |
| Reference clock frequency range after pre-divider | —                               | 10        | —   | 40       | MHz  |
| Output clock frequency range (dpdck_2)            | —                               | 300       | —   | 1025     | MHz  |
| Pre-division factor <sup>2</sup>                  | —                               | 1         | —   | 16       | —    |
| Multiplication factor integer part                | —                               | 5         | —   | 15       | —    |
| Multiplication factor numerator <sup>3</sup>      | Should be less than denominator | –67108862 | —   | 67108862 | —    |
| Multiplication factor denominator <sup>2</sup>    | —                               | 1         | —   | 67108863 | —    |
| Output duty cycle                                 | —                               | 48.5      | 50  | 51.5     | %    |

Table 39. DPLL Electrical Parameters (continued)

| Parameter                                                        | Test Conditions/Remarks                                                                                                                                          | Min | Typ  | Max                                                     | Unit              |
|------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|---------------------------------------------------------|-------------------|
| Frequency lock time <sup>4</sup><br>(FOL mode or non-integer MF) | —                                                                                                                                                                | —   | —    | 398                                                     | T <sub>dpre</sub> |
| Phase lock time                                                  | —                                                                                                                                                                | —   | —    | 100                                                     | μs                |
| Frequency jitter <sup>5</sup> (peak value)                       | —                                                                                                                                                                | —   | 0.02 | 0.04                                                    | T <sub>dck</sub>  |
| Phase jitter (peak value)                                        | FPL mode, integer and fractional MF                                                                                                                              | —   | 2.0  | 3.5                                                     | ns                |
| Power dissipation                                                | $f_{dck} = 300 \text{ MHz @ } avdd = 1.8 \text{ V,}$<br>$dvdd = 1.2 \text{ V}$<br>$f_{dck} = 650 \text{ MHz @ } avdd = 1.8 \text{ V,}$<br>$dvdd = 1.2 \text{ V}$ | —   | —    | 0.65 (avdd)<br>0.92 (dvdd)<br>1.98 (avdd)<br>1.8 (dvdd) | mW                |

<sup>1</sup> Device input range cannot exceed the electrical specifications of the CAMP, see Table 38.

<sup>2</sup> The values specified here are internal to DPLL. Inside the DPLL, a 1 is added to the value specified by the user. Therefore, the user has to enter a value 1 less than the desired value at the inputs of DPLL for PDF and MFD.

<sup>3</sup> The maximum total multiplication factor (MFI + MFN/MFD) allowed is 15. Therefore, if the MFI value is 15, MFN value must be zero.

<sup>4</sup> T<sub>dpre</sub> is the time period of the reference clock after predivider. According to the specification, the maximum lock time in FOL mode is 398 cycles of divided reference clock when DPLL starts after full reset.

<sup>5</sup> T<sub>dck</sub> is the time period of the output clock, dpdck\_2.

## 4.6.5 General Purpose Media Interface (GPMI) Parameters

The i.MX50 GPMI controller is a flexible interface NAND Flash controller with 8-bit data width, up to 200 MB/s I/O speed and individual chip select.

It supports Asynchronous timing mode, Source Synchronous timing mode and Samsung Toggle timing mode separately described in the following paragraphs.

### 4.6.5.1 Asynchronous Mode AC Timing (ONFI 1.0 Compatible)

Asynchronous mode AC timings are provided as multiplications of the clock cycle and fixed delay. The Maximum I/O speed of GPMI in Asynchronous mode is about 50 MB/s. Figure 8, Figure 9, Figure 10 and Figure 11 depict the relative timing between GPMI signals at the module level for different

operations under Asynchronous mode. Table 40 describes the timing parameters (NF1–NF17) that are shown in the figures.

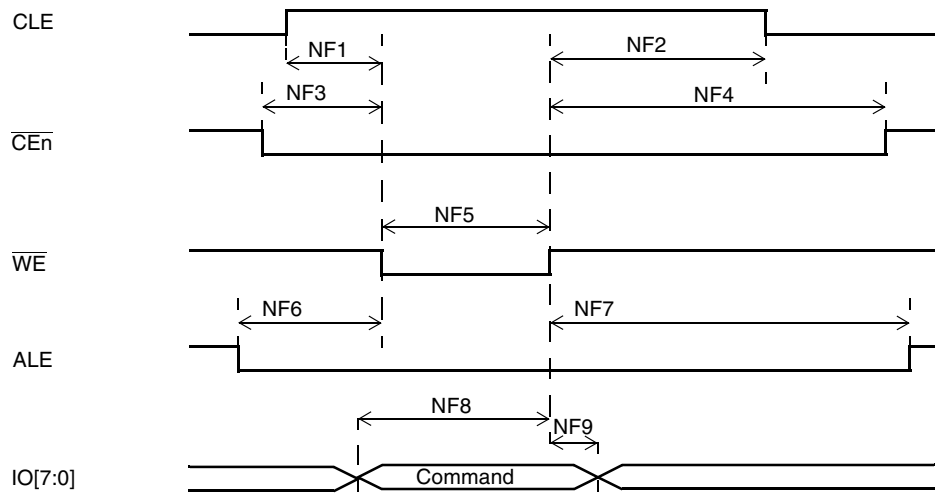


Figure 8. Command Latch Cycle Timing Diagram

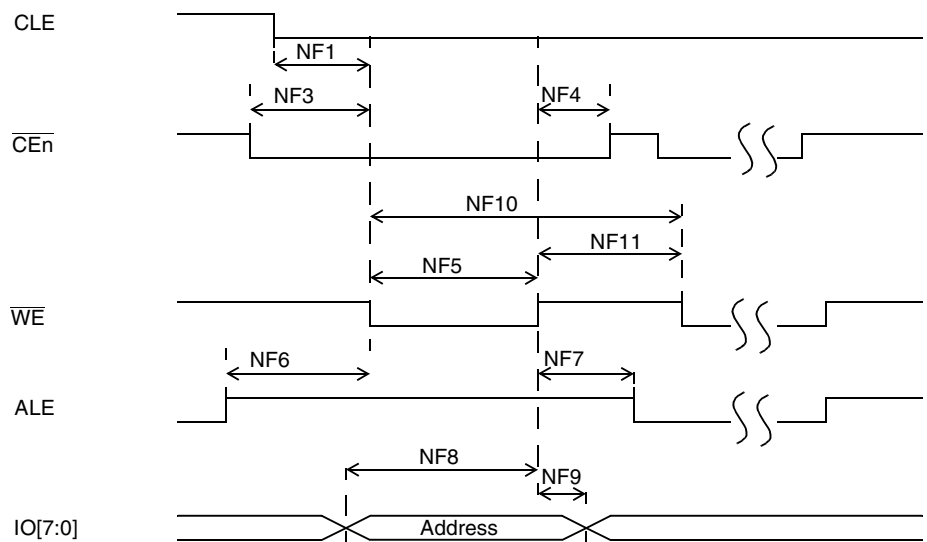


Figure 9. Address Latch Cycle Timing Diagram

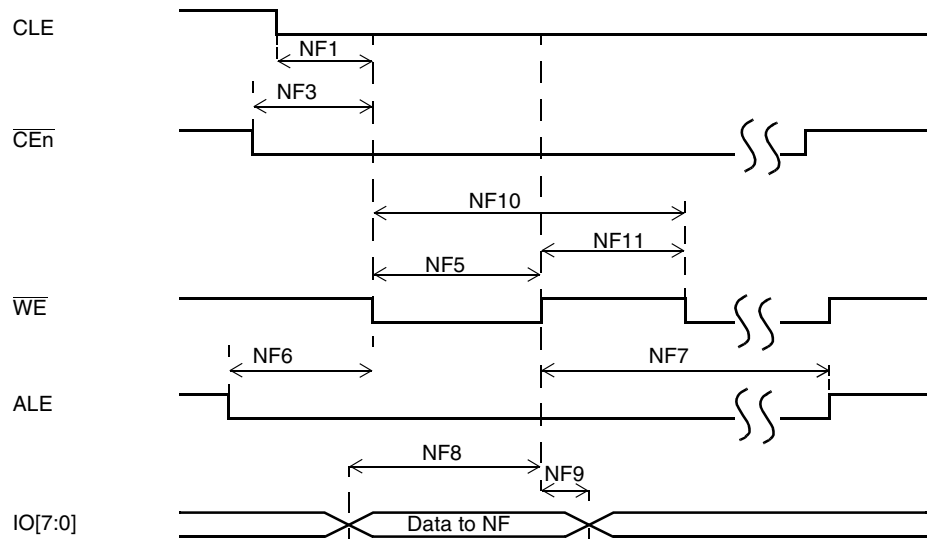


Figure 10. Write Data Latch Cycle Timing Diagram

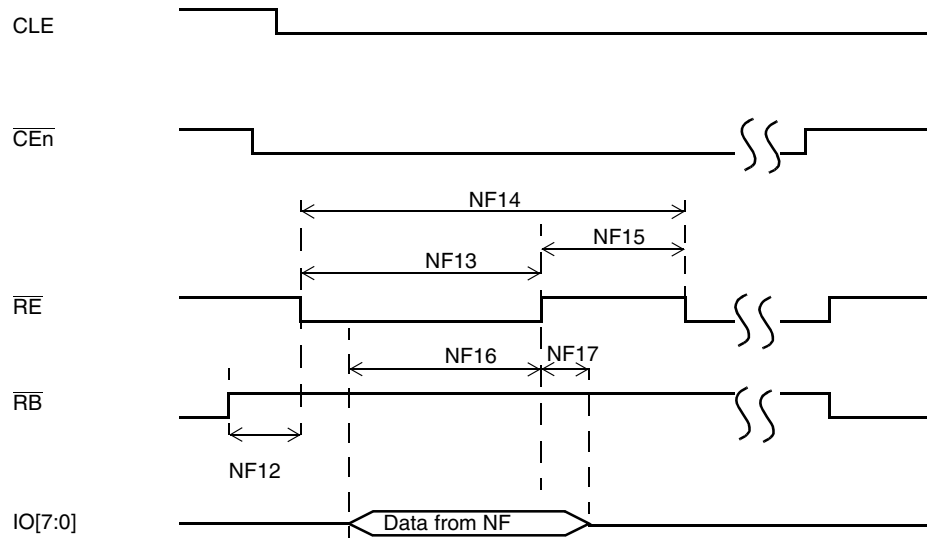


Figure 11. Read Data Latch Cycle Timing Diagram

Table 40. Asynchronous Mode Timing Parameters<sup>1</sup>

| ID  | Parameter                          | Symbol | Timing<br>$T^2 = \text{GPMI Clock Cycle}^3$ |      | Example Timing for<br>GPMI Clock $\approx 100\text{MHz}$<br>$T = 10\text{ns}$ |      | Unit |
|-----|------------------------------------|--------|---------------------------------------------|------|-------------------------------------------------------------------------------|------|------|
|     |                                    |        | Min.                                        | Max. | Min.                                                                          | Max. |      |
| NF1 | CLE setup time                     | tCLS   | $(AS+1)*T$                                  | —    | 10                                                                            | —    | ns   |
| NF2 | CLE hold time                      | tCLH   | $(DH+1)*T$                                  | —    | 20                                                                            | —    | ns   |
| NF3 | $\overline{\text{CEn}}$ setup time | tCS    | $(AS+1)*T$                                  | —    | 10                                                                            | —    | ns   |
| NF4 | $\overline{\text{CE}}$ hold time   | tCH    | $(DH+1)*T$                                  | —    | 20                                                                            | —    | ns   |

Table 40. Asynchronous Mode Timing Parameters<sup>1</sup> (continued)

| ID   | Parameter                             | Symbol | Timing<br>$T^2 = \text{GPMI Clock Cycle}^3$ |      | Example Timing for<br>GPMI Clock $\approx 100\text{MHz}$<br>$T = 10\text{ns}$ |      | Unit |
|------|---------------------------------------|--------|---------------------------------------------|------|-------------------------------------------------------------------------------|------|------|
|      |                                       |        | Min.                                        | Max. | Min.                                                                          | Max. |      |
| NF5  | $\overline{\text{WE}}$ pulse width    | tWP    | DS*T                                        |      | 10                                                                            |      | ns   |
| NF6  | ALE setup time                        | tALS   | (AS+1)*T                                    | —    | 10                                                                            | —    | ns   |
| NF7  | ALE hold time                         | tALH   | (DH+1)*T                                    | —    | 20                                                                            | —    | ns   |
| NF8  | Data setup time                       | tDS    | DS*T                                        | —    | 10                                                                            | —    | ns   |
| NF9  | Data hold time                        | tDH    | DH*T                                        | —    | 10                                                                            | —    | ns   |
| NF10 | Write cycle time                      | tWC    | (DS+DH)*T                                   |      | 20                                                                            |      | ns   |
| NF11 | $\overline{\text{WE}}$ hold time      | tWH    | DH*T                                        |      | 10                                                                            |      | ns   |
| NF12 | Ready to $\overline{\text{RE}}$ low   | tRR    | (AS+1)*T                                    | —    | 10                                                                            | —    | ns   |
| NF13 | $\overline{\text{RE}}$ pulse width    | tRP    | DS*T                                        | —    | 10                                                                            | —    | ns   |
| NF14 | READ cycle time                       | tRC    | (DS+DH)*T                                   | —    | 20                                                                            | —    | ns   |
| NF15 | $\overline{\text{RE}}$ high hold time | tREH   | DH*T                                        |      | 10                                                                            | —    | ns   |
| NF16 | Data setup on read                    | tDSR   | N/A                                         |      | 10                                                                            | —    | ns   |
| NF17 | Data hold on read                     | tDHR   | N/A                                         |      | 10                                                                            | —    | ns   |

<sup>1</sup> GPMI's Async Mode output timing could be controlled by module's internal register, say HW\_GPMI\_TIMING0\_ADDRESS\_SETUP, HW\_GPMI\_TIMING0\_DATA\_SETUP, and HW\_GPMI\_TIMING0\_DATA\_HOLD. This AC timing depends on these registers' setting. In the above table, we use AS/DS/DH representing these settings each.

<sup>2</sup> T represents for the GPMI clock period.

<sup>3</sup> AS minimum value could be 0, while DS/DH minimum value is 1.

### 4.6.5.2 Source Synchronous Mode AC Timing (ONFI 2.x Compatible)

The following diagrams show the write and read timing of Source Synchronous Mode.

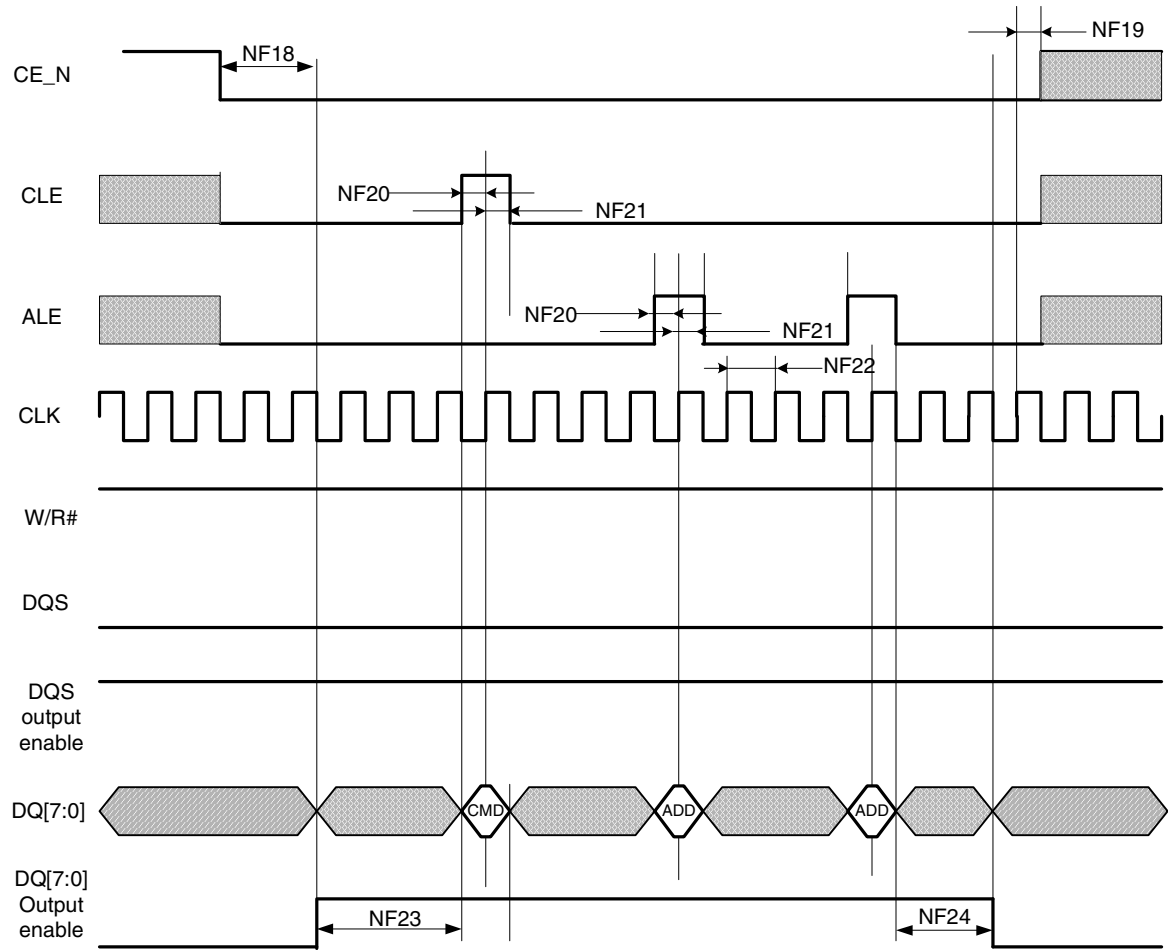


Figure 12. Source Synchronous Mode Command and Address Timing Diagram

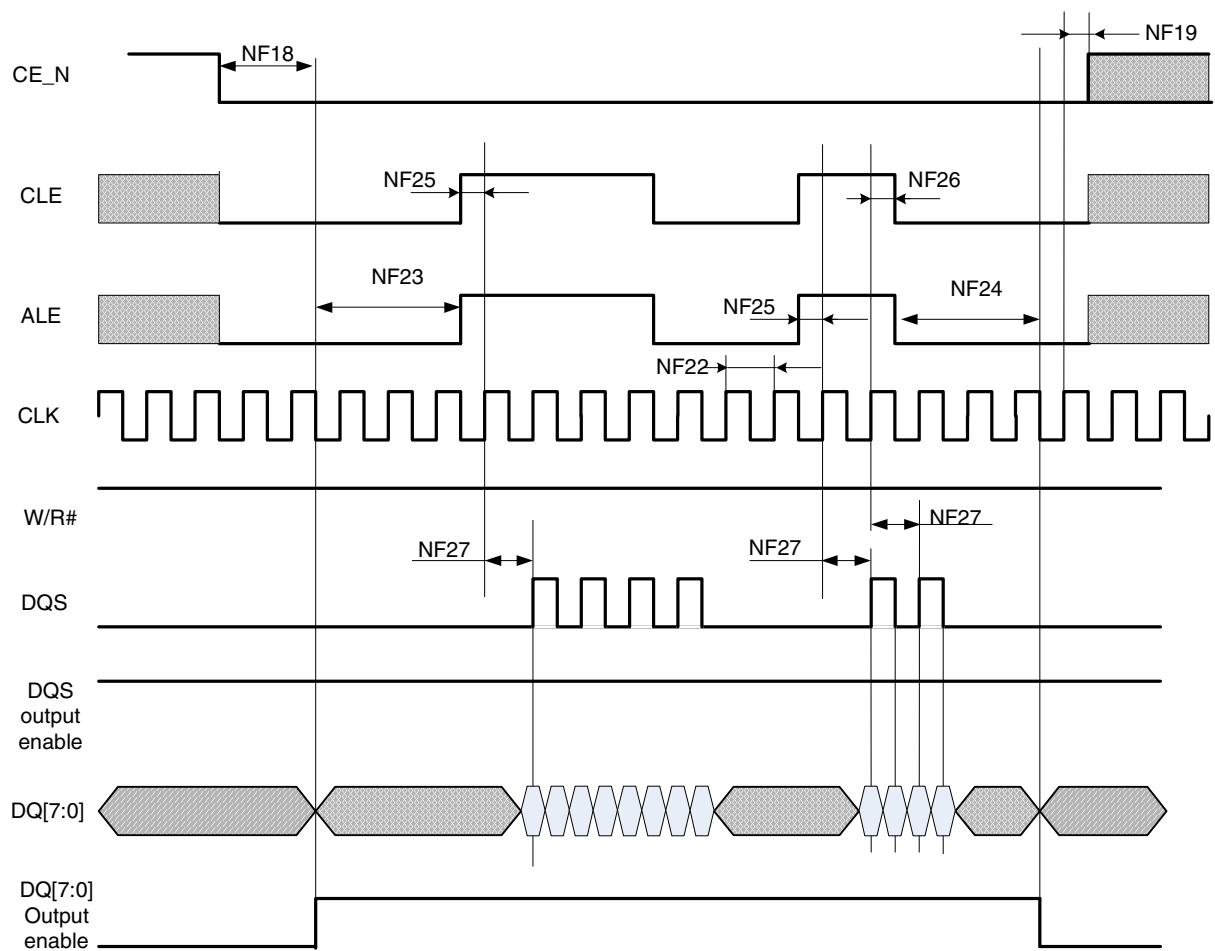
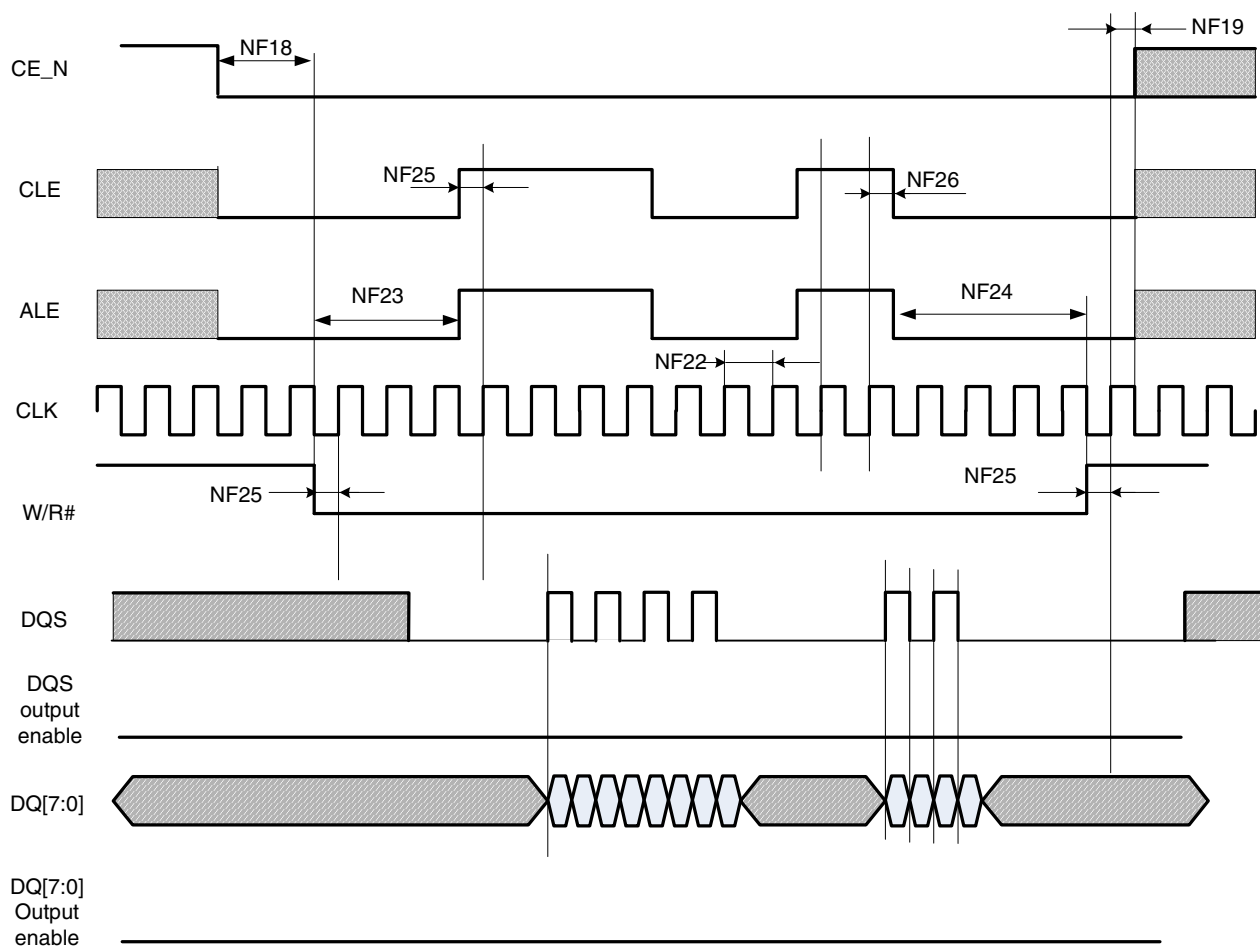


Figure 13. Source Synchronous Mode Data Write Timing Diagram



**Figure 14. Source Synchronous Mode Data Read Timing Diagram**

**Table 41. Source Synchronous Mode Timing Parameters<sup>1</sup>**

| ID   | Parameter                     | Symbol    | Timing<br>T = GPMI Clock Cycle |      | Unit |
|------|-------------------------------|-----------|--------------------------------|------|------|
|      |                               |           | Min.                           | Max. |      |
| NF18 | CE# access time               | $t_{CE}$  | $CE\_DELAY \cdot t_{CK}$       | —    | ns   |
| NF19 | CE# hold time                 | $t_{CH}$  | $0.5 \cdot t_{CK}$             | —    | ns   |
| NF20 | Command/address DQ setup time | $t_{CAS}$ | $0.5 \cdot t_{CK}$             | —    | ns   |
| NF21 | Command/address DQ hold time  | $t_{CAH}$ | $0.5 \cdot t_{CK}$             | —    | ns   |
| NF22 | clock period                  | $t_{CK}$  | 5                              | —    | ns   |
| NF23 | preamble delay                | $t_{PRE}$ | $PRE\_DELAY \cdot t_{CK}$      | —    | ns   |

Table 41. Source Synchronous Mode Timing Parameters<sup>1</sup> (continued)

| ID   | Parameter                                   | Symbol     | Timing<br>T = GPMI Clock Cycle |      | Unit |
|------|---------------------------------------------|------------|--------------------------------|------|------|
|      |                                             |            | Min.                           | Max. |      |
| NF24 | postamble delay                             | $t_{POST}$ | $POST\_DELAY \cdot t_{CK}$     | —    | ns   |
| NF25 | CLE and ALE setup time                      | $t_{CALS}$ | $0.5 \cdot t_{CK}$             | —    | ns   |
| NF26 | CLE and ALE hold time                       | $t_{CALH}$ | $0.5 \cdot t_{CK}$             | —    | ns   |
| NF27 | Data input to first DQS latching transition | $t_{DQSS}$ | $t_{CK}$                       | —    | ns   |

<sup>1</sup> GPMI's sync mode output timing could be controlled by module's internal register, say HW\_GPMI\_TIMING2\_CE\_DELAY, HW\_GPMI\_TIMING\_PREAMBLE\_DELAY, and HW\_GPMI\_TIMING2\_POST\_DELAY. This AC timing depends on these registers' setting. In the above table, we use CE\_DELAY/PRE\_DELAY/POST\_DELAY representing these settings each.

### 4.6.5.3 Samsung Toggle Mode AC Timing

#### 4.6.5.3.1 Command and Address Timing

**NOTE**

Samsung Toggle Mode command and address timing is the same as ONFI 1.0 compatible Async mode AC timing. Please refer to the above chapter for details.

4.6.5.3.2 Read and Write Timing

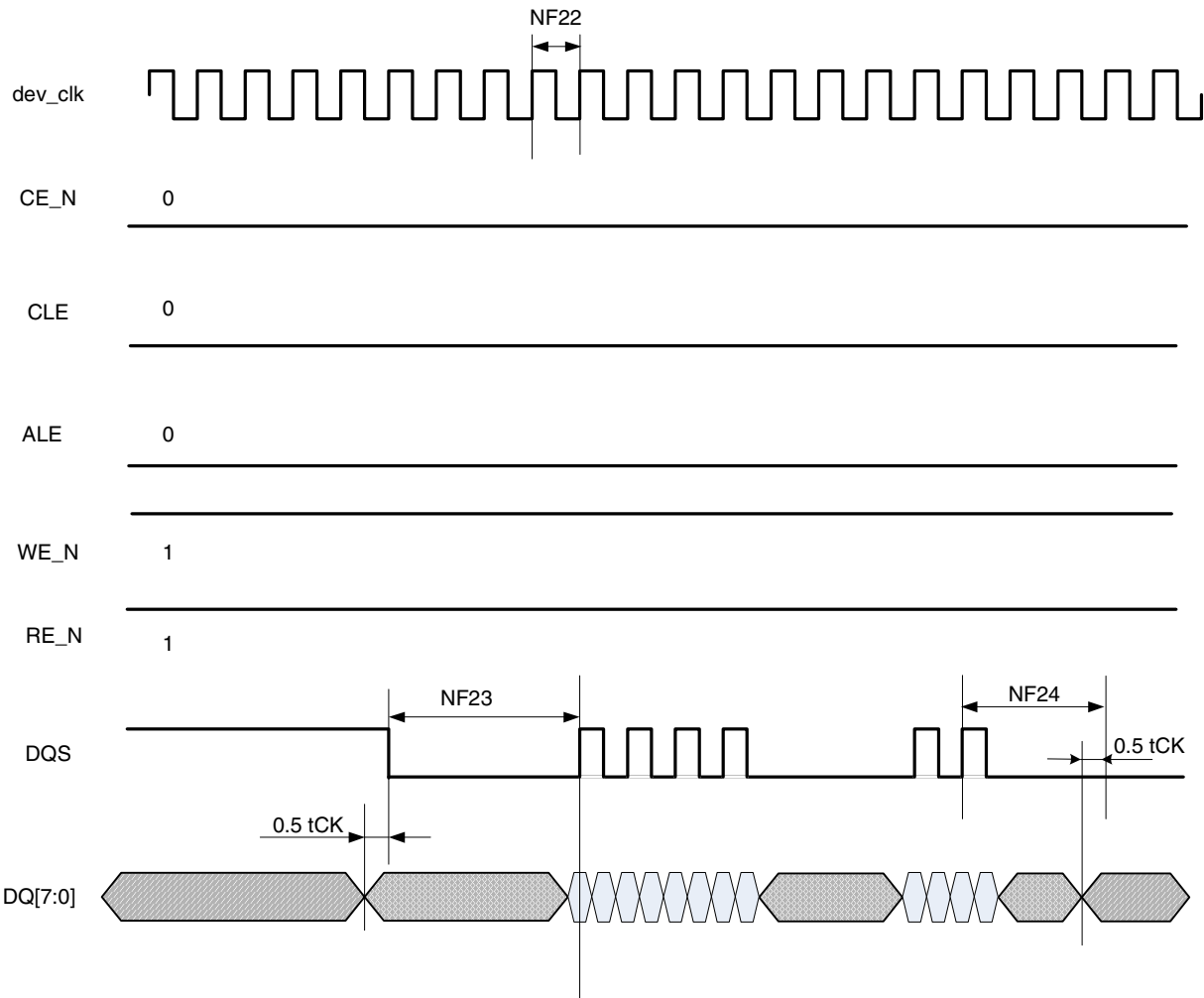


Figure 15. Samsung Toggle Mode Data Write Timing

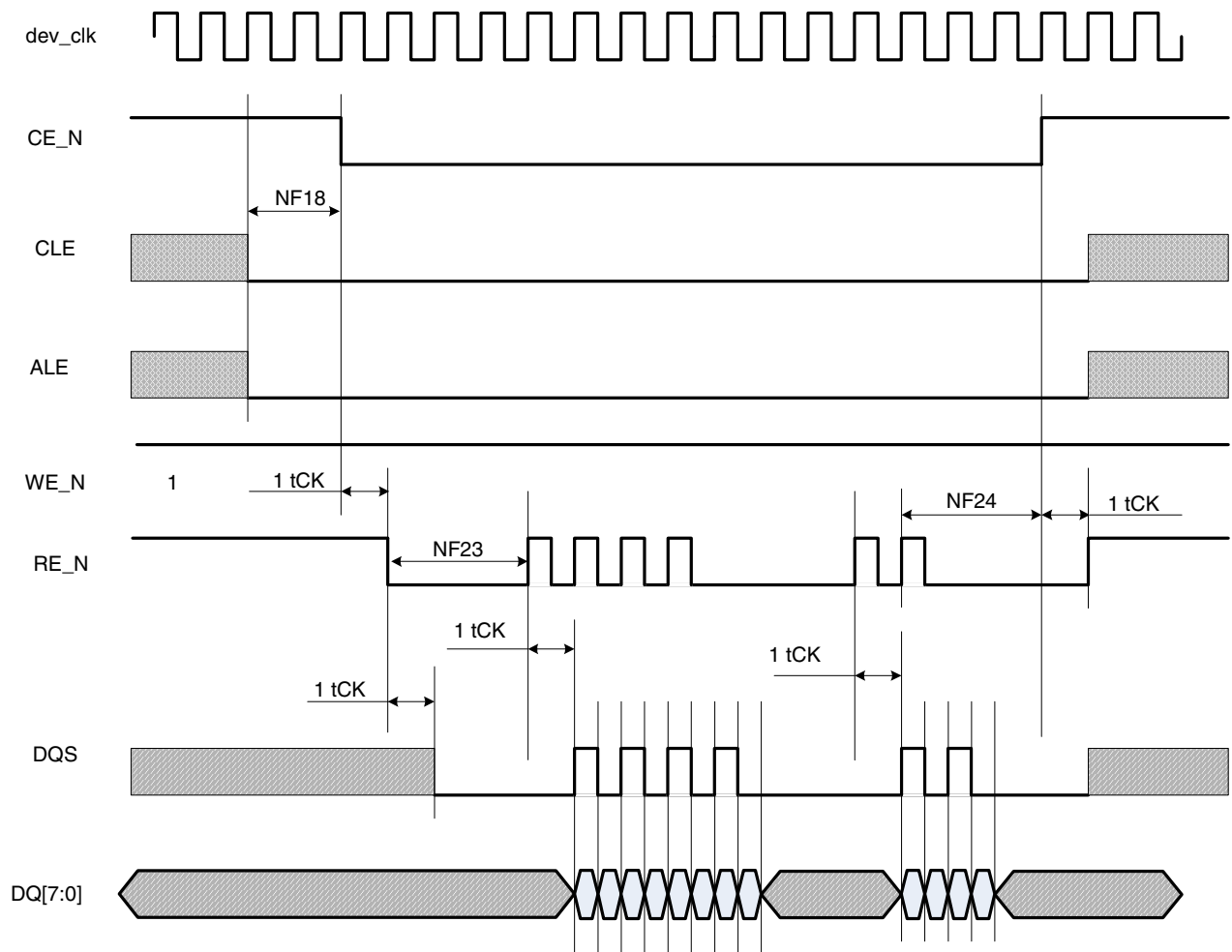


Figure 16. Samsung Toggle Mode Data Read Timing

Table 42. Samsung Toggle Mode Timing Parameters<sup>1</sup>

| ID   | Parameter                     | Symbol    | Timing<br>T = GPMI Clock Cycle |      | Unit |
|------|-------------------------------|-----------|--------------------------------|------|------|
|      |                               |           | Min.                           | Max. |      |
| NF18 | CE# access time               | $t_{CE}$  | $CE\_DELAY * t_{CK}$           | —    | ns   |
| NF19 | CE# hold time                 | $t_{CH}$  | $0.5 * t_{CK}$                 | —    | ns   |
| NF20 | Command/address DQ setup time | $t_{CAS}$ | $0.5 * t_{CK}$                 | —    | ns   |
| NF21 | Command/address DQ hold time  | $t_{CAH}$ | $0.5 * t_{CK}$                 | —    | ns   |
| NF22 | clock period                  | $t_{CK}$  | 7.5                            | —    | ns   |

**Table 42. Samsung Toggle Mode Timing Parameters<sup>1</sup> (continued)**

| ID   | Parameter              | Symbol     | Timing<br>T = GPMI Clock Cycle |      | Unit |
|------|------------------------|------------|--------------------------------|------|------|
|      |                        |            | Min.                           | Max. |      |
| NF23 | preamble delay         | $t_{PRE}$  | $(PRE\_DELAY+1)*t_{CK}$        | —    | ns   |
| NF24 | postamble delay        | $t_{POST}$ | $POST\_DELAY*t_{CK}$           | —    | ns   |
| NF25 | CLE and ALE setup time | $t_{CALS}$ | $0.5*t_{CK}$                   | —    | ns   |
| NF26 | CLE and ALE hold time  | $t_{CALH}$ | $0.5*t_{CK}$                   | —    | ns   |

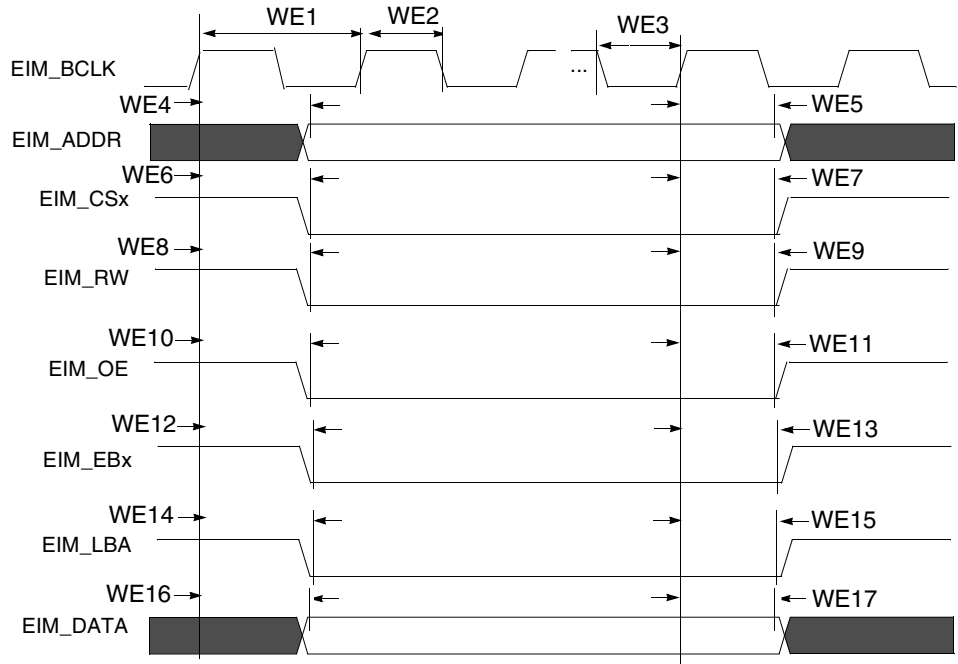
<sup>1</sup> GPMI's sync mode output timing could be controlled by module's internal register, say HW\_GPMI\_TIMING2\_CE\_DELAY, HW\_GPMI\_TIMING\_PREAMBLE\_DELAY, HW\_GPMI\_TIMING2\_POST\_DELAY. This AC timing depends on these registers' setting. In the above table, we use CE\_DELAY/PRE\_DELAY/POST\_DELAY representing these settings each.

## 4.7 External Interface Module (EIM)

The following sections provide information on the EIM.

### 4.7.1 General EIM Timing

Figure 17, Figure 18, and Table 43 specify the timings related to the EIM module. All EIM output control signals may be asserted and de-asserted by an internal clock synchronized to the EIM\_BCLK rising edge according to corresponding assertion/negation control fields.



**Figure 17. EIM Outputs Timing Diagram**

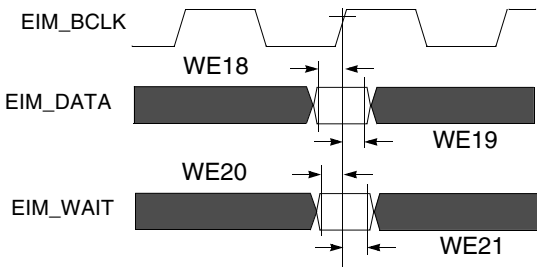


Figure 18. EIM Inputs Timing Diagram

**Table 43. EIM Bus Timing Parameters <sup>1</sup>**

| ID   | Parameter                                | BCD = 0     |             | BCD = 1  |          | BCD = 2   |           | BCD = 3   |           |
|------|------------------------------------------|-------------|-------------|----------|----------|-----------|-----------|-----------|-----------|
|      |                                          | Min         | Max         | Min      | Max      | Min       | Max       | Min       | Max       |
| WE1  | EIM_BCLK Cycle time <sup>2</sup>         | t           | —           | 2t       | —        | 3t        | —         | 4t        | —         |
| WE2  | EIM_BCLK Low Level Width                 | 0.4t        | —           | 0.8t     | —        | 1.2t      | —         | 1.6t      | —         |
| WE3  | EIM_BCLK High Level Width                | 0.4t        | —           | 0.8t     | —        | 1.2t      | —         | 1.6t      | —         |
| WE4  | Clock rise to address valid <sup>3</sup> | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE5  | Clock rise to address invalid            | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE6  | Clock rise to EIM_CSx valid              | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE7  | Clock rise to EIM_CSx invalid            | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE8  | Clock rise to EIM_RW valid               | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE9  | Clock rise to EIM_RW invalid             | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE10 | Clock rise to EIM_OE valid               | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE11 | Clock rise to EIM_OE invalid             | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE12 | Clock rise to EIM_EBx valid              | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE13 | Clock rise to EIM_EBx invalid            | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE14 | Clock rise to EIM_LBA valid              | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE15 | Clock rise to EIM_LBA invalid            | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 3t – 1.25 | 3t + 1.75 |
| WE16 | Clock rise to Output Data valid          | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 2t – 1.25 | 2t + 1.75 |
| WE17 | Clock rise to Output Data Invalid        | 0.5t – 1.25 | 0.5t + 1.75 | t – 1.25 | t + 1.75 | 2t – 1.25 | 2t + 1.75 | 2t – 1.25 | 2t + 1.75 |
| WE18 | Input Data setup time to Clock rise      | 2           | —           | 2        | —        | 2         | —         | 2         | —         |
| WE19 | Input Data hold time from Clock rise     | 2.5         | —           | 2.5      | —        | 2.5       | —         | 2.5       | —         |
| WE20 | EIM_WAIT setup time to Clock rise        | 2           | —           | 2        | —        | 2         | —         | 2         | —         |
| WE21 | EIM_WAIT hold time from Clock rise       | 2.5         | —           | 2.5      | —        | 2.5       | —         | 2.5       | —         |

<sup>1</sup> t is axi\_clk cycle time. The maximum allowed axi\_clk frequency is 133 MHz, whereas the maximum allowed EIM\_BCLK frequency is 66.5 MHz. As a result, if BCD = 0, axi\_clk must be ≤ 66.5 MHz. If BCD = 1, then 133 MHz is allowed for axi\_clk, resulting in a EIM\_BCLK of 66.5 MHz. When the clock branch to EIM is decreased to 66.5 MHz, other buses are impacted which are clocked from this source. See the CCM chapter of the *MCIMX50 Applications Processor Reference Manual* (MCIMX50RM) for a detailed clock tree description.

- <sup>2</sup> EIM\_BCLK parameters are being measured from the 50% point that is, high is defined as 50% of signal value and low is defined as 50% as signal value.
- <sup>3</sup> For signal measurements *High* is defined as 80% of signal value and *Low* is defined as 20% of signal value.

### 4.7.2 Examples of EIM Accesses

Figure 19, Figure 20, Figure 21, Figure 22, Figure 23, and Figure 24 give a few examples of basic EIM accesses to external memory devices with the timing parameters mentioned previously for specific control parameters settings.

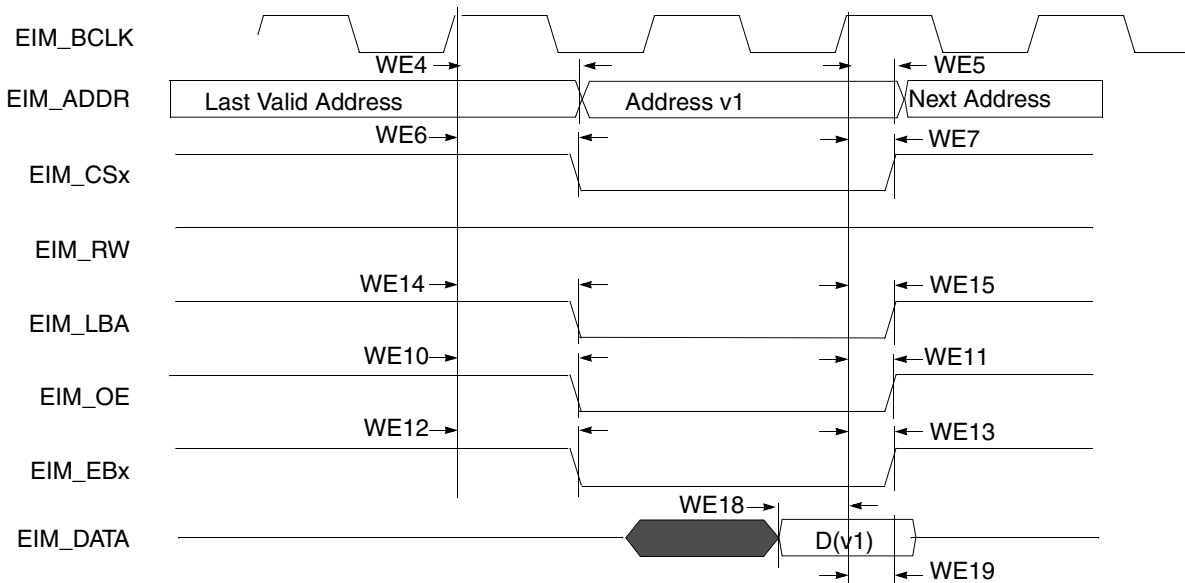


Figure 19. Synchronous Memory Read Access, WSC=1

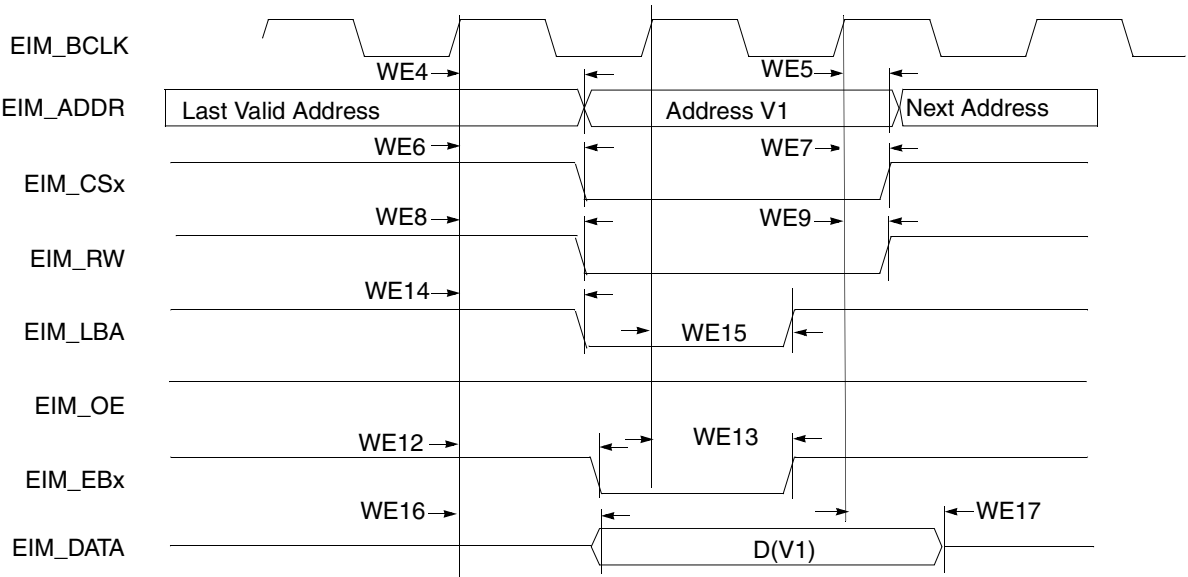


Figure 20. Synchronous Memory, Write Access, WSC=1, WBEA=1, WBEN=1, and WADV=0

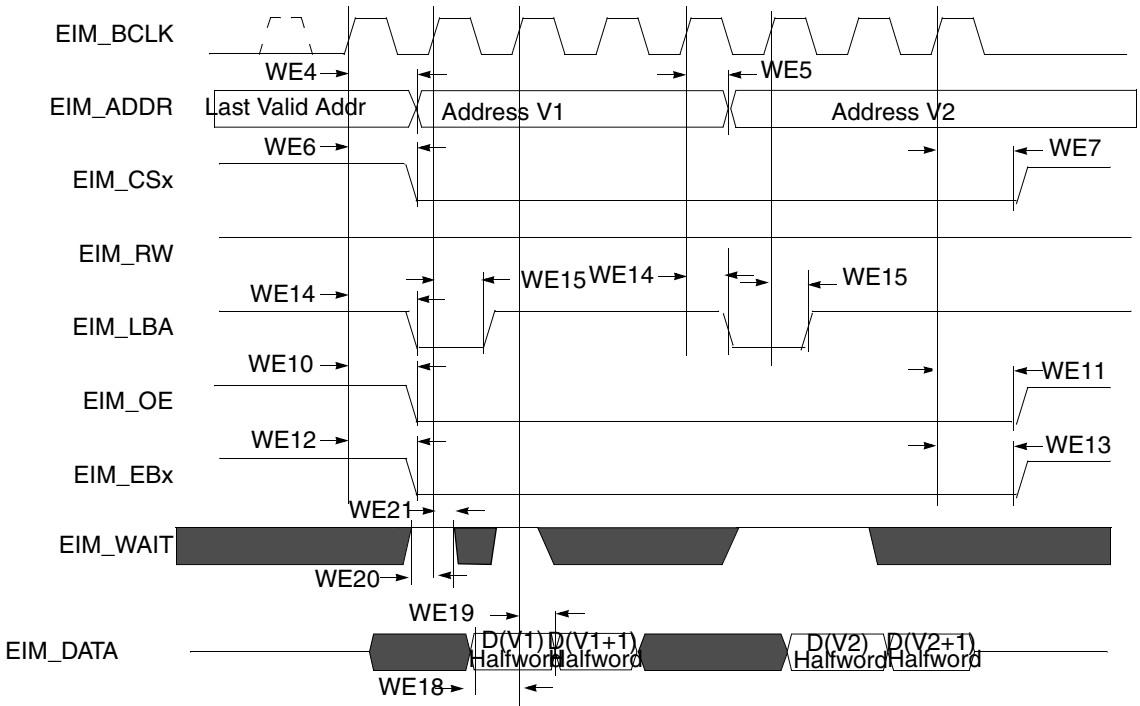
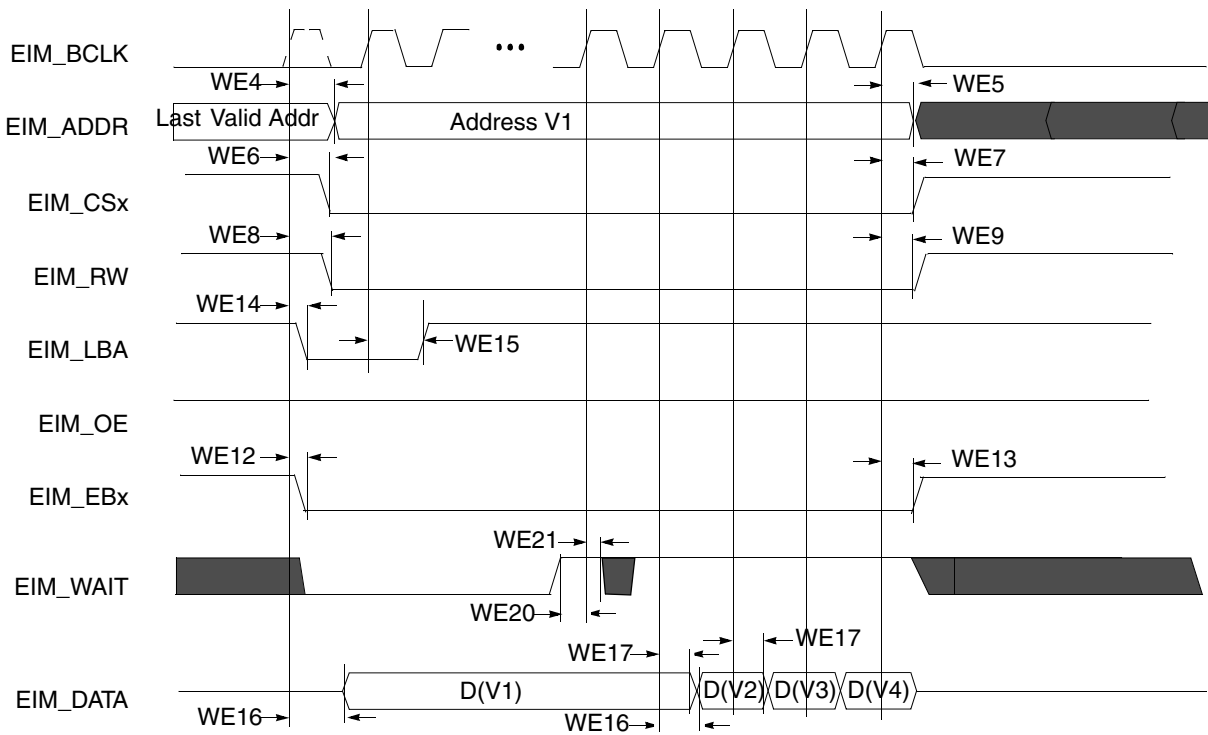
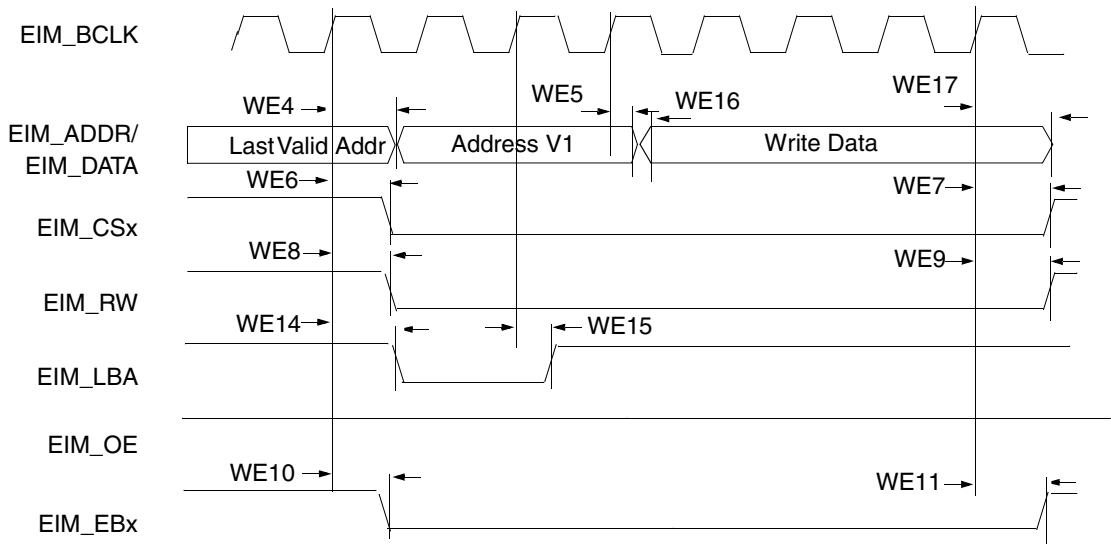


Figure 21. Synchronous 16-Bit Memory, Two Non-Sequential 32-Bit Read Accesses, WSC=2, SRD=1, BCD=0



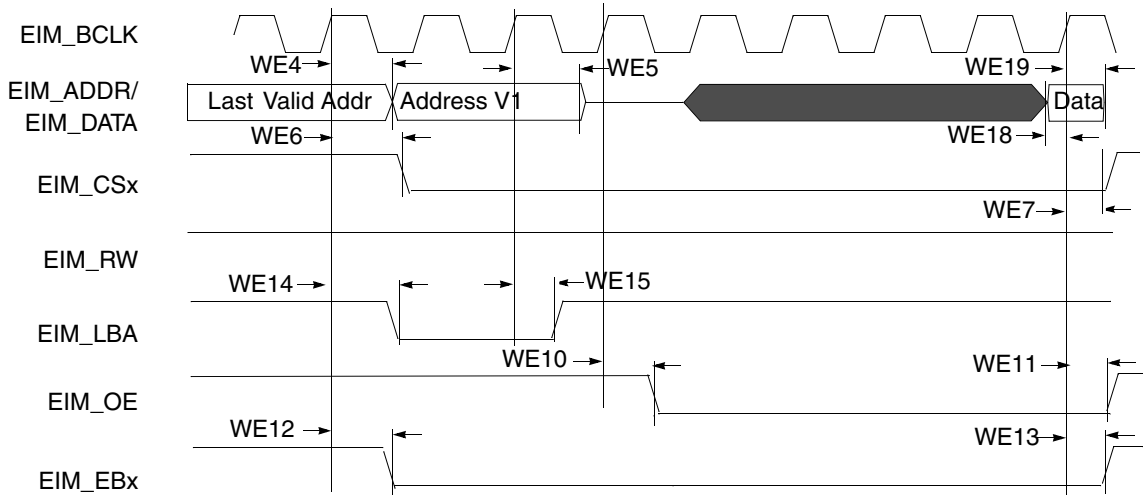
**Figure 22. Synchronous Memory, Burst Write, BCS=1, WSC=4, SRD=1, and BCD=0**



**Figure 23. Muxed Address/Data (A/D) Mode, Synchronous Write Access, WSC=6, ADVA=1, ADVN=1, and ADH=1**

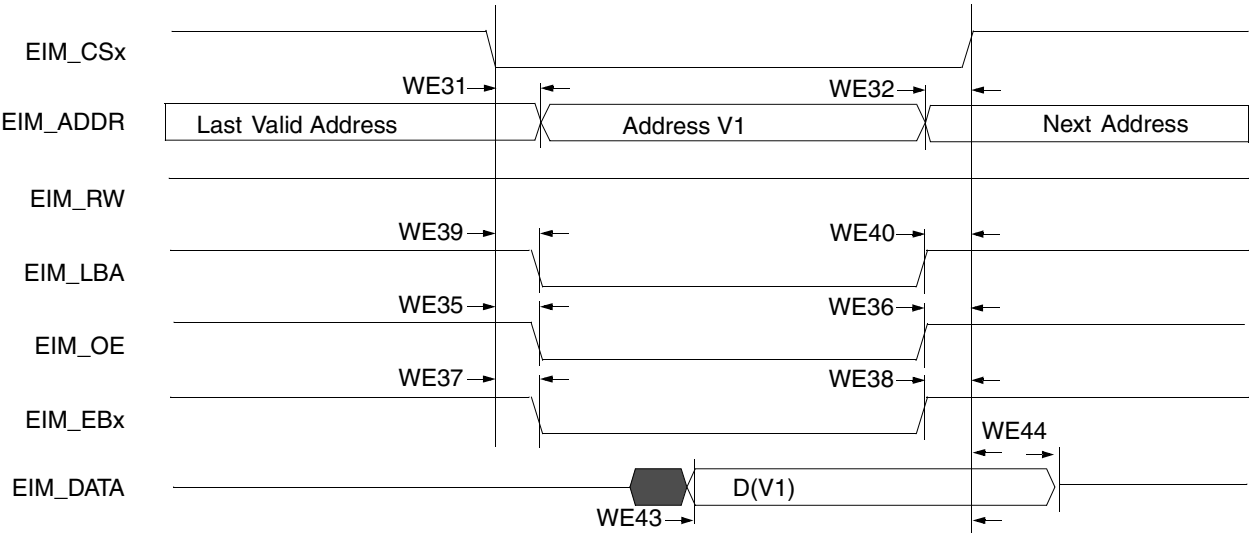
**NOTE**

In 32-bit muxed address/data (A/D) mode, the 16 MSBs are driven on the data bus.



**Figure 24. 16-Bit Muxed A/D Mode, Synchronous Read Access, WSC=7, RADVN=1, ADH=1, OEA=2**

Figure 25, Figure 26, Figure 27, and Table 44 help to determine timing parameters relative to the chip select (CS) state for asynchronous and DTACK EIM accesses with corresponding EIM bit fields and the timing parameters mentioned above.



**Figure 25. Asynchronous Memory Read Access**

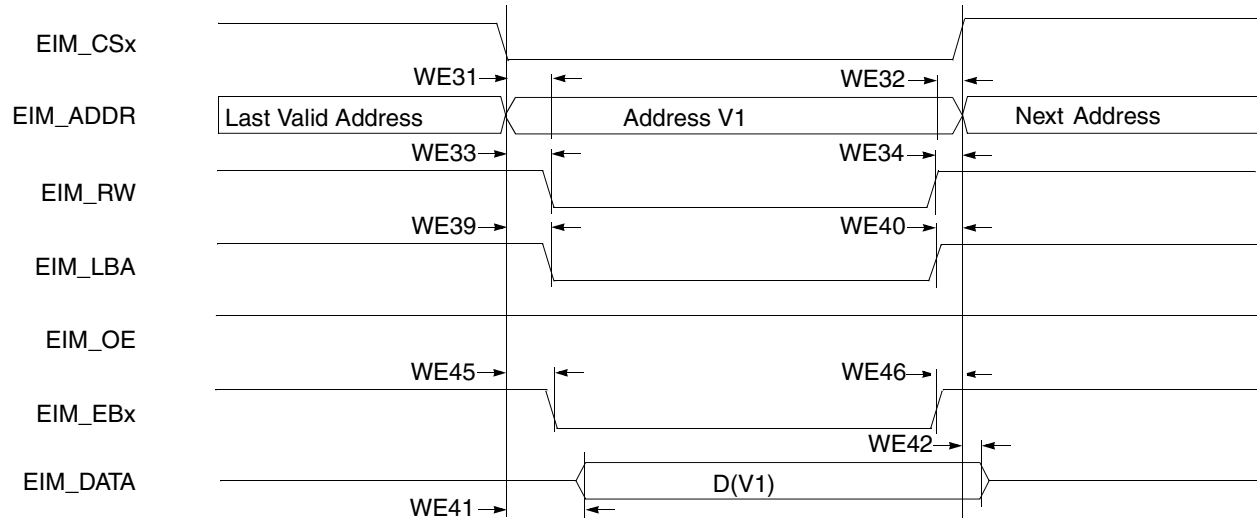


Figure 26. Asynchronous Memory Write Access

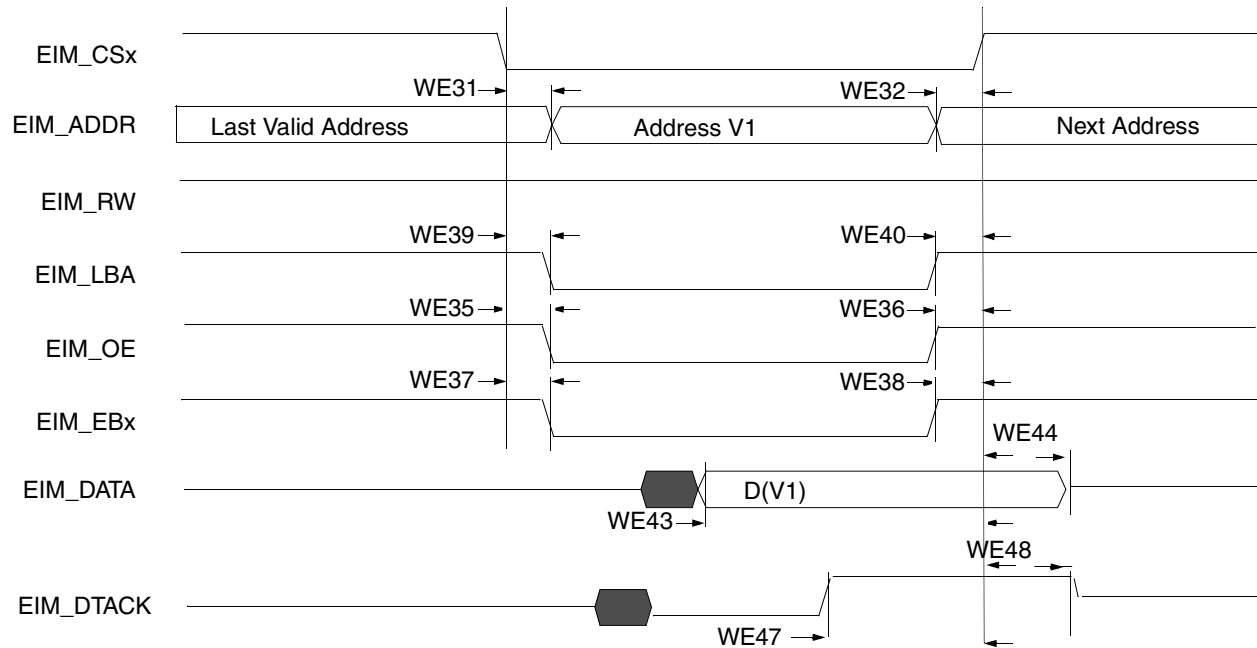


Figure 27. DTACK Read Access

Table 44. EIM Asynchronous Timing Parameters Table Relative Chip Select

| ID   | Parameter                          | Determination by Synchronous Measured Parameters <sup>1</sup> | Min | Max               | Unit |
|------|------------------------------------|---------------------------------------------------------------|-----|-------------------|------|
| WE31 | EIM_CSx valid to Address valid     | $WE4 - WE6 - CSA^2$                                           | —   | $3 - CSA$         | ns   |
| WE32 | Address invalid to EIM_CSx invalid | $WE7 - WE5 - CSN^3$                                           | —   | $3 - CSN$         | ns   |
| WE33 | EIM_CSx valid to EIM_RW valid      | $WE8 - WE6 + (WEA - CSA)$                                     | —   | $3 + (WEA - CSA)$ | ns   |

Table 44. EIM Asynchronous Timing Parameters Table Relative Chip Select (continued)

| ID   | Parameter                                              | Determination by Synchronous Measured Parameters <sup>1</sup> | Min                                      | Max                           | Unit |
|------|--------------------------------------------------------|---------------------------------------------------------------|------------------------------------------|-------------------------------|------|
| WE34 | EIM_RW invalid to EIM_CSx invalid                      | WE7 – WE9 + (WEN – CSN)                                       | —                                        | 3 – (WEN_CSN)                 | ns   |
| WE35 | EIM_CSx valid to EIM_OE valid                          | WE10 – WE6 + (OEA – CSA)                                      | —                                        | 3 + (OEA – CSA)               | ns   |
| WE36 | EIM_OE invalid to EIM_CSx invalid                      | WE7 – WE11 + (OEN – CSN)                                      | —                                        | 3 – (OEN – CSN)               | ns   |
| WE37 | EIM_CSx valid to EIM_EBx valid (Read access)           | WE12 – WE6 + (RBEA – CSA)                                     | —                                        | 3 + (RBEA <sup>4</sup> – CSA) | ns   |
| WE38 | EIM_EBx invalid to EIM_CSx invalid (Read access)       | WE7 – WE13 + (RBEN – CSN)                                     | —                                        | 3 – (RBEN <sup>5</sup> – CSN) | ns   |
| WE39 | EIM_CSx valid to EIM_LBA valid                         | WE14 – WE6 + (ADV – CSA)                                      | —                                        | 3 + (ADVA – CSA)              | ns   |
| WE40 | EIM_LBA invalid to EIM_CSx invalid (ADV_L is asserted) | WE7 – WE15 – CSN                                              | —                                        | 3 – CSN                       | ns   |
| WE41 | EIM_CSx valid to Output Data valid                     | WE16 – WE6 – WCSA                                             | —                                        | 3 – WCSA                      | ns   |
| WE42 | Output Data invalid to EIM_CSx invalid                 | WE17 – WE7 – CSN                                              | —                                        | 3 – CSN                       | ns   |
| WE43 | Input Data valid to EIM_CSx invalid                    | MAXCO + MAXDI                                                 | MAXCO <sup>6</sup> + MAXDI <sup>7</sup>  | —                             | ns   |
| WE44 | EIM_CSx invalid to Input Data invalid                  | 0                                                             | 0                                        | —                             | ns   |
| WE45 | EIM_CSx valid to EIM_EBx valid (Write access)          | WE12 – WE6 + (WBEA – CSA)                                     | —                                        | 3 + (WBEA – CSA)              | ns   |
| WE46 | EIM_EBx invalid to EIM_CSx invalid (Write access)      | WE7 – WE13 + (WBEN – CSN)                                     | —                                        | –3 + (WBEN – CSN)             | ns   |
| WE47 | EIM_DTACK valid to EIM_CSx invalid                     | MAXCO + MAXDTI                                                | MAXCO <sup>6</sup> + MAXDTI <sup>8</sup> | —                             | ns   |
| WE48 | EIM_CSx invalid to EIM_DTACK invalid                   | 0                                                             | 0                                        | —                             | ns   |

<sup>1</sup> Parameters WE4–WE21 value, see in the Table 44.

<sup>2</sup> EIM\_CSx Assertion. This bit field determines when EIM\_CSx signal is asserted during read/write cycles.

<sup>3</sup> EIM\_CSx Negation. This bit field determines when EIM\_CSx signal is negated during read/write cycles.

<sup>4</sup> EIM\_EBx Assertion. This bit field determines when EIM\_EBx signal is asserted during read cycles.

<sup>5</sup> EIM\_EBx Negation. This bit field determines when EIM\_EBx signal is negated during read cycles.

<sup>6</sup> Output maximum delay from internal driving the FFs to chip outputs. The maximum delay between all memory controls (EIM\_ADDR, EIM\_CSx, EIM\_OE, EIM\_RW, EIM\_EBx, and EIM\_LBA).

<sup>7</sup> Maximum delay from chip input data to internal FFs. The maximum delay between all data input pins.

<sup>8</sup> DTACK maximum delay from chip input data to internal FF.

## 4.8 DRAM Timing Parameters

This section includes descriptions of the electrical specifications of DRAM MC module which interfaces external DDR2, LPDDR1, and LPDDR2 memory devices.

### 4.8.1 DRAM Command & Address Output Timing—DDR2 and LPDDR1

The following diagrams and tables specify the timings related to the address and command pins, which interfaces DDR2 and LPDDR1 memory devices.

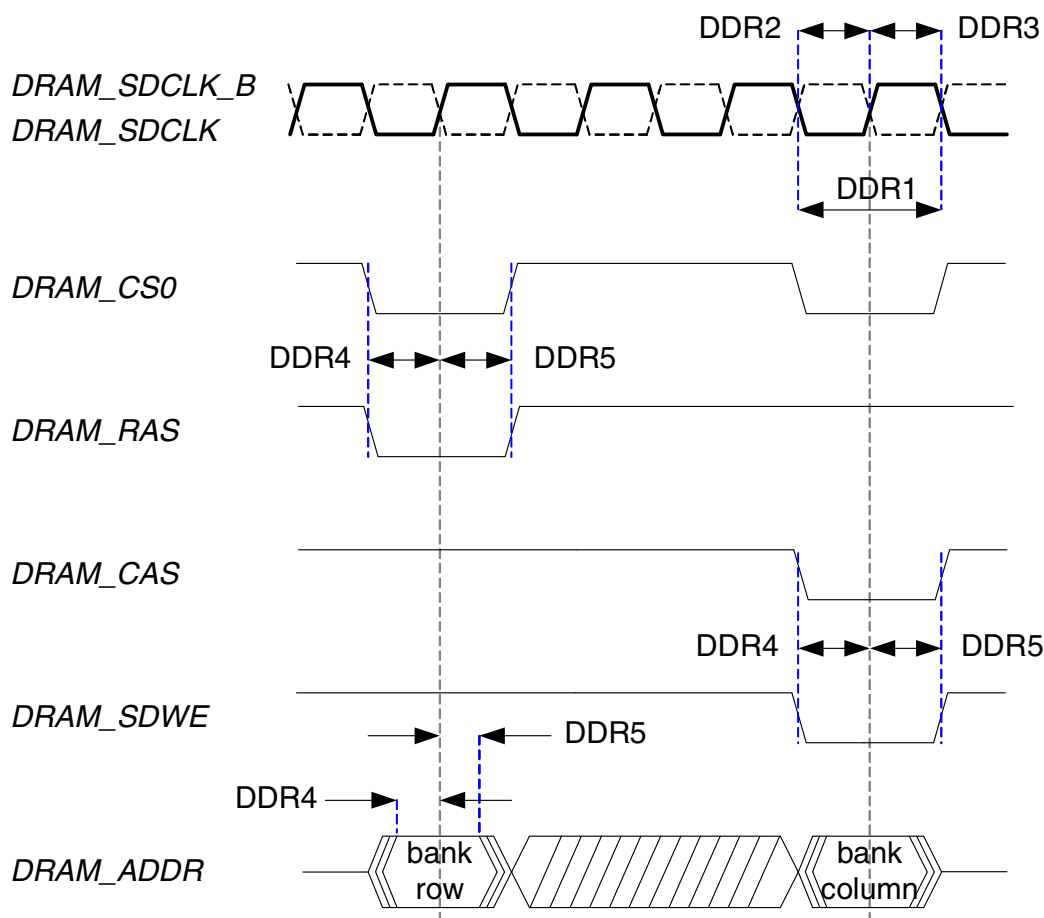


Figure 28. DRAM Command/Address Output Timing—DDR2 and LPDDR1

Table 45. EMI Command/Address AC Timing

| ID   | Description                           | Symbol | Min              | Max      | Unit |
|------|---------------------------------------|--------|------------------|----------|------|
| DDR1 | CK cycle time                         | tCK    | 3.75             | —        | ns   |
| DDR2 | CK high level width                   | tCH    | 0.48 tCK         | 0.52 tCK | ns   |
| DDR3 | CK low level width                    | tCL    | 0.48 tCK         | 0.52 tCK | ns   |
| DDR4 | Address and control output setup time | tIS    | 0.5 tCK<br>- 0.3 | —        | ns   |
| DDR5 | Address and control output hold time  | tIH    | 0.5 tCK<br>- 0.3 | —        | ns   |

## 4.8.2 DRAM Command and Address Output Timing—LPDDR2

The following diagrams and tables specify the timings related to the address and command pins, which interface LPDDR2 memory devices.

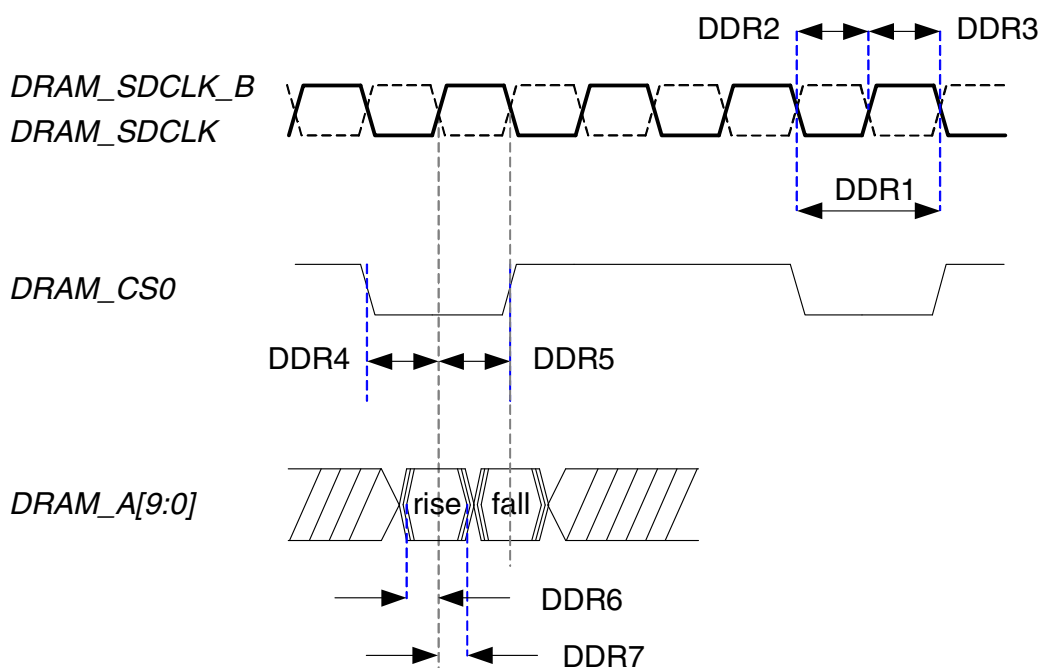


Figure 29. DRAM Command/Address Output Timing—LPDDR2

Table 46. EMI Command/Address AC Timing

| ID                   | Description               | Symbol | Min              | Max      | Unit |
|----------------------|---------------------------|--------|------------------|----------|------|
| DDR1                 | CK cycle time             | tCK    | 3.75             | —        | ns   |
| DDR2                 | CK high level width       | tCH    | 0.48 tCK         | 0.52 tCK | ns   |
| DDR3                 | CK low level width        | tCL    | 0.48 tCK         | 0.52 tCK | ns   |
| DDR4                 | Control output setup time | tIS    | 0.5 tCK<br>- 0.3 | —        | ns   |
| DDR5                 | Control output hold time  | tIH    | 0.5 tCK<br>- 0.3 | —        | ns   |
| DDR6<br>CK ≥ 200 MHz | Address output setup time | tIS    | 0.5 tCK<br>- 1.3 | —        | ns   |
| DDR7<br>CK ≥ 200 MHz | Address output hold time  | tIH    | 0.5 tCK<br>- 1.3 | —        | ns   |
| DDR6<br>CK < 200 MHz | Address output setup time | tIS    | 1                | —        | ns   |
| DDR7<br>CK < 200 MHz | Address output hold time  | tIH    | 1                | —        | ns   |

### NOTE

DDR6 and DDR7 can be adjusted by the parameter -DLL\_WR\_DELAY-;

The ideal case is that SDCLK is center aligned to the DRAM\_A[9:0] data valid window;

For this table, HW\_DRAM\_PHY23[14:8] (DLL\_WR\_DELAY) = 0x10;

## 4.8.3 DRAM Data Output Timing

The DRAM data output timing is defined for all DDR types: DDR2, LPDDR1, and LPDDR2.

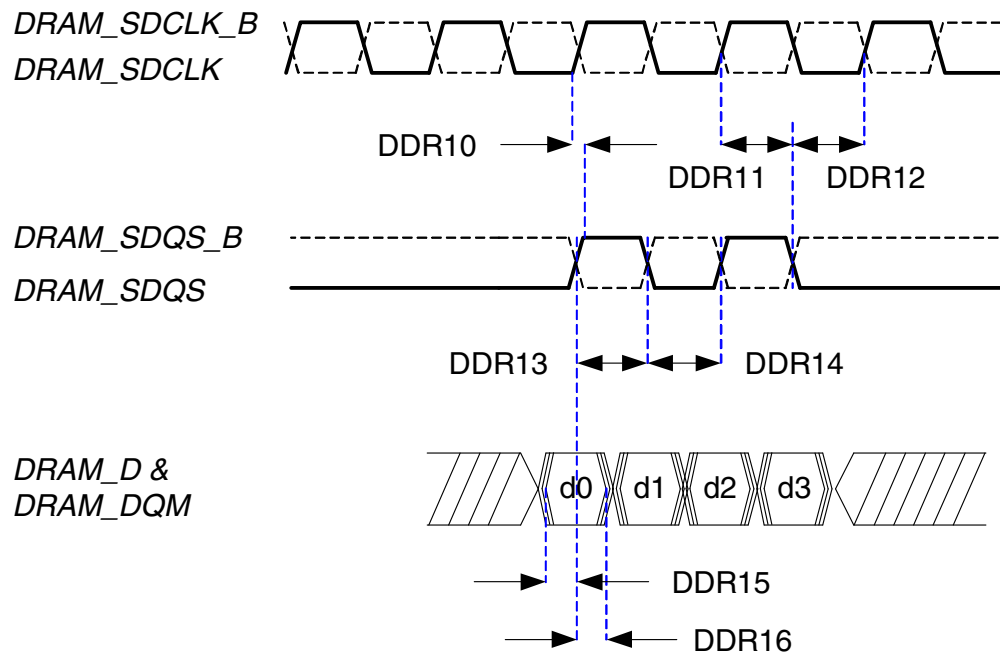


Figure 30. DRAM Data Output Timing

Table 47. DDR Output AC Timing

| ID                    | Description                                      | Symbol | Min              | Max              | Unit |
|-----------------------|--------------------------------------------------|--------|------------------|------------------|------|
| DDR10                 | Positive DQS latching edge to associated CK edge | tDQSS  | -0.3             | 0.3              | ns   |
| DDR11                 | DQS falling edge from CK rising edge—hold time   | tDSH   | 0.5 tCK<br>- 0.3 | 0.5 tCK<br>+ 0.3 | ns   |
| DDR12                 | DQS falling edge to CK rising edge—setup time    | tDSS   | 0.5 tCK<br>- 0.3 | 0.5 tCK<br>+ 0.3 | ns   |
| DDR13                 | DQS output high pulse width                      | tDQSH  | 0.48 tCK         | 0.52 tCK         | ns   |
| DDR14                 | DQS output low pulse width                       | tDQSL  | 0.48 tCK         | 0.52 tCK         | ns   |
| DDR15<br>CK ≥ 200 MHz | DQ & DQM output setup time relative to DQS       | tDS    | 0.5 tCK<br>- 1.3 | —                | ns   |

Table 47. DDR Output AC Timing

| ID                         | Description                                | Symbol | Min              | Max | Unit |
|----------------------------|--------------------------------------------|--------|------------------|-----|------|
| DDR16<br>CK $\geq$ 200 MHz | DQ & DQM output hold time relative to DQS  | tDH    | 0.5 tCK<br>- 1.3 | —   | ns   |
| DDR15<br>CK < 200 MHz      | DQ & DQM output setup time relative to DQS | tDS    | 1                | —   | ns   |
| DDR16<br>CK < 200 MHz      | DQ & DQM output hold time relative to DQS  | tDH    | 1                | —   | ns   |

**NOTE**

The DDR15,16 could be adjusted by the parameter “DLL\_WR\_DELAY”;  
The ideal case is that SDQS is center aligned to the DRAM\_D data valid window;  
For this table, HW\_DRAM\_PHY15[14:8] (DLL\_WR\_DELAY) = 0x10;

### 4.8.4 DRAM Data Input Timing

DRAM Data input timing is defined for all DDR types: DDR2, LPDDR1, and LPDDR2.

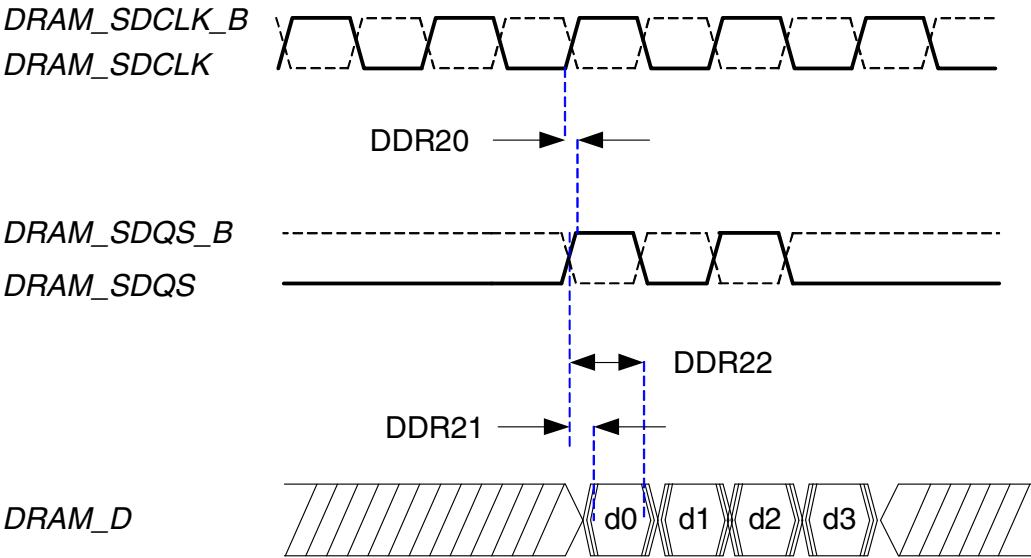


Figure 31. DRAM Data Input Timing

Table 48. DDR2 Input AC Timing

| ID    | Description                                      | Symbol | Min      | Max | Unit |
|-------|--------------------------------------------------|--------|----------|-----|------|
| DDR20 | Positive DQS latching edge to associated CK edge | tDQSCK | -0.5 tCK | —   | ns   |

Table 48. DDR2 Input AC Timing

| ID    | Description               | Symbol | Min               | Max  | Unit |
|-------|---------------------------|--------|-------------------|------|------|
| DDR21 | DQS to DQ input skew      | tDQSQ  | —                 | 0.65 | ns   |
| DDR22 | DQS to DQ input hold time | tQH    | 0.45 tCK<br>-0.85 | —    | ns   |

**NOTE**

The timing parameter DDR20(tDQSCK) is not strictly required by this DRAM MC design.

## 4.9 External Peripheral Interfaces

The following sections provide information on external peripheral interfaces.

### 4.9.1 AUDMUX Timing Parameters

The AUDMUX provides programmable interconnect logic for voice, audio and data routing between internal serial interfaces (SSIs) and external serial interfaces (audio and voice codecs). The AC timing of AUDMUX external pins is hence governed by the SSI module.

### 4.9.2 CSPI and eCSPI Timing Parameters

This section describes the timing parameters of the CSPI and eCSPI modules. The CSPI and eCSPI have separate timing parameters for master and slave modes. The nomenclature used with the CSPI/eCSPI modules and the respective routing of these signals is shown in [Table 49](#).

Table 49. CSPI Nomenclature and Routing

| Module | I/O Access                                              |
|--------|---------------------------------------------------------|
| eCSPI1 | GPIO, KPP, DISP0_DAT, CSI0_DAT, and EIM_D through IOMUX |
| eCSPI2 | DISP0_DAT, CSI0_DAT, and EIM through IOMUX              |
| CSPI   | DISP0_DAT, EIM_A/D, SD1, and SD2 through IOMUX          |

### 4.9.2.1 CSPI Master Mode Timing

Figure 32 depicts the timing of CSPI in master mode and Table 50 lists the CSPI master mode timing characteristics.

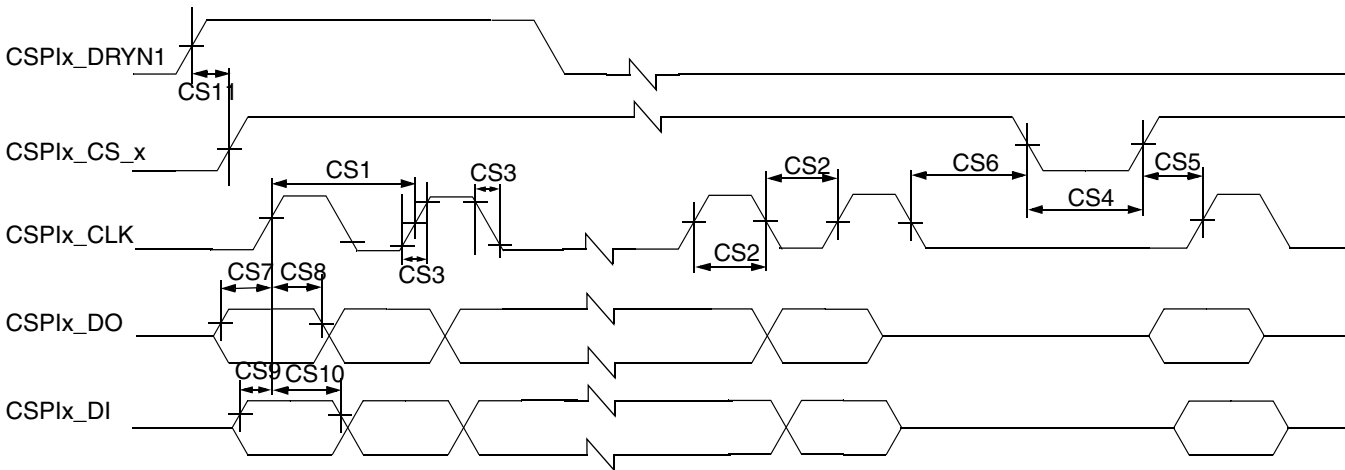


Figure 32. CSPI Master Mode Timing Diagram

Table 50. CSPI Master Mode Timing Parameters

| ID   | Parameter                            | Symbol          | Min | Max | Unit |
|------|--------------------------------------|-----------------|-----|-----|------|
| CS1  | CSPIx_CLK Cycle Time                 | $t_{clk}$       | 60  | —   | ns   |
| CS2  | CSPIx_CLK High or Low Time           | $t_{SW}$        | 6   | —   | ns   |
| CS3  | CSPIx_CLK Rise or Fall               | $t_{RISE/FALL}$ | —   | —   | ns   |
| CS4  | CSPIx_CS_x pulse width               | $t_{CSLH}$      | 15  | —   | ns   |
| CS5  | CSPIx_CS_x Lead Time (CS setup time) | $t_{SCS}$       | 5   | —   | ns   |
| CS6  | CSPIx_CS_x Lag Time (CS hold time)   | $t_{HCS}$       | 5   | —   | ns   |
| CS7  | CSPIx_DO Setup Time                  | $t_{Smosi}$     | 5   | —   | ns   |
| CS8  | CSPIx_DO Hold Time                   | $t_{Hmosi}$     | 5   | —   | ns   |
| CS9  | CSPIx_DI Setup Time                  | $t_{Smiso}$     | 5   | —   | ns   |
| CS10 | CSPIx_DI Hold Time                   | $t_{Hmiso}$     | 5   | —   | ns   |
| CS11 | CSPIx_DRYN Setup Time                | $t_{SDRY}$      | 5   | —   | ns   |

### 4.9.2.2 CSPI Slave Mode Timing

Figure 33 depicts the timing of CSPI in slave mode. Table 51 lists the CSPI slave mode timing characteristics.

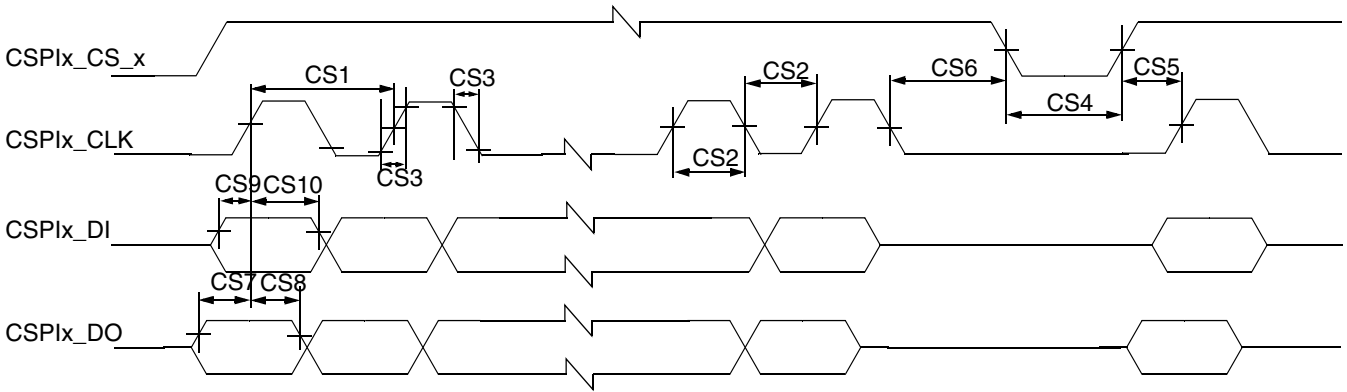


Figure 33. CSPI Slave Mode Timing Diagram

Table 51. CSPI Slave Mode Timing Parameters

| ID   | Parameter                            | Symbol          | Min | Max | Unit |
|------|--------------------------------------|-----------------|-----|-----|------|
| CS1  | CSPIx_CLK Cycle Time                 | $t_{clk}$       | 60  | —   | ns   |
| CS2  | CSPIx_CLK High or Low Time           | $t_{SW}$        | 15  | —   | ns   |
| CS3  | CSPIx_CLK Rise or Fall               | $t_{RISE/FALL}$ | —   | —   | ns   |
| CS4  | CSPIx_CS_x pulse width               | $t_{CSLH}$      | 30  | —   | ns   |
| CS5  | CSPIx_CS_x Lead Time (CS setup time) | $t_{SCS}$       | 5   | —   | ns   |
| CS6  | CSPIx_CS_x Lag Time (CS hold time)   | $t_{HCS}$       | 5   | —   | ns   |
| CS7  | CSPIx_DO Setup Time                  | $t_{Smosi}$     | 5   | —   | ns   |
| CS8  | CSPIx_DO Hold Time                   | $t_{Hmosi}$     | 5   | —   | ns   |
| CS9  | CSPIx_DI Setup Time                  | $t_{Smiso}$     | 5   | —   | ns   |
| CS10 | CSPIx_DI Hold Time                   | $t_{Hmiso}$     | 5   | —   | ns   |

### 4.9.2.3 eCSPI Master Mode Timing

Figure 34 depicts the timing of eCSPI in master mode and Table 52 lists the eCSPI master mode timing characteristics.

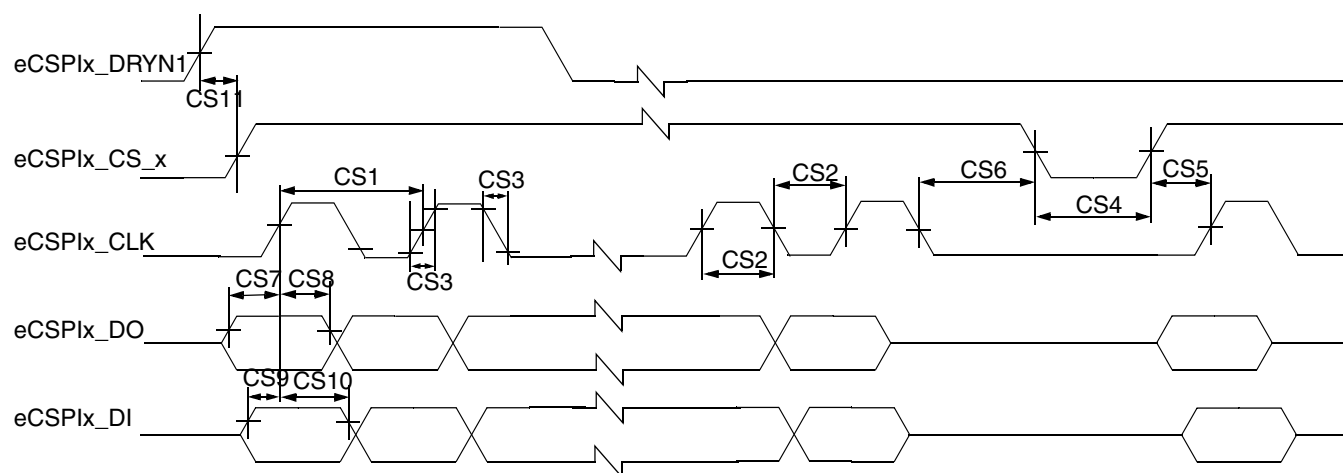


Figure 34. eCSPI Master Mode Timing Diagram

Table 52. eCSPI Master Mode Timing Parameters

| ID   | Parameter                                                 | Symbol          | Min      | Max | Unit |
|------|-----------------------------------------------------------|-----------------|----------|-----|------|
| CS1  | eCSPIx_CLK Cycle Time–Read<br>eCSPIx_CLK Cycle Time–Write | $t_{clk}$       | 60<br>15 | —   | ns   |
| CS2  | eCSPIx_CLK High or Low Time                               | $t_{SW}$        | 6        | —   | ns   |
| CS3  | eCSPIx_CLK Rise or Fall                                   | $t_{RISE/FALL}$ | —        | —   | ns   |
| CS4  | eCSPIx_CS_x pulse width                                   | $t_{CSLH}$      | 15       | —   | ns   |
| CS5  | eCSPIx_CS_x Lead Time (CS setup time)                     | $t_{SCS}$       | 5        | —   | ns   |
| CS6  | eCSPIx_CS_x Lag Time (CS hold time)                       | $t_{HCS}$       | 5        | —   | ns   |
| CS7  | eCSPIx_DO Setup Time                                      | $t_{Smosi}$     | 5        | —   | ns   |
| CS8  | eCSPIx_DO Hold Time                                       | $t_{Hmosi}$     | 5        | —   | ns   |
| CS9  | eCSPIx_DI Setup Time                                      | $t_{Smiso}$     | 5        | —   | ns   |
| CS10 | eCSPIx_DI Hold Time                                       | $t_{Hmiso}$     | 5        | —   | ns   |
| CS11 | eCSPIx_DRYN Setup Time                                    | $t_{SDRY}$      | 5        | —   | ns   |

### 4.9.2.4 eCSPI Slave Mode Timing

Figure 35 depicts the timing of eCSPI in slave mode and Table 53 lists the eCSPI slave mode timing characteristics.

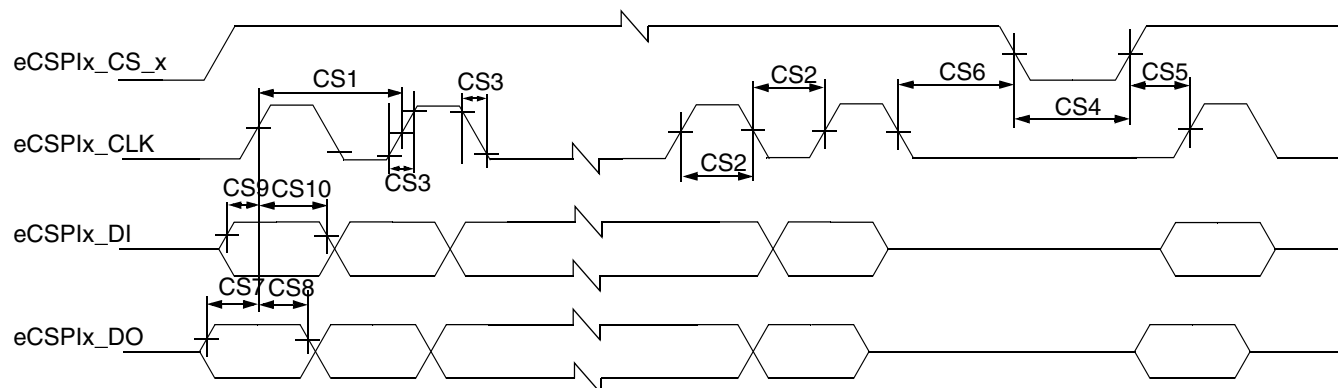


Figure 35. eCSPI Slave Mode Timing Diagram

Table 53. eCSPI Slave Mode Timing Parameters

| ID   | Parameter                                                 | Symbol          | Min      | Max | Unit |
|------|-----------------------------------------------------------|-----------------|----------|-----|------|
| CS1  | eCSPIx_CLK Cycle Time—Read<br>eCSPIx_CLK Cycle Time—Write | $t_{clk}$       | 60<br>15 | —   | ns   |
| CS2  | eCSPIx_CLK High or Low Time                               | $t_{SW}$        | 6        | —   | ns   |
| CS3  | eCSPIx_CLK Rise or Fall                                   | $t_{RISE/FALL}$ | —        | —   | ns   |
| CS4  | eCSPIx_CS_x pulse width                                   | $t_{CSLH}$      | 15       | —   | ns   |
| CS5  | eCSPIx_CS_x Lead Time (CS setup time)                     | $t_{SCS}$       | 5        | —   | ns   |
| CS6  | eCSPIx_CS_x Lag Time (CS hold time)                       | $t_{HCS}$       | 5        | —   | ns   |
| CS7  | eCSPIx_DO Setup Time                                      | $t_{Smosi}$     | 5        | —   | ns   |
| CS8  | eCSPIx_DO Hold Time                                       | $t_{Hmosi}$     | 5        | —   | ns   |
| CS9  | eCSPIx_DI Setup Time                                      | $t_{Smiso}$     | 5        | —   | ns   |
| CS10 | eCSPIx_DI Hold Time                                       | $t_{Hmiso}$     | 5        | —   | ns   |

## 4.9.3 Enhanced Secured Digital Host Controller (eSDHCv2/v3) and uSDHC AC Timing

This section describes the electrical information of the eSDHCv2/v3 and the uSDHC, which includes SD/eMMC4.3 (Single Data Rate) timing and eMMC4.4 (Dual Data Rate) timing.

### 4.9.3.1 SD/eMMC4.3 (Single Data Rate) eSDHCv3 and uSDHC AC Timing

Figure 36 depicts the timing of SD/eMMC4.3, and Table 54 lists the SD/eMMC4.3 timing characteristics.

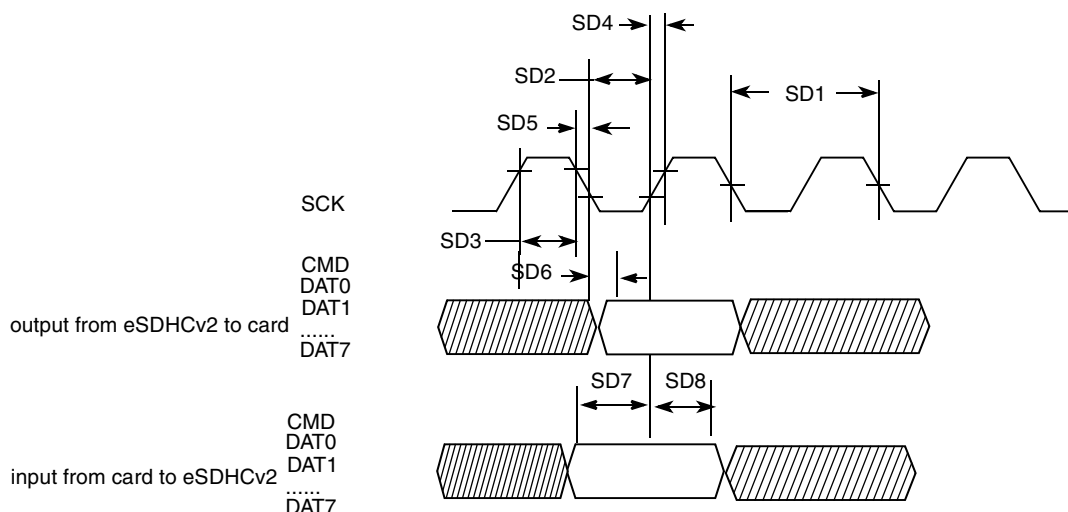


Figure 36. SD/eMMC4.3 Timing

Table 54. SD/eMMC4.3 Interface Timing Specification

| ID                      | Parameter                                       | Symbols    | Min | Max   | Unit |
|-------------------------|-------------------------------------------------|------------|-----|-------|------|
| <b>Card Input Clock</b> |                                                 |            |     |       |      |
| SD1                     | Clock Frequency (Low Speed)                     | $f_{PP}^1$ | 0   | 400   | kHz  |
|                         | Clock Frequency (SD/SDIO Full Speed/High Speed) | $f_{PP}^2$ | 0   | 25/50 | MHz  |
|                         | Clock Frequency (MMC Full Speed/High Speed)     | $f_{PP}^3$ | 0   | 20/52 | MHz  |
|                         | Clock Frequency (Identification Mode)           | $f_{OD}$   | 100 | 400   | kHz  |
| SD2                     | Clock Low Time                                  | $t_{WL}$   | 7   | —     | ns   |
| SD3                     | Clock High Time                                 | $t_{WH}$   | 7   | —     | ns   |
| SD4                     | Clock Rise Time                                 | $t_{TLH}$  | —   | 3     | ns   |
| SD5                     | Clock Fall Time                                 | $t_{THL}$  | —   | 3     | ns   |

Table 54. SD/eMMC4.3 Interface Timing Specification (continued)

| ID                                                          | Parameter                          | Symbols   | Min | Max | Unit |
|-------------------------------------------------------------|------------------------------------|-----------|-----|-----|------|
| <b>eSDHC Output/Card Inputs CMD, DAT (Reference to CLK)</b> |                                    |           |     |     |      |
| SD6                                                         | eSDHC Output Delay                 | $t_{OD}$  | -2  | 2   | ns   |
| <b>eSDHC Input/Card Outputs CMD, DAT (Reference to CLK)</b> |                                    |           |     |     |      |
| SD7                                                         | eSDHC Input Setup Time             | $t_{ISU}$ | 2.5 | —   | ns   |
| SD8                                                         | eSDHC Input Hold Time <sup>4</sup> | $t_{IH}$  | 2.5 | —   | ns   |

<sup>1</sup> In low speed mode, card clock must be lower than 400 kHz, voltage ranges from 2.7 to 3.6 V.

<sup>2</sup> In normal (full) speed mode for SD/SDIO card, clock frequency can be any value between 0–25 MHz. In high-speed mode, clock frequency can be any value between 0–50 MHz.

<sup>3</sup> In normal (full) speed mode for MMC card, clock frequency can be any value between 0–20 MHz. In high-speed mode, clock frequency can be any value between 0–52 MHz.

<sup>4</sup> To satisfy hold timing, the delay difference between clock input and cmd/data input must not exceed 2 ns.

### 4.9.3.2 eMMC4.4 (Dual Data Rate) eSDHCv3 and uSDHC AC Timing

Figure 37 depicts the timing of eMMC4.4, and Table 55 lists the eMMC4.4 timing characteristics. Be aware that only DAT0-7 is sampled on both edges of clock (not applicable to CMD).

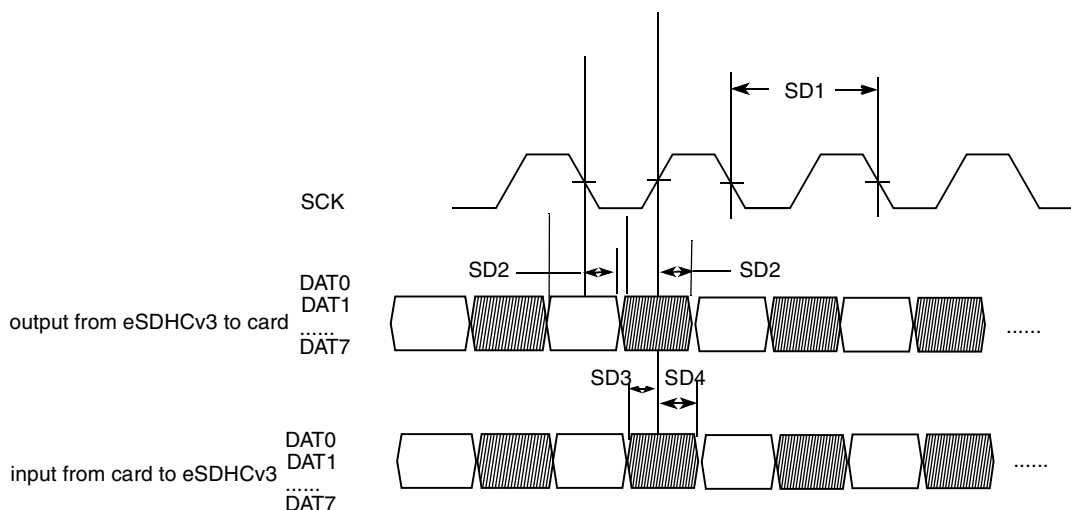


Figure 37. eMMC4.4 Timing

Table 55. eMMC4.4 Interface Timing Specification

| ID                                                          | Parameter                                   | Symbols  | Min | Max | Unit |
|-------------------------------------------------------------|---------------------------------------------|----------|-----|-----|------|
| <b>Card Input Clock</b>                                     |                                             |          |     |     |      |
| SD1                                                         | Clock Frequency (MMC Full Speed/High Speed) | $f_{PP}$ | 0   | 52  | MHz  |
| <b>eSDHC Output/Card Inputs CMD, DAT (Reference to CLK)</b> |                                             |          |     |     |      |

**Table 55. eMMC4.4 Interface Timing Specification (continued)**

| ID                                                          | Parameter              | Symbols   | Min | Max | Unit |
|-------------------------------------------------------------|------------------------|-----------|-----|-----|------|
| SD2                                                         | eSDHC Output Delay     | $t_{OD}$  | -5  | 5   | ns   |
| <b>eSDHC Input/Card Outputs CMD, DAT (Reference to CLK)</b> |                        |           |     |     |      |
| SD3                                                         | eSDHC Input Setup Time | $t_{ISU}$ | 2.5 | —   | ns   |
| SD4                                                         | eSDHC Input Hold Time  | $t_{IH}$  | 1.5 | —   | ns   |

## 4.9.4 FEC AC Timing Parameters

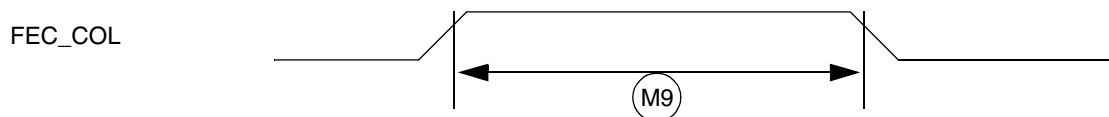
This section describes the AC timing specifications of the FEC. The i.MX50 FEC supports 10/100 Mbps RMII with MII serial management interface. The RMII and serial management signals are compatible with transceivers operating at a voltage of 3.3 V.

### 4.9.4.1 RMII Async Inputs Signal Timing (FEC\_COL)

Table 56 lists RMII asynchronous inputs signal timing information. Figure 38 shows MII asynchronous input timings listed in Table 56.

**Table 56. RMII Async Inputs Signal Timing**

| Num | Characteristics             | Min | Max | Unit              |
|-----|-----------------------------|-----|-----|-------------------|
| M9  | FEC_COL minimum pulse width | 1.5 | —   | FEC_TX_CLK period |



**Figure 38. MII Async Inputs Timing Diagram**

### 4.9.4.2 RMII Serial Management Channel Timing (FEC\_MDIO and FEC\_MDC)

Table 57 lists RMII serial management channel timings. Figure 39 shows RMII serial management channel timings listed in Table 57. The MDC frequency should be equal to or less than 2.5 MHz to be compliant with the IEEE 802.3 RMII specification. However, the FEC can function correctly with a maximum MDC frequency of 15 MHz.

**Table 57. RMII Transmit Signal Timing**

| ID  | Characteristics                                                             | Min | Max | Unit |
|-----|-----------------------------------------------------------------------------|-----|-----|------|
| M10 | FEC_MDC falling edge to FEC_MDIO output invalid (minimum propagation delay) | 0   | —   | ns   |
| M11 | FEC_MDC falling edge to FEC_MDIO output valid (max propagation delay)       | —   | 5   | ns   |
| M12 | FEC_MDIO (input) to FEC_MDC rising edge setup                               | 18  | —   | ns   |
| M13 | FEC_MDIO (input) to FEC_MDC rising edge hold                                | 0   | —   | ns   |

Table 57. RMII Transmit Signal Timing (continued)

| ID  | Characteristics          | Min | Max | Unit           |
|-----|--------------------------|-----|-----|----------------|
| M14 | FEC_MDC pulse width high | 40% | 60% | FEC_MDC period |
| M15 | FEC_MDC pulse width low  | 40% | 60% | FEC_MDC period |

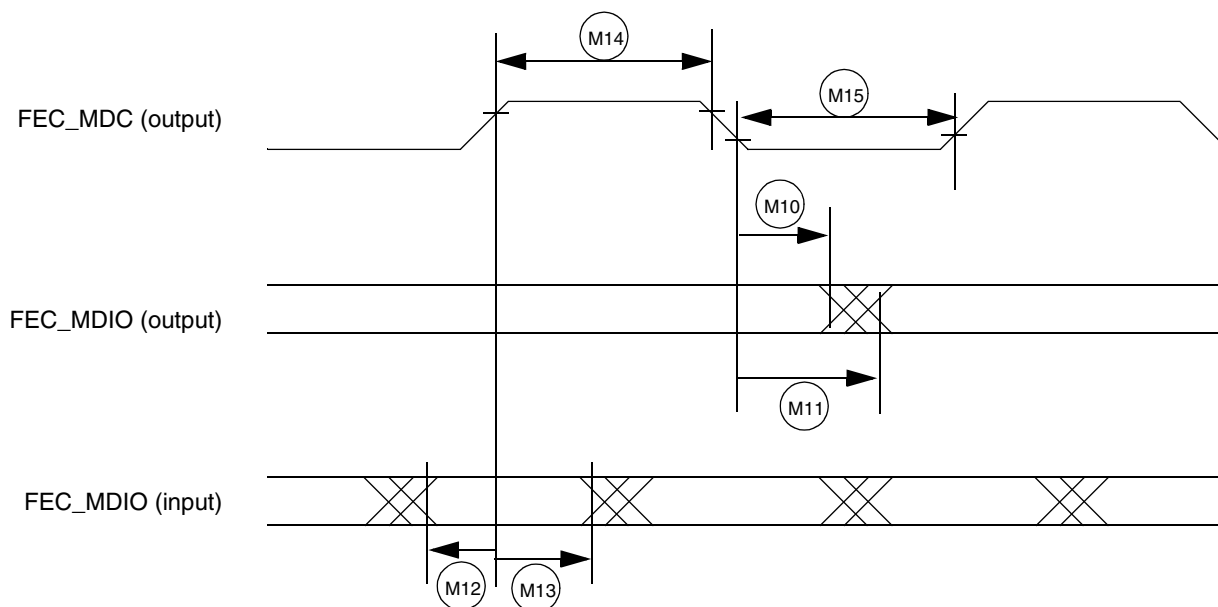


Figure 39. RMII Serial Management Channel Timing Diagram

#### 4.9.4.3 RMII Mode Timing

In RMII mode, FEC\_TX\_CLK is used as the REF\_CLK which is a 50 MHz  $\pm$  50 ppm continuous reference clock. FEC\_RX\_DV is used as the CRS\_DV in RMII, and other signals under RMII mode include FEC\_TX\_EN, FEC\_TXD[1:0], FEC\_RXD[1:0] and optional FEC\_RX\_ER.

The RMII mode timings are shown in Table 58 and Figure 40.

Table 58. RMII Signal Timing

| No. | Characteristics                                             | Min | Max | Unit           |
|-----|-------------------------------------------------------------|-----|-----|----------------|
| M16 | REF_CLK(FEC_TX_CLK) pulse width high                        | 35% | 65% | REF_CLK period |
| M17 | REF_CLK(FEC_TX_CLK) pulse width low                         | 35% | 65% | REF_CLK period |
| M18 | REF_CLK to FEC_TXD[1:0], FEC_TX_EN invalid                  | 2   | —   | ns             |
| M19 | REF_CLK to FEC_TXD[1:0], FEC_TX_EN valid                    | —   | 16  | ns             |
| M20 | FEC_RXD[1:0], CRS_DV(FEC_RX_DV), FEC_RX_ER to REF_CLK setup | 4   | —   | ns             |
| M21 | REF_CLK to FEC_RXD[1:0], FEC_RX_DV, FEC_RX_ER hold          | 2   | —   | ns             |

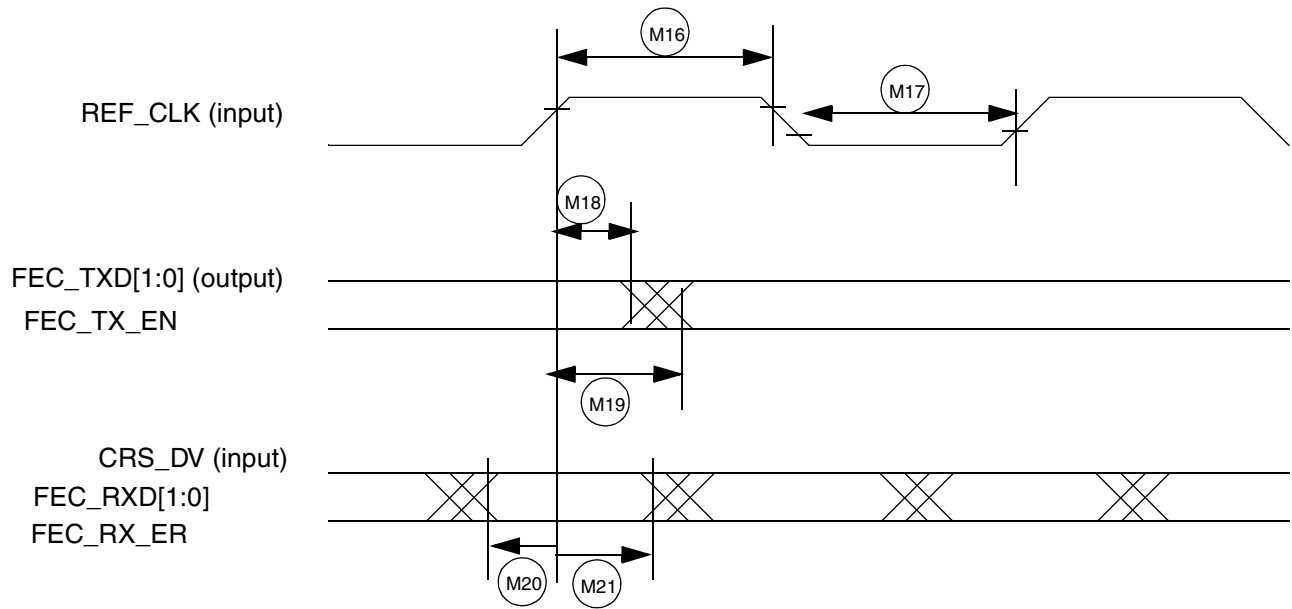


Figure 40. RMII Mode Signal Timing Diagram

### 4.9.5 I<sup>2</sup>C Module Timing Parameters

This section describes the timing parameters of the I<sup>2</sup>C module. Figure 41 depicts the timing of I<sup>2</sup>C module, and Table 59 lists the I<sup>2</sup>C module timing characteristics.

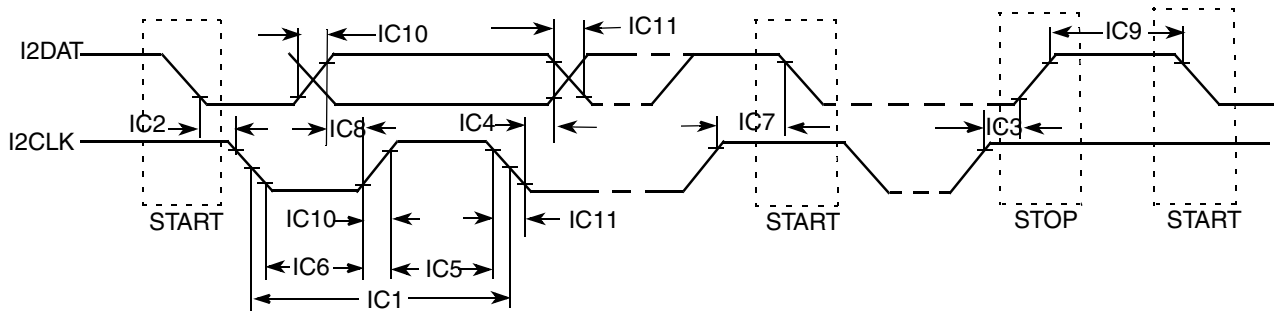


Figure 41. I<sup>2</sup>C Bus Timing

Table 59. I<sup>2</sup>C Module Timing Parameters

| ID  | Parameter                            | Standard Mode<br>Supply Voltage =<br>1.65 V–1.95 V, 2.7 V–3.3 V |     | Fast Mode<br>Supply Voltage =<br>2.7 V–3.3 V |     | Unit |
|-----|--------------------------------------|-----------------------------------------------------------------|-----|----------------------------------------------|-----|------|
|     |                                      | Min                                                             | Max | Min                                          | Max |      |
| IC1 | I2CLK cycle time                     | 10                                                              | —   | 2.5                                          | —   | μs   |
| IC2 | Hold time (repeated) START condition | 4.0                                                             | —   | 0.6                                          | —   | μs   |
| IC3 | Set-up time for STOP condition       | 4.0                                                             | —   | 0.6                                          | —   | μs   |

Table 59. I<sup>2</sup>C Module Timing Parameters (continued)

| ID   | Parameter                                           | Standard Mode<br>Supply Voltage =<br>1.65 V–1.95 V, 2.7 V–3.3 V |                   | Fast Mode<br>Supply Voltage =<br>2.7 V–3.3 V |                  | Unit |
|------|-----------------------------------------------------|-----------------------------------------------------------------|-------------------|----------------------------------------------|------------------|------|
|      |                                                     | Min                                                             | Max               | Min                                          | Max              |      |
| IC4  | Data hold time                                      | 0 <sup>1</sup>                                                  | 3.45 <sup>2</sup> | 0 <sup>1</sup>                               | 0.9 <sup>2</sup> | μs   |
| IC5  | HIGH Period of I2CLK Clock                          | 4.0                                                             | —                 | 0.6                                          | —                | μs   |
| IC6  | LOW Period of the I2CLK Clock                       | 4.7                                                             | —                 | 1.3                                          | —                | μs   |
| IC7  | Set-up time for a repeated START condition          | 4.7                                                             | —                 | 0.6                                          | —                | μs   |
| IC8  | Data set-up time                                    | 250                                                             | —                 | 100 <sup>3</sup>                             | —                | ns   |
| IC9  | Bus free time between a STOP and START condition    | 4.7                                                             | —                 | 1.3                                          | —                | μs   |
| IC10 | Rise time of both I2DAT and I2CLK signals           | —                                                               | 1000              | 20 + 0.1C <sub>b</sub> <sup>4</sup>          | 300              | ns   |
| IC11 | Fall time of both I2DAT and I2CLK signals           | —                                                               | 300               | 20 + 0.1C <sub>b</sub> <sup>4</sup>          | 300              | ns   |
| IC12 | Capacitive load for each bus line (C <sub>b</sub> ) | —                                                               | 400               | —                                            | 400              | pF   |

<sup>1</sup> A device must internally provide a hold time of at least 300 ns for I2DAT signal in order to bridge the undefined region of the falling edge of I2CLK.

<sup>2</sup> The maximum hold time has only to be met if the device does not stretch the LOW period (ID no IC5) of the I2CLK signal.

<sup>3</sup> A Fast-mode I<sup>2</sup>C-bus device can be used in a Standard-mode I<sup>2</sup>C-bus system, but the requirement of Set-up time (ID No IC7) of 250 ns must be met. This automatically is the case if the device does not stretch the LOW period of the I2CLK signal. If such a device does stretch the LOW period of the I2CLK signal, it must output the next data bit to the I2DAT line max\_rise\_time (IC9) + data\_setup\_time (IC7) = 1000 + 250 = 1250 ns (according to the Standard-mode I<sup>2</sup>C-bus specification) before the I2CLK line is released.

<sup>4</sup> C<sub>b</sub> = total capacitance of one bus line in pF.

## 4.9.6 One-Wire (OWIRE) Timing Parameters

Figure 42 depicts the RPP timing, and Table 60 lists the RPP timing parameters.

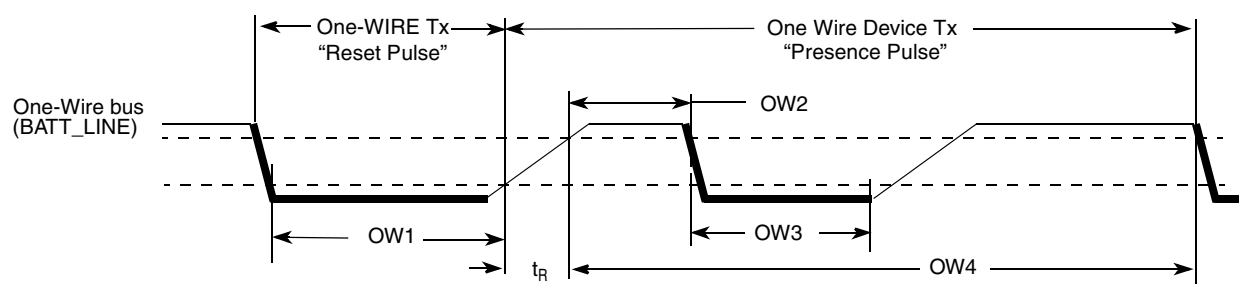


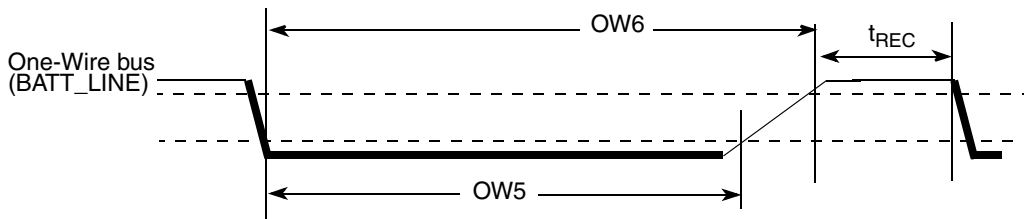
Figure 42. Reset and Presence Pulses (RPP) Timing Diagram

**Table 60. RPP Sequence Delay Comparisons Timing Parameters**

| ID  | Parameters                                  | Symbol     | Min | Typ | Max            | Unit    |
|-----|---------------------------------------------|------------|-----|-----|----------------|---------|
| OW1 | Reset Time Low                              | $t_{RSTL}$ | 480 | 511 | — <sup>1</sup> | $\mu s$ |
| OW2 | Presence Detect High                        | $t_{PDH}$  | 15  | —   | 60             | $\mu s$ |
| OW3 | Presence Detect Low                         | $t_{PDL}$  | 60  | —   | 240            | $\mu s$ |
| OW4 | Reset Time High<br>(includes recovery time) | $t_{RSTH}$ | 480 | 512 | —              | $\mu s$ |

<sup>1</sup> In order not to mask signaling by other devices on the 1-Wire bus,  $t_{RSTL} + t_R$  should always be less than 960  $\mu s$ .

Figure 43 depicts Write 0 Sequence timing, and Table 61 lists the timing parameters.

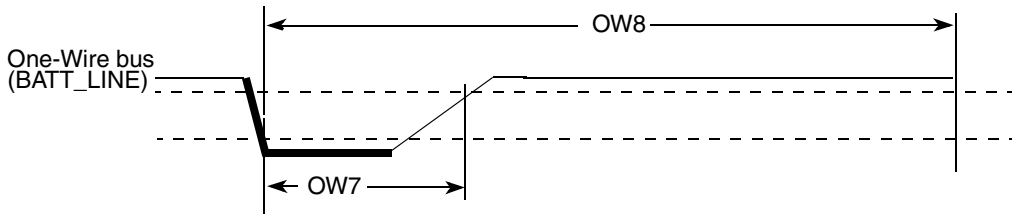


**Figure 43. Write 0 Sequence Timing Diagram**

**Table 61. WR0 Sequence Timing Parameters**

| ID  | Parameter              | Symbol     | Min | Typ | Max | Unit    |
|-----|------------------------|------------|-----|-----|-----|---------|
| OW5 | Write 0 Low Time       | $t_{LOW0}$ | 60  | 100 | 120 | $\mu s$ |
| OW6 | Transmission Time Slot | $t_{SLOT}$ | OW5 | 117 | 120 | $\mu s$ |
| —   | Recovery time          | $t_{REC}$  | 1   | —   | —   | $\mu s$ |

Figure 44 depicts Write 1 Sequence timing, Figure 45 depicts the Read Sequence timing, and Table 62 lists the timing parameters.



**Figure 44. Write 1 Sequence Timing Diagram**

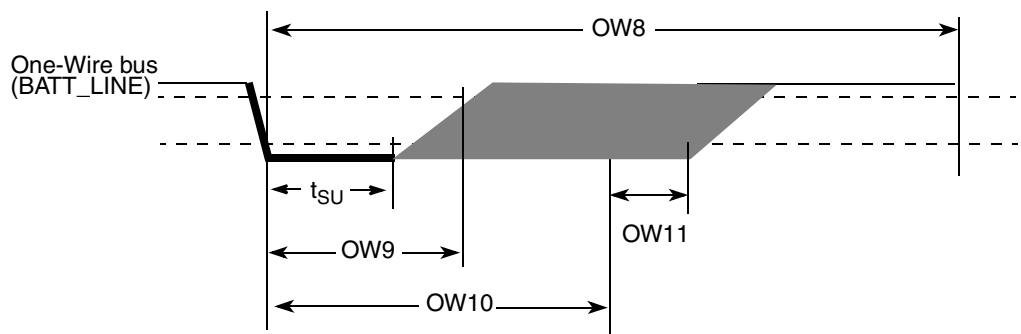


Figure 45. Read Sequence Timing Diagram

Table 62. WR1 /RD Timing Parameters

| ID   | Parameter              | Symbol        | Min | Typ | Max | Unit    |
|------|------------------------|---------------|-----|-----|-----|---------|
| OW7  | Write 1 Low Time       | $t_{LOW1}$    | 1   | 5   | 15  | $\mu s$ |
| OW8  | Transmission Time Slot | $t_{SLOT}$    | 60  | 117 | 120 | $\mu s$ |
| —    | Read Data Setup        | $t_{SU}$      | —   | —   | 1   | $\mu s$ |
| OW9  | Read Low Time          | $t_{LOWR}$    | 1   | 5   | 15  | $\mu s$ |
| OW10 | Read Data Valid        | $t_{RDV}$     | —   | 15  | —   | $\mu s$ |
| OW11 | Release Time           | $t_{RELEASE}$ | 0   | —   | 45  | $\mu s$ |

### 4.9.7 Pulse Width Modulator (PWM) Timing Parameters

This section describes the electrical information of the PWM. The PWM can be programmed to select one of three clock signals as its source frequency. The selected clock signal is passed through a prescaler before being input to the counter. The output is available at the pulse-width modulator output (PWMO) external pin.

Figure 46 depicts the timing of the PWM, and Table 63 lists the PWM timing parameters.

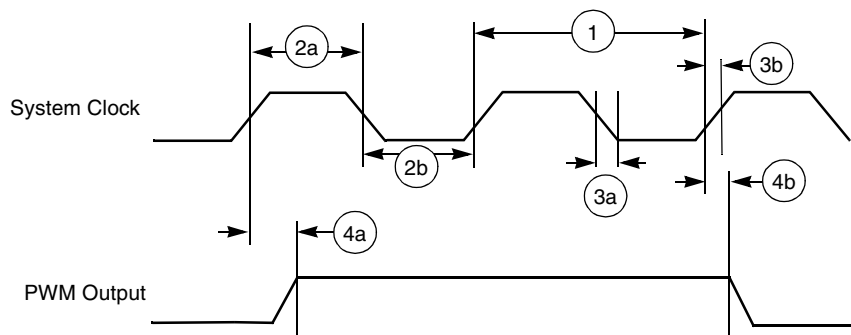


Figure 46. PWM Timing

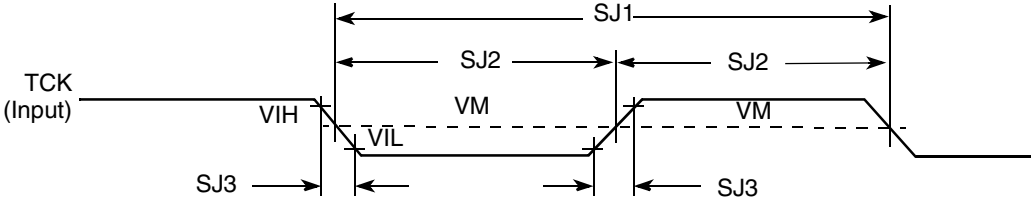
**Table 63. PWM Output Timing Parameter**

| Ref. No. | Parameter                         | Min   | Max     | Unit |
|----------|-----------------------------------|-------|---------|------|
| 1        | System CLK frequency <sup>1</sup> | 0     | ipg_clk | MHz  |
| 2a       | Clock high time                   | 12.29 | —       | ns   |
| 2b       | Clock low time                    | 9.91  | —       | ns   |
| 3a       | Clock fall time                   | —     | 0.5     | ns   |
| 3b       | Clock rise time                   | —     | 0.5     | ns   |
| 4a       | Output delay time                 | —     | 9.37    | ns   |
| 4b       | Output setup time                 | 8.71  | —       | ns   |

<sup>1</sup> CL of PWMO = 30 pF

### 4.9.8 Secure JTAG Controller (SJC) Timing Parameters

Figure 47 depicts the SJC test clock input timing. Figure 48 depicts the SJC boundary scan timing. Figure 49 depicts the SJC test access port. Figure 50 depicts the TRST timing. The signal parameters are listed in Table 64.



**Figure 47. Test Clock Input Timing Diagram**

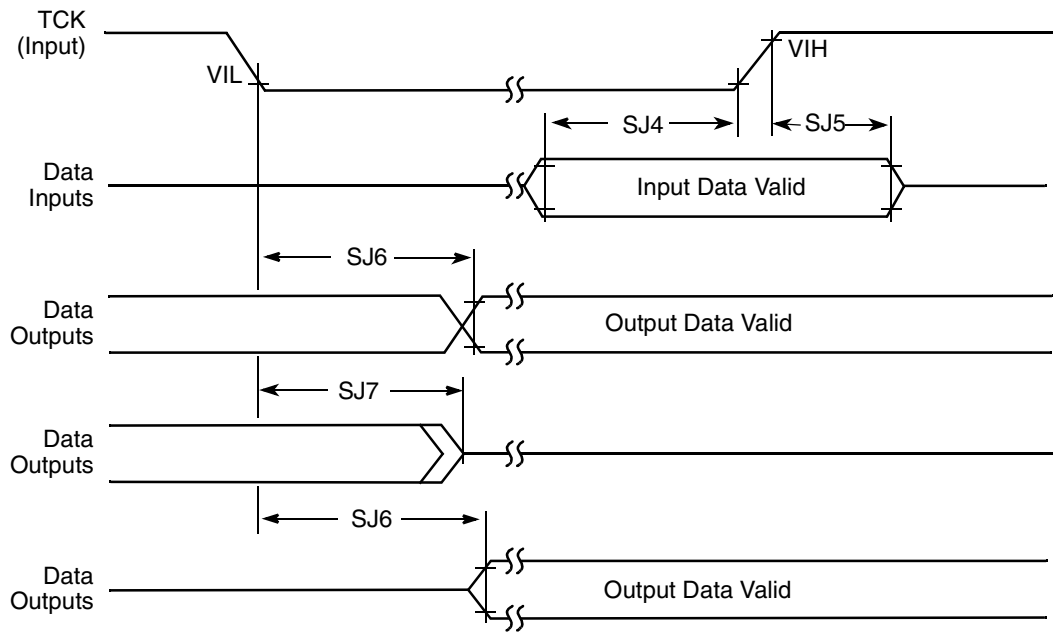


Figure 48. Boundary Scan (JTAG) Timing Diagram

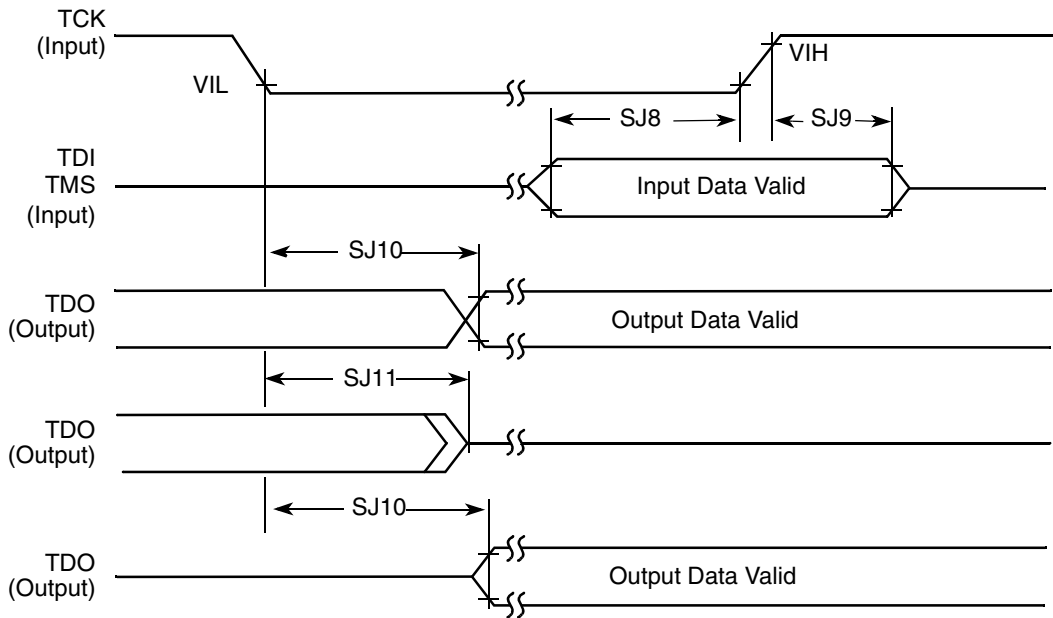


Figure 49. Test Access Port Timing Diagram

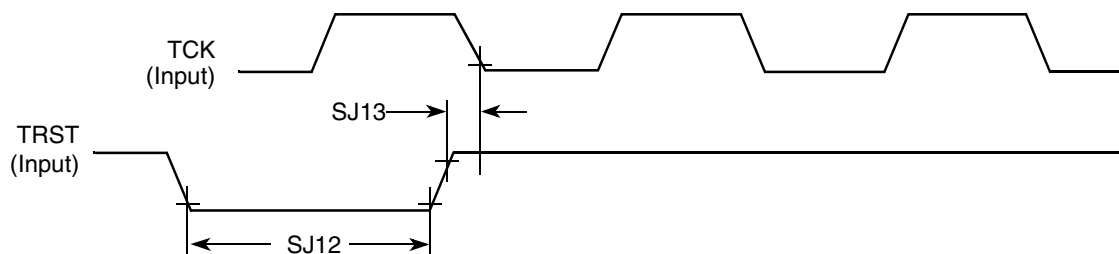


Figure 50.  $\overline{\text{TRST}}$  Timing Diagram

Table 64. JTAG Timing

| ID   | Parameter <sup>1,2</sup>                          | All Frequencies |     | Unit |
|------|---------------------------------------------------|-----------------|-----|------|
|      |                                                   | Min             | Max |      |
| SJ0  | TCK frequency of operation $1/(3 \cdot T_{DC})^1$ | 0.001           | 22  | MHz  |
| SJ1  | TCK cycle time in crystal mode                    | 45              | —   | ns   |
| SJ2  | TCK clock pulse width measured at $V_M^2$         | 22.5            | —   | ns   |
| SJ3  | TCK rise and fall times                           | —               | 3   | ns   |
| SJ4  | Boundary scan input data set-up time              | 5               | —   | ns   |
| SJ5  | Boundary scan input data hold time                | 24              | —   | ns   |
| SJ6  | TCK low to output data valid                      | —               | 40  | ns   |
| SJ7  | TCK low to output high impedance                  | —               | 40  | ns   |
| SJ8  | TMS, TDI data set-up time                         | 5               | —   | ns   |
| SJ9  | TMS, TDI data hold time                           | 25              | —   | ns   |
| SJ10 | TCK low to TDO data valid                         | —               | 44  | ns   |
| SJ11 | TCK low to TDO high impedance                     | —               | 44  | ns   |
| SJ12 | $\overline{\text{TRST}}$ assert time              | 100             | —   | ns   |
| SJ13 | $\overline{\text{TRST}}$ set-up time to TCK low   | 40              | —   | ns   |

<sup>1</sup>  $T_{DC}$  = target frequency of SJC

<sup>2</sup>  $V_M$  = mid-point voltage

### 4.9.9 SSI Timing Parameters

This section describes the timing parameters of the SSI module. The connectivity of the serial synchronous interfaces are summarized in [Table 65](#).

**Table 65. AUDMUX Port Allocation**

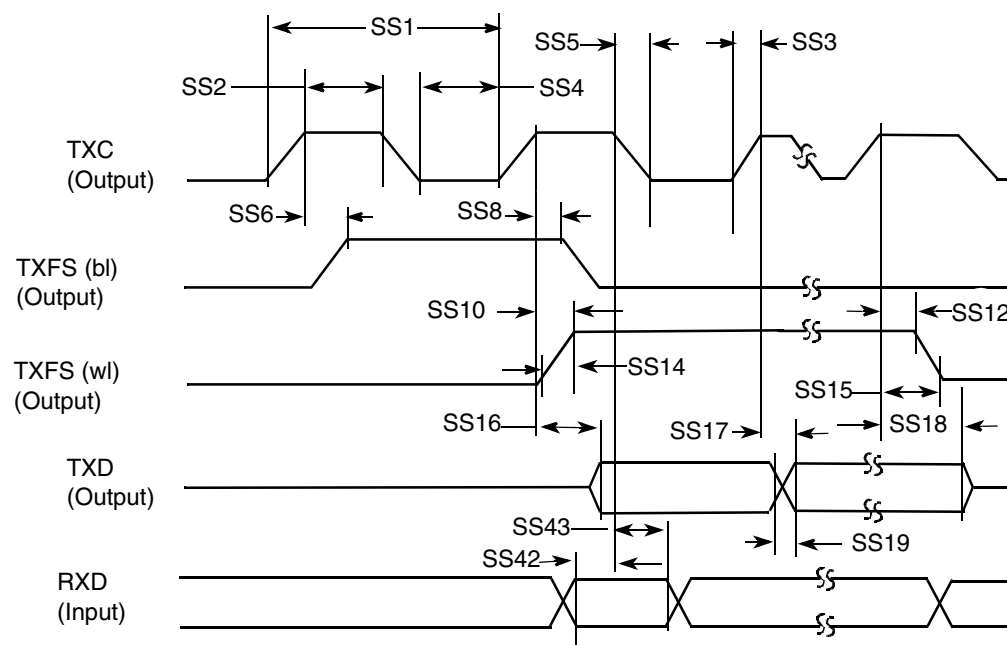
| Port          | Signal Nomenclature | Type and Access                         |
|---------------|---------------------|-----------------------------------------|
| AUDMUX port 1 | SSI 1               | Internal                                |
| AUDMUX port 2 | SSI 2               | Internal                                |
| AUDMUX port 3 | AUD3                | External— AUD3 I/O                      |
| AUDMUX port 4 | AUD4                | External—EIM or CSPI1 I/O through IOMUX |
| AUDMUX port 5 | AUD5                | External—EIM or SD1 I/O through IOMUX   |
| AUDMUX port 6 | AUD6                | External—EIM or DISP2 through IOMUX     |

#### NOTE

- The terms WL and BL used in the timing diagrams and tables refer to Word Length (WL) and Bit Length (BL).
- The SSI timing diagrams use generic signal names wherein the names used in the *MCIMX50 Applications Processor Reference Manual* (MCIMX50RM) are channel specific signal names. For example, a channel clock referenced in the IOMUXC chapter as AUD3\_TXC appears in the timing diagram as TXC.

### 4.9.9.1 SSI Transmitter Timing with Internal Clock

Figure 51 depicts the SSI transmitter internal clock timing and Table 66 lists the timing parameters for the SSI transmitter internal clock.



Note: SRXD input in synchronous mode only

Figure 51. SSI Transmitter Internal Clock Timing Diagram

Table 66. SSI Transmitter Timing with Internal Clock

| ID                       | Parameter                                      | Min  | Max  | Unit |
|--------------------------|------------------------------------------------|------|------|------|
| Internal Clock Operation |                                                |      |      |      |
| SS1                      | (Tx/Rx) CK clock period                        | 81.4 | —    | ns   |
| SS2                      | (Tx/Rx) CK clock high period                   | 36.0 | —    | ns   |
| SS3                      | (Tx/Rx) CK clock rise time                     | —    | 6.0  | ns   |
| SS4                      | (Tx/Rx) CK clock low period                    | 36.0 | —    | ns   |
| SS5                      | (Tx/Rx) CK clock fall time                     | —    | 6.0  | ns   |
| SS6                      | (Tx) CK high to FS (bl) high                   | —    | 15.0 | ns   |
| SS8                      | (Tx) CK high to FS (bl) low                    | —    | 15.0 | ns   |
| SS10                     | (Tx) CK high to FS (wl) high                   | —    | 15.0 | ns   |
| SS12                     | (Tx) CK high to FS (wl) low                    | —    | 15.0 | ns   |
| SS14                     | (Tx/Rx) Internal FS rise time                  | —    | 6.0  | ns   |
| SS15                     | (Tx/Rx) Internal FS fall time                  | —    | 6.0  | ns   |
| SS16                     | (Tx) CK high to STXD valid from high impedance | —    | 15.0 | ns   |

**Table 66. SSI Transmitter Timing with Internal Clock (continued)**

| ID                                          | Parameter                           | Min  | Max  | Unit |
|---------------------------------------------|-------------------------------------|------|------|------|
| SS17                                        | (Tx) CK high to STXD high/low       | —    | 15.0 | ns   |
| SS18                                        | (Tx) CK high to STXD high impedance | —    | 15.0 | ns   |
| SS19                                        | STXD rise/fall time                 | —    | 6.0  | ns   |
| <b>Synchronous Internal Clock Operation</b> |                                     |      |      |      |
| SS42                                        | SRXD setup before (Tx) CK falling   | 10.0 | —    | ns   |
| SS43                                        | SRXD hold after (Tx) CK falling     | 0.0  | —    | ns   |
| SS52                                        | Loading                             | —    | 25.0 | pF   |

### NOTE

- All the timings for the SSI are given for a non-inverted serial clock polarity (TSCKP/RSCCKP = 0) and a non-inverted frame sync (TFSI/RFSI = 0). If the polarity of the clock and/or the frame sync have been inverted, all the timing remains valid by inverting the clock signal STCK/SRCK and/or the frame sync STFS/SRFS shown in both the tables and figures.
- All timings are on Audiomux Pads when SSI is being used for data transfer.
- The terms WL and BL refer to word length (WL) and bit length (BL).
- Tx and Rx refer to the transmit and receive sections of the SSI.
- For internal frame sync operation using external clock, the FS timing is same as that of Tx Data (for example, during AC97 mode of operation).

### 4.9.9.2 SSI Receiver Timing with Internal Clock

Figure 52 depicts the SSI receiver internal clock timing and Table 67 lists the timing parameters for the receiver timing with internal clock.

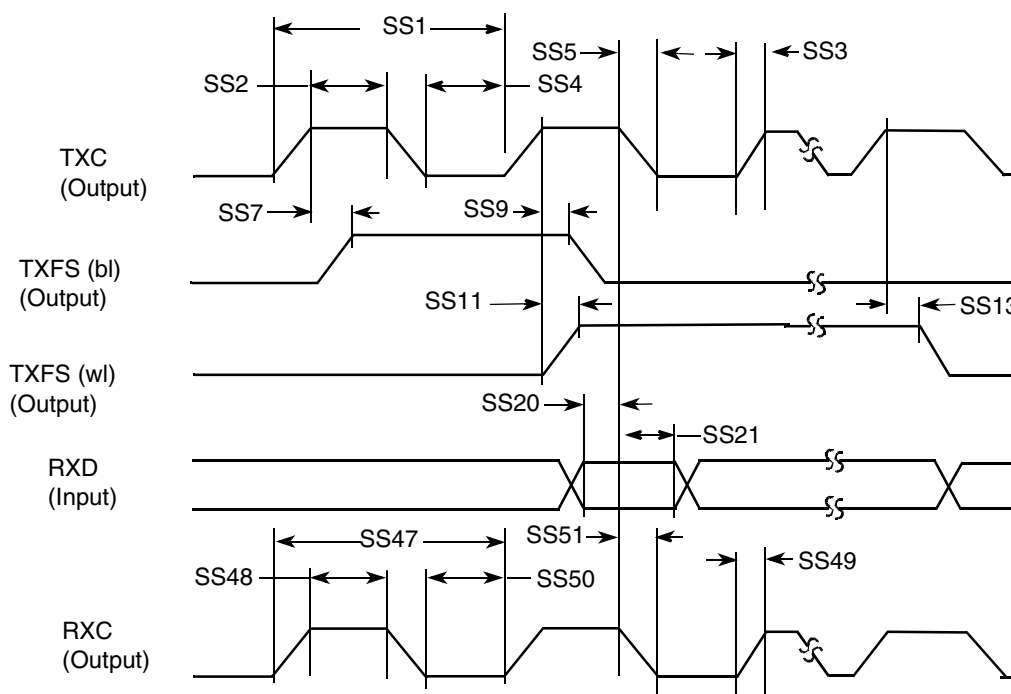


Figure 52. SSI Receiver Internal Clock Timing Diagram

Table 67. SSI Receiver Timing with Internal Clock

| ID                       | Parameter                          | Min  | Max  | Unit |
|--------------------------|------------------------------------|------|------|------|
| Internal Clock Operation |                                    |      |      |      |
| SS1                      | (Tx/Rx) CK clock period            | 81.4 | —    | ns   |
| SS2                      | (Tx/Rx) CK clock high period       | 36.0 | —    | ns   |
| SS3                      | (Tx/Rx) CK clock rise time         | —    | 6.0  | ns   |
| SS4                      | (Tx/Rx) CK clock low period        | 36.0 | —    | ns   |
| SS5                      | (Tx/Rx) CK clock fall time         | —    | 6.0  | ns   |
| SS7                      | (Rx) CK high to FS (bl) high       | —    | 15.0 | ns   |
| SS9                      | (Rx) CK high to FS (bl) low        | —    | 15.0 | ns   |
| SS11                     | (Rx) CK high to FS (wl) high       | —    | 15.0 | ns   |
| SS13                     | (Rx) CK high to FS (wl) low        | —    | 15.0 | ns   |
| SS20                     | SRXD setup time before (Rx) CK low | 10.0 | —    | ns   |
| SS21                     | SRXD hold time after (Rx) CK low   | 0.0  | —    | ns   |

Table 67. SSI Receiver Timing with Internal Clock (continued)

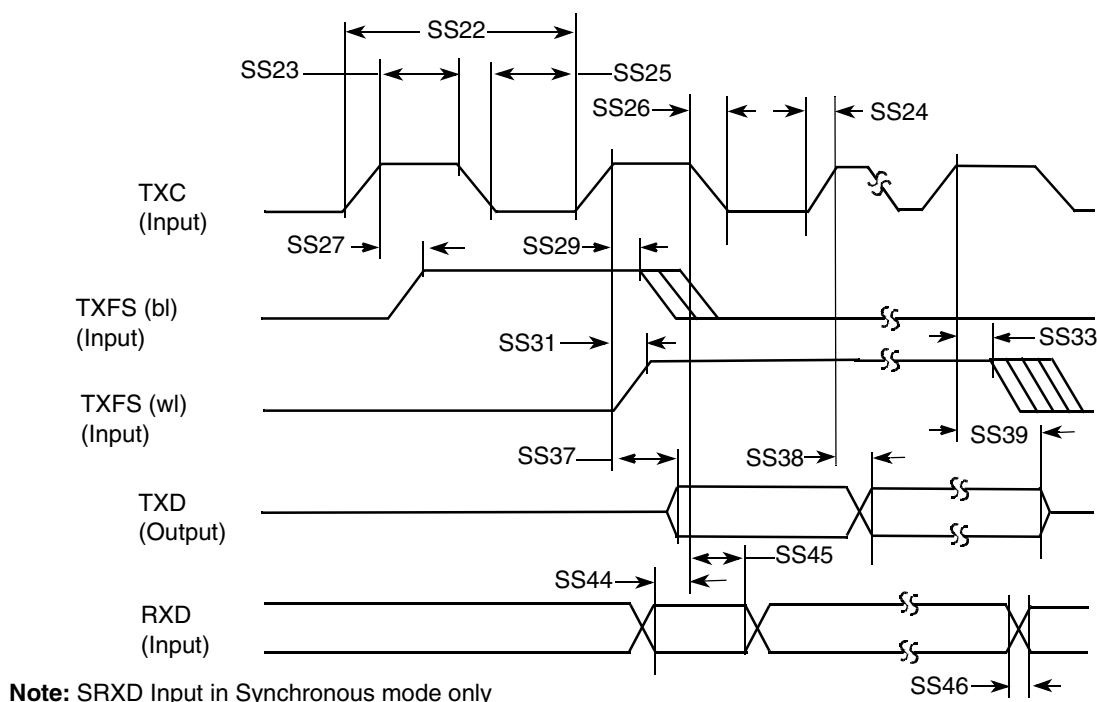
| ID                           | Parameter                      | Min   | Max | Unit |
|------------------------------|--------------------------------|-------|-----|------|
| Oversampling Clock Operation |                                |       |     |      |
| SS47                         | Oversampling clock period      | 15.04 | —   | ns   |
| SS48                         | Oversampling clock high period | 6.0   | —   | ns   |
| SS49                         | Oversampling clock rise time   | —     | 3.0 | ns   |
| SS50                         | Oversampling clock low period  | 6.0   | —   | ns   |
| SS51                         | Oversampling clock fall time   | —     | 3.0 | ns   |

### NOTE

- All the timings for the SSI are given for a non-inverted serial clock polarity (TSCKP/RSCCKP = 0) and a non-inverted frame sync (TFISI/RFSI = 0). If the polarity of the clock and/or the frame sync have been inverted, all the timing remains valid by inverting the clock signal STCK/SRCK and/or the frame sync STFS/SRFS as shown in both the tables and figures.
- All timings are on Audiomux Pads when SSI is being used for data transfer.
- **Tx** and **Rx** refer to the transmit and receive sections of the SSI.
- The terms WL and BL refer to word length (WL) and bit length (BL).
- For internal frame sync operation using external clock, the FS timing is same as that of Tx Data (for example, during AC97 mode of operation).

## 4.9.9.3 SSI Transmitter Timing with External Clock

Figure 53 depicts the SSI transmitter external clock timing and Table 68 lists the timing parameters for the transmitter timing with external clock.



**Figure 53. SSI Transmitter External Clock Timing Diagram**

**Table 68. SSI Transmitter Timing with External Clock**

| ID                              | Parameter                                      | Min   | Max  | Unit |
|---------------------------------|------------------------------------------------|-------|------|------|
| <b>External Clock Operation</b> |                                                |       |      |      |
| SS22                            | (Tx/Rx) CK clock period                        | 81.4  | —    | ns   |
| SS23                            | (Tx/Rx) CK clock high period                   | 36.0  | —    | ns   |
| SS24                            | (Tx/Rx) CK clock rise time                     | —     | 6.0  | ns   |
| SS25                            | (Tx/Rx) CK clock low period                    | 36.0  | —    | ns   |
| SS26                            | (Tx/Rx) CK clock fall time                     | —     | 6.0  | ns   |
| SS27                            | (Tx) CK high to FS (bl) high                   | −10.0 | 15.0 | ns   |
| SS29                            | (Tx) CK high to FS (bl) low                    | 10.0  | —    | ns   |
| SS31                            | (Tx) CK high to FS (wl) high                   | −10.0 | 15.0 | ns   |
| SS33                            | (Tx) CK high to FS (wl) low                    | 10.0  | —    | ns   |
| SS37                            | (Tx) CK high to STXD valid from high impedance | —     | 15.0 | ns   |
| SS38                            | (Tx) CK high to STXD high/low                  | —     | 15.0 | ns   |

**Table 68. SSI Transmitter Timing with External Clock (continued)**

| ID                                          | Parameter                           | Min  | Max  | Unit |
|---------------------------------------------|-------------------------------------|------|------|------|
| SS39                                        | (Tx) CK high to STXD high impedance | —    | 15.0 | ns   |
| <b>Synchronous External Clock Operation</b> |                                     |      |      |      |
| SS44                                        | SRXD setup before (Tx) CK falling   | 10.0 | —    | ns   |
| SS45                                        | SRXD hold after (Tx) CK falling     | 2.0  | —    | ns   |
| SS46                                        | SRXD rise/fall time                 | —    | 6.0  | ns   |

### NOTE

- All the timings for the SSI are given for a non-inverted serial clock polarity (TSCKP/RSCCKP = 0) and a non-inverted frame sync (TFISI/RFSI = 0). If the polarity of the clock and/or the frame sync have been inverted, all the timing remains valid by inverting the clock signal STCK/SRCK and/or the frame sync STFS/SRFS shown in both the tables and figures.
- All timings are on Audiomux Pads when SSI is being used for data transfer.
- Tx and Rx refer to the transmit and receive sections of the SSI.
- The terms WL and BL refer to word length (WL) and bit length (BL).
- For internal frame sync operation using external clock, the FS timing is same as that of Tx Data (for example, during AC97 mode of operation).

### 4.9.9.4 SSI Receiver Timing with External Clock

Figure 54 depicts the SSI receiver external clock timing and Table 69 lists the timing parameters for the receiver timing with external clock.

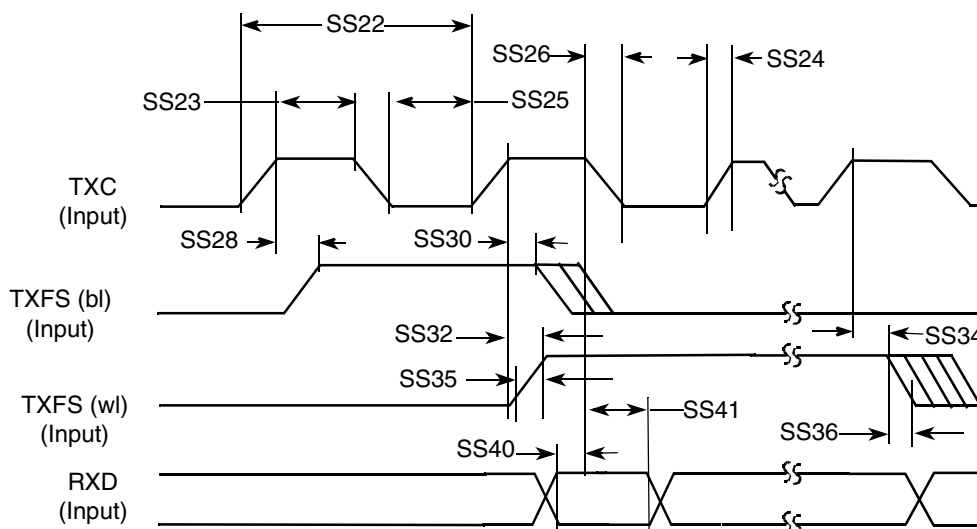


Figure 54. SSI Receiver External Clock Timing Diagram

Table 69. SSI Receiver Timing with External Clock

| ID                              | Parameter                          | Min  | Max  | Unit |
|---------------------------------|------------------------------------|------|------|------|
| <b>External Clock Operation</b> |                                    |      |      |      |
| SS22                            | (Tx/Rx) CK clock period            | 81.4 | —    | ns   |
| SS23                            | (Tx/Rx) CK clock high period       | 36   | —    | ns   |
| SS24                            | (Tx/Rx) CK clock rise time         | —    | 6.0  | ns   |
| SS25                            | (Tx/Rx) CK clock low period        | 36   | —    | ns   |
| SS26                            | (Tx/Rx) CK clock fall time         | —    | 6.0  | ns   |
| SS28                            | (Rx) CK high to FS (bl) high       | -10  | 15.0 | ns   |
| SS30                            | (Rx) CK high to FS (bl) low        | 10   | —    | ns   |
| SS32                            | (Rx) CK high to FS (wl) high       | -10  | 15.0 | ns   |
| SS34                            | (Rx) CK high to FS (wl) low        | 10   | —    | ns   |
| SS35                            | (Tx/Rx) External FS rise time      | —    | 6.0  | ns   |
| SS36                            | (Tx/Rx) External FS fall time      | —    | 6.0  | ns   |
| SS40                            | SRXD setup time before (Rx) CK low | 10   | —    | ns   |
| SS41                            | SRXD hold time after (Rx) CK low   | 2    | —    | ns   |

**NOTE**

- All the timings for the SSI are given for a non-inverted serial clock polarity (TSCKP/RSCCKP = 0) and a non-inverted frame sync (TFSI/RFSI = 0). If the polarity of the clock and/or the frame sync have been inverted, all the timing remains valid by inverting the clock signal STCK/SRCK and/or the frame sync STFS/SRFS shown in both the tables and figures.
- All timings are on Audiomux Pads when SSI is being used for data transfer.
- Tx and Rx refer to the transmit and receive sections of the SSI.
- The terms WL and BL refer to word length (WL) and bit length (BL).
- For internal Frame Sync operation using external clock, the FS timing is same as that of Tx Data (for example, during AC97 mode of operation).

### 4.9.10 UART I/O Configuration and Timing Parameters

The following sections describe the UART I/O configuration and timing parameters.

#### 4.9.10.1 UART RS-232 I/O Configuration in Different Modes

Table 70 shows the UART I/O configuration based on which mode is enabled.

**Table 70. UART I/O Configuration vs. Mode**

| Port    | DTE Mode  |                             | DCE Mode  |                             |
|---------|-----------|-----------------------------|-----------|-----------------------------|
|         | Direction | Description                 | Direction | Description                 |
| RTS     | Output    | RTS from DTE to DCE         | Input     | RTS from DTE to DCE         |
| CTS     | Input     | CTS from DCE to DTE         | Output    | CTS from DCE to DTE         |
| TXD_MUX | Input     | Serial data from DCE to DTE | Output    | Serial data from DCE to DTE |
| RXD_MUX | Output    | Serial data from DTE to DCE | Input     | Serial data from DTE to DCE |

#### 4.9.10.2 UART RS-232 Serial Mode Timing

The following sections describe the electrical information of the UART module in the RS-232 mode.

### 4.9.10.2.1 UART Transmitter

Figure 55 depicts the transmit timing of UART in the RS-232 serial mode with 8 data bit/1 stop bit format. Table 71 lists the UART RS-232 serial mode transmit timing characteristics.

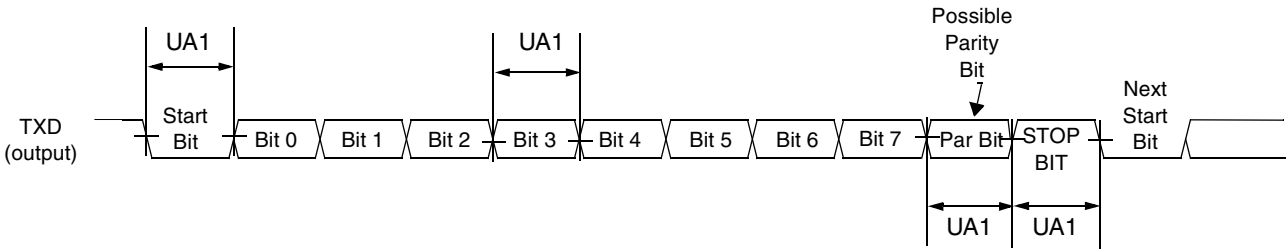


Figure 55. UART RS-232 Serial Mode Transmit Timing Diagram

Table 71. RS-232 Serial Mode Transmit Timing Parameters

| ID  | Parameter         | Symbol     | Min                                   | Max                               | Units |
|-----|-------------------|------------|---------------------------------------|-----------------------------------|-------|
| UA1 | Transmit Bit Time | $t_{Tbit}$ | $1/F_{baud\_rate}^1 - T_{ref\_clk}^2$ | $1/F_{baud\_rate} + T_{ref\_clk}$ | —     |

<sup>1</sup>  $F_{baud\_rate}$ : Baud rate frequency. The maximum baud rate the UART can support is  $(ipg\_perclk \text{ frequency})/16$ .

<sup>2</sup>  $T_{ref\_clk}$ : The period of UART reference clock  $ref\_clk$  ( $ipg\_perclk$  after RFDIV divider).

### 4.9.10.2.2 UART Receiver

Figure 56 depicts the RS-232 serial mode receive timing with 8 data bit/1 stop bit format. Table 72 lists serial mode receive timing characteristics.

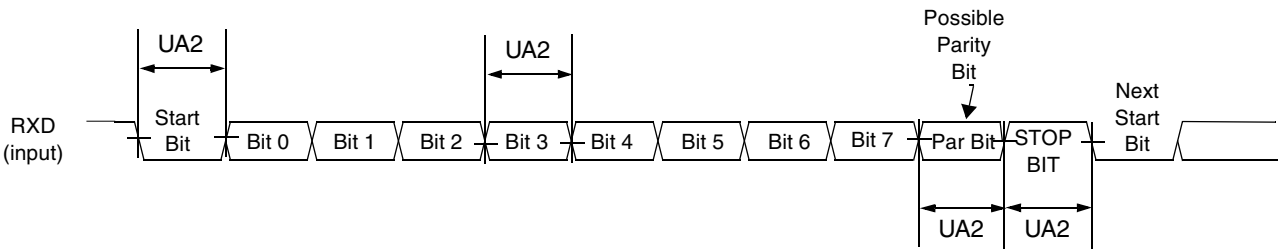


Figure 56. UART RS-232 Serial Mode Receive Timing Diagram

Table 72. RS-232 Serial Mode Receive Timing Parameters

| ID  | Parameter                     | Symbol     | Min                                                | Max                                              | Units |
|-----|-------------------------------|------------|----------------------------------------------------|--------------------------------------------------|-------|
| UA2 | Receive Bit Time <sup>1</sup> | $t_{Rbit}$ | $1/F_{baud\_rate}^2 - 1/(16 \cdot F_{baud\_rate})$ | $1/F_{baud\_rate} + 1/(16 \cdot F_{baud\_rate})$ | —     |

<sup>1</sup> The UART receiver can tolerate  $1/(16 \cdot F_{baud\_rate})$  tolerance in each bit. But accumulation tolerance in one frame must not exceed  $3/(16 \cdot F_{baud\_rate})$ .

<sup>2</sup>  $F_{baud\_rate}$ : Baud rate frequency. The maximum baud rate the UART can support is  $(ipg\_perclk \text{ frequency})/16$ .

### 4.9.10.3 UART IrDA Mode Timing

The following sections give the UART transmit and receive timings in IrDA mode.

### 4.9.10.3.1 UART IrDA Mode Transmitter

Figure 57 depicts the UART IrDA mode transmit timing with 8 data bit/1 stop bit format. Table 73 lists the transmit timing characteristics.

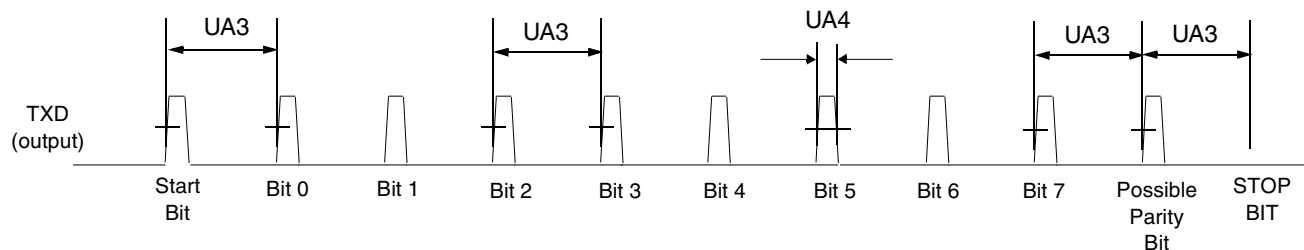


Figure 57. UART IrDA Mode Transmit Timing Diagram

Table 73. IrDA Mode Transmit Timing Parameters

| ID  | Parameter                      | Symbol         | Min                                        | Max                                        | Units |
|-----|--------------------------------|----------------|--------------------------------------------|--------------------------------------------|-------|
| UA3 | Transmit Bit Time in IrDA mode | $t_{TIRbit}$   | $1/F_{baud\_rate}^1 - T_{ref\_clk}^2$      | $1/F_{baud\_rate} + T_{ref\_clk}$          | —     |
| UA4 | Transmit IR Pulse Duration     | $t_{TIRpulse}$ | $(3/16)*(1/F_{baud\_rate}) - T_{ref\_clk}$ | $(3/16)*(1/F_{baud\_rate}) + T_{ref\_clk}$ | —     |

<sup>1</sup>  $F_{baud\_rate}$ : Baud rate frequency. The maximum baud rate the UART can support is ( $ipg\_perclk$  frequency)/16.

<sup>2</sup>  $T_{ref\_clk}$ : The period of UART reference clock  $ref\_clk$  ( $ipg\_perclk$  after RFDIV divider).

### 4.9.10.3.2 UART IrDA Mode Receiver

Figure 58 depicts the UART IrDA mode receive timing with 8 data bit/1 stop bit format. Table 74 lists the receive timing characteristics.

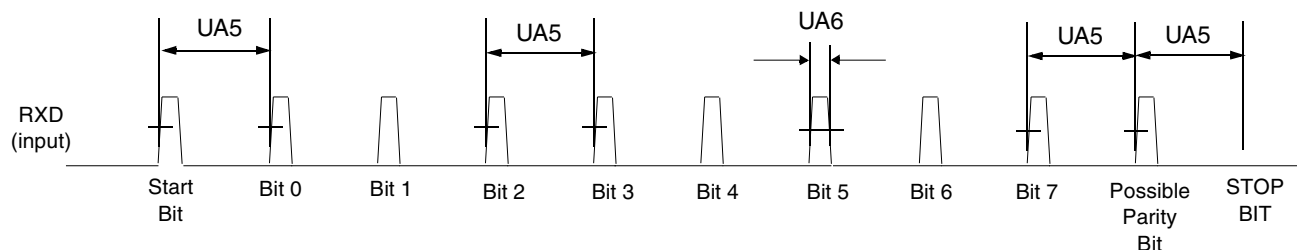


Figure 58. UART IrDA Mode Receive Timing Diagram

Table 74. IrDA Mode Receive Timing Parameters

| ID  | Parameter                                  | Symbol         | Min.                                         | Max.                                       | Units |
|-----|--------------------------------------------|----------------|----------------------------------------------|--------------------------------------------|-------|
| UA5 | Receive Bit Time <sup>1</sup> in IrDA mode | $t_{RIRbit}$   | $1/F_{baud\_rate}^2 - 1/(16*F_{baud\_rate})$ | $1/F_{baud\_rate} + 1/(16*F_{baud\_rate})$ | —     |
| UA6 | Receive IR Pulse Duration                  | $t_{RIRpulse}$ | 1.41 $\mu s$                                 | $(5/16)*(1/F_{baud\_rate})$                | —     |

<sup>1</sup> The UART receiver can tolerate  $1/(16*F_{baud\_rate})$  tolerance in each bit. But accumulation tolerance in one frame must not exceed  $3/(16*F_{baud\_rate})$ .

<sup>2</sup>  $F_{baud\_rate}$ : Baud rate frequency. The maximum baud rate the UART can support is ( $ipg\_perclk$  frequency)/16.

## 4.9.11 USB PHY Parameters

This section describes the USB OTG PHY and the USB host port PHY parameters.

### 4.9.11.1 USB PHY AC Parameters

Table 75 lists the AC timing parameters for USB PHY.

**Table 75. USB PHY AC Timing Parameters**

| Parameter | Conditions                   | Min            | Typ | Max            | Unit |
|-----------|------------------------------|----------------|-----|----------------|------|
| trise     | 1.5Mbps<br>12Mbps<br>480Mbps | 75<br>4<br>0.5 | —   | 300<br>20      | ns   |
| tfall     | 1.5Mbps<br>12Mbps<br>480Mbps | 75<br>4<br>0.5 | —   | 300<br>20      | ns   |
| Jitter    | 1.5Mbps<br>12Mbps<br>480Mbps | —              | —   | 10<br>1<br>0.2 | ns   |

### 4.9.11.2 USB PHY Additional Electrical Parameters

Table 76 lists the parameters for additional electrical characteristics for USB PHY.

**Table 76. Additional Electrical Characteristics for USB PHY**

| Parameter                                           | Conditions             | Min          | Typ    | Max        | Unit |
|-----------------------------------------------------|------------------------|--------------|--------|------------|------|
| Vcm DC<br>(dc level measured at receiver connector) | HS Mode<br>LS/FS Mode  | −0.05<br>0.8 | —      | 0.5<br>2.5 | V    |
| Crossover Voltage                                   | LS Mode<br>FS Mode     | 1.3<br>1.3   | —      | 2<br>2     | V    |
| Power supply ripple noise<br>(analog 3.3 V)         | < 160 MHz              | −50          | 0      | 50         | mV   |
| Power supply ripple noise<br>(analog 2.5 V)         | < 1.2 MHz<br>> 1.2 MHz | −10<br>−50   | 0<br>0 | 10<br>50   | mV   |
| Power supply ripple noise<br>(Digital 1.2 V)        | All conditions         | −50          | 0      | 50         | mV   |

### 4.9.11.3 USB PHY System Clocking (SYSCLK)

Table 77 lists the USB PHY system clocking parameters

**Table 77. USB PHY System Clocking Parameters**

| Parameter       | Conditions                          | Min  | Typ | Max | Unit |
|-----------------|-------------------------------------|------|-----|-----|------|
| Clock deviation | Reference Clock<br>frequency 24 MHz | −150 | —   | 150 | ppm  |
| Rise/fall time  | —                                   | —    | —   | 200 | ps   |

**Table 77. USB PHY System Clocking Parameters (continued)**

| Parameter          | Conditions                       | Min | Typ | Max | Unit |
|--------------------|----------------------------------|-----|-----|-----|------|
| Jitter (peak-peak) | <1.2 MHz                         | 0   | —   | 50  | ps   |
| Jitter (peak-peak) | >1.2 MHz                         | 0   | —   | 100 | ps   |
| Duty-cycle         | Reference Clock frequency 24 MHz | 40  | —   | 60  | %    |

#### 4.9.11.4 USB VBUS Parameters

Table 78 lists the USB VBUS input parameters.

**Table 78. VBUS Comparators Thresholds**

| Parameter                                    | Conditions    | Min | Typ  | Max  | Unit |
|----------------------------------------------|---------------|-----|------|------|------|
| A-Device Session Valid Comparator Threshold  | —             | 0.8 | 1.4  | 2.0  | V    |
| B-Device Session Valid Comparator Threshold  | —             | 0.8 | 1.4  | 4.0  | V    |
| B-Device Session End Comparator Threshold    | —             | 0.2 | 0.45 | 0.8  | V    |
| VBUS Valid Comparator Threshold <sup>1</sup> | —             | 4.4 | 4.6  | 4.75 | V    |
| VBUS for CHGR_DET_B Operation                | —             | 3.0 | —    | —    | V    |
| VBUS Input Current                           | VBUS = 5.25 V | —   | —    | 350  | μA   |

<sup>1</sup> For VBUS maximum rating, see Table 7.

## 5 Package Information and Contact Assignments

This section includes the contact assignment information and mechanical package drawing.

### 5.1 13 x 13 mm, 0.5 mm Pitch, 416 Pin MAPBGA Package Information

This section contains the outline drawing, signal assignment map, ground, power, reference ID (by ball grid location) for the 13 x 13 mm, 0.5 mm pitch, 416 pin MAPBGA package.

### 5.1.1 Case 416 MAPBGA, 13 x 13 mm, 0.5 mm Pitch Package Views

Figure 59 shows the top view of the 13 x 13 mm package, Figure 60 shows the bottom view (416 soldier balls) of the 13 x 13 mm package, and Figure 61 shows the side view of the 13 x 13 mm package.

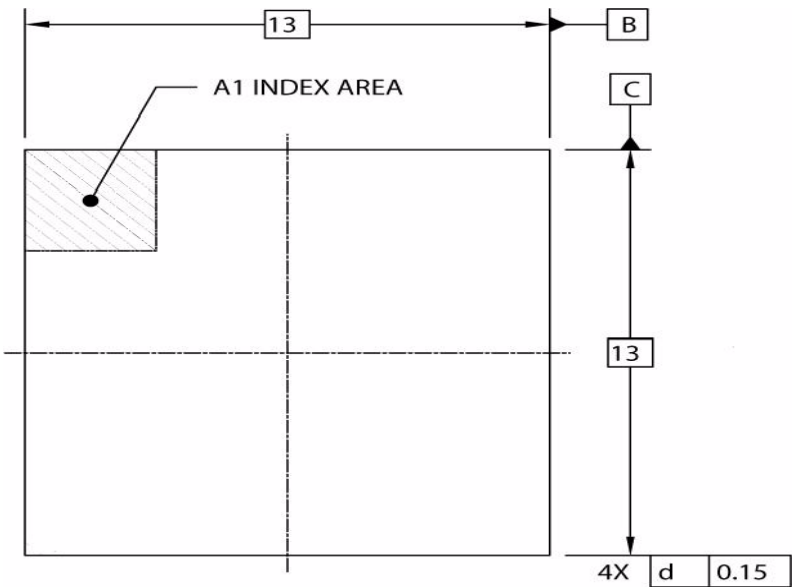


Figure 59. 416 MAPBGA 13x13 mm Package Top View

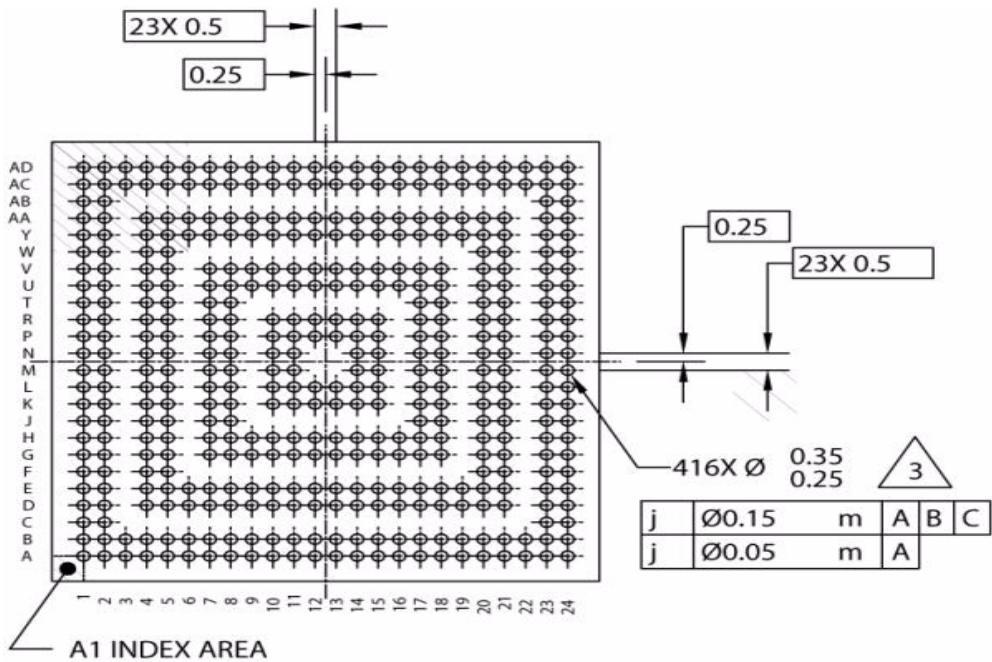
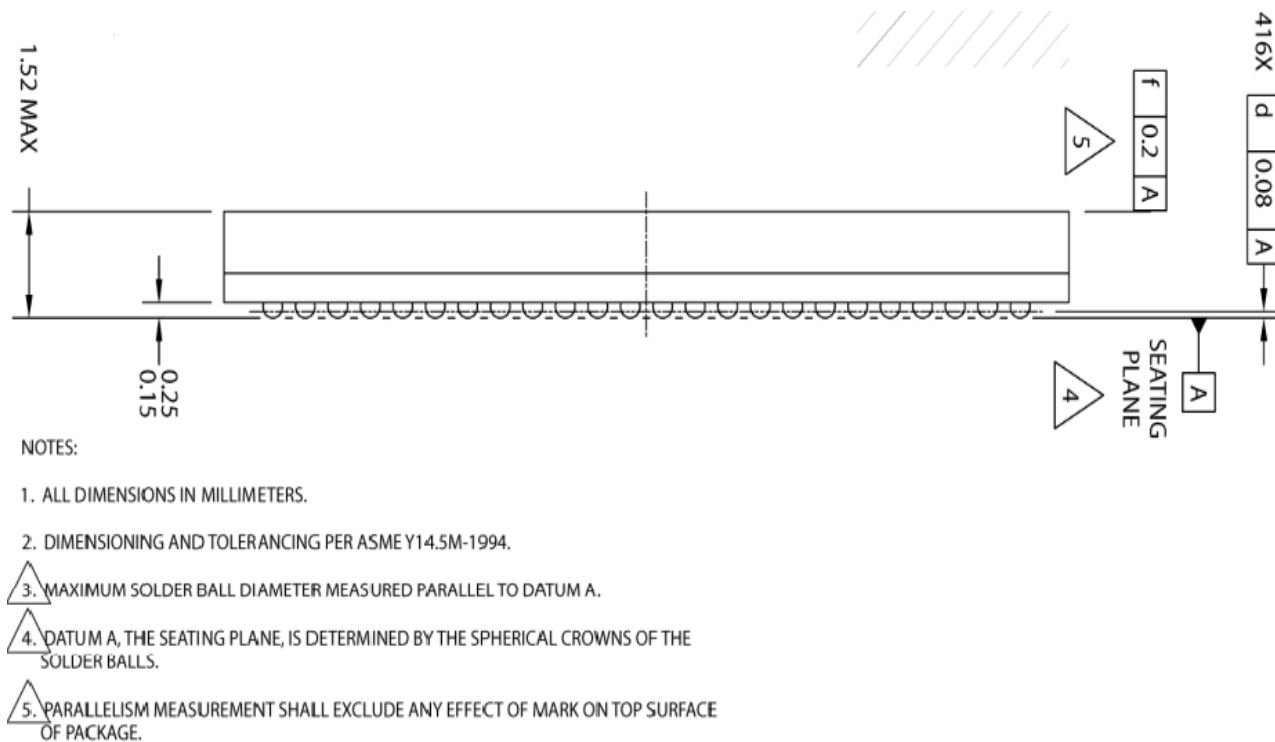


Figure 60. 416 MAPBGA 13x13 mm Package Bottom View



**Figure 61. 416 MAPBGA 13x13 mm Package Side View**

The following notes apply to [Figure 59](#), [Figure 60](#), and [Figure 61](#):

- Unless otherwise specified dimensions are in millimeters.
- All dimensions and tolerances conform to ASME Y14.5M-1994.
- Parallelism measurement shall exclude any effect of mark on top surface of package.

## 5.1.2 416 MAPBGA 13 x 13 mm, 0.5 mm Pitch Ball Map

Table 79 shows the 416 MAPBGA 13 x 13 mm, 0.5 mm pitch ball map.

**Table 79. 416 MAPBGA 13x13 mm, 0.5 mm Pitch Ball Map**

| G             | F        | E          | D             | C            | B             | A             |    |
|---------------|----------|------------|---------------|--------------|---------------|---------------|----|
| I2C3_SCL      | I2C2_SCL | I2C1_SCL   | KEY_ROW0      | KEY_COL2     | KEY_COL0      | VSS           | 1  |
| I2C3_SDA      | I2C2_SDA | I2C1_SDA   | KEY_ROW1      | KEY_COL3     | KEY_COL1      | EIM_RDY       | 2  |
| NC            | NC       | NC         | NC            | NC           | EIM_OE        | EIM_CRE       | 3  |
| EPITO         | PWM2     | KEY_ROW3   | KEY_ROW2      | NC           | EIM_EB1       | EIM_EB0       | 4  |
| WDOG          | PWM1     | EIM_LBA    | EIM_WAIT      | NC           | EIM_RW        | EIM_BCLK      | 5  |
| NC            | NC       | EIM_DA15   | EIM_DA14      | NC           | EIM_DA13      | EIM_DA12      | 6  |
| OWIRE         | NC       | EIM_DA11   | EIM_DA10      | NC           | EIM_DA9       | EIM_DA8       | 7  |
| VDDGP         | NC       | EIM_DA7    | EIM_DA6       | NC           | EIM_DA5       | EIM_DA4       | 8  |
| VDDGP         | NC       | EIM_DA3    | EIM_DA2       | NC           | EIM_DA1       | EIM_DA0       | 9  |
| VDDGP         | NC       | EIM_CS2    | EIM_CS1       | NC           | EIM_CS0       | EPDC_SDSTR    | 10 |
| EPDC_PWRCTRL0 | NC       | EPDC_SDCE5 | EPDC_SDCE4    | NC           | EPDC_GDOE     | EPDC_GDCLK    | 11 |
| EPDC_PWRCTRL1 | NC       | EPDC_SDCE3 | EPDC_SDCE2    | NC           | EPDC_GDSP     | EPDC_GDRL     | 12 |
| EPDC_PWRCTRL2 | NC       | EPDC_SDCE1 | EPDC_SDCE0    | NC           | EPDC_SDCLKN   | EPDC_SDCLK    | 13 |
| EPDC_PWRCTRL3 | NC       | EPDC_D15   | EPDC_D14      | NC           | EPDC_D13      | EPDC_D12      | 14 |
| EPDC_PWRSTAT  | NC       | EPDC_D7    | EPDC_D6       | NC           | EPDC_D9       | EPDC_D8       | 15 |
| EPDC_VCOM0    | NC       | EPDC_D3    | EPDC_D2       | NC           | EPDC_D5       | EPDC_D4       | 16 |
| DRAM_SDODT0   | NC       | EPDC_SDOE  | EPDC_SDLE     | NC           | EPDC_D1       | EPDC_D0       | 17 |
| NC            | NC       | EPDC_SDOEZ | EPDC_SDOED    | NC           | VSS           | VSS           | 18 |
| VSS           | DRAM_A14 | EPDC_BDR0  | EPDC_VCOM1    | NC           | DRAM_D31      | DRAM_D30      | 19 |
| VSS           | DRAM_A13 | EPDC_BDR1  | NVCC_EMI_DRAM | NC           | DRAM_D28      | DRAM_D29      | 20 |
| NC            | NC       | NC         | NC            | NC           | NVCC_EMI_DRAM | NVCC_EMI_DRAM | 21 |
| VSS           | DRAM_D12 | DRAM_D15   | NVCC_EMI_DRAM | NC           | DRAM_D27      | DRAM_D26      | 22 |
| DRAM_D10      | DRAM_D13 | DRAM_D14   | NVCC_EMI_DRAM | DRAM_SDQS3_B | DRAM_D24      | DRAM_D25      | 23 |
| G             | F        | E          | D             | C            | B             | VSS           | 24 |
|               |          |            |               |              |               | A             |    |

Table 79. 416 MAPBGA 13x13 mm, 0.5 mm Pitch Ball Map (continued)

| P            | N            | M              | L                | K             | J         | H           |
|--------------|--------------|----------------|------------------|---------------|-----------|-------------|
| SD1_CLK      | ECSP11_SCLK  | CSPI1_SCLK     | UART2_RXD        | UART2_TXD     | UART1_RXD | UART1_TXD   |
| SD1_D1       | ECSP11_MOSI  | CSPI1_MOSI     | UART2_RTS        | UART2_CTS     | UART1_RTS | UART1_CTS   |
| NC           | NC           | NC             | NC               | NC            | NC        | NC          |
| ECSP12_SCLK  | ECSP12_SS0   | CSPI1_SS0      | UART3_RXD        | UART3_TXD     | SSI_TXC   | SSI_TXFS    |
| ECSP12_MOSI  | ECSP12_MISO  | CSPI1_MISO     | UART4_RXD        | UART4_TXD     | SSI_RXD   | SSI_TXD     |
| NC           | NC           | NC             | NC               | NC            | NC        | NC          |
| ECSP11_SS0   | ECSP11_MISO  | NVCC_EIM       | NVCC_EIM         | VDDGP         | SSI_RXC   | SSI_RXFS    |
| NVCC_MISC    | NVCC_KEYPAD  | NVCC_EIM       | VDDGP            | VDDGP         | VDDGP     | VDDGP       |
| NC           | NC           | NC             | NC               | NC            | NC        | VDDGP       |
| NVCC_EPDC    | NVCC_EPDC    | NVCC_EPDC      | VDDGP            | VDDGP         | NC        | VDDGP       |
| VSS          | VSS          | VSS            | VDDGP            | VDDGP         | NC        | VDDGP       |
| VSS          | NC           | NC             | VSS              | VSS           | NC        | VSS         |
| VSS          | NC           | NC             | VSS              | VSS           | NC        | VSS         |
| VSS          | VSS          | VSS            | VSS              | VCC           | NC        | VCC         |
| VDDAL1       | VSS          | VSS            | VCC              | VCC           | NC        | VCC         |
| NC           | NC           | NC             | NC               | NC            | NC        | VCC         |
| VDDA         | VSS          | VSS            | VSS              | VCC           | VCC       | VCC         |
| DRAM_SDWE    | DRAM_SDBA2   | VSS            | DRAM_SDBA1       | DRAM_SDBA0    | DRAM_OPEN | DRAM_OPENFB |
| NC           | NC           | NC             | NC               | NC            | NC        | NC          |
| DRAM_A5      | DRAM_A7      | VSS            | DRAM_CALIBRATION | DRAM_A10      | DRAM_A11  | DRAM_A12    |
| DRAM_A6      | DRAM_A8      | VSS            | DRAM_A9          | NVCC_EMI_DRAM | DRAM_CAS  | DRAM_RAS    |
| NC           | NC           | NC             | NC               | NC            | NC        | NC          |
| DRAM_SDQS0   | VDDO25       | VREF           | DRAM_SDQS1       | NVCC_EMI_DRAM | DRAM_D8   | DRAM_D11    |
| DRAM_SDQS0_B | DRAM_SDCLK_0 | DRAM_SDCLK_0_B | DRAM_SDQS1_B     | NVCC_EMI_DRAM | DRAM_DQM1 | DRAM_D9     |
| P            | N            | M              | L                | K             | J         | H           |

## Table 79. 416 MAPBGA 13x13 mm, 0.5 mm Pitch Ball Map (continued)

| AA              | Y               | W             | V          | U         | T            | R              |
|-----------------|-----------------|---------------|------------|-----------|--------------|----------------|
| NVCC_SRTC       | CKIL            | PMIC_ON_REQ   | SD2_D2     | SD2_CLK   | SD2_D0       | SD1_CMD        |
| NGND_SRTC       | ECKIL           | PMIC_STBY_REQ | SD2_D3     | SD2_D5    | SD2_D1       | SD1_D0         |
| NC              | NC              | NC            | NC         | NC        | NC           | NC             |
| JTAG_TDI        | JTAG_TMS        | JTAG_TCK      | SD2_D4     | SD2_D6    | SD2_CD       | SD1_D2         |
| JTAG_TRSTB      | VDD_DCDCO       | GND_DCDC      | SD2_CMD    | SD2_D7    | SD2_WP       | SD1_D3         |
| CKIH            | VDD_DCDCI       | NC            | NC         | NC        | NC           | NC             |
| GND_KEL         | USB_OTG_GPANAIO | NC            | JTAG_MOD   | JTAG_TDO  | NVCC_SD1     | NVCC_SPI       |
| USB_OTG_RREFEXT | USB_OTG_ID      | NC            | NVCC_RESET | NVCC_SD2  | NVCC_UART    | NVCC_SSI       |
| VSS             | USB_OTG_VBUS    | NC            | NVCC_NANDF | NVCC_JTAG | NC           | NC             |
| USB_H1_RREFEXT  | USB_H1_VBUS     | NC            | NVCC_NANDF | NVCC_EPDC | NC           | NVCC_EPDC      |
| VSS             | USB_H1_GPANAIO  | NC            | CHGR_DET_B | NVCC_LCD  | NC           | VSS            |
| DISP_D0         | DISP_D1         | NC            | DISP_D11   | VSS       | NC           | VSS            |
| DISP_D2         | DISP_D3         | NC            | DISP_D12   | VSS       | NC           | VSS            |
| DISP_D4         | DISP_D5         | NC            | DISP_D13   | VSS       | NC           | VSS            |
| DISP_D6         | DISP_D7         | NC            | DISP_D14   | VSS       | NC           | VDDAL1         |
| DISP_D8         | DISP_D9         | NC            | DISP_D15   | VSS       | NC           | NC             |
| SD3_D3          | DISP_D10        | NC            | VSS        | VSS       | VSS          | VDDA           |
| SD3_D4          | SD3_D5          | NC            | VSS        | VSS       | VSS          | DRAM_SDOdT1    |
| SD3_D6          | SD3_D7          | NC            | NC         | NC        | NC           | NC             |
| DRAM_A4         | DRAM_A2         | DRAM_A0       | VSS        | DRAM_SCKE | DRAM_SDCLK_1 | DRAM_SDCLK_1_B |
| NVCC_EMI_DRAM   | DRAM_A3         | DRAM_A1       | VSS        | DRAM_CS1  | DRAM_CS0     | NVCC_EMI_DRAM  |
| NC              | NC              | NC            | NC         | NC        | NC           | NC             |
| NVCC_EMI_DRAM   | DRAM_D1         | DRAM_D2       | VSS        | DRAM_D5   | DRAM_D6      | NVCC_EMI_DRAM  |
| NVCC_EMI_DRAM   | DRAM_D0         | DRAM_D3       | DRAM_D4    | DRAM_D7   | DRAM_DQM0    | NVCC_EMI_DRAM  |
| AA              | Y               | W             | V          | U         | T            | R              |

Table 79. 416 MAPBGA 13x13 mm, 0.5 mm Pitch Ball Map (continued)

|    | AD              | AC               | AB           |
|----|-----------------|------------------|--------------|
| 1  | VSS             | RESET_IN_B       | BOOT_MODE0   |
| 2  | POR_B           | TEST_MODE        | BOOT_MODE1   |
| 3  | VDD3P0          | GND3P0           | NC           |
| 4  | VDD2P5          | GND2P5           | NC           |
| 5  | XTAL            | EXTAL            | NC           |
| 6  | VDD1P2          | GND1P2           | NC           |
| 7  | VDD1P8          | GND1P8           | NC           |
| 8  | USB_OTG_DP      | USB_OTG_DN       | NC           |
| 9  | USB_H1_VDDA25_1 | USB_OTG_VDDA25_1 | NC           |
| 10 | USB_H1_DP       | USB_H1_DN        | NC           |
| 11 | USB_OTG_VDDA33  | USB_H1_VDDA33    | NC           |
| 12 | DISP_WR         | DISP_BUSY        | NC           |
| 13 | DISP_RD         | DISP_RS          | NC           |
| 14 | DISP_CS         | DISP_RESET       | NC           |
| 15 | SD3_WP          | SD3_D0           | NC           |
| 16 | SD3_CLK         | SD3_D1           | NC           |
| 17 | SD3_CMD         | SD3_D2           | NC           |
| 18 | VSS             | VSS              | NC           |
| 19 | DRAM_D17        | DRAM_D16         | NC           |
| 20 | DRAM_D19        | DRAM_D18         | NC           |
| 21 | NVCC_EMI_DRAM   | NVCC_EMI_DRAM    | NC           |
| 22 | DRAM_D21        | DRAM_D20         | NC           |
| 23 | DRAM_D23        | DRAM_D22         | DRAM_SDQS2   |
| 24 | VSS             | DRAM_DQM2        | DRAM_SDQS2_B |
|    | AD              | AC               | AB           |

### 5.1.3 416 MAPBGA 13 x 13 Power Rails

Table 80. 416 MAPBGA 13x13 Ground, Power, Sense, and Reference Contact Signals

| Pin Name      | Ball Number                                                                         | Comments |
|---------------|-------------------------------------------------------------------------------------|----------|
| GND_DCDC      | W5                                                                                  | —        |
| NVCC_EIM      | L7, M7, M8                                                                          | —        |
| NVCC_EMI_DRAM | A21, AA21, AA23, AA24, AC21, AD21, B21, D21, D23, D24, K21, K23, K24, R21, R23, R24 | —        |
| NVCC_EPDC     | M10, N10, P10, R10, U10                                                             | —        |
| NVCC_JTAG     | U9                                                                                  | —        |
| NVCC_KEYPAD   | N8                                                                                  | —        |
| NVCC_LCD      | U11                                                                                 | —        |
| NVCC_MISC     | P8                                                                                  | —        |
| NVCC_NANDEF   | V9, V10                                                                             | —        |
| NVCC_RESET    | V8                                                                                  | —        |
| NVCC_SD1      | T7                                                                                  | —        |
| NVCC_SD2      | U8                                                                                  | —        |
| NVCC_SPI      | R7                                                                                  | —        |

**Table 80. 416 MAPBGA 13x13 Ground, Power, Sense, and Reference Contact Signals (continued)**

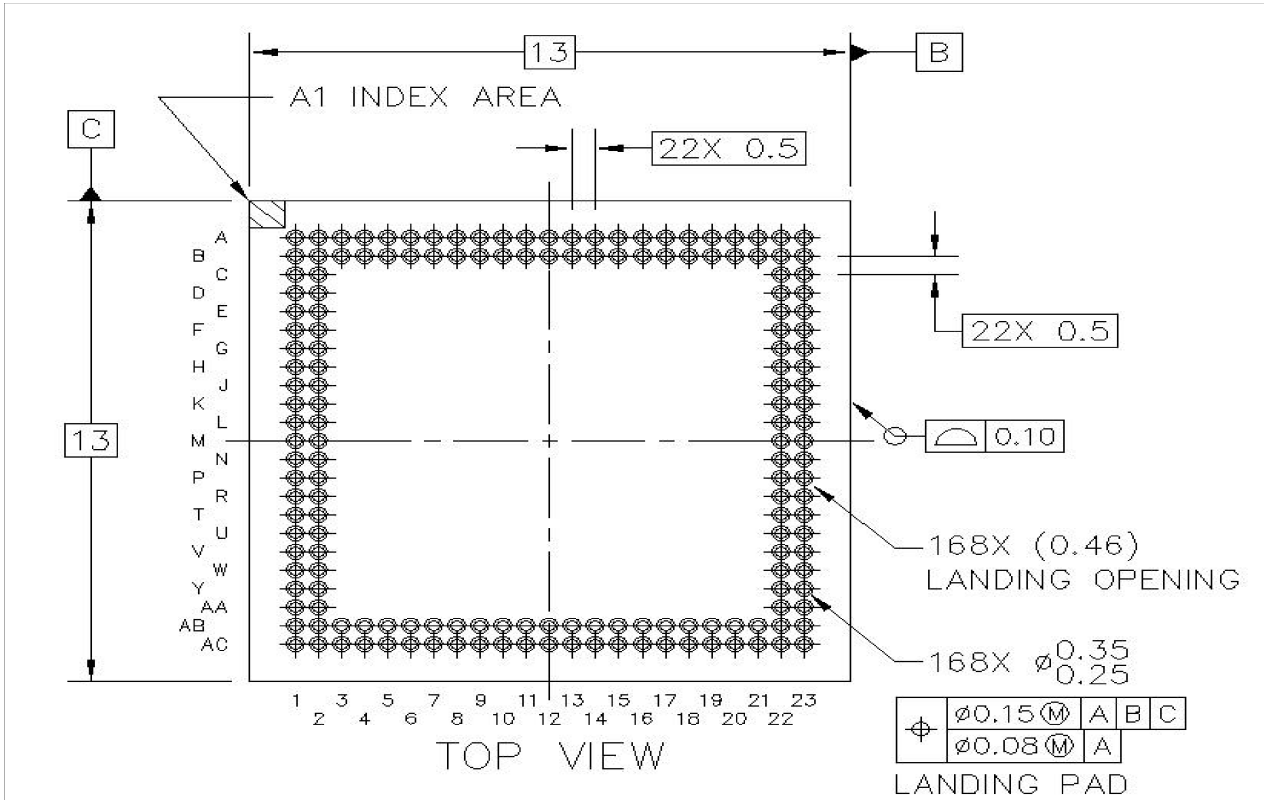
|                |                                                                                                                                                                                                                                                                                                          |                                                                                                              |
|----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------------------------------|
| NVCC_SRTC      | AA1                                                                                                                                                                                                                                                                                                      | —                                                                                                            |
| NVCC_SSI       | R8                                                                                                                                                                                                                                                                                                       | —                                                                                                            |
| NVCC_UART      | T8                                                                                                                                                                                                                                                                                                       | —                                                                                                            |
| USB_H1_VDDA25  | AD9                                                                                                                                                                                                                                                                                                      | Note that on the 416 MAPBGA package, USB_OTG_VDDA25 and USB_H1_VDDA25 are shorted together on the substrate. |
| USB_H1_VDDA33  | AC11                                                                                                                                                                                                                                                                                                     | Note that on the 416 MAPBGA package, USB_OTG_VDDA33 and USB_H1_VDDA33 are shorted together on the substrate. |
| USB_OTG_VDDA25 | AC9                                                                                                                                                                                                                                                                                                      | Note that on the 416 MAPBGA package, USB_OTG_VDDA25 and USB_H1_VDDA25 are shorted together on the substrate. |
| USB_OTG_VDDA33 | AD11                                                                                                                                                                                                                                                                                                     | Note that on the 416 MAPBGA package, USB_OTG_VDDA33 and USB_H1_VDDA33 are shorted together on the substrate. |
| VCC            | H14, H15, H16, H17, J17, K14, K15, K17, L15                                                                                                                                                                                                                                                              | —                                                                                                            |
| VDD_DCDCI      | Y6                                                                                                                                                                                                                                                                                                       | —                                                                                                            |
| VDD_DCDCO      | Y5                                                                                                                                                                                                                                                                                                       | —                                                                                                            |
| VDD1P2         | AD6                                                                                                                                                                                                                                                                                                      | —                                                                                                            |
| VDD1P8         | AD7                                                                                                                                                                                                                                                                                                      | —                                                                                                            |
| VDD2P5         | AD4                                                                                                                                                                                                                                                                                                      | —                                                                                                            |
| VDD3P0         | AD3                                                                                                                                                                                                                                                                                                      | —                                                                                                            |
| VDDA           | P17, R17                                                                                                                                                                                                                                                                                                 | —                                                                                                            |
| VDDAL1         | P15, R15                                                                                                                                                                                                                                                                                                 | —                                                                                                            |
| VDDGP          | G10, G8, G9, H10, H11, H8, H9, J8, K10, K11, K7, K8, L10, L11, L8                                                                                                                                                                                                                                        | —                                                                                                            |
| VDDO25         | N23                                                                                                                                                                                                                                                                                                      | —                                                                                                            |
| VSS            | A1, A18, A24, AA11, AA2, AA9, AC18, AC3, AC4, AC6, AC7, AD1, AD18, AD24, B18, G20, G21, G23, H12, H13, K12, K13, L12, L13, L14, L17, M11, M14, M15, M17, M18, M20, M21, N11, N14, N15, N17, P11, P12, P13, P14, R11, R12, R13, R14, T17, T18, U12, U13, U14, U15, U16, U17, U18, V17, V18, V20, V21, V23 | —                                                                                                            |

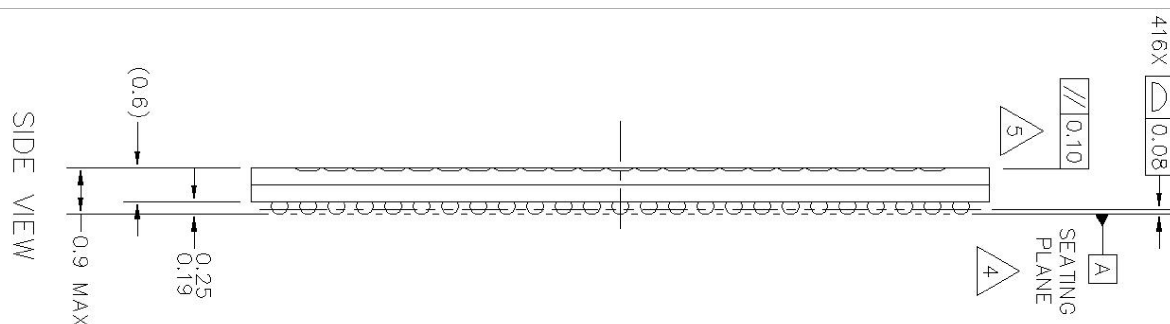
## 5.2 13 x 13 mm, 0.5 mm Pitch, 416 Pin PoPBGA Package Information

This section contains the outline drawing, signal assignment map, ground, power, reference ID (by ball grid location) for the 13 x 13 mm, 0.5 mm pitch, 416 pin PoPBGA package.

### 5.2.1 416 PoPBGA 13 x 13 mm Package Views

Figure shows the top view of the 416 PoPBGA 13 x 13 package, Figure 63 shows the side view of the package, and Figure 64 shows the bottom view of the package.

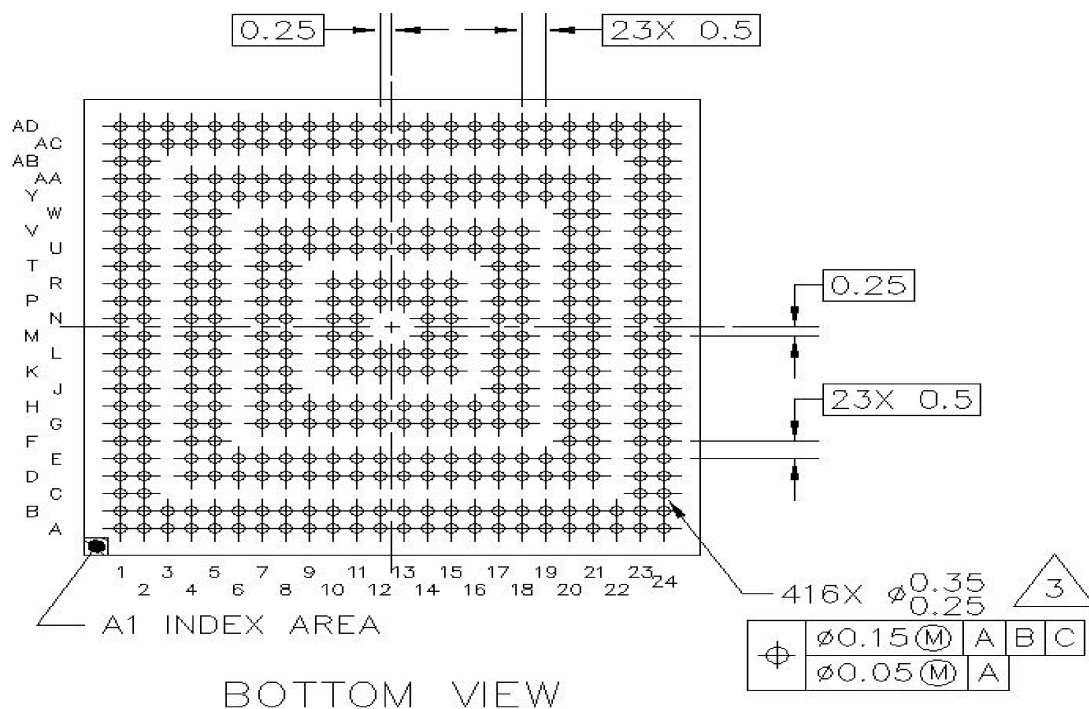




## NOTES:

1. ALL DIMENSIONS IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. MAXIMUM SOLDER BALL DIAMETER MEASURED PARALLEL TO DATUM A.
4. DATUM A, THE SEATING PLANE, IS DETERMINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
5. PARALLELISM MEASUREMENT SHALL EXCLUDE ANY EFFECT OF MARK ON TOP SURFACE OF PACKAGE.

**Figure 63. 416 PoPBGA 13 x 13 Package Side View**



**Figure 64. 416 PoPBGA 13 x 13 mm Package Bottom View**

The following notes apply to [Figure](#) , [Figure 63](#), and [Figure 64](#):

- Unless otherwise specified dimensions are in millimeters.

- All dimensions and tolerances conform to ASME Y14.5M-1994.
- Parallelism measurement shall exclude any effect of mark on top surface of package.

## 5.2.2 416 PoPBGA 13 x 13 mm, 0.5 Pitch Ball Map

Table 81 shows the 416 PoPBGA 13 x 13 mm ball map.

Table 81. 416 PoPBGA 13 x 13 mm Ball Map

| F             | E             | D             | C         | B               | A               |    |
|---------------|---------------|---------------|-----------|-----------------|-----------------|----|
| SD2_D2        | SD2_CLK       | SD2_D0        | UART2_RXD | UART2_TXD       | VSS             | 1  |
| SD2_D3        | SD2_D5        | SD2_D1        | UART2_RTS | UART2_CTS       | UART1_RXD       | 2  |
| NC            | NC            | NC            | NC        | UART1_RTS       | UART1_TXD       | 3  |
| SD2_D7        | UART3_RXD     | UART3_TXD     | NC        | UART1_CTS       | I2C3_SCL        | 4  |
| NVCC_EMI_DRAM | NVCC_EMI_DRAM | UART4_RXD     | NC        | I2C3_SDA        | I2C2_SCL        | 5  |
| NC            | NVCC_EMI_DRAM | UART4_TXD     | NC        | I2C2_SDA        | I2C1_SCL        | 6  |
| NC            | NVCC_EMI_DRAM | KEY_ROW2      | NC        | I2C1_SDA        | KEY_ROW3        | 7  |
| NC            | VSS           | EPITO         | NC        | KEY_ROW1        | KEY_ROW0        | 8  |
| NC            | VSS           | WDOG          | NC        | KEY_COL2        | KEY_COL0        | 9  |
| NC            | DRAM_D31      | PWM2          | NC        | KEY_COL3        | KEY_COL1        | 10 |
| NC            | DRAM_D30      | PWM1          | NC        | EIM_RDY         | EIM_WAIT        | 11 |
| NC            | DRAM_D29      | OWIRE         | NC        | EIM_OE          | EIM_BCLK        | 12 |
| NC            | DRAM_D28      | EIM_CRE       | NC        | EIM_LBA         | EIM_DA14        | 13 |
| NC            | DRAM_D26      | EIM_EB1       | NC        | EIM_RW          | EIM_DA10        | 14 |
| NC            | DRAM_D25      | EIM_EB0       | NC        | EIM_DA15        | EIM_DA13        | 15 |
| NC            | DRAM_SDQS3    | EIM_CS2       | NC        | EIM_DA11        | EIM_DA12        | 16 |
| NC            | VSS           | EIM_CS1       | NC        | EIM_DA7         | EIM_DA9         | 17 |
| NC            | VSS           | EPDC_SDCE5    | NC        | EIM_DA6         | EIM_DA8         | 18 |
| NC            | DRAM_D15      | POP_NAND_VCC  | NC        | POP_LPDDR2_1.8V | POP_EMMC_RST    | 19 |
| DRAM_D13      | DRAM_D14      | POP_NAND_VCC  | NC        | POP_LPDDR2_1.8V | POP_LPDDR2_1.8V | 20 |
| VSS           | VSS           | NVCC_EMI_DRAM | NC        | NVCC_EMI_DRAM   | NVCC_EMI_DRAM   | 21 |
| NC            | NC            | NC            | NC        | EIM_DA5         | EIM_DA3         | 22 |
| EPDC_PWRCTRL2 | EPDC_PWRCOM   | NVCC_EMI_DRAM | EIM_DA2   | EIM_DA0         | EIM_DA4         | 23 |
| EPDC_PWRSTAT  | EPDC_PWRCTRL0 | NVCC_EMI_DRAM | EIM_DA1   | EIM_CS0         | VSS             | 24 |

## Table 81. 416 PoPBGA 13 x 13 mm Ball Map (continued)

| N               | M               | L             | K             | J          | H          | G             |
|-----------------|-----------------|---------------|---------------|------------|------------|---------------|
| SD1_CMD         | SD1_CLK         | ECSP12_SCLK   | ECSP12_SS0    | CSPI_MOSI  | CSPI_SCLK  | SD2_CMD       |
| SD1_D1          | SD1_D2          | ECSP12_MISO   | ECSP12_MOSI   | CSPI_SS0   | CSPI_MISO  | SD2_D4        |
| NC              | NC              | NC            | NC            | NC         | NC         | NC            |
| ECSP11_MOSI     | ECSP11_SCLK     | ECSP11_SS0    | ECSP11_MISO   | SD2_CD     | SD2_D6     | SD2_WP        |
| POP_LPDDR2_1.8V | POP_LPDDR2_1.8V | DRAM_A6       | DRAM_A7       | DRAM_A8    | DRAM_A9    | NVCC_EMI_DRAM |
| NC              | NC              | NC            | NC            | NC         | NC         | NC            |
| NVCC_EIM        | NVCC_EIM        | VDDGP         | VDDGP         | VDDGP      | VDDGP      | NVCC_EMI_DRAM |
| NVCC_KEYPAD     | NVCC_EIM        | VDDGP         | VDDGP         | VDDGP      | VDDGP      | VDDGP         |
| NC              | NC              | NC            | NC            | NC         | VDDGP      | VDDGP         |
| NVCC_EPDC       | NVCC_EPDC       | VDDGP         | VDDGP         | NC         | VDDGP      | VDDGP         |
| VSS             | VSS             | VSS           | VSS           | NC         | VSS        | VSS           |
| NC              | NC              | VSS           | VSS           | NC         | VSS        | VSS           |
| NC              | NC              | VSS           | VSS           | NC         | VSS        | VSS           |
| VSS             | VSS             | VSS           | VCC           | NC         | VCC        | DRAM_D27      |
| VSS             | VSS             | VCC           | VCC           | NC         | VCC        | DRAM_D24      |
| NC              | NC              | NC            | NC            | NC         | VCC        | DRAM_SDQS3_B  |
| VSS             | VSS             | VSS           | VCC           | VCC        | VCC        | DRAM_DQM3     |
| DRAM_SDQS0      | DRAM_DQM0       | DRAM_DQM1     | DRAM_SDQS1_B  | DRAM_D8    | DRAM_D11   | DRAM_D12      |
| NC              | NC              | NC            | NC            | NC         | NC         | NC            |
| NVCC_EMI_DRAM   | NVCC_EMI_DRAM   | NVCC_EMI_DRAM | NVCC_EMI_DRAM | DRAM_SDQS1 | DRAM_D9    | DRAM_D10      |
| EPDC_D14        | EPDC_D13        | EPDC_PWRCTRL3 | EPDC_SDCE4    | EPDC_SDCE3 | EPDC_SDCE2 | VSS           |
| NC              | NC              | NC            | NC            | NC         | NC         | NC            |
| VDDO25          | VREF            | EPDC_GDRL     | EPDC_PWRCTRL1 | EPDC_D12   | EPDC_SDSHR | VSS           |
| EPDC_SDCE0      | EPDC_SDLE       | EPDC_SDCLKN   | EPDC_SDCLK    | EPDC_GDOE  | EPDC_VCOM0 | EPDC_GDCLK    |

Table 81. 416 PoPBGA 13 x 13 mm Ball Map (continued)

| Y             | W             | V             | U          | T          | R             | P                |
|---------------|---------------|---------------|------------|------------|---------------|------------------|
| CKIL          | PMIC_ON_REQ   | SD3_D0        | SD3_D5     | SD3_CLK    | SD3_D2        | SD3_D4           |
| ECKIL         | PMIC_STBY_REQ | SD3_D1        | SD3_D3     | SD3_CMD    | SD3_D6        | SD1_D0           |
| NC            | NC            | NC            | NC         | NC         | NC            | NC               |
| JTAG_TMS      | JTAG_TCK      | JTAG_TDO      | SD3_D7     | SD3_WP     | SD1_D3        | DRAM_CALIBRATION |
| VDD_DCDCO     | GND_DCDC      | JTAG_MOD      | DRAM_CS0   | DRAM_SDCKE | DRAM_SDCLK_0  | DRAM_SDCLK_0_B   |
| VDD_DCDCI     | NC            | NC            | NC         | NC         | NC            | NC               |
| DRAM_A1       | NC            | DRAM_A0       | DRAM_CS1   | NVCC_SD1   | NVCC_SPI      | DRAM_A5          |
| DRAM_A2       | NC            | NVCC_RESET    | NVCC_SD2   | NVCC_UART  | NVCC_SSI      | NVCC_MISC        |
| DRAM_A3       | NC            | NVCC_NANDF    | NVCC_JTAG  | NC         | NC            | NC               |
| DRAM_A4       | NC            | NVCC_NANDF    | NVCC_EPDC  | NC         | NVCC_EPDC     | NVCC_EPDC        |
| DRAM_D17      | NC            | DRAM_D16      | NVCC_LCD   | NC         | VSS           | VSS              |
| DRAM_D19      | NC            | DRAM_D18      | VSS        | NC         | VSS           | VSS              |
| DRAM_D21      | NC            | DRAM_D20      | VSS        | NC         | VSS           | VSS              |
| DRAM_D23      | NC            | DRAM_D22      | VSS        | NC         | VSS           | VSS              |
| DRAM_SDQS2    | NC            | DRAM_SDQS2_B  | VSS        | NC         | VDDAL1        | VDDAL1           |
| DRAM_DQM2     | NC            | DRAM_D0       | VSS        | NC         | NC            | NC               |
| DRAM_D1       | NC            | DRAM_D2       | VSS        | VSS        | VDDA          | VDDA             |
| NVCC_EMI_DRAM | NC            | NVCC_EMI_DRAM | DRAM_D5    | DRAM_D6    | DRAM_D7       | DRAM_SDQS0_B     |
| NVCC_EMI_DRAM | NC            | NC            | NC         | NC         | NC            | NC               |
| NVCC_EMI_DRAM | NVCC_EMI_DRAM | NVCC_EMI_DRAM | DRAM_D3    | DRAM_D4    | NVCC_EMI_DRAM | NVCC_EMI_DRAM    |
| EPDC_BDR0     | EPDC_VCOM1    | EPDC_SDOE     | EPDC_SDOEZ | EPDC_D9    | EPDC_D11      | EPDC_D15         |
| NC            | NC            | NC            | NC         | NC         | NC            | NC               |
| EPDC_BDR1     | EPDC_D8       | EPDC_D10      | EPDC_D2    | EPDC_D7    | EPDC_SDOED    | EPDC_GDSP        |
| EPDC_D0       | EPDC_D1       | EPDC_D3       | EPDC_D6    | EPDC_D5    | EPDC_D4       | EPDC_SDCE1       |

Table 81. 416 PoPBGA 13 x 13 mm Ball Map (continued)

| AD         | AC         | AB         | AA              |
|------------|------------|------------|-----------------|
| VSS        | RESET_IN_B | BOOT_MODE0 | NVCC_SRTC       |
| POR_B      | TEST_MODE  | BOOT_MODE1 | VSS             |
| VDD3P0     | VSS        | NC         | NC              |
| VDD2P5     | VSS        | NC         | JTAG_TDI        |
| XTAL       | EXTAL      | NC         | JTAG_TRSTB      |
| VDD1P2     | VSS        | NC         | CKIH            |
| VDD1P8     | VSS        | NC         | GND_KEL         |
| USB_OTG_DP | USB_OTG_DN | NC         | USB_OTG_RREFEXT |
| USB_VDDA25 | USB_VDDA25 | NC         | VSS             |
| USB_H1_DP  | USB_H1_DN  | NC         | USB_H1_RREFEXT  |
| USB_VDDA33 | USB_VDDA33 | NC         | VSS             |
| SSI_RXC    | SSI_TXFS   | NC         | USB_OTG_ID      |
| SSI_RXFS   | SSI_TXC    | NC         | USB_OTG_VBUS    |
| SSI_TXD    | SSI_RXD    | NC         | USB_OTG_GPANAIO |
| DISP_D2    | DISP_D3    | NC         | CHGR_DET_B      |
| DISP_D6    | DISP_D1    | NC         | USB_H1_VBUS     |
| DISP_      | DISP_D0    | NC         | USB_H1_GPANAIO  |
| VSS        | VSS        | NC         | VSS             |
| DISP_D11   | DISP_D7    | NC         | DISP_RESET      |
| DISP_WR    | DISP_D9    | NC         | DISP_RD         |
| DISP_D15   | DISP_CS    | NC         | DISP_BUSY       |
| DISP_D10   | DISP_D12   | NC         | NC              |
| DISP_RS    | DISP_D13   | DISP_D14   | POP_LPDDR2_ZQ1  |
| VSS        | DISP_D4    | DISP_D5    | POP_LPDDR2_ZQ0  |

### 5.2.3 416 PoPBGA 13 x 13 mm Power Rails

Table 82 shows the device connection list for ground, power, sense, and reference contact signals. Table 85 displays an alpha-sorted list of the signal assignments including power rails and associated power supplies.

Table 82. 416 PoPBGA 13 x 13 mm Ground, Power, Sense, and Reference Contact Signals

| Pin Name      | Ball Number                                                                                                 | Comments                                                                                |
|---------------|-------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------|
| GND_DCDC      | W5                                                                                                          | —                                                                                       |
| NVCC_EIM      | N7 M7 M8                                                                                                    | —                                                                                       |
| NVCC_EMI_DRAM | A21, B21, D21, D23, D24, E5, E6, E7, F5, G5, G7, K20, L20, M20, N20, P20, R20, V18, V20, W20, Y18, Y19, Y20 | These are the 1.2V supply to both the i.MX50 DRAM controller as well as the PoP LPDDR2. |
| NVCC_EPDC     | M10, N10, P10, R10, U10                                                                                     | —                                                                                       |
| NVCC_JTAG     | U9                                                                                                          | —                                                                                       |
| NVCC_KEYPAD   | N8                                                                                                          | —                                                                                       |
| NVCC_LCD      | U11                                                                                                         | —                                                                                       |
| NVCC_MISC     | P8                                                                                                          | —                                                                                       |
| NVCC_NANDEF   | V9, V10                                                                                                     | —                                                                                       |

**Table 82. 416 PoPBGA 13 x 13 mm Ground, Power, Sense, and Reference Contact Signals (continued)**

|                 |                                             |                                                                                                                                                                                                      |
|-----------------|---------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NVCC_RESET      | V8                                          | —                                                                                                                                                                                                    |
| NVCC_SD1        | T7                                          | —                                                                                                                                                                                                    |
| NVCC_SD2        | U8                                          | —                                                                                                                                                                                                    |
| NVCC_SPI        | R7                                          | —                                                                                                                                                                                                    |
| NVCC_SRTC       | AA1                                         | —                                                                                                                                                                                                    |
| NVCC_SSI        | R8                                          | —                                                                                                                                                                                                    |
| NVCC_UART       | T8                                          | —                                                                                                                                                                                                    |
| POP_EMMC_RST    | A19                                         | This is PoP eMMC 4.4 NAND Reset input pin. This pin does not connect to the i.MX50. If using eMMC 4.4 NAND, this pin can be connected to a GPIO. For non 4.4 eMMC applications, leave floating.      |
| POP_LPDDR2_1.8V | A20, B19, B20, M5, N5                       | This is the 1.8V supply for the PoP LPDDR2. These pins do not connect to the i.MX50.                                                                                                                 |
| POP_LPDDR2_ZQ0  | AA24                                        | This is the PoP LPDDR2 ZQ0 pin. This pin does not connect to the i.MX50. This should be connected on the PCB to a 240 $\Omega$ 1% resistor to ground                                                 |
| POP_LPDDR2_ZQ1  | AA23                                        | This is the PoP LPDDR2 ZQ1 pin. This pin does not connect to the i.MX50. If used, this should be connected on the PCB to a 240 $\Omega$ 1% resistor to ground                                        |
| POP_NAND_VCC    | D19, D20                                    | This is the 3.3V I/O and memory supply for the PoP eMMC NAND. Note that because the eMMC memory and I/O domains are shorted together, it is not possible to support 1.8 V I/O for the PoP eMMC NAND. |
| USB_VDDA25      | AC9, AD9                                    | Note that on the PoPBGA package, USB_OTG_VDDA25 and USB_H1_VDDA25 are shorted together.                                                                                                              |
| USB_VDDA33      | AC11, AD11                                  | Note that on the PoPBGA package, USB_OTG_VDDA33 and USB_H1_VDDA33 are shorted together.                                                                                                              |
| VCC             | H14, H15, H16, H17, J17, K14, K15, K17, L15 | —                                                                                                                                                                                                    |
| VDD_DCDCI       | Y6                                          | —                                                                                                                                                                                                    |
| VDD_DCDCO       | Y5                                          | —                                                                                                                                                                                                    |
| VDD1P2          | AD6                                         | —                                                                                                                                                                                                    |
| VDD1P8          | AD7                                         | —                                                                                                                                                                                                    |

**Table 82. 416 PoPBGA 13 x 13 mm Ground, Power, Sense, and Reference Contact Signals (continued)**

|        |                                                                                                                                                                                                                                                                                                         |   |
|--------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---|
| VDD2P5 | AD4                                                                                                                                                                                                                                                                                                     | — |
| VDD3P0 | AD3                                                                                                                                                                                                                                                                                                     | — |
| VDDA   | P17, R17                                                                                                                                                                                                                                                                                                | — |
| VDDAL1 | P15, R15                                                                                                                                                                                                                                                                                                | — |
| VDDGP  | G10, G8, G9, H10, H7, H8, H9, J7, J8, K10, K7, K8, L10, L7, L8                                                                                                                                                                                                                                          | — |
| VDDO25 | N23                                                                                                                                                                                                                                                                                                     | — |
| VSS    | A1, A24, AA11, AA18, AA2, AA9, AC18, AC3, AC4, AC6, AC7, AD1, AD18, AD24, E17, E18, E21, E8, E9, F21, G11, G12, G13, G21, G23, H11, H12, H13, K11, K12, K13, L11, L12, L13, L14, L17, M11, M14, M15, M17, N11, N14, N15, N17, P11, P12, P13, P14, R11, R12, R13, R14, T17, U12, U13, U14, U15, U16, U17 | — |

## 5.3 17 x 17 mm, 0.8 mm Pitch, 400 Pin MAPBGA Package Information

This section contains the outline drawing, signal assignment map, ground, power, reference ID (by ball grid location) for the 17 x 17 mm, 0.8 mm pitch, 400 pin MAPBGA package.

### 5.3.1 400 MAPBGA 17 x 17 mm Package Views

Figure 65 shows the top view of the 17 x 17 mm package, Figure 66 shows the bottom view of the package, and Figure 67 shows the side view of the package.

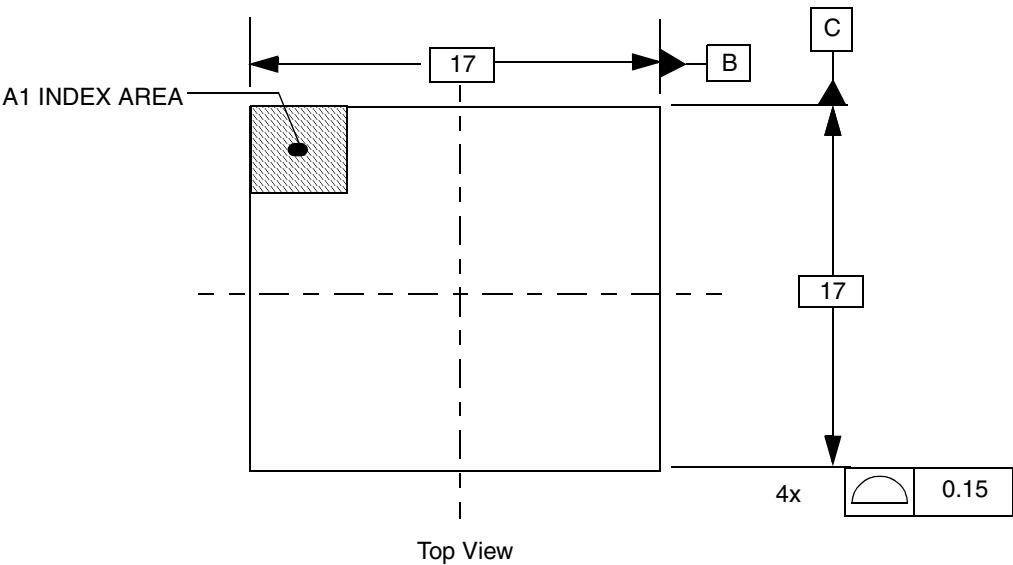


Figure 65. 400 MAPBGA 17x17 mm Package Top view

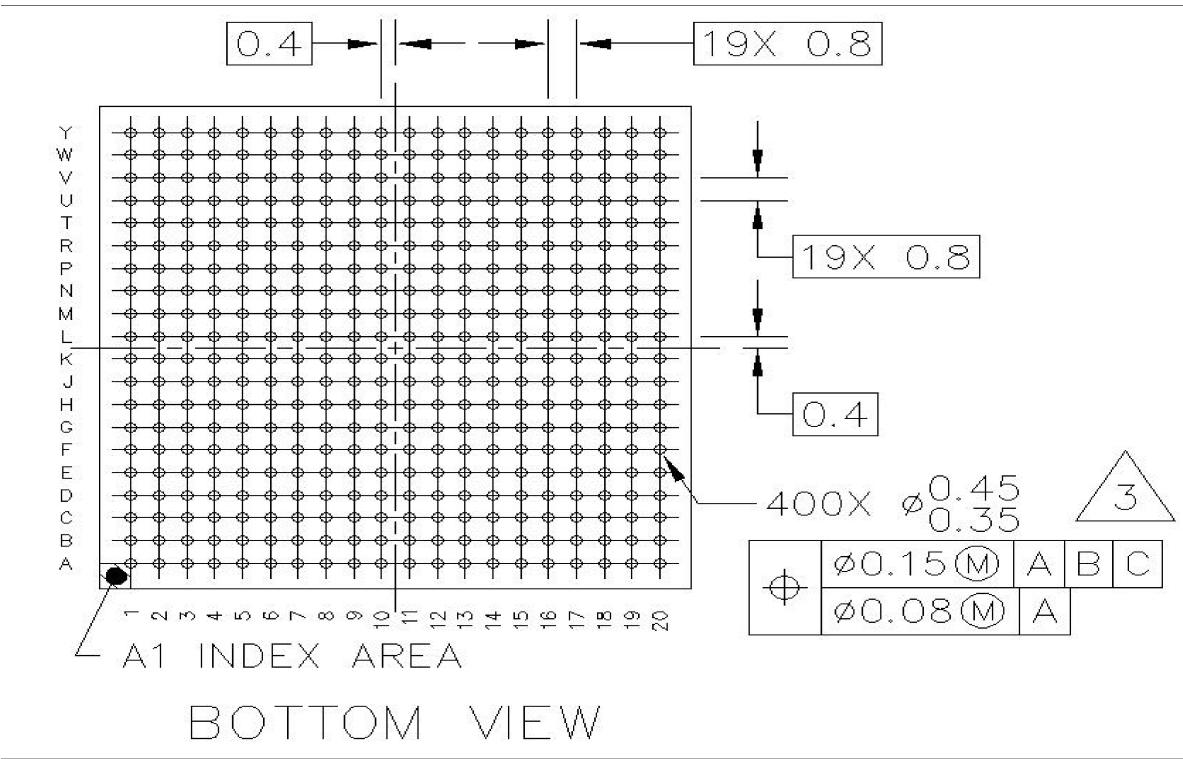
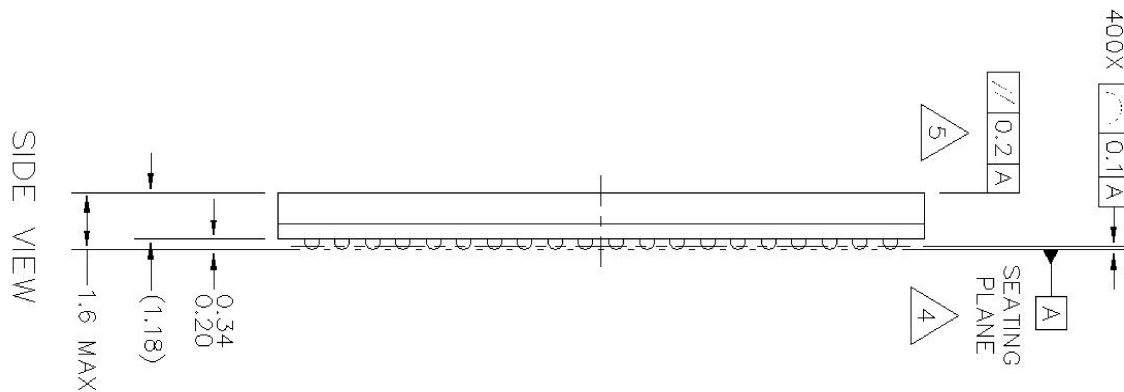


Figure 66. 400 MAPBGA 17x17 mm Package Bottom View



## NOTES:

1. ALL DIMENSIONS IN MILLIMETERS.

2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

3. MAXIMUM SOLDER BALL DIAMETER MEASURED PARALLEL TO DATUM A.

4. DATUM A, THE SEATING PLANE, IS DETERMINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.

5. PARALLELISM MEASUREMENT SHALL EXCLUDE ANY EFFECT OF MARK ON TOP SURFACE OF PACKAGE.

**Figure 67. 400 MAPBGA 17x17 mm Package Side View**

The following notes apply to [Figure 65](#), [Figure 66](#), and [Figure 67](#):

- Unless otherwise specified dimensions are in millimeters.
- All dimensions and tolerances conform to ASME Y14.5M-1994.
- Parallelism measurement shall exclude any effect of mark on top surface of package.

## 5.3.2 400 MAPBGA 17 x 17 mm Ball Map

[Table 83](#) shows the 400 MAPBGA 17 x 17 mm ball map.

**Table 83. 400 MAPBGA 17 x 17 mm Ball Map**

|   | 1        | 2        | 3       | 4       | 5        | 6        | 7       | 8          | 9       | 10        | 11         | 12         | 13         | 14         | 15        | 16       | 17       | 18       | 19       | 20       |
|---|----------|----------|---------|---------|----------|----------|---------|------------|---------|-----------|------------|------------|------------|------------|-----------|----------|----------|----------|----------|----------|
| A | NC       | EIM_RDY  | EIM_CRE | EIM_EB0 | EIM_BCLK | EIM_DA12 | EIM_DA8 | EPDC_SDSHR | EIM_DA4 | EPDC_GDRL | EPDC_GDCLK | EPDC_SDCE1 | EPDC_D5    | EPDC_D1    | EPDC_BDR0 | DRAM_D26 | DRAM_D28 | DRAM_D29 | DRAM_D30 | NC       |
| B | KEY_COLO | KEY_COL1 | EIM_OE  | EIM_EB1 | EIM_RW   | EIM_DA13 | EIM_DA9 | EIM_DA5    | EIM_DA1 | EIM_DA0   | EIM_CS0    | EPDC_SDCE0 | EPDC_SDCLK | EPDC_VCOM0 | EPDC_D0   | EPDC_D2  | DRAM_D27 | DRAM_D25 | DRAM_D24 | DRAM_D31 |

Table 83. 400 MAPBGA 17 x 17 mm Ball Map (continued)

| J              | H             | G            | F                | E             | D           | C            |
|----------------|---------------|--------------|------------------|---------------|-------------|--------------|
| UART1_CTS      | UART1_TXD     | I2C3_SCL     | I2C2_SCL         | I2C1_SCL      | KEY_ROW0    | KEY_COL2     |
| UART3_TXD      | UART4_TXD     | I2C3_SDA     | I2C2_SDA         | I2C1_SDA      | KEY_ROW1    | KEY_COL3     |
| UART4_RXD      | SSI_TXFS      | SSI_TXC      | SSI_RXD          | PWM2          | KEY_ROW3    | KEY_ROW2     |
| CSPI_SS0       | SSI_RXC       | SSI_TXD      | WDOG             | PWM1          | EIM_LBA     | EIM_WAIT     |
| NVCC_MISC      | NVCC_KEYPAD   | SSI_RXFS     | EPITO            | OWIRE         | EIM_DA15    | EIM_DA14     |
| VDDGP          | VDDGP         | VDDGP        | NVCC_EIM         | EPDC_SDCE5    | EIM_DA11    | EIM_DA10     |
| VDDGP          | VDDGP         | VDDGP        | NVCC_EIM         | EPDC_PWRCOM   | EIM_DA7     | EIM_DA6      |
| VSS            | VDDGP         | VDDGP        | NVCC_EIM         | EPDC_SDCE3    | EIM_DA3     | EIM_DA2      |
| VDDAL1         | VDDGP         | VDDGP        | NVCC_EPDC        | EPDC_PWRCTRL1 | EIM_CS2     | EIM_CS1      |
| VDDAL1         | VDDGP         | VDDGP        | NVCC_EPDC        | EPDC_PWRCTRL0 | EPDC_SDCE4  | EPDC_GDOE    |
| VDDA           | VSS           | VSS          | NVCC_EPDC        | EPDC_D14      | EPDC_GDSP   | EPDC_SDCE2   |
| VCC            | VSS           | VSS          | NVCC_EPDC        | EPDC_PWRCTRL2 | EPDC_SDCLKN | EPDC_PWRSTAT |
| VSS            | VSS           | VSS          | EPDC_D12         | EPDC_D15      | EPDC_D10    | EPDC_SDOE    |
| VSS            | VSS           | VSS          | EPDC_D11         | EPDC_D13      | EPDC_D7     | EPDC_D6      |
| NVCC_EMI_DRAM  | VSS           | EPDC_VCOM1   | EPDC_PWRCTRL3    | EPDC_D8       | EPDC_D4     | EPDC_SDLE    |
| NVCC_EMI_DRAM  | NVCC_EMI_DRAM | EPDC_SDOED   | EPDC_SDOEZ       | EPDC_D9       | EPDC_BDR1   | EPDC_D3      |
| DRAM_SDCLK_0   | DRAM_OPENFB   | DRAM_SDQS1   | DRAM_DQM1        | DRAM_D10      | DRAM_D8     | DRAM_D15     |
| DRAM_SDCLK_0_B | DRAM_OPEN     | DRAM_SDQS1_B | DRAM_D9          | DRAM_D13      | DRAM_D12    | DRAM_D14     |
| DRAM_A10       | DRAM_A11      | DRAM_A9      | DRAM_A13         | DRAM_A12      | DRAM_D11    | DRAM_SDQS3   |
| DRAM_SDBA0     | DRAM_SDBA1    | DRAM_CAS     | DRAM_CALIBRATION | DRAM_RAS      | DRAM_DQM3   | DRAM_SDQS3_B |

Table 83. 400 MAPBGA 17 x 17 mm Ball Map (continued)

| T            | R             | P             | N             | M             | L             | K             |
|--------------|---------------|---------------|---------------|---------------|---------------|---------------|
| SD2_CD       | SD1_CLK       | SD1_D1        | ECSP12_MOSI   | CSPI_SCLK     | UART2_TXD     | UART1_RXD     |
| SD2_WP       | SD1_D0        | SD1_D3        | ECSP11_SCLK   | ECSP12_SS0    | UART2_RXD     | UART1_RTS     |
| SD2_CLK      | SD2_D0        | SD1_D2        | ECSP11_SS0    | ECSP11_MISO   | CSPI_MOSI     | UART3_RXD     |
| SD2_D3       | SD2_D6        | SD1_CMD       | ECSP12_SCLK   | ECSP11_MOSI   | ECSP12_MISO   | CSPI_MISO     |
| VSS          | NVCC_SRTC     | NVCC_SD2      | NVCC_SD1      | NVCC_SPI      | NVCC_UART     | NVCC_SSI      |
| VDD_DCDCO    | GND_DCDC      | NVCC_RESET    | VSS           | VSS           | VDDGP         | VDDGP         |
| GND_KEL      | VDD_DCDCI     | VSS           | VSS           | VSS           | VSS           | VDDGP         |
| JTAG_MOD     | JTAG_TCK      | VSS           | VSS           | VSS           | VSS           | VSS           |
| JTAG_TDO     | JTAG_TMS      | NVCC_JTAG     | VSS           | VSS           | VSS           | VDDA          |
| CHGR_DET_B   | VSS           | NVCC_LCD      | VSS           | VCC           | VCC           | VCC           |
| DISP_D1      | VSS           | NVCC_NANDF    | VSS           | VCC           | VCC           | VCC           |
| DISP_CS      | VSS           | NVCC_NANDF    | VSS           | VSS           | VCC           | VCC           |
| DISP_D13     | VSS           | VSS           | VSS           | VSS           | VSS           | VSS           |
| DISP_RESET   | VSS           | VSS           | NVCC_EMI_DRAM | VSS           | VSS           | NVCC_EMI_DRAM |
| SD3_D7       | VSS           | NVCC_EMI_DRAM | NVCC_EMI_DRAM | VSS           | NVCC_EMI_DRAM | NVCC_EMI_DRAM |
| SD3_D2       | NVCC_EMI_DRAM | NVCC_EMI_DRAM | NVCC_EMI_DRAM | NVCC_EMI_DRAM | NVCC_EMI_DRAM | NVCC_EMI_DRAM |
| DRAM_A0      | DRAM_A4       | DRAM_CS0      | DRAM_DQM0     | DRAM_SDQS0    | VDDO25        | VREF          |
| DRAM_A1      | DRAM_SDCKE    | DRAM_CS1      | DRAM_D5       | DRAM_SDQS0_B  | DRAM_SDWE     | DRAM_SDODT0   |
| DRAM_SDQS2   | DRAM_D1       | DRAM_D3       | DRAM_D7       | DRAM_SDBA2    | DRAM_A6       | DRAM_A5       |
| DRAM_SDQS2_B | DRAM_D0       | DRAM_D2       | DRAM_D4       | DRAM_D6       | DRAM_A8       | DRAM_A7       |

## Table 83. 400 MAPBGA 17 x 17 mm Ball Map (continued)

| Y              | W               | V               | U              |
|----------------|-----------------|-----------------|----------------|
| NC             | SD2_D7          | SD2_CMD         | SD2_D1         |
| PMIC_STBY_REQ  | SD2_D2          | SD2_D4          | SD2_D5         |
| PMIC_ON_REQ    | RESET_IN_B      | BOOT_MODE0      | BOOT_MODE1     |
| CKIL           | ECKIL           | CKIH            | TEST_MODE      |
| POR_B          | VSS             | VDD2P5          | VDD3P0         |
| XTAL           | EXTAL           | VDD1P8          | VDD1P2         |
| USB_OTG_ID     | USB_OTG_RREFEXT | USB_OTG_GPANAIO | JTAG_TRSTB     |
| USB_OTG_DP     | USB_OTG_DN      | USB_OTG_VBUS    | JTAG_TDI       |
| USB_H1_VDDA25  | USB_OTG_VDDA25  | USB_H1_VBUS     | USB_H1_RREFEXT |
| USB_H1_DP      | USB_H1_DN       | DISP_WR         | USB_H1_GPANAIO |
| USB_OTG_VDDA33 | USB_H1_VDDA33   | DISP_D0         | DISP_BUSY      |
| DISP_RS        | DISP_D2         | DISP_RD         | DISP_D6        |
| DISP_D4        | DISP_D3         | DISP_D7         | DISP_D5        |
| SD3_CLK        | DISP_D11        | DISP_D12        | DISP_D14       |
| DISP_D15       | DISP_D8         | DISP_D9         | SD3_D3         |
| DISP_D10       | SD3_WP          | SD3_D1          | SD3_CMD        |
| SD3_D0         | SD3_D4          | SD3_D6          | SD3_D5         |
| DRAM_D17       | DRAM_D21        | DRAM_A3         | DRAM_A2        |
| DRAM_D16       | DRAM_D19        | DRAM_D18        | DRAM_D23       |
| NC             | DRAM_D20        | DRAM_D22        | DRAM_DQM2      |

### 5.3.3 400 MAPBGA 17 x 17 Power Rails

Table 84. 400 MAPBGA 17x17 Ground, Power, Sense, and Reference Contact Signals

| Pin Name       | Ball Number                                                                                                                                                                |
|----------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NC             | A1 Y1 A20 Y20                                                                                                                                                              |
| NVCC_EIM       | F6 F7 F8                                                                                                                                                                   |
| NVCC_EMI_DRAM  | K14 N14 J15 K15 L15 N15 P15 H16 J16 K16 L16 M16 N16 P16 R16                                                                                                                |
| NVCC_EPDC      | F9 F10 F11 F12                                                                                                                                                             |
| NVCC_JTAG      | P9                                                                                                                                                                         |
| NVCC_KEYPAD    | H5                                                                                                                                                                         |
| NVCC_LCD       | P10                                                                                                                                                                        |
| NVCC_MISC      | J5                                                                                                                                                                         |
| NVCC_NANDF     | P11 P12                                                                                                                                                                    |
| NVCC_RESET     | P6                                                                                                                                                                         |
| NVCC_SD1       | N5                                                                                                                                                                         |
| NVCC_SD2       | P5                                                                                                                                                                         |
| NVCC_SPI       | M5                                                                                                                                                                         |
| NVCC_SRTC      | R5                                                                                                                                                                         |
| NVCC_SSI       | K5                                                                                                                                                                         |
| NVCC_UART      | L5                                                                                                                                                                         |
| USB_H1_VDDA25  | Y9                                                                                                                                                                         |
| USB_H1_VDDA33  | W11                                                                                                                                                                        |
| USB_OTG_VDDA25 | W9                                                                                                                                                                         |
| USB_OTG_VDDA33 | Y11                                                                                                                                                                        |
| VCC            | K10 L10 M10 K11 L11 M11 J12 K12 L12                                                                                                                                        |
| VDD1P2         | U6                                                                                                                                                                         |
| VDD1P8         | V6                                                                                                                                                                         |
| VDD2P5         | V5                                                                                                                                                                         |
| VDD3P0         | U5                                                                                                                                                                         |
| VDDA           | K9 J11                                                                                                                                                                     |
| VDDAL1         | J9 J10                                                                                                                                                                     |
| VDDGP          | G6 H6 J6 K6 L6 G7 H7 J7 K7 G8 H8 G9 H9 G10 H10                                                                                                                             |
| VDDO25         | L17                                                                                                                                                                        |
| VSS            | T5 W5 M6 N6 L7 M7 N7 P7 J8 K8 L8 M8 N8 P8 L9 M9 N9 N10 R10 G11 H11 N11 R11 G12 H12 M12 N12 R12 G13 H13 J13 K13 L13 M13 N13 P13 R13 G14 H14 J14 L14 M14 P14 R14 H15 M15 R15 |

**Table 84. 400 MAPBGA 17x17 Ground, Power, Sense, and Reference Contact Signals (continued)**

|           |    |
|-----------|----|
| VDD_DCDCI | R7 |
| VDD_DCDCO | T6 |
| GND_DCDC  | R6 |

## 5.4 Signal Assignments

**Table 85. Alphabetical List of Signal Assignments**

| Pin Name   | 416<br>MAPBGA<br>Ball<br>Number | 416<br>PoPBGA<br>Ball<br>Number | 400<br>MAPBGA<br>Ball<br>Number | Pin Power<br>Domain             | Pad Type | IOMUX<br>MUX<br>CTL<br>After<br>Reset | Direction<br>After<br>Reset | IOMUX<br>PAD CTL<br>After<br>Reset |
|------------|---------------------------------|---------------------------------|---------------------------------|---------------------------------|----------|---------------------------------------|-----------------------------|------------------------------------|
| BOOT_MODE0 | AB1                             | AB1                             | V3                              | NVCC_RESET                      | LVIO     | ALT0                                  | IN                          | 100K PU                            |
| BOOT_MODE1 | AB2                             | AB2                             | U3                              | NVCC_RESET                      | LVIO     | ALT0                                  | IN                          | 100K PU                            |
| CHGR_DET_B | V11                             | AA15                            | T10                             | USB_H1_VDDA25,<br>USB_H1_VDDA33 | ANALOG25 | —                                     | OUT-OD                      | —                                  |
| CKIH       | AA6                             | AA6                             | V4                              | NVCC_JTAG                       | ANALOG   | —                                     | —                           | —                                  |
| CKIL       | Y1                              | Y1                              | Y4                              | NVCC_SRTC                       | ANALOG   | —                                     | —                           | —                                  |
| CSPI_MISO  | M5                              | H2                              | K4                              | NVCC_SPI                        | HVIO     | ALT1                                  | IN                          | Keeper                             |
| CSPI_MOSI  | M2                              | J1                              | L3                              | NVCC_SPI                        | HVIO     | ALT1                                  | IN                          | Keeper                             |
| CSPI_SCLK  | M1                              | H1                              | M1                              | NVCC_SPI                        | HVIO     | ALT1                                  | IN                          | Keeper                             |
| CSPI_SS0   | M4                              | J2                              | J4                              | NVCC_SPI                        | HVIO     | ALT1                                  | IN                          | Keeper                             |
| DISP_BUSY  | AC12                            | AA21                            | U11                             | NVCC_LCD                        | HVIO     | ALT1                                  | IN                          | Keeper                             |
| DISP_CS    | AD14                            | AC21                            | T12                             | NVCC_LCD                        | HVIO     | ALT3                                  | OUT-LO                      | 100K PU                            |
| DISP_D0    | AA12                            | AC17                            | V11                             | NVCC_LCD                        | HVIO     | ALT3                                  | OUT-LO                      | 100K PU                            |
| DISP_D1    | Y12                             | AC16                            | T11                             | NVCC_LCD                        | HVIO     | ALT3                                  | OUT-LO                      | 100K PU                            |
| DISP_D10   | Y17                             | AD22                            | Y16                             | NVCC_NANDF                      | HVIO     | ALT1                                  | IN                          | Keeper                             |
| DISP_D11   | V12                             | AD19                            | W14                             | NVCC_NANDF                      | HVIO     | ALT1                                  | IN                          | Keeper                             |
| DISP_D12   | V13                             | AC22                            | V14                             | NVCC_NANDF                      | HVIO     | ALT1                                  | IN                          | Keeper                             |
| DISP_D13   | V14                             | AC23                            | T13                             | NVCC_NANDF                      | HVIO     | ALT1                                  | IN                          | Keeper                             |
| DISP_D14   | V15                             | AB23                            | U14                             | NVCC_NANDF                      | HVIO     | ALT1                                  | IN                          | Keeper                             |
| DISP_D15   | V16                             | AD21                            | Y15                             | NVCC_NANDF                      | HVIO     | ALT1                                  | IN                          | Keeper                             |
| DISP_D2    | AA13                            | AD15                            | W12                             | NVCC_LCD                        | HVIO     | ALT3                                  | OUT-LO                      | 100K PU                            |
| DISP_D3    | Y13                             | AC15                            | W13                             | NVCC_LCD                        | HVIO     | ALT3                                  | OUT-LO                      | 100K PU                            |
| DISP_D4    | AA14                            | AC24                            | Y13                             | NVCC_LCD                        | HVIO     | ALT3                                  | OUT-LO                      | 100K PU                            |
| DISP_D5    | Y14                             | AB24                            | U13                             | NVCC_LCD                        | HVIO     | ALT3                                  | OUT-LO                      | 100K PU                            |

Table 85. Alphabetical List of Signal Assignments (continued)

| Pin Name         | 416<br>MAPBGA<br>Ball<br>Number | 416<br>PoPBGA<br>Ball<br>Number | 400<br>MAPBGA<br>Ball<br>Number | Pin Power<br>Domain | Pad Type      | IOMUX<br>MUX<br>CTL<br>After<br>Reset | Direction<br>After<br>Reset | IOMUX<br>PAD CTL<br>After<br>Reset |
|------------------|---------------------------------|---------------------------------|---------------------------------|---------------------|---------------|---------------------------------------|-----------------------------|------------------------------------|
| DISP_D6          | AA15                            | AD16                            | U12                             | NVCC_LCD            | HVIO          | ALT3                                  | OUT-LO                      | 100K PU                            |
| DISP_D7          | Y15                             | AC19                            | V13                             | NVCC_LCD            | HVIO          | ALT3                                  | OUT-LO                      | 100K PU                            |
| DISP_D8          | AA16                            | AD17                            | W15                             | NVCC_NANDF          | HVIO          | ALT1                                  | IN                          | Keeper                             |
| DISP_D9          | Y16                             | AC20                            | V15                             | NVCC_NANDF          | HVIO          | ALT1                                  | IN                          | Keeper                             |
| DISP_RD          | AD13                            | AA20                            | V12                             | NVCC_LCD            | HVIO          | ALT3                                  | OUT-LO                      | 100K PU                            |
| DISP_RESET       | AC14                            | AA19                            | T14                             | NVCC_LCD            | HVIO          | ALT1                                  | IN                          | Keeper                             |
| DISP_RS          | AC13                            | AD23                            | Y12                             | NVCC_LCD            | HVIO          | ALT3                                  | OUT-LO                      | 100K PU                            |
| DISP_WR          | AD12                            | AD20                            | V10                             | NVCC_LCD            | HVIO          | ALT3                                  | OUT-LO                      | 100K PU                            |
| DRAM_A0          | W20                             | V7                              | T17                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A1          | W21                             | Y7                              | T18                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A10         | K20                             | —                               | J19                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A11         | J20                             | —                               | H19                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A12         | H20                             | —                               | E19                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A13         | F21                             | —                               | F19                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A14         | F20                             | —                               | —                               | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A2          | Y20                             | Y8                              | U18                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A3          | Y21                             | Y9                              | V18                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A4          | AA20                            | Y10                             | R17                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A5          | P20                             | P7                              | K19                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A6          | P21                             | L5                              | L19                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A7          | N20                             | K5                              | K20                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A8          | N21                             | J5                              | L20                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_A9          | L21                             | H5                              | G19                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_CALIBRATION | L20                             | P4                              | F20                             | NVCC_EMI_DRAM       | DRAMCALI<br>B | —                                     | —                           | —                                  |
| DRAM_CAS         | J21                             | —                               | G20                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-HI                      | Keeper                             |
| DRAM_CS0         | T21                             | U5                              | P17                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-HI                      | Keeper                             |
| DRAM_CS1         | U21                             | U7                              | P18                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | OUT-HI                      | Keeper                             |
| DRAM_D0          | Y24                             | V16                             | R20                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | IN                          | Keeper                             |
| DRAM_D1          | Y23                             | Y17                             | R19                             | NVCC_EMI_DRAM       | DRAM          | ALT0                                  | IN                          | Keeper                             |

## Table 85. Alphabetical List of Signal Assignments (continued)

| Pin Name | 416<br>MAPBGA<br>Ball<br>Number | 416<br>PoPBGA<br>Ball<br>Number | 400<br>MAPBGA<br>Ball<br>Number | Pin Power<br>Domain | Pad Type | IOMUX<br>MUX<br>CTL<br>After<br>Reset | Direction<br>After<br>Reset | IOMUX<br>PAD CTL<br>After<br>Reset |
|----------|---------------------------------|---------------------------------|---------------------------------|---------------------|----------|---------------------------------------|-----------------------------|------------------------------------|
| DRAM_D10 | G24                             | G20                             | E17                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D11 | H23                             | H18                             | D19                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D12 | F23                             | G18                             | D18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D13 | F24                             | F20                             | E18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D14 | E24                             | E20                             | C18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D15 | E23                             | E19                             | C17                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D16 | AC19                            | V11                             | Y19                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D17 | AD19                            | Y11                             | Y18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D18 | AC20                            | V12                             | V19                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D19 | AD20                            | Y12                             | W19                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D2  | W23                             | V17                             | P20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D20 | AC22                            | V13                             | W20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D21 | AD22                            | Y13                             | W18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D22 | AC23                            | V14                             | V20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D23 | AD23                            | Y14                             | U19                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D24 | B23                             | G15                             | B19                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D25 | A23                             | E15                             | B18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D26 | A22                             | E14                             | A16                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D27 | B22                             | G14                             | B17                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D28 | B20                             | E13                             | A17                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D29 | A20                             | E12                             | A18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D3  | W24                             | U20                             | P19                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D30 | A19                             | E11                             | A19                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D31 | B19                             | E10                             | B20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D4  | V24                             | T20                             | N20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D5  | U23                             | U18                             | N18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D6  | T23                             | T18                             | M20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D7  | U24                             | R18                             | N19                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D8  | J23                             | J18                             | D17                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_D9  | H24                             | H20                             | F18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |

Table 85. Alphabetical List of Signal Assignments (continued)

| Pin Name       | 416<br>MAPBGA<br>Ball<br>Number | 416<br>PoPBGA<br>Ball<br>Number | 400<br>MAPBGA<br>Ball<br>Number | Pin Power<br>Domain | Pad Type | IOMUX<br>MUX<br>CTL<br>After<br>Reset | Direction<br>After<br>Reset | IOMUX<br>PAD CTL<br>After<br>Reset |
|----------------|---------------------------------|---------------------------------|---------------------------------|---------------------|----------|---------------------------------------|-----------------------------|------------------------------------|
| DRAM_DQM0      | T24                             | M18                             | N17                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_DQM1      | J24                             | L18                             | F17                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_DQM2      | AC24                            | Y16                             | U20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_DQM3      | B24                             | G17                             | D20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_OPEN      | J18                             | —                               | H18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_OPENFB    | H18                             | —                               | H17                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | IN                          | Keeper                             |
| DRAM_RAS       | H21                             | —                               | E20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | OUT-HI                      | Keeper                             |
| DRAM_SDBA0     | K18                             | —                               | J20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_SDBA1     | L18                             | —                               | H20                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_SDBA2     | N18                             | —                               | M19                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_SDCKE     | U20                             | T5                              | R18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_SDCLK_0   | N24                             | R5                              | J17                             | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_SDCLK_0_B | M24                             | P5                              | J18                             | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | OUT-HI                      | —                                  |
| DRAM_SDCLK_1   | T20                             | —                               | —                               | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_SDCLK_1_B | R20                             | —                               | —                               | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | OUT-HI                      | —                                  |
| DRAM_SDODT0    | G18                             | —                               | K18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_SDODT1    | R18                             | —                               | —                               | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | OUT-LO                      | Keeper                             |
| DRAM_SDQS0     | P23                             | N18                             | M17                             | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | IN                          | —                                  |
| DRAM_SDQS0_B   | P24                             | P18                             | M18                             | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | IN                          | —                                  |
| DRAM_SDQS1     | L23                             | J20                             | G17                             | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | IN                          | —                                  |
| DRAM_SDQS1_B   | L24                             | K18                             | G18                             | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | IN                          | —                                  |
| DRAM_SDQS2     | AB23                            | Y15                             | T19                             | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | IN                          | —                                  |
| DRAM_SDQS2_B   | AB24                            | V15                             | T20                             | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | IN                          | —                                  |
| DRAM_SDQS3     | C23                             | E16                             | C19                             | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | IN                          | —                                  |
| DRAM_SDQS3_B   | C24                             | G16                             | C20                             | NVCC_EMI_DRAM       | DRAMCLK  | ALT0                                  | IN                          | —                                  |
| DRAM_SDWE      | P18                             | —                               | L18                             | NVCC_EMI_DRAM       | DRAM     | ALT0                                  | OUT-HI                      | Keeper                             |
| ECKIL          | Y2                              | Y2                              | W4                              | NVCC_SRTC           | ANALOG   | —                                     | —                           | —                                  |
| ECSP11_MISO    | N7                              | K4                              | M3                              | NVCC_SPI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| ECSP11_MOSI    | N2                              | N4                              | M4                              | NVCC_SPI            | HVIO     | ALT1                                  | IN                          | Keeper                             |

**Table 85. Alphabetical List of Signal Assignments (continued)**

| Pin Name    | 416<br>MAPBGA<br>Ball<br>Number | 416<br>PoPBGA<br>Ball<br>Number | 400<br>MAPBGA<br>Ball<br>Number | Pin Power<br>Domain | Pad Type | IOMUX<br>MUX<br>CTL<br>After<br>Reset | Direction<br>After<br>Reset | IOMUX<br>PAD CTL<br>After<br>Reset |
|-------------|---------------------------------|---------------------------------|---------------------------------|---------------------|----------|---------------------------------------|-----------------------------|------------------------------------|
| ECSPI1_SCLK | N1                              | M4                              | N2                              | NVCC_SPI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| ECSPI1_SS0  | P7                              | L4                              | N3                              | NVCC_SPI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| ECSPI2_MISO | N5                              | L2                              | L4                              | NVCC_SPI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| ECSPI2_MOSI | P5                              | K2                              | N1                              | NVCC_SPI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| ECSPI2_SCLK | P4                              | L1                              | N4                              | NVCC_SPI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| ECSPI2_SS0  | N4                              | K1                              | M2                              | NVCC_SPI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EIM_BCLK    | A5                              | A12                             | A5                              | NVCC_EIM            | HVIO     | ALT0                                  | OUT-LO                      | 100K PU                            |
| EIM_CRE     | A3                              | D13                             | A3                              | NVCC_EIM            | HVIO     | ALT0                                  | OUT-LO                      | 100K PU                            |
| EIM_CS0     | B10                             | B24                             | B11                             | NVCC_EIM            | HVIO     | ALT0                                  | OUT-HI                      | 100K PU                            |
| EIM_CS1     | D10                             | D17                             | C9                              | NVCC_EIM            | HVIO     | ALT0                                  | OUT-HI                      | 100K PU                            |
| EIM_CS2     | E10                             | D16                             | D9                              | NVCC_EIM            | HVIO     | ALT0                                  | OUT-HI                      | 100K PU                            |
| EIM_DA0     | A9                              | B23                             | B10                             | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA1     | B9                              | C24                             | B9                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA10    | D7                              | A14                             | C6                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA11    | E7                              | B16                             | D6                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA12    | A6                              | A16                             | A6                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA13    | B6                              | A15                             | B6                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA14    | D6                              | A13                             | C5                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA15    | E6                              | B15                             | D5                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA2     | D9                              | C23                             | C8                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA3     | E9                              | A22                             | D8                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA4     | A8                              | A23                             | A9                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA5     | B8                              | B22                             | B8                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA6     | D8                              | B18                             | C7                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA7     | E8                              | B17                             | D7                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA8     | A7                              | A18                             | A7                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_DA9     | B7                              | A17                             | B7                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_EB0     | A4                              | D15                             | A4                              | NVCC_EIM            | HVIO     | ALT0                                  | OUT-HI                      | 100K PU                            |
| EIM_EB1     | B4                              | D14                             | B4                              | NVCC_EIM            | HVIO     | ALT0                                  | OUT-HI                      | 100K PU                            |
| EIM_LBA     | E5                              | B13                             | D4                              | NVCC_EIM            | HVIO     | ALT0                                  | OUT-HI                      | 100K PU                            |

Table 85. Alphabetical List of Signal Assignments (continued)

| Pin Name          | 416<br>MAPBGA<br>Ball<br>Number | 416<br>PoPBGA<br>Ball<br>Number | 400<br>MAPBGA<br>Ball<br>Number | Pin Power<br>Domain | Pad Type | IOMUX<br>MUX<br>CTL<br>After<br>Reset | Direction<br>After<br>Reset | IOMUX<br>PAD CTL<br>After<br>Reset |
|-------------------|---------------------------------|---------------------------------|---------------------------------|---------------------|----------|---------------------------------------|-----------------------------|------------------------------------|
| EIM_OE            | B3                              | B12                             | B3                              | NVCC_EIM            | HVIO     | ALT0                                  | OUT-HI                      | 100K PU                            |
| EIM_RDY           | A2                              | B11                             | A2                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EIM_RW            | B5                              | B14                             | B5                              | NVCC_EIM            | HVIO     | ALT0                                  | OUT-HI                      | 100K PU                            |
| EIM_WAIT          | D5                              | A11                             | C4                              | NVCC_EIM            | HVIO     | ALT0                                  | IN                          | 100K PU                            |
| EPDC_BDR0         | E20                             | Y21                             | A15                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_BDR1         | E21                             | Y23                             | D16                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D0           | A17                             | Y24                             | B15                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D1           | B17                             | W24                             | A14                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D10          | D15                             | V23                             | D13                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D11          | E15                             | R21                             | F14                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D12          | A14                             | J23                             | F13                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D13          | B14                             | M21                             | E14                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D14          | D14                             | N21                             | E11                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D15          | E14                             | P21                             | E13                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D2           | D17                             | U23                             | B16                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D3           | E17                             | V24                             | C16                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D4           | A16                             | R24                             | D15                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D5           | B16                             | T24                             | A13                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D6           | D16                             | U24                             | C14                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D7           | E16                             | T23                             | D14                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D8           | A15                             | W23                             | E15                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_D9           | B15                             | T21                             | E16                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_GDCLK        | A11                             | G24                             | A11                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_GDOE         | B11                             | J24                             | C10                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_GDRL         | A12                             | L23                             | A10                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_GDSP         | B12                             | P23                             | D11                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_PWRCOM       | G11                             | E23                             | E7                              | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_PWRCTRL<br>0 | G12                             | E24                             | E10                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_PWRCTRL<br>1 | G13                             | K23                             | E9                              | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |

## Table 85. Alphabetical List of Signal Assignments (continued)

| Pin Name       | 416<br>MAPBGA<br>Ball<br>Number | 416<br>PoPBGA<br>Ball<br>Number | 400<br>MAPBGA<br>Ball<br>Number | Pin Power<br>Domain | Pad Type | IOMUX<br>MUX<br>CTL<br>After<br>Reset | Direction<br>After<br>Reset | IOMUX<br>PAD CTL<br>After<br>Reset |
|----------------|---------------------------------|---------------------------------|---------------------------------|---------------------|----------|---------------------------------------|-----------------------------|------------------------------------|
| EPDC_PWRCTRL_2 | G14                             | F23                             | E12                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_PWRCTRL_3 | G15                             | L21                             | F15                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_PWRSTAT   | G16                             | F24                             | C12                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDCE0     | D13                             | N24                             | B12                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDCE1     | E13                             | P24                             | A12                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDCE2     | D12                             | H21                             | C11                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDCE3     | E12                             | J21                             | E8                              | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDCE4     | D11                             | K21                             | D10                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDCE5     | E11                             | D18                             | E6                              | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDCLK     | A13                             | K24                             | B13                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDCLKN    | B13                             | L24                             | D12                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDLE      | D18                             | M24                             | C15                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDOE      | E18                             | V21                             | C13                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDOED     | D19                             | R23                             | G16                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDOEZ     | E19                             | U21                             | F16                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_SDSHR     | A10                             | H23                             | A8                              | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_VCOM0     | G17                             | H24                             | B14                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPDC_VCOM1     | D20                             | W21                             | G15                             | NVCC_EPDC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EPITO          | G4                              | D8                              | F5                              | NVCC_MISC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| EXTAL          | AC5                             | AC5                             | W6                              | VDD2P5              | ANALOG   | —                                     | —                           | —                                  |
| GND_KEL        | AA7                             | AA7                             | T7                              | VDD2P5              | ANALOG   | —                                     | —                           | —                                  |
| I2C1_SCL       | E1                              | A6                              | E1                              | NVCC_MISC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| I2C1_SDA       | E2                              | B7                              | E2                              | NVCC_MISC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| I2C2_SCL       | F1                              | A5                              | F1                              | NVCC_MISC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| I2C2_SDA       | F2                              | B6                              | F2                              | NVCC_MISC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| I2C3_SCL       | G1                              | A4                              | G1                              | NVCC_MISC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| I2C3_SDA       | G2                              | B5                              | G2                              | NVCC_MISC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| JTAG_MOD       | V7                              | V5                              | T8                              | NVCC_JTAG           | GPIO     | ALT0                                  | IN                          | 100K PU                            |
| JTAG_TCK       | W4                              | W4                              | R8                              | NVCC_JTAG           | GPIO     | ALT0                                  | IN                          | 100K PD                            |

Table 85. Alphabetical List of Signal Assignments (continued)

| Pin Name      | 416<br>MAPBGA<br>Ball<br>Number | 416<br>PoPBGA<br>Ball<br>Number | 400<br>MAPBGA<br>Ball<br>Number | Pin Power<br>Domain | Pad Type | IOMUX<br>MUX<br>CTL<br>After<br>Reset | Direction<br>After<br>Reset | IOMUX<br>PAD CTL<br>After<br>Reset |
|---------------|---------------------------------|---------------------------------|---------------------------------|---------------------|----------|---------------------------------------|-----------------------------|------------------------------------|
| JTAG_TDI      | AA4                             | AA4                             | U8                              | NVCC_JTAG           | GPIO     | ALT0                                  | IN                          | 47K PU                             |
| JTAG_TDO      | U7                              | V4                              | T9                              | NVCC_JTAG           | GPIO     | ALT0                                  | OUT-LO                      | Keeper                             |
| JTAG_TMS      | Y4                              | Y4                              | R9                              | NVCC_JTAG           | GPIO     | ALT0                                  | IN                          | 47K PU                             |
| JTAG_TRSTB    | AA5                             | AA5                             | U7                              | NVCC_JTAG           | GPIO     | ALT0                                  | IN                          | 47K PU                             |
| KEY_COL0      | B1                              | A9                              | B1                              | NVCC_KEYPAD         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| KEY_COL1      | B2                              | A10                             | B2                              | NVCC_KEYPAD         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| KEY_COL2      | C1                              | B9                              | C1                              | NVCC_KEYPAD         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| KEY_COL3      | C2                              | B10                             | C2                              | NVCC_KEYPAD         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| KEY_ROW0      | D1                              | A8                              | D1                              | NVCC_KEYPAD         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| KEY_ROW1      | D2                              | B8                              | D2                              | NVCC_KEYPAD         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| KEY_ROW2      | D4                              | D7                              | C3                              | NVCC_KEYPAD         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| KEY_ROW3      | E4                              | A7                              | D3                              | NVCC_KEYPAD         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| OWIRE         | G7                              | D12                             | E5                              | NVCC_MISC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| PMIC_ON_REQ   | W1                              | W1                              | Y3                              | NVCC_SRTC           | GPIO     | ALT0                                  | OUT-LO                      | —                                  |
| PMIC_STBY_REQ | W2                              | W2                              | Y2                              | NVCC_SRTC           | GPIO     | ALT0                                  | OUT-LO                      | —                                  |
| POR_B         | AD2                             | AD2                             | Y5                              | NVCC_RESET          | LVIO     | ALT0                                  | IN                          | 100K PU                            |
| PWM1          | F5                              | D11                             | E4                              | NVCC_MISC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| PWM2          | F4                              | D10                             | E3                              | NVCC_MISC           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| RESET_IN_B    | AC1                             | AC1                             | W3                              | NVCC_RESET          | LVIO     | ALT0                                  | IN                          | 100K PU                            |
| SD1_CLK       | P1                              | M1                              | R1                              | NVCC_SD1            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD1_CMD       | R1                              | N1                              | P4                              | NVCC_SD1            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD1_D0        | R2                              | P2                              | R2                              | NVCC_SD1            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD1_D1        | P2                              | N2                              | P1                              | NVCC_SD1            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD1_D2        | R4                              | M2                              | P3                              | NVCC_SD1            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD1_D3        | R5                              | R4                              | P2                              | NVCC_SD1            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_CD        | T4                              | J4                              | T1                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_CLK       | U1                              | E1                              | T3                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_CMD       | V5                              | G1                              | V1                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_D0        | T1                              | D1                              | R3                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_D1        | T2                              | D2                              | U1                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |

**Table 85. Alphabetical List of Signal Assignments (continued)**

| Pin Name  | 416<br>MAPBGA<br>Ball<br>Number | 416<br>PoPBGA<br>Ball<br>Number | 400<br>MAPBGA<br>Ball<br>Number | Pin Power<br>Domain | Pad Type | IOMUX<br>MUX<br>CTL<br>After<br>Reset | Direction<br>After<br>Reset | IOMUX<br>PAD CTL<br>After<br>Reset |
|-----------|---------------------------------|---------------------------------|---------------------------------|---------------------|----------|---------------------------------------|-----------------------------|------------------------------------|
| SD2_D2    | V1                              | F1                              | W2                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_D3    | V2                              | F2                              | T4                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_D4    | V4                              | G2                              | V2                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_D5    | U2                              | E2                              | U2                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_D6    | U4                              | H4                              | R4                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_D7    | U5                              | F4                              | W1                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD2_WP    | T5                              | G4                              | T2                              | NVCC_SD2            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_CLK   | AD16                            | T1                              | Y14                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_CMD   | AD17                            | T2                              | U16                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_D0    | AC15                            | V1                              | Y17                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_D1    | AC16                            | V2                              | V16                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_D2    | AC17                            | R1                              | T16                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_D3    | AA17                            | U2                              | U15                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_D4    | AA18                            | P1                              | W17                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_D5    | Y18                             | U1                              | U17                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_D6    | AA19                            | R2                              | V17                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_D7    | Y19                             | U4                              | T15                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SD3_WP    | AD15                            | T4                              | W16                             | NVCC_NANDF          | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SSI_RXC   | J7                              | AD12                            | H4                              | NVCC_SSI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SSI_RXD   | J5                              | AC14                            | F3                              | NVCC_SSI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SSI_RXFS  | H7                              | AD13                            | G5                              | NVCC_SSI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SSI_TXC   | J4                              | AC13                            | G3                              | NVCC_SSI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SSI_TXD   | H5                              | AD14                            | G4                              | NVCC_SSI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| SSI_TXFS  | H4                              | AC12                            | H3                              | NVCC_SSI            | HVIO     | ALT1                                  | IN                          | Keeper                             |
| TEST_MODE | AC2                             | AC2                             | U4                              | NVCC_RESET          | LVIO     | ALT0                                  | IN                          | 100K PD                            |
| UART1_CTS | H2                              | B4                              | J1                              | NVCC_UART           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| UART1_RTS | J2                              | B3                              | K2                              | NVCC_UART           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| UART1_RXD | J1                              | A2                              | K1                              | NVCC_UART           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| UART1_TXD | H1                              | A3                              | H1                              | NVCC_UART           | HVIO     | ALT1                                  | IN                          | Keeper                             |
| UART2_CTS | K2                              | B2                              |                                 | NVCC_UART           | HVIO     | ALT1                                  | IN                          | Keeper                             |

Table 85. Alphabetical List of Signal Assignments (continued)

| Pin Name        | 416<br>MAPBGA<br>Ball<br>Number | 416<br>PoPBGA<br>Ball<br>Number | 400<br>MAPBGA<br>Ball<br>Number | Pin Power<br>Domain               | Pad Type | IOMUX<br>MUX<br>CTL<br>After<br>Reset | Direction<br>After<br>Reset | IOMUX<br>PAD CTL<br>After<br>Reset |
|-----------------|---------------------------------|---------------------------------|---------------------------------|-----------------------------------|----------|---------------------------------------|-----------------------------|------------------------------------|
| UART2_RTS       | L2                              | C2                              |                                 | NVCC_UART                         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| UART2_RXD       | L1                              | C1                              | L2                              | NVCC_UART                         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| UART2_TXD       | K1                              | B1                              | L1                              | NVCC_UART                         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| UART3_RXD       | L4                              | E4                              | K3                              | NVCC_UART                         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| UART3_TXD       | K4                              | D4                              | J2                              | NVCC_UART                         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| UART4_RXD       | L5                              | D5                              | J3                              | NVCC_UART                         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| UART4_TXD       | K5                              | D6                              | H2                              | NVCC_UART                         | HVIO     | ALT1                                  | IN                          | Keeper                             |
| USB_H1_DN       | AC10                            | AC10                            | W10                             | USB_H1_VDDA25,<br>USB_H1_VDDA33   | ANALOG50 | —                                     | —                           | —                                  |
| USB_H1_DP       | AD10                            | AD10                            | Y10                             | USB_H1_VDDA25,<br>USB_H1_VDDA33   | ANALOG50 | —                                     | —                           | —                                  |
| USB_H1_GPANAIO  | Y11                             | AA17                            | U10                             | USB_H1_VDDA25,<br>USB_H1_VDDA33   | ANALOG25 | —                                     | —                           | —                                  |
| USB_H1_RREFEXT  | AA10                            | AA10                            | U9                              | USB_H1_VDDA25,<br>USB_H1_VDDA33   | ANALOG25 | —                                     | —                           | —                                  |
| USB_H1_VBUS     | Y10                             | AA16                            | V9                              | USB_H1_VDDA25,<br>USB_H1_VDDA33   | ANALOG50 | —                                     | —                           | —                                  |
| USB_OTG_DN      | AC8                             | AC8                             | W8                              | USB_OTG_VDDA25,<br>USB_OTG_VDDA33 | ANALOG50 | —                                     | —                           | —                                  |
| USB_OTG_DP      | AD8                             | AD8                             | Y8                              | USB_OTG_VDDA25,<br>USB_OTG_VDDA33 | ANALOG50 | —                                     | —                           | —                                  |
| USB_OTG_GPANAIO | Y7                              | AA14                            | V7                              | USB_OTG_VDDA25,<br>USB_OTG_VDDA33 | ANALOG25 | —                                     | —                           | —                                  |
| USB_OTG_ID      | Y8                              | AA12                            | Y7                              | USB_OTG_VDDA25,<br>USB_OTG_VDDA33 | ANALOG25 | —                                     | —                           | —                                  |
| USB_OTG_RREFEXT | AA8                             | AA8                             | W7                              | USB_OTG_VDDA25,<br>USB_OTG_VDDA33 | ANALOG25 | —                                     | —                           | —                                  |
| USB_OTG_VBUS    | Y9                              | AA13                            | V8                              | USB_OTG_VDDA25,<br>USB_OTG_VDDA33 | ANALOG50 | —                                     | —                           | —                                  |
| VREF            | M23                             | M23                             | K17                             | VDDO25                            | ANALOG   | —                                     | —                           | —                                  |
| WDOG            | G5                              | D9                              | F4                              | NVCC_MISC                         | HVIO     | ALT1                                  | IN                          | —                                  |
| XTAL            | AD5                             | AD5                             | Y6                              | VDD2P5                            | ANALOG   | —                                     | —                           | —                                  |

## 6 Revision History

Table 86 provides a revision history for this data sheet.

**Table 86. i.MX50 Data Sheet Document Revision History**

| Rev. Number | Date    | Substantive Change(s)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|-------------|---------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rev. 7      | 10/2013 | <ul style="list-style-type: none"> <li>Added new part number information for parts with 1 GHz core frequencies: <ul style="list-style-type: none"> <li>— MCIMX508CVK1B</li> <li>— MCIMX508CVM1B</li> <li>— MCIMX507CVM1B</li> <li>— MCIMX507CVK1B</li> </ul> </li> <li>Updated sections: <ul style="list-style-type: none"> <li>— Section 1, "Introduction"</li> <li>— Table 1, "Ordering Information"</li> <li>— Table 11, "i.MX50 Operating Ranges"</li> <li>— Table 15, "Maximum Supply Current Consumption—ARM CLK = 1 GHz" (added)</li> </ul> </li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                             |
| Rev. 6      | 07/2013 | <ul style="list-style-type: none"> <li>In Table 11, "i.MX50 Operating Ranges," added VCC Stop mode ranges.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| Rev. 5      | 05/2013 | <ul style="list-style-type: none"> <li>In Table 11, "i.MX50 Operating Ranges," changed VCC peripheral supply (LPM) minimum voltage from 0.9 V to 1 V, and changed nominal voltage from 0.95 V to 1.05 V.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| Rev. 4      | 01/2013 | <ul style="list-style-type: none"> <li>In Table 1, "Ordering Information," on page 7, added new part number information for MCIMX507CVK8B.</li> <li>In Figure 27, "DTACK Read Access," on page 67, updated timing of EIM_DTACK.</li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| Rev. 3      | 10/2012 | <ul style="list-style-type: none"> <li>In Table 11, "i.MX50 Operating Ranges," on page 24: <ul style="list-style-type: none"> <li>— Changed DDR clock rate for reduced performance mode (RPM) of VCC from 100 MHz to 133 MHz</li> <li>— Changed DDR clock rate for high performance mode (HPM) of VCC from 200 MHz to 266 MHz</li> </ul> </li> </ul>                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| Rev. 2      | 05/2012 | <ul style="list-style-type: none"> <li>In Table 1, "Ordering Information," on page 7, added the following new part numbers: MCIMX508CZK8B, MCIMX503CVK8B, MCIMX503EVM8B, MCIMX502CVK8B, and MCIMX502EVM8B.</li> <li>In Table 1, "Ordering Information," on page 7, added a new column, <math>T_{junction}</math>.</li> <li>In Table 3, "Package Feature Comparison," on page 9, added a new row for 416 PoPBGA package.</li> <li>Updated Figure 1, "i.MX50 System Block Diagram," on page 10 by removing "LDOx3" and "DC-DC 1.2V."</li> <li>In Table 5, "Special Signal Considerations," on page 17, updated details for the following signals: DRAM_OPEN/DRAM_OPENFB and DRAM_SDODT0/DRAM_SDODT1</li> <li>In Table 5, "Special Signal Considerations," on page 17, added new rows for the following signals: POP_EMMC_RST, POP_LPDDR2_ZQ0/ZQ1, POP_LPDDR2_1.8V, and POP_NAND_VCC.</li> <li>Added Section 4.1.2.1, "13 x 13 mm MAPBGA Package Thermal Resistance Data."</li> <li>Added Section 4.1.2.2, "13 x 13 mm PoPBGA Package Thermal Resistance Data."</li> <li>Added Section 4.1.2.3, "17 x 17 mm MAPBGA Package Thermal Resistance Data."</li> <li>In Table 11, "i.MX50 Operating Ranges," on page 24, added footnotes for USB_OTG_VDDA25 and USB_OTG_VDDA33.</li> <li>In Table 78, "VBUS Comparators Thresholds," on page 101, changed VBUS input max current to 350 <math>\mu</math>A.</li> <li>Added Section 5.2, "13 x 13 mm, 0.5 mm Pitch, 416 Pin PoPBGA Package Information."</li> <li>In Table 85, "Alphabetical List of Signal Assignments," on page 124: <ul style="list-style-type: none"> <li>— Added a new column "416 PoPBGA Ball Number"</li> <li>— Changed "USB_H1_VDDA" to "USB_H1_VDDA25, USB_H1_VDDA33"</li> <li>— Changed "USB_OTG_VDDA" to "USB_OTG_VDDA25, USB_OTG_VDDA33"</li> </ul> </li> <li>Replace mDDR with LPDDR1 throughout the document.</li> </ul> |

Table 86. i.MX50 Data Sheet Document Revision History (continued)

| Rev. Number | Date    | Substantive Change(s)                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |
|-------------|---------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rev. 1      | 10/2011 | <ul style="list-style-type: none"> <li>Table 5, "Special Signal Considerations," on page 17 changed CHRG_DET_B to CHGR_DET_B.</li> <li>Table 5, "Special Signal Considerations," on page 17 in the CHGR_DET_B signal remarks, added "The maximum current leakage at this pin is 8.5 <math>\mu</math>A."</li> <li>Table 5, "Special Signal Considerations," on page 17 in the JTAG_MOD remarks, changed "pull-down" to "pull-up, by default" and added "If JTAG port is not needed, the internal pull-up can be disabled in order to reduce supply current to the pin."</li> <li>Table 14, "Maximum Supply Current Consumption—ARM CLK = 800 MHz," on page 27 in the 11<sup>th</sup> row under the Supply column, changed VDDO2P5 to VDDO25.</li> <li>Table 78, "VBUS Comparators Thresholds," on page 101 changed CHRG_DET_B to CHGR_DET_B.</li> <li>Table 5, "Special Signal Considerations," on page 17 for 416 MAPBGA, DRAM_SDCLK_0 pin number was changed to N24 and DRAM_SDCLK_0_B pin number was changed to M24.</li> <li>Table 5, "Special Signal Considerations," on page 17 for 416 MAPBGA, DRAM_SDCLK_1 pin number was changed to T20 and DRAM_SDCLK_1_B pin number was changed to R20.</li> <li>Table 5, "Special Signal Considerations," on page 17 for 416 MAPBGA, DRAM_SDQS0 pin number was changed to P23 and DRAM_SDQS0_B pin number was changed to P24.</li> <li>Table 5, "Special Signal Considerations," on page 17 changed pad type of pin DRAM_CALIBRATION to DRAMCALIB.</li> <li>Table 5, "Special Signal Considerations," on page 17 changed pad type of pins DRAM_SDCLK_0, DRAM_SDCLK_0_B, DRAM_SDCLK_1, DRAM_SDCLK_1_B, DRAM_SDQS0, DRAM_SDQS0_B, DRAM_SDQS1, DRAM_SDQS1_B, DRAM_SDQS2, DRAM_SDQS2_B, DRAM_SDQS3, and DRAM_SDQS3_B to DRAMCLK.</li> </ul> |
| Rev. 0      | 07/2011 | Initial release.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |

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